



Components Selection Guide

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3 dB Hybrid Couplers

| Model Number | Package Size [Inch] | Freq. Band [MHz] | Ins. loss [dB max] | Isolation [dB min] | VSWR [max:1] | ± Amp. Bal. [dB max] | 90 ± Ph. Bal [deg. max] | Avg. Power [W max] |
|--------------|---------------------|------------------|--------------------|--------------------|--------------|----------------------|-------------------------|--------------------|
| XC0450A-03 | 0.56 x 0.35 | 410 - 480 | 0.36 | 23.0 | 1.22 | ± 0.15 | 90 ± 3.5 | 45 |
| XC0450L-03 | 0.65 x 0.48 | 410 - 480 | 0.20 | 23.0 | 1.15 | ± 0.15 | 90 ± 2.0 | 200 |
| XC0450E-03 | 0.56 x 0.20 | 460 - 470 | 0.35 | 20.0 | 1.22 | ± 0.35 | 90 ± 3.0 | 100 |
| 1F1304-3 | 0.65 x 0.48 | 670-860 | 0.40 | 21.0 | 1.25 | ± 0.50 | 90 ± 3.0 | 100 |
| XC0900P-03 | 0.25 x 0.20 | 800 - 1000 | 0.40 | 20.0 | 1.22 | ± 0.30 | 90 ± 4.0 | 25 |
| | | 824 - 849 | 0.35 | 20.0 | 1.22 | ± 0.30 | 90 ± 4.0 | 28 |
| | | 869 - 894 | 0.35 | 24.0 | 1.15 | ± 0.20 | 90 ± 4.0 | 28 |
| | | 925 - 960 | 0.37 | 25.0 | 1.17 | ± 0.20 | 90 ± 3.0 | 27 |
| XC0900E-03 | 0.56 x 0.20 | 800 - 1000 | 0.22 | 21.0 | 1.19 | ± 0.20 | 90 ± 3.0 | 70 |
| | | 869 - 894 | 0.20 | 23.0 | 1.17 | ± 0.15 | 90 ± 2.0 | 80 |
| | | 925 - 960 | 0.21 | 23.0 | 1.17 | ± 0.15 | 90 ± 2.5 | 75 |
| XC0900A-03 | 0.56 x 0.35 | 811 - 1000 | 0.15 | 23.0 | 1.15 | ± 0.20 | 90 ± 2.0 | 175 |
| | | 869 - 894 | 0.12 | 25.0 | 1.12 | ± 0.14 | 90 ± 2.0 | 225 |
| | | 925 - 960 | 0.12 | 25.0 | 1.12 | ± 0.14 | 90 ± 2.0 | 225 |
| XC0900L-03 | 0.65 x 0.48 | 800 -1000 | 0.12 | 25.0 | 1.12 | ± 0.13 | 90 ± 2.0 | 225 |
| S03B888N3 | 1.00 x 0.50 | 815 - 960 | 0.15 | 20.0 | 1.25 | ± 0.30 | 90 ± 1.5 | 300 |
| 11305-3 | 0.56 x 0.35 | 1000-2000 | 0.45 | 20.0 | 1.30 | ± 0.55 | 90 ± 3.0 | 60 |
| XC1400P-03 | 0.25 x 0.20 | 1200 - 1600 | 0.32 | 23.0 | 1.20 | ± 0.30 | 90 ± 4.0 | 30 |
| | | 1215 - 1240 | 0.23 | 23.0 | 1.17 | ± 0.30 | 90 ± 3.0 | 40 |
| | | 1563 - 1588 | 0.32 | 23.0 | 1.20 | ± 0.30 | 90 ± 4.0 | 30 |
| 1P503 | 0.25 x 0.20 | 1700 - 2000 | 0.25 | 18.0 | 1.28 | ± 0.30 | 90 ± 3.0 | 30 |
| XC1900E-03 | 0.56 x 0.20 | 1700 - 2000 | 0.12 | 23.0 | 1.17 | ± 0.13 | 90 ± 2.0 | 120 |
| | | 1805 - 1880 | 0.12 | 25.0 | 1.12 | ± 0.10 | 90 ± 2.0 | 120 |
| | | 1930 - 1990 | 0.12 | 25.0 | 1.12 | ± 0.10 | 90 ± 2.0 | 120 |
| XC1900A-03 | 0.56 x 0.35 | 1700 - 2000 | 0.15 | 25.0 | 1.15 | ± 0.13 | 90 ± 2.0 | 150 |
| | | 1805 - 1880 | 0.12 | 27.0 | 1.12 | ± 0.10 | 90 ± 2.0 | 150 |
| | | 1930 - 1990 | 0.12 | 27.0 | 1.12 | ± 0.10 | 90 ± 2.0 | 150 |
| S03B1960N3 | 1.00 x 0.50 | 1930 - 1990 | 0.15 | 20.0 | 1.25 | ± 0.25 | 90 ± 1.5 | 300 |
| XC2100E-03 | 0.56 x 0.20 | 2000 - 2300 | 0.12 | 23.0 | 1.17 | ± 0.15 | 90 ± 2.0 | 95 |
| | | 2110 - 2170 | 0.12 | 25.0 | 1.12 | ± 0.10 | 90 ± 2.0 | 100 |
| XC2100A-03 | 0.56 x 0.35 | 2000 - 2300 | 0.15 | 23.0 | 1.15 | ± 0.15 | 90 ± 2.0 | 105 |
| | | 2110 - 2170 | 0.12 | 25.0 | 1.12 | ± 0.10 | 90 ± 2.0 | 145 |
| S03B2150N3 | 1.00 x 0.50 | 2000 - 2300 | 0.15 | 20.0 | 1.25 | ± 0.25 | 90 ± 2.0 | 300 |
| XC2650P-03 | 0.25 x 0.20 | 2650 - 2800 | 0.25 | 20.0 | 1.20 | ± 0.15 | 90 ± 3.0 | 50 |
| XC2500E-03 | 0.56 x 0.20 | 2300 - 2700 | 0.15 | 22.0 | 1.17 | ± 0.15 | 90 ± 3.0 | 80 |
| XC2500A-03 | 0.56 x 0.35 | 2300 - 2700 | 0.13 | 25.0 | 1.14 | ± 0.15 | 90 ± 4.0 | 150 |
| | | 2300 - 2400 | 0.10 | 25.0 | 1.14 | ± 0.15 | 90 ± 4.0 | 200 |
| JP503 | 0.25 x 0.20 | 2000 - 2300 | 0.30 | 20.0 | 1.20 | ± 0.25 | 90 ± 3.0 | 25 |
| 11306-3 | 0.56 x 0.35 | 2000 - 4000 | 0.35 | 20.0 | 1.30 | ± 0.55 | 90 ± 5.0 | 60 |
| 1P603 | 0.25 x 0.20 | 2300 - 2700 | 0.30 | 20.0 | 1.20 | ± 0.25 | 90 ± 3.0 | 25 |
| 1M803 | 0.40 x 0.20 | 4800 - 6000 | 0.25 | 20.0 | 1.21 | ± 0.30 | 90 ± 3.5 | 20 |
| XC3500P-03 | 0.25 x 0.20 | 3300 - 3800 | 0.25 | 21.0 | 1.20 | ± 0.25 | 90 ± 3.0 | 55 |
| XC3500M-03 | 0.40 x 0.20 | 3300 - 3800 | 0.25 | 21.0 | 1.20 | ± 0.25 | 90 ± 3.0 | 70 |

Nomenclature Chart

XX XXXX X - XX X X

| Function | Frequency (MHz) | Size (Inches) | Coupling Value | Plating Finish | Packaging |
|--------------|--------------------|-----------------|----------------|-------------------|-----------|
| XC = Coupler | 0450 = 410 - 480 | A = 0.56 x 0.35 | 03 = 3 dB | P = Tin Lead | T = Tube |
| | 0900 = 800 - 1000 | B = 1.00 x 0.50 | 05 = 5 dB | S = Tin Immersion | R = Reel |
| | 1500 = 1000 - 2000 | E = 0.56 x 0.20 | 10 = 10 dB | | |
| | 1900 = 1700 - 2000 | L = 0.65 x 0.48 | 20 = 20 dB | | |
| | 2100 = 2000 - 2300 | M = 0.40 x 0.20 | 30 = 30 dB | | |
| | 2500 = 2300 - 2700 | P = 0.25 x 0.20 | | | |
| | 2650 = 2650 - 2800 | | | | |
| | 3500 = 3300 - 3700 | | | | |

Note: These tables are for reference only. Please review complete data sheet for actual specification data.

Nomenclature Chart

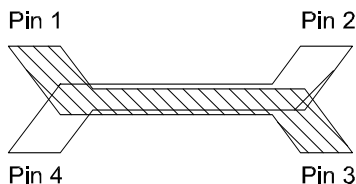
X X X XX X X

| Function | Size (Inches) | Frequency (MHz) | Coupling Value | Plating Finish | Packaging |
|--------------------|-----------------|-----------------|----------------|-------------------|-----------|
| 1 = Coupler | A = 0.56 x 0.35 | 4 = 670 - 860 | 03 = 3 dB | P = Tin Lead | T = Tube |
| J = Coupler | B = 1.00 x 0.50 | 5 = 1700 - 2300 | 05 = 5 dB | S = Tin Immersion | R = Reel |
| S03 = 3 dB Coupler | E = 0.56 x 0.20 | 6 = 2000 - 2700 | 06 = 6 dB | | |
| | F = 0.65 x 0.48 | 7 = 3300 - 3700 | 10 = 10 dB | | |
| | L = 0.65 x 0.48 | 8 = 5000 - 6000 | 20 = 20 dB | | |
| | M = 0.40 x 0.20 | | 30 = 30 dB | | |
| | P = 0.25 x 0.20 | | | | |
| | | | | | |

Note: These tables are for reference only. Please review complete data sheet for actual specification data

Hybrid Coupler Pin Configuration

The component has an orientation marker to denote Pin 1. Once port 1 has been identified, the other ports are known automatically. Please see the chart below for clarification:



| Configuration | Pin 1 | Pin 2 | Pin 3 | Pin 4 |
|---------------|---------------------------|---------------------------|---------------------------|---------------------------|
| Splitter | Input | Isolated | -3dB $\angle \theta - 90$ | -3dB $\angle \theta$ |
| Splitter | Isolated | Input | -3dB $\angle \theta$ | -3dB $\angle \theta - 90$ |
| Splitter | -3dB $\angle \theta - 90$ | -3dB $\angle \theta$ | Input | Isolated |
| Splitter | -3dB $\angle \theta$ | -3dB $\angle \theta - 90$ | Isolated | Input |
| *Combiner | $A \angle \theta - 90$ | $A \angle \theta$ | Isolated | Output |
| *Combiner | $A \angle \theta$ | $A \angle \theta - 90$ | Output | Isolated |
| *Combiner | Isolated | Output | $A \angle \theta - 90$ | $A \angle \theta$ |
| *Combiner | Output | Isolated | $A \angle \theta$ | $A \angle \theta - 90$ |

*Note: "A" is the amplitude of the applied signals. When two quadrature signals with equal amplitudes are applied to the coupler as described in the table, they will combine at the output port. If the amplitudes are not equal, some of the applied energy will be directed to the isolated port.

Directional Couplers

| Model Number | Package Size [Inch] | Freq. Band [MHz] | Mean Coupling [dB] | Ins. Loss [dB max] | Directivity [dB max] | VSWR [max:1] | Freq. Sens. [dB] | 90 ± Ph. Bal [deg. Max] | Avg. Power [W max] |
|--------------|---------------------|------------------|--------------------|--------------------|----------------------|--------------|------------------|-------------------------|--------------------|
| XC0450E-20 | 0.56 x 0.20 | 460 - 470 | 20.1 ± 1.5 | 0.30 | 17.0 | 1.22 | ± 0.20 | N/A | 100 |
| XC0900A-05 | 0.56 x 0.35 | 800 - 1000 | 5.0 ± 0.35 | 0.19 | 21.0 | 1.19 | ± 0.25 | 90 ± 2.0 | 200 |
| | | 869 - 894 | 5.0 ± 0.25 | 0.15 | 23.0 | 1.12 | ± 0.05 | 90 ± 2.0 | 250 |
| | | 925 - 960 | 5.0 ± 0.25 | 0.15 | 23.0 | 1.12 | ± 0.05 | 90 ± 2.0 | 250 |
| XC0900A-10 | 0.56 x 0.35 | 800 - 1000 | 10.1 ± 0.60 | 0.16 | 21.0 | 1.19 | ± 0.30 | N/A | 225 |
| | | 869 - 894 | 10.0 ± 0.50 | 0.14 | 25.0 | 1.12 | ± 0.08 | N/A | 250 |
| | | 925 - 960 | 10.0 ± 0.50 | 0.14 | 25.0 | 1.12 | ± 0.08 | N/A | 250 |
| XC0900A-20 | 0.56 x 0.35 | 800 - 1000 | 20.1 ± 0.60 | 0.18 | 23.0 | 1.15 | ± 0.20 | N/A | 150 |
| | | 700 - 800 | 20.7 ± 1.00 | 0.16 | 18.0 | 1.28 | ± 0.40 | N/A | 200 |
| | | 869 - 894 | 20.0 ± 0.50 | 0.14 | 25.0 | 1.12 | ± 0.05 | N/A | 200 |
| | | 925 - 960 | 20.0 ± 0.50 | 0.14 | 25.0 | 1.12 | ± 0.05 | N/A | 200 |
| XC0900B-30 | 1.00 x 0.50 | 800 - 1000 | 29.8 ± 1.00 | 0.10 | 23.0 | 1.15 | ± 0.40 | N/A | 355 |
| | | 865 - 895 | 29.6 ± 0.80 | 0.09 | 25.0 | 1.12 | ± 0.12 | N/A | 385 |
| | | 925 - 960 | 29.5 ± 0.80 | 0.09 | 25.0 | 1.12 | ± 0.08 | N/A | 355 |
| 1G1304-30 | 0.56 x 0.35 | 800 - 1000 | 30 ± 1.5 | 0.25 | 18.0 | 1.27 | ± 0.10 | N/A | 150 |
| XC0900P-10 | 0.25 x 0.20 | 800 - 1000 | 10.2 ± 1.0 | 0.38 | 15.0 | 1.35 | ± 0.36 | N/A | 45 |
| | | 869 - 894 | 10 ± 1.00 | 0.28 | 18.0 | 1.20 | ± 0.05 | N/A | 55 |
| | | 925 - 960 | 10 ± 1.00 | 0.32 | 18.0 | 1.20 | ± 0.05 | N/A | 50 |
| XC1500A-20 | 0.56 x 0.35 | 1000 - 2000 | 20.0 ± 0.70 | 0.19 | 21.0 | 1.28 | ± 1.25 | N/A | 150 |
| 1P520 | 0.25 x 0.20 | 1700 - 2000 | 20 ± 0.75 | 0.25 | 20.0 | 1.22 | ± 0.20 | N/A | 25 |
| XC1900A-05 | 0.56 x 0.35 | 1700 - 2000 | 5.0 ± 0.22 | 0.15 | 23.0 | 1.15 | ± 0.05 | 90 ± 2.0 | 200 |
| | | 1805 - 1880 | 5.0 ± 0.19 | 0.12 | 25.0 | 1.12 | ± 0.03 | 90 ± 2.0 | 200 |
| | | 1930 - 1990 | 5.0 ± 0.19 | 0.12 | 25.0 | 1.12 | ± 0.03 | 90 ± 2.0 | 200 |
| XC1900A-10 | 0.56 x 0.35 | 1700 - 2000 | 10.1 ± 0.50 | 0.16 | 23.0 | 1.15 | ± 0.10 | N/A | 175 |
| | | 1805 - 1880 | 10.0 ± 0.40 | 0.14 | 25.0 | 1.12 | ± 0.05 | N/A | 175 |
| | | 1930 - 1990 | 10.0 ± 0.40 | 0.14 | 25.0 | 1.12 | ± 0.05 | N/A | 175 |
| XC1900A-20 | 0.56 x 0.35 | 1700 - 2000 | 20.1 ± 0.60 | 0.15 | 23.0 | 1.15 | ± 0.12 | N/A | 150 |
| | | 1805 - 1880 | 20.0 ± 0.50 | 0.12 | 25.0 | 1.12 | ± 0.05 | N/A | 150 |
| | | 1930 - 1990 | 20.0 ± 0.50 | 0.12 | 25.0 | 1.12 | ± 0.05 | N/A | 150 |
| XC1900E-10 | 0.56 x 0.20 | 1700 - 2000 | 10.1 ± 0.50 | 0.14 | 21.0 | 1.19 | ± 0.10 | N/A | 175 |
| | | 1805 - 1880 | 10.0 ± 0.40 | 0.12 | 23.0 | 1.15 | ± 0.05 | N/A | 190 |
| | | 1930 - 1990 | 10.0 ± 0.40 | 0.14 | 23.0 | 1.15 | ± 0.05 | N/A | 175 |
| XC2100A-05 | 0.56 x 0.35 | 2000 - 2300 | 5.0 ± 0.22 | 0.15 | 23.0 | 1.15 | ± 0.05 | 90 ± 2.0 | 125 |
| | | 2110 - 2170 | 5.0 ± 0.19 | 0.12 | 25.0 | 1.12 | ± 0.03 | 90 ± 2.0 | 175 |
| XC2100A-10 | 0.56 x 0.35 | 2000 - 2300 | 10.1 ± 0.50 | 0.16 | 23.0 | 1.15 | ± 0.10 | N/A | 150 |
| | | 2110 - 2170 | 10.0 ± 0.40 | 0.14 | 25.0 | 1.12 | ± 0.05 | N/A | 175 |
| XC2100A-20 | 0.56 x 0.35 | 2000 - 2300 | 20.1 ± 0.60 | 0.15 | 23.0 | 1.15 | ± 0.12 | N/A | 120 |
| | | 2110 - 2170 | 20.0 ± 0.50 | 0.12 | 25.0 | 1.12 | ± 0.05 | N/A | 150 |
| XC2100A-30 | 0.56 x 0.35 | 2000 - 2300 | 30.0 ± 0.80 | 0.15 | 20.0 | 1.22 | ± 0.15 | N/A | 105 |
| | | 2110 - 2170 | 30.0 ± 0.60 | 0.12 | 22.0 | 1.17 | ± 0.10 | N/A | 105 |
| | | 1930 - 1990 | 30.0 ± 0.80 | 0.12 | 20.0 | 1.22 | ± 0.15 | N/A | 105 |
| | | 1805 - 1880 | 30.0 ± 0.80 | 0.12 | 20.0 | 1.22 | ± 0.15 | N/A | 105 |
| XC2100B-30 | 1.00 X 0.35 | 2300 - 2700 | 30.0 ± 1.25 | 0.15 | 18.0 | 1.22 | ± 0.40 | N/A | 150 |
| | | 1805 - 1880 | 29.8 ± 1.00 | 0.12 | 20.0 | 1.22 | ± 0.15 | N/A | 300 |
| | | 1930 - 1990 | 29.8 ± 1.00 | 0.12 | 20.0 | 1.22 | ± 0.10 | N/A | 300 |
| | | 2110 - 2170 | 29.8 ± 1.00 | 0.12 | 20.0 | 1.22 | ± 0.10 | N/A | 300 |
| XC2100E-10 | 0.56 x 0.20 | 2000 - 2300 | 10.1 ± 0.50 | 0.14 | 21.0 | 1.19 | ± 0.10 | N/A | 155 |
| | | 2110 - 2170 | 10.0 ± 0.40 | 0.12 | 23.0 | 1.15 | ± 0.05 | N/A | 165 |
| JP506 | 0.25 x 0.20 | 2000 - 2300 | 6 ± 0.5 | 0.30 | 20.0 | 1.22 | ± 0.20 | N/A | 20 |
| 1P510 | 0.25 x 0.20 | 2000 - 2300 | 10 ± 0.75 | 0.25 | 20.0 | 1.22 | ± 0.20 | N/A | 20 |
| JP510 | 0.25 x 0.20 | 2000 - 2300 | 10 ± 0.75 | 0.25 | 20.0 | 1.22 | ± 0.20 | N/A | 20 |
| JP520 | 0.25 x 0.20 | 2000 - 2300 | 20 ± 0.75 | 0.25 | 20.0 | 1.22 | ± 0.20 | N/A | 25 |
| XC2500E-10 | 0.56 x 0.20 | 2300 - 2700 | 10.0 ± 0.50 | 0.14 | 21.0 | 1.19 | ± 0.10 | N/A | 145 |
| XC2500P-20 | 0.25 x 0.20 | 2300 - 2700 | 20.0 ± 1.00 | 0.20 | 20.0 | 1.20 | ± 0.30 | N/A | 20 |
| 1P610 | 0.25 x 0.20 | 2300 - 2700 | 10 ± 0.75 | 0.25 | 20.0 | 1.22 | ± 0.20 | N/A | 20 |
| 1P620 | 0.25 x 0.20 | 2300 - 2700 | 20 ± 0.75 | 0.25 | 20.0 | 1.22 | ± 0.20 | N/A | 25 |
| XC3500P-20 | 0.25 x 0.20 | 3300 - 3800 | 20.0 ± 1.00 | 0.20 | 20.0 | 1.20 | ± 0.30 | N/A | 45 |
| XC3500M-20 | 0.40 x 0.20 | 3300 - 3800 | 20.0 ± 1.00 | 0.20 | 21.0 | 1.20 | ± 0.30 | N/A | 80 |
| 1M710 | 0.40 x 0.20 | 3300 - 3700 | 10.5 ± 0.8 | 0.25 | 20.0 | 1.20 | ± 0.20 | N/A | 22 |
| 1M810 | 0.40 x 0.20 | 5000 - 6000 | 10.0 ± .75 | 0.30 | 18.0 | 1.33 | ± 0.30 | N/A | 15 |

Nomenclature Chart

XX XXXX X - XX X X

| Function | Frequency (MHz) | Size (Inches) | Coupling Value | Plating Finish | Packaging |
|--------------|--------------------|-----------------|----------------|-------------------|-----------|
| XC = Coupler | 0450 = 410 - 480 | A = 0.56 x 0.35 | 03 = 3 dB | P = Tin Lead | T = Tube |
| | 0900 = 800 - 1000 | B = 1.00 x 0.50 | 05 = 5 dB | S = Tin Immersion | R = Reel |
| | 1500 = 1000 - 2000 | E = 0.56 x 0.20 | 10 = 10 dB | | |
| | 1900 = 1700 - 2000 | L = 0.65 x 0.48 | 20 = 20 dB | | |
| | 2100 = 2000 - 2300 | M = 0.40 x 0.20 | 30 = 30 dB | | |
| | 2500 = 2300 - 2700 | P = 0.25 x 0.20 | | | |
| | 2650 = 2650 - 2800 | | | | |
| | 3500 = 3300 - 3700 | | | | |

Note: These tables are for reference only. Please review complete data sheet for actual specification data.

Nomenclature Chart

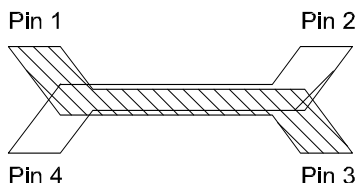
X X X XX X X

| Function | Size (Inches) | Frequency (MHz) | Coupling Value | Plating Finish | Packaging |
|--------------------|-----------------|-----------------|----------------|-------------------|-----------|
| 1 = Coupler | A = 0.56 x 0.35 | 4 = 670 - 860 | 03 = 3 dB | P = Tin Lead | T = Tube |
| J = Coupler | B = 1.00 x 0.50 | 5 = 1700 - 2300 | 05 = 5 dB | S = Tin Immersion | R = Reel |
| S03 = 3 dB Coupler | E = 0.56 x 0.20 | 6 = 2000 - 2700 | 06 = 6 dB | | |
| | F = 0.65 x 0.48 | 7 = 3300 - 3700 | 10 = 10 dB | | |
| | L = 0.65 x 0.48 | 8 = 5000 - 6000 | 20 = 20 dB | | |
| | M = 0.40 x 0.20 | | 30 = 30 dB | | |
| | P = 0.25 x 0.20 | | | | |
| | | | | | |

Note: These tables are for reference only. Please review complete data sheet for actual specification data.

Directional Coupler Pin Configuration (5dB Only)

The component has an orientation marker to denote Pin 1. Once port one has been identified the other ports are known automatically. Please see the chart below for clarification:

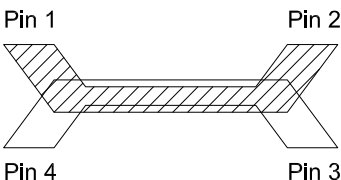


| Pin 1 | Pin 2 | Pin 3 | Pin 4 |
|----------|----------|----------|----------|
| Input | Isolated | Direct | Coupled |
| Isolated | Input | Coupled | Direct |
| Direct | Coupled | Input | Isolated |
| Coupled | Direct | Isolated | Input |

Note: The direct port has a DC connection to the input port and the coupled port has a DC connection to the isolated port.

Directional Coupler Pin Configuration (All Other Directionals)

The component has an orientation marker to denote Pin 1. Once port one has been identified the other ports are known automatically. Please see the chart below for clarification:



20dB Coupler Pin Configuration

| Pin 1 | Pin 2 | Pin 3 | Pin 4 |
|--------|--------|----------|----------|
| Input | Direct | Isolated | Coupled |
| Direct | Input | Coupled | Isolated |

Note: The direct port has a DC connection to the input port and the coupled port has a DC connection to the isolated port.

For optimum performance, use Pin 1 or Pin 2 as inputs.



Selection Matrix

| Crossover Selection Matrix | | | | | | |
|----------------------------|-----------------|-----------|-------------------|---------------------|------------------|-----------------------------|
| Model Number | Frequency [MHz] | Power [W] | Size LxW [inches] | Insertion Loss [dB] | Return Loss [dB] | Port Impedance [Ω] |
| X2A | 0 – 6000 | 30 | 0.2 x 0.2 | 0.05 | 15 | 50 |
| X2B | 0 – 6000 | 30 | 0.2 x 0.2 | 0.05 | 15 | 50 |

| Balun Transformers Selection Matrix | | | | | | | | | |
|-------------------------------------|-----------------|-----------|-------------------|--|--------------------------------------|---------------------|------------------------|-------------------|--------------------|
| Model Number | Frequency [MHz] | Power [W] | Size LxW [inches] | Unbalanced Port Impedance [Ω] | Balanced Port Impedance [Ω] | Insertion Loss [dB] | Amplitude Balance [dB] | Phase Balance [°] | RL Unbalanced [dB] |
| 3A325 | 470 – 860 | 275 | 0.75 x 0.87 | 50 | 25 | 0.65 | 0.50 | 180 \pm 5 | 10.0 |
| 3A412 | 800 – 1000 | 250 | 1.00 x 0.75 | 50 | 12.5 | 0.48 | 0.40 | 180 \pm 5 | 15.0 |
| 3A425 | 800 – 1000 | 250 | 0.75 x 0.79 | 50 | 25 | 0.35 | 0.40 | 180 \pm 5 | 15.0 |
| 3A512 | 1400 – 1600 | 250 | 0.75 x 0.55 | 50 | 12.5+j3.5 | 0.30 | 0.40 | 180 \pm 5 | 15.0 |
| 3A525 | 1500 – 1900 | 150 | 0.65 x 0.48 | 50 | 25 | 0.35 | 0.40 | 180 \pm 5 | 15.0 |
| 3A625 | 2300 – 2700 | 150 | 0.65 x 0.48 | 50 | 25 | 0.35 | 0.40 | 180 \pm 5 | 15.0 |
| 3W512 | 1800 – 2200 | 150 | 0.75 x 0.55 | 50 | 12.5+j5.5 | 0.40 | 0.40 | 180 \pm 5 | 15.0 |
| 3W525 | 1800 – 2500 | 150 | 0.65 x 0.48 | 50 | 25 | 0.38 | 0.40 | 180 \pm 5 | 15.0 |

Note: These tables are for reference only. Please review complete data sheet for actual specification data.

Nomenclature Chart

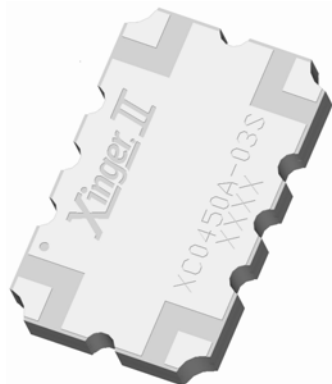
X X X XX X X

| Function | Miscellaneous Code | Frequency (MHz) | Output to Ω Ground | Plating Finish | Packaging |
|-----------------------|--------------------|-----------------|---------------------------|-------------------|-----------|
| 3 = Balun Transformer | A | 3 = 470 – 880 | 12 = 12.5 Ohms | P = Tin Lead | T = Tube |
| | W | 4 = 800 - 1000 | 25 = 25 Ohms | S = Tin Immersion | R = Reel |
| | | 5 = 1400 - 2500 | | | |
| | | 6 = 2000 - 2700 | | | |

Note: These tables are for reference only. Please review complete data sheet for actual specification data.

Xinger II

Hybrid Coupler 3 dB, 90°



Description

The XC0450A-03 is a low profile, high performance 3dB hybrid coupler in a new easy to use, manufacturing friendly surface mount package. It is designed for NMT band applications. The XC0450A-03 is designed particularly for balanced power and low noise amplifiers, plus signal distribution and other applications where low insertion loss and tight amplitude and phase balance is required. It can be used in high power applications up to 45 Watts.

Parts have been subjected to rigorous qualification testing and they are manufactured using materials with coefficients of thermal expansion (CTE) compatible with common substrates such as FR4, G-10, RF-35, RO4350, and polyimide. Available in both 5 of 6 tin lead (XC0450A-03P) and 6 of 6 RoHS compliant tin immersion (XC0450A-03S).

Electrical Specifications **

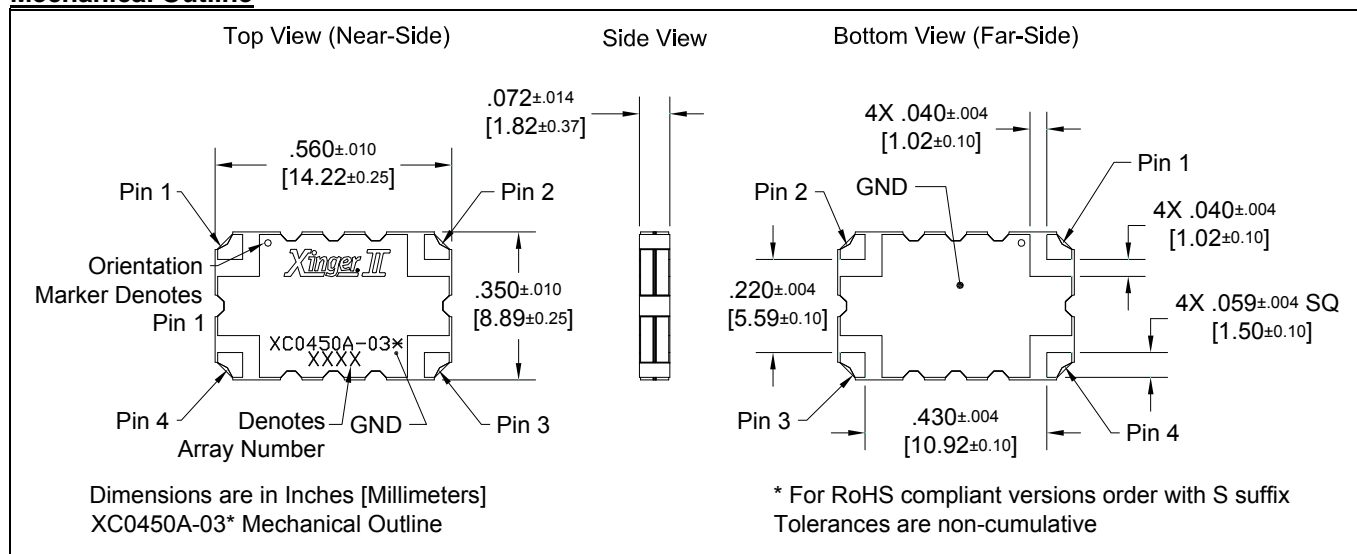
Features:

- 410 – 480 MHz
- NMT
- Very Low Loss
- Tight Amplitude Balance
- High Isolation
- Production Friendly
- Tape and Reel
- Available in Lead-Free (as illustrated) or Tin-Lead
- Reliable, FIT= 0.53

| Frequency | Isolation | Insertion Loss | VSWR | Amplitude Balance |
|---------------|---------------|----------------|-----------------|-------------------|
| MHz | dB Min | dB Max | Max : 1 | dB Max |
| 410-480 | 23 | 0.36 | 1.22 | ± 0.15 |
| Phase Balance | Power | ΘJC | Operating Temp. | |
| Degrees | Avg. CW Watts | °C/Watt | °C | |
| 90 ± 3.5 | 45 | 27 | -55 to +95 | |

**Specification based on performance of unit properly installed on Anaren Test Board 58481-0001 with small signal applied. Specifications subject to change without notice. Refer to parameter definitions for details.

Mechanical Outline



Xinger II

Hybrid Coupler 3 dB, 90°



Description

The XC0450L-03 is a low profile, high performance 3dB hybrid coupler in a new easy to use, manufacturing friendly surface mount package. It is designed for NMT band applications. The XC0450L-03 is designed particularly for balanced power and low noise amplifiers, plus signal distribution and other applications where low insertion loss and tight amplitude and phase balance is required. It can be used in high power applications up to 200 Watts.

Parts have been subjected to rigorous qualification testing and they are manufactured using materials with coefficients of thermal expansion (CTE) compatible with common substrates such as FR4, G-10, RF-35, and RO4350. Available in both 5 of 6 tin lead (XC0450L-03P) and 6 of 6 tin immersion (XC0450L-03S) RoHS compliant finishes.

Electrical Specifications **

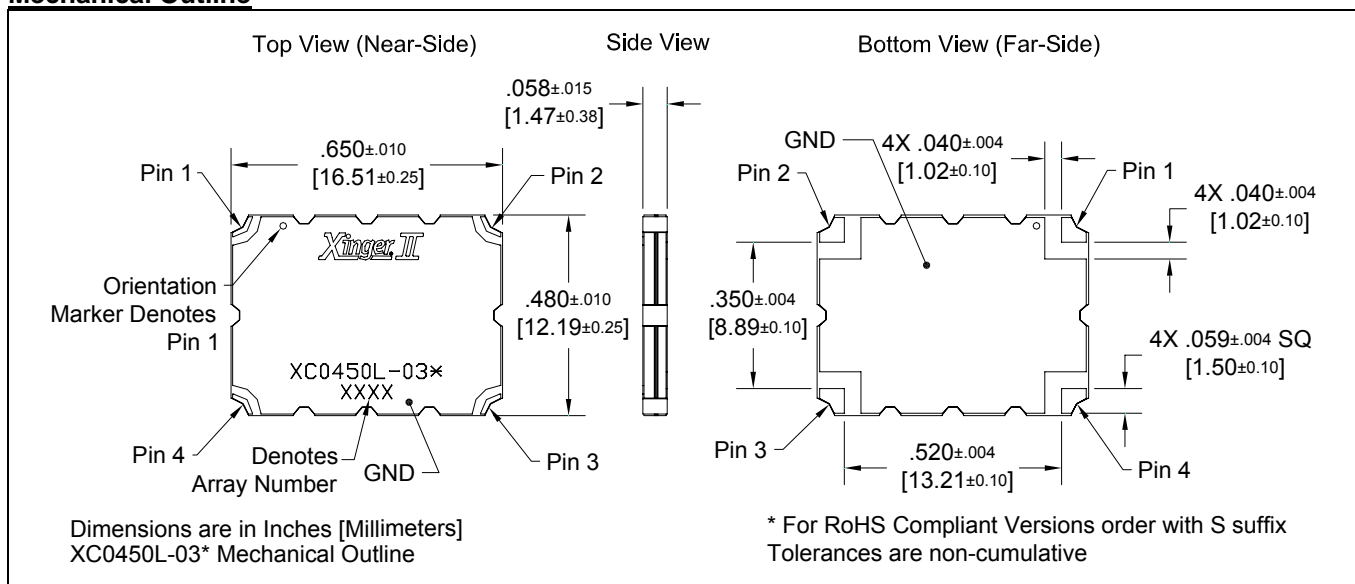
Features:

- 410 – 480 MHz
- NMT
- High Power
- Very Low Loss
- Tight Amplitude Balance
- High Isolation
- Production Friendly
- Tape and Reel
- Available in Lead-Free (as illustrated) or Tin-Lead
- Reliable, FIT= 0.53

| Frequency | Isolation | Insertion Loss | VSWR | Amplitude Balance |
|---------------|---------------|----------------|-----------------|-------------------|
| MHz | dB Min | dB Max | Max:1 | dB Max |
| 410 – 480 | 23 | 0.20 | 1.15 | ± 0.15 |
| Phase Balance | Power | θJC | Operating Temp. | |
| Degrees | Ave. CW Watts | °C/ Watt | °C | |
| 90 ± 2 | 200 | 11.0 | -55 to +95 | |

**Specification based on performance of unit properly installed on Anaren Test Board 57904-0001 with small signal applied. Specifications subject to change without notice. Refer to parameter definitions for details.

Mechanical Outline



Xinger II

Hybrid Coupler 3 dB, 90°



Description

The XC0450E-03S is a low profile, high performance 3dB hybrid coupler in a new easy to use, manufacturing friendly surface mount package. The XC0450E-03S is designed particularly for balanced power and low noise amplifiers, plus signal distribution and other applications where low insertion loss and tight amplitude and phase balance is required. It can be used in high power applications up to 100 watts.

Parts have been subjected to rigorous qualification testing and they are manufactured using materials with coefficients of thermal expansion (CTE) compatible with common substrates such as FR4, G-10, RF-35, RO4350 and polyimide. Produced with 6 of 6 RoHS compliant Tin Immersion finish.

Features:

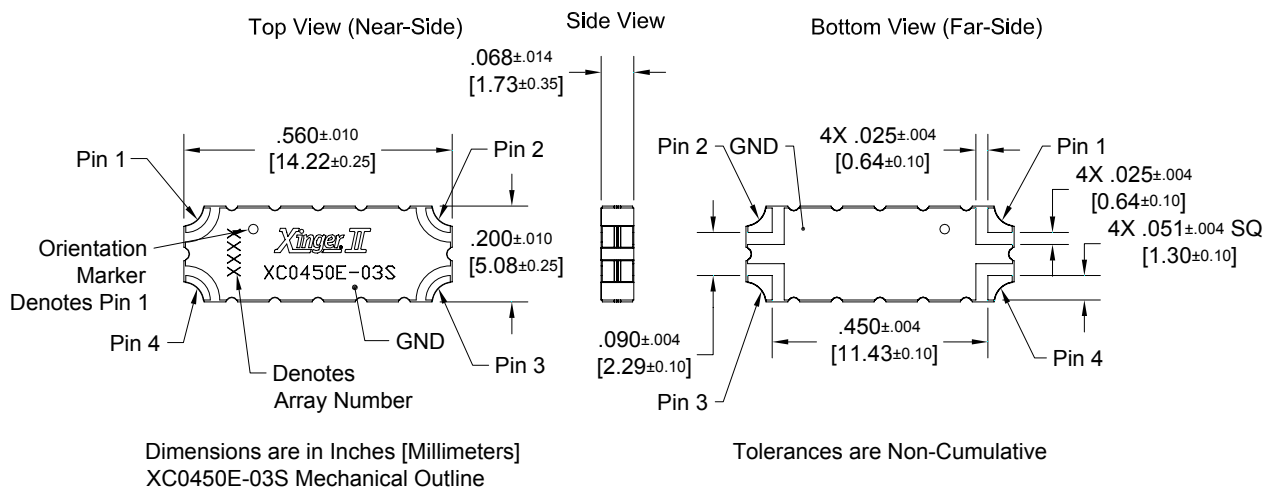
- 460-470 MHz
- High Power
- Very Low Loss
- Tight Amplitude Balance
- High Isolation
- Production Friendly
- Tape and Reel
- Lead-Free

Electrical Specifications **

| Frequency | Isolation | Insertion Loss | VSWR | Amplitude Balance |
|-----------|---------------|----------------|-----------------|-------------------|
| MHz | dB Min | dB Max | Max : 1 | dB Max |
| 460 – 470 | 20 | 0.35 | 1.22 | ± 0.35 |
| Phase | Power | θJC | Operating Temp. | |
| Degrees | Avg. CW Watts | °C/Watt | °C | |
| 90 ± 3.0 | 100 | 19.4 | -55 to +85 | |

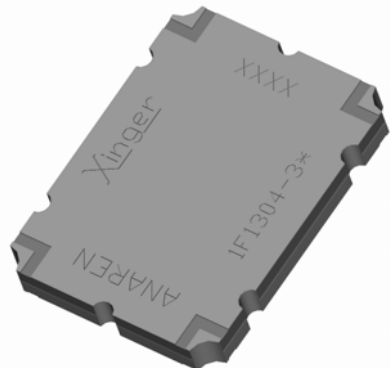
**Specification based on performance of unit properly installed on Anaren Test Board 58492-0001 with small signal applied. Specifications subject to change without notice. Refer to parameter definitions for details.

Mechanical Outline



Xinger®

Hybrid Couplers 3 dB, 90°



Description

The 1F1304-3S is a low profile 3dB hybrid coupler in an easy to use surface mount package covering 470 to 860 MHz. The 1F1304-3S is ideal for balanced amplifiers and signal distribution and can be used in most high power designs. Parts have been subjected to rigorous qualification testing and units are 100% tested. They are manufactured using materials with x and y thermal expansion coefficients compatible with common substrates such as FR4, G-10 and polyimide. Available in both 5 of 6 tin lead (1F1304-3) and 6 of 6 tin immersion (1F1304-3S) RoHS compliant finishes.

Features:

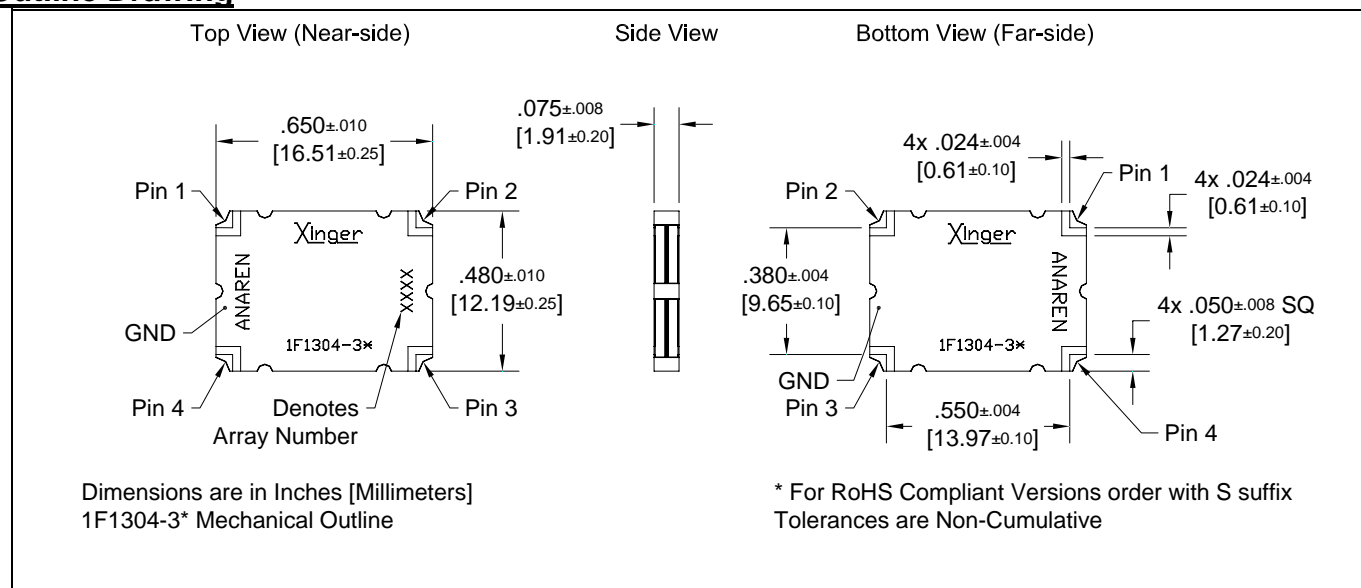
- 470 - 860 MHz
- Low loss
- High Isolation
- 90° Quadrature
- Surface Mountable
- Tape And Reel
- Convenient Package
- 100% Tested
- Lead Free Available

ELECTRICAL SPECIFICATIONS**

| Frequency | Isolation | Insertion Loss | VSWR | |
|-------------------|---------------|----------------|----------|-----------------|
| MHz | dB Min | dB Max | Max:1 | |
| 470 - 860 | 21 | 0.40 | 1.25 | |
| Amplitude Balance | Phase Balance | Power | ΘJC | Operating Temp. |
| dB Max | Degrees | Ave. CW Watts | °C/ Watt | °C |
| ± 0.50 | ± 3 | 100 | 8.6 | -55 to +85 |

**Specification based on performance of unit properly installed on microstrip printed circuit boards with 50 Ω nominal impedance. Specifications subject to change without notice.

Outline Drawing



Xinger® II

Hybrid Coupler 3 dB, 90°



Description

The XC0900P-03S is a low profile, high performance 3dB hybrid coupler in a new easy to use, manufacturing friendly surface mount package. It is designed for AMPS band applications. The XC0900P-03S is designed particularly for balanced power and low noise amplifiers, plus signal distribution and other applications where low insertion loss and tight amplitude and phase balance is required. It can be used in high power applications up to 28 Watts.

Parts have been subjected to rigorous qualification testing and they are manufactured using materials with coefficients of thermal expansion (CTE) compatible with common substrates such as FR4, G-10, RF-35, and RO4350. Produced with 6 of 6 RoHS compliant tin immersion.

Electrical Specifications **

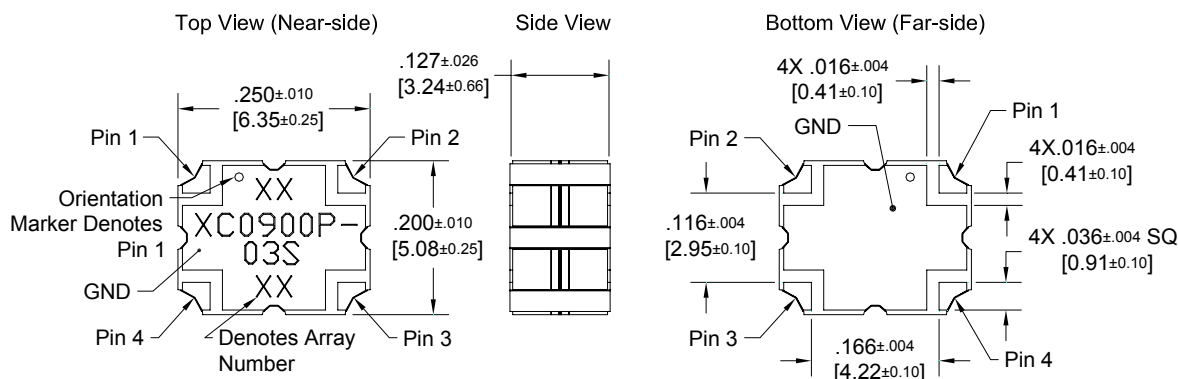
Features:

- 800 – 1000 MHz
- AMPS
- High Power
- Very Low Loss
- Tight Amplitude Balance
- High Isolation
- Production Friendly
- Tape and Reel
- Lead-Free
- Reliable, FIT=0.49

| Frequency | Isolation | Insertion Loss | VSWR | Amplitude Balance |
|------------|---------------|----------------|-----------------|-------------------|
| MHz | dB Min | dB Max | Max : 1 | dB Max |
| 800 - 1000 | 20 | 0.40 | 1.22 | +/-0.30 |
| 824 - 849 | 20 | 0.35 | 1.22 | +/-0.30 |
| 869 - 894 | 24 | 0.35 | 1.15 | +/-0.20 |
| 925 - 960 | 25 | 0.37 | 1.17 | +/-0.20 |
| Phase | Power | θJC | Operating Temp. | |
| Degrees | Avg. CW Watts | °C/Watt | °C | |
| 90 ± 5.0 | 25 | 45 | -55 to +85 | |
| 90 ± 4.0 | 28 | 45 | -55 to +85 | |
| 90 ± 4.0 | 28 | 45 | -55 to +85 | |
| 90 ± 4.0 | 27 | 45 | -55 to +85 | |

**Specification based on performance of unit properly installed on Anaren Test Board 54147-0001 with small signal applied. Specifications subject to change without notice. Refer to parameter definitions for details.

Mechanical Outline



Dimensions are in Inches [Millimeters]
XC0900P-03S Mechanical Outline

Tolerances are Non-Cumulative



Xinger II

Hybrid Coupler 3 dB, 90°



Description

The XC0900E-03 is a low profile, high performance 3dB hybrid coupler in a new easy to use, manufacturing friendly surface mount package. It is designed for AMPS band applications. The XC0900E-03 is designed particularly for balanced power and low noise amplifiers, plus signal distribution and other applications where low insertion loss and tight amplitude and phase balance is required. It can be used in high power applications up to 80 watts.

Parts have been subjected to rigorous qualification testing and they are manufactured using materials with coefficients of thermal expansion (CTE) compatible with common substrates such as FR4, G-10, RF-35, RO4350 and polyimide. Available in both 5 of 6 tin lead (XC0900E-03P) and 6 of 6 tin immersion (XC0900E-03S) RoHS compliant finishes.

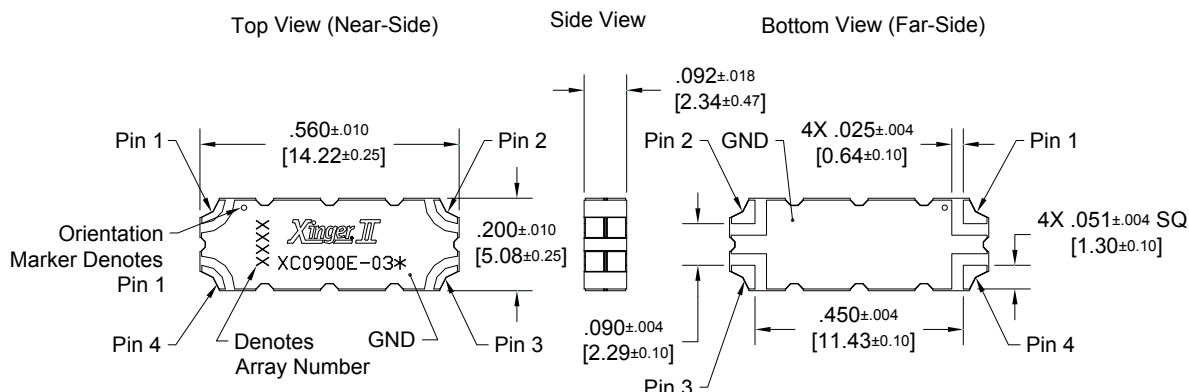
Electrical Specifications **

Features:

- 800-1000 MHz
- AMPS
- High Power
- Very Low Loss
- Tight Amplitude Balance
- High Isolation
- Production Friendly
- Tape and Reel
- Available in Lead-Free (as illustrated) or Tin-Lead
- Reliable, FIT=0.53

| Frequency | Isolation | Insertion Loss | VSWR | Amplitude Balance |
|-----------|---------------|----------------|-----------------|-------------------|
| MHz | dB Min | dB Max | Max : 1 | dB Max |
| 800-1000 | 21 | 0.22 | 1.19 | ± 0.20 |
| 869-894 | 23 | 0.20 | 1.17 | ± 0.15 |
| 925-960 | 23 | 0.21 | 1.17 | ± 0.15 |
| Phase | Power | ΘJC | Operating Temp. | |
| Degrees | Avg. CW Watts | °C/Watt | °C | |
| 90 ± 3.0 | 70 | 31 | -55 to +95 | |
| 90 ± 2.0 | 80 | 31 | -55 to +95 | |
| 90 ± 2.5 | 75 | 31 | -55 to +95 | |

**Specification based on performance of unit properly installed on Anaren Test Board 58492-0001 with small signal applied. Specifications subject to change without notice. Refer to parameter definitions for details.



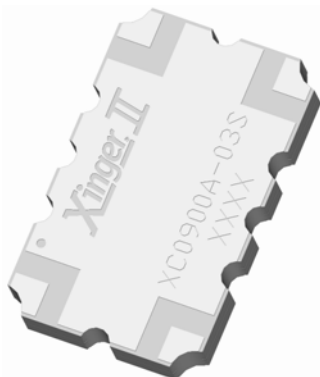
Dimensions are in Inches [Millimeters]
XC0900E-03* Mechanical Outline

*For RoHS Compliant Versions order with S suffix
Tolerances are Non-Cumulative



Xinger II

Hybrid Coupler 3 dB, 90°



Description

The XC0900A-03 is a low profile, high performance 3dB hybrid coupler in a new easy to use, manufacturing friendly surface mount package. It is designed for AMPS band applications. The XC0900A-03 is designed particularly for balanced power and low noise amplifiers, plus signal distribution and other applications where low insertion loss and tight amplitude and phase balance is required. It can be used in high power applications up to 225 Watts.

Parts have been subjected to rigorous qualification testing and they are manufactured using materials with coefficients of thermal expansion (CTE) compatible with common substrates such as FR4, G-10, RF-35, RO4350 and polyimide. Available in both 5 of 6 tin lead (XC0900A-03P) and 6 of 6 tin immersion (XC0900A-03S) RoHS compliant finishes.

Electrical Specifications **

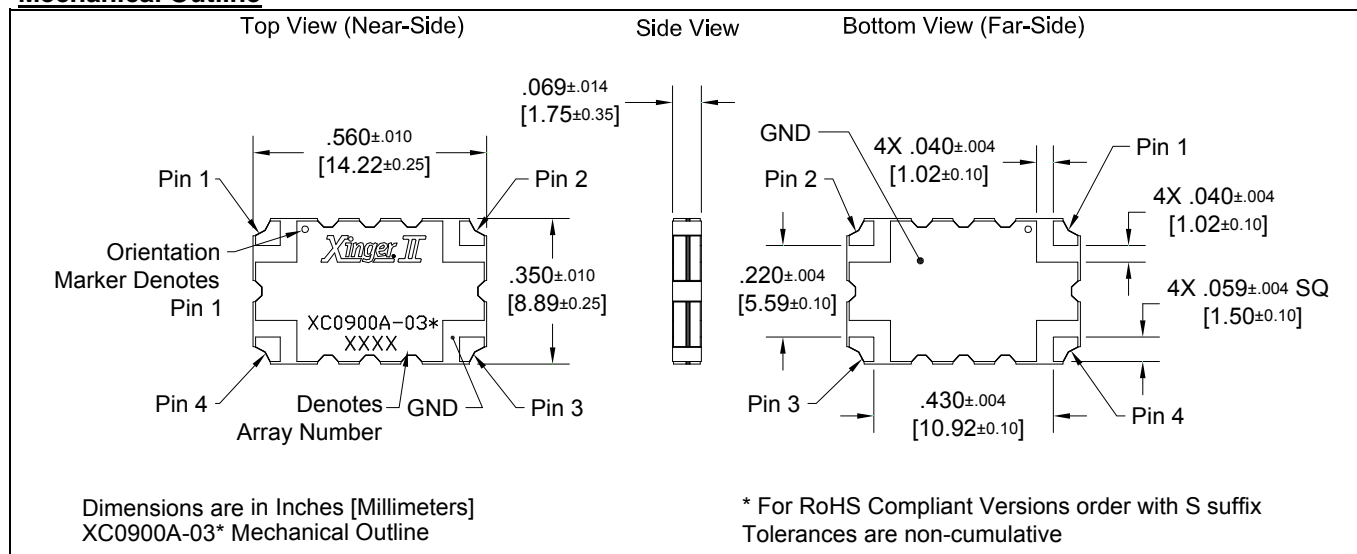
Features:

- 811 – 1000 MHz
- AMPS
- High Power
- Very Low Loss
- Tight Amplitude Balance
- High Isolation
- Production Friendly
- Tape and Reel
- Available in Lead-Free (as illustrated) or Tin-Lead
- Reliable, FIT=0.53

| Frequency | Isolation | Insertion Loss | VSWR | Amplitude Balance |
|---------------|---------------|----------------|-----------------|-------------------|
| MHz | dB Min | dB Max | Max : 1 | dB Max |
| 811 - 1000 | 23 | 0.15 | 1.15 | ± 0.20 |
| 869 - 894 | 25 | 0.12 | 1.12 | ± 0.14 |
| 925 - 960 | 25 | 0.12 | 1.12 | ± 0.14 |
| Phase Balance | Power | θJC | Operating Temp. | |
| Degrees | Avg. CW Watts | °C/Watt | °C | |
| 90 ± 2.0 | 175 | 18 | -55 to +95 | |
| 90 ± 2.0 | 225 | 18 | -55 to +95 | |
| 90 ± 2.0 | 225 | 18 | -55 to +95 | |

**Specification based on performance of unit properly installed on Anaren Test Board 58481-0001 with small signal applied. Specifications subject to change without notice. Refer to parameter definitions for details.

Mechanical Outline



Hybrid Coupler

3 dB, 90°

Description

The XC0900L-03 is a low profile, high performance 3dB hybrid coupler in a new easy to use, manufacturing friendly surface mount package. It is designed for AMPS band applications. The XC0900L-03 is designed particularly for balanced power and low noise amplifiers, plus signal distribution and other applications where low insertion loss and tight amplitude and phase balance is required. It can be used in high power applications up to 225 Watts.

Parts have been subjected to rigorous qualification testing and they are manufactured using materials with coefficients of thermal expansion (CTE) compatible with common substrates such as FR4, G-10, RF-35, and RO4350. Available in both 5 of 6 tin lead (XC0900L-03P) and 6 of 6 tin immersion (XC0900L-03S) RoHS compliant finishes.

Electrical Specifications **

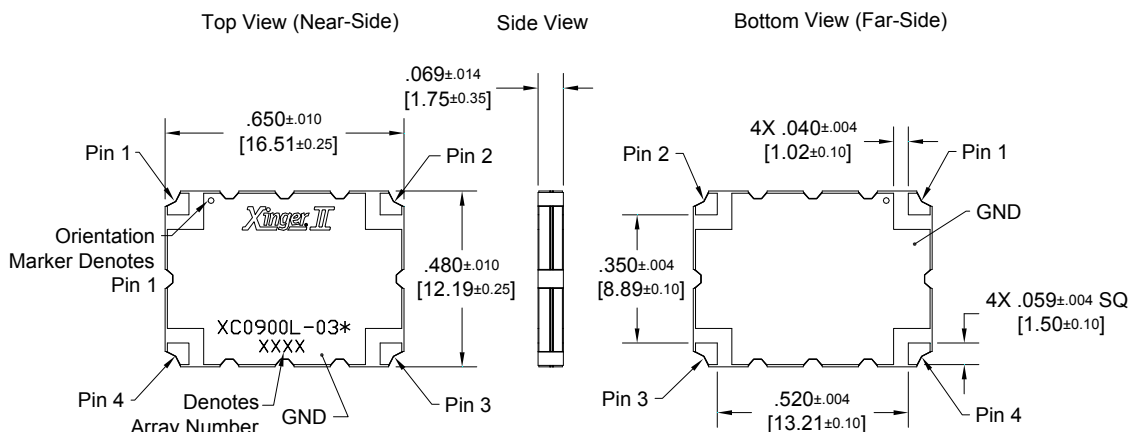
Features:

- 800 – 1000 MHz
- AMPS
- High Power
- Very Low Loss
- Tight Amplitude Balance
- High Isolation
- Production Friendly
- Tape and Reel
- Available in Lead-Free (as illustrated) or Tin-Lead
- Reliable, FIT=0.53

| Frequency | Isolation | Insertion Loss | VSWR | Amplitude Balance |
|------------|---------------|----------------|----------------|-------------------|
| <i>MHz</i> | <i>dB Min</i> | <i>dB Max</i> | <i>Max : 1</i> | <i>dB Max</i> |
| 800 - 1000 | 23 | 0.16 | 1.15 | ± 0.17 |
| 869 - 894 | 25 | 0.12 | 1.12 | ± 0.13 |
| 925 - 960 | 25 | 0.12 | 1.12 | ± 0.13 |

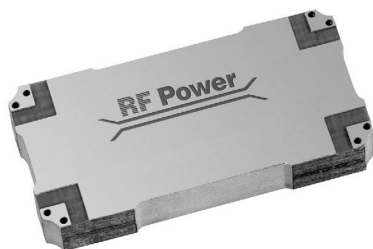
| Phase | Power | ⊙JC | Operating Temp. |
|----------------|----------------------|----------------|-----------------|
| <i>Degrees</i> | <i>Avg. CW Watts</i> | <i>°C/Watt</i> | <i>°C</i> |
| 90 ± 2.0 | 175 | 15 | -55 to +95 |
| 90 ± 2.0 | 225 | 15 | -55 to +95 |
| 90 ± 2.0 | 225 | 15 | -55 to +95 |

**Specification based on performance of unit properly installed on Anaren Test Board 57904-0001 with small signal applied. Specifications subject to change without notice. Refer to parameter definitions for details.



Dimensions are in Inches [Millimeters]
XC0900L-03* Mechanical Outline

*For RoHS Compliant Versions order with S suffix
Tolerances are Non-Cumulative



Description

The S03B888N3 is a low profile 3 dB hybrid coupler in an easy to use surface mount package for AMPS, GSM and EDGE applications. The S03B888N3 is ideal for balanced amplifiers and signal distribution and can be used in very high power designs. Parts have been run through rigorous qualifications and units are 100% tested. They are manufactured using materials with X and Y thermal expansion coefficients compatible with common substrates.

Features

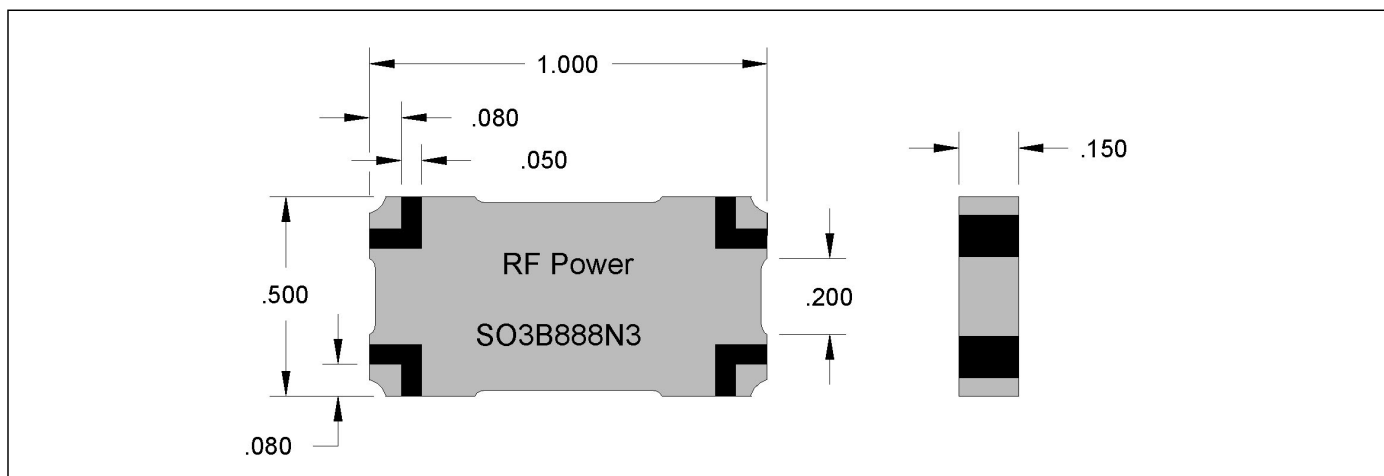
- 815 - 960 MHz
- 300 Watts
- Low Loss
- High Isolation
- 90° Quadrature
- Surface Mountable
- Tape and Reel
- Convenient Package
- 100% Tested

Electrical Specifications

| Frequency MHz | Isolation dB Min | Insert. Loss dB Max | VSWR Max: 1 |
|---------------------|---------------------------|------------------------|------------------------|
| 815 - 960 | 20 | 0.15 | 1.25 |
| Amp. Bal. dB Max | Phase Bal. Degrees Max | Temp. °C | Power Avg. CW Watts |
| ±0.30 | ±1.5 | -55 to +85 | 300 |

Specifications subject to change without notice.

Outline Drawing



VER. 3/13/02

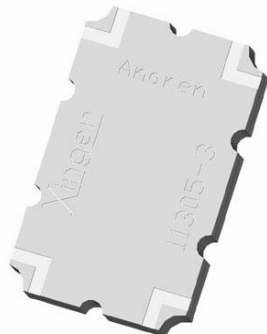


Available on Tape and Reel for Pick and Place Manufacturing.

Sales Desk USA: Voice: (800) 544-2414 Fax: (315) 432-9121
Sales Desk Europe: Voice: (+44) 23 92 232392 Fax: (+44) 23 92 251369

Xinger®

Hybrid Couplers 3 dB, 90°



Description

The 11305-3 is a low profile 3dB hybrid coupler in an easy to use surface mount package covering 1.0 to 2.0 GHz. The 11305-3 is ideal for balanced amplifiers and signal distribution and can be used in most high power designs. Parts have been subjected to rigorous qualification testing and units are 100% tested. They are manufactured using materials with x and y thermal expansion coefficients compatible with common substrates such as FR4, G-10 and polyamide.

Features:

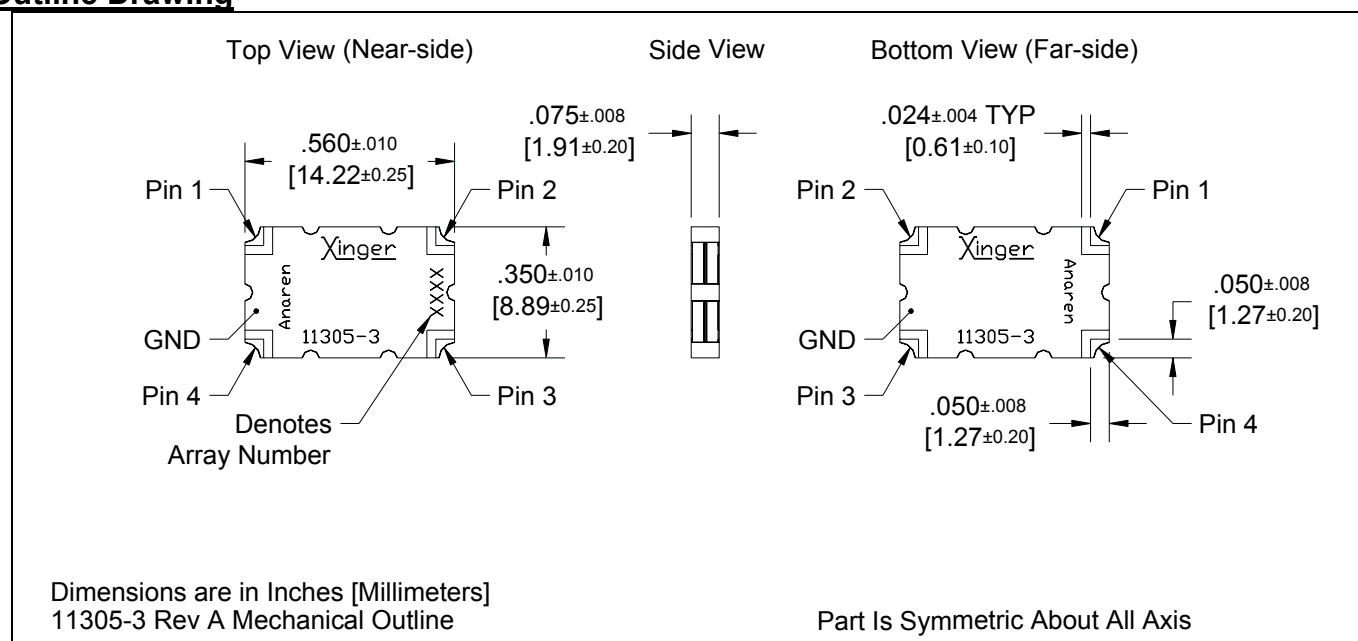
- 1.0 – 2.0 GHz
- Low Loss
- High Isolation
- 90° Quadrature
- Surface Mountable
- Tape And Reel
- Convenient Package
- 100% Tested

ELECTRICAL SPECIFICATIONS**

| Frequency | Isolation | Insertion Loss | VSWR | |
|-------------------|---------------|----------------|---------|-----------------|
| GHz | dB Min | dB Max | Max:1 | |
| 1.0 – 2.0 | 20 | 0.45 | 1.30 | |
| Amplitude Balance | Phase Balance | Power | ΘJC | Operating Temp. |
| dB Max | Degrees | Ave. CW Watts | °C/Watt | °C |
| ± 0.55 | ± 3 | 60 | 18.6 | -55 to +85 |

**Specification based on performance of unit properly installed on microstrip printed circuit boards with 50 Ω nominal impedance. Specifications subject to change without notice.

Outline Drawing



Xinger® II

Hybrid Coupler 3 dB, 90°



Description

The XC1400P-03S is a low profile, high performance 3dB hybrid coupler in a new easy to use, manufacturing friendly surface mount package. It is designed for GPS band applications. The XC1400P-03S is designed particularly for balanced power and low noise amplifiers, plus signal distribution and other applications where low insertion loss and tight amplitude and phase balance is required. It can be used in high power applications up to 40 Watts.

Parts have been subjected to rigorous qualification testing and they are manufactured using materials with coefficients of thermal expansion (CTE) compatible with common substrates such as FR4, G-10, RF-35, and RO4350. Produced with 6 of 6 RoHS compliant tin immersion.

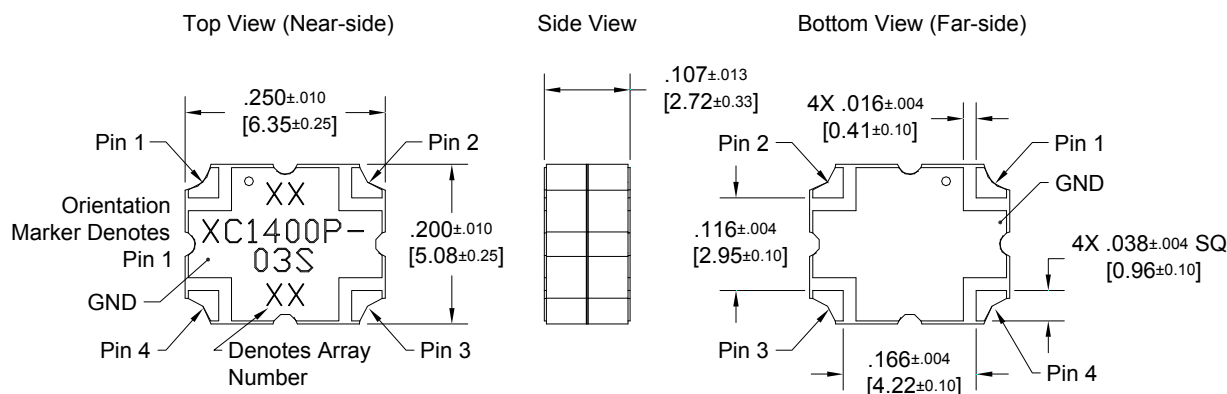
Electrical Specifications **

Features:

- 1200 – 1600 MHz
- GPS
- High Power
- Very Low Loss
- Tight Amplitude Balance
- High Isolation
- Production Friendly
- Tape and Reel
- Lead-Free
- Reliable, FIT=0.49

| Frequency | Isolation | Insertion Loss | VSWR | Amplitude Balance |
|-----------|---------------|----------------|-----------------|-------------------|
| MHz | dB Min | dB Max | Max : 1 | dB Max |
| 1200-1600 | 23 | 0.32 | 1.20 | +/-0.30 |
| 1215-1240 | 23 | 0.23 | 1.17 | +/-0.30 |
| 1563-1588 | 23 | 0.32 | 1.20 | +/-0.30 |
| Phase | Power | ΘJC | Operating Temp. | |
| Degrees | Avg. CW Watts | °C/Watt | °C | |
| 90 ± 4.0 | 30 | 57 | -55 to +85 | |
| 90 ± 3.0 | 40 | 57 | -55 to +85 | |
| 90 ± 4.0 | 30 | 57 | -55 to +85 | |

**Specification based on performance of unit properly installed on Anaren Test Board 54147-0001 with small signal applied. Specifications subject to change without notice. Refer to parameter definitions for details.



Dimensions are in Inches [Millimeters]
XC1400P-03S Mechanical Outline Rev B

Tolerances are Non-Cumulative



Xinger®

Hybrid Couplers 3 dB, 90°



Description

The 1P503 Pico Xinger is a low profile, miniature 3dB hybrid coupler in an easy to use surface mount package designed for DCS and PCS applications. The 1P503 is designed for balanced amplifiers, variable phase shifters and attenuators, LNAs, signal distribution and is an ideal solution for the ever-increasing demands of the wireless industry for smaller printed circuit boards and high performance. Parts have been subjected to rigorous qualification testing and units are 100% tested. They are manufactured using materials with x and y thermal expansion coefficients compatible with common substrates.

Features:

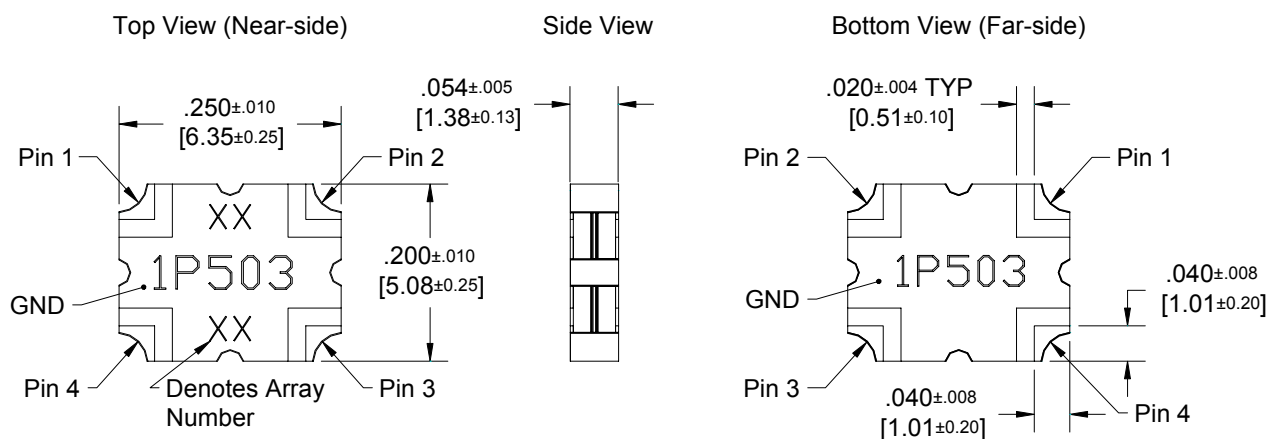
- 1.7 – 2.0 GHz.
- DCS and PCS
- Low Loss
- High Isolation
- 90° Quadrature
- Surface Mountable
- Tape And Reel
- New Pico-Package
- 100% Tested

ELECTRICAL SPECIFICATIONS**

| Frequency | Isolation* | Insertion Loss | VSWR | |
|-------------------|---------------|----------------|---------|-----------------|
| GHz | dB Min | dB Max | Max:1 | |
| 1.7 – 1.8 | 18 | 0.25 | 1.28 | |
| 1.8 – 2.0 | 18 | 0.25 | 1.28 | |
| Amplitude Balance | Phase Balance | Power | ΘJC | Operating Temp. |
| dB Max | Degrees | Ave. CW Watts | °C/Watt | °C |
| ± 0.45 | ± 3 | 30 | 27.5 | -55 to +85 |
| ± 0.30 | ± 3 | 30 | 27.5 | -55 to +85 |

**Specification based on performance of unit properly installed on microstrip printed circuit boards with 50 Ω nominal impedance. * See Anaren Application Note #AAN-231 for information on how to improve RF performance on your printed circuit board Specifications subject to change without notice.

Outline Drawing



Dimensions are in Inches [Millimeters]
1P503 Rev A Mechanical Outline

Part Is Symmetric About All Axis



Xinger II

Hybrid Coupler 3 dB, 90°



Description

The XC1900E-03 is a low profile, high performance 3dB hybrid coupler in a new easy to use, manufacturing friendly surface mount package. It is designed for DCS and PCS band applications. The XC1900E-03 is designed particularly for balanced power and low noise amplifiers, plus signal distribution and other applications where low insertion loss and tight amplitude and phase balance is required. It can be used in high power applications up to 120 watts.

Parts have been subjected to rigorous qualification testing and they are manufactured using materials with coefficients of thermal expansion (CTE) compatible with common substrates such as FR4, G-10, RF-35, RO4350 and polyimide. Available in both 5 of 6 tin lead (XC1900E-03P) and 6 of 6 tin immersion (XC1900E-03S) RoHS compliant finishes.

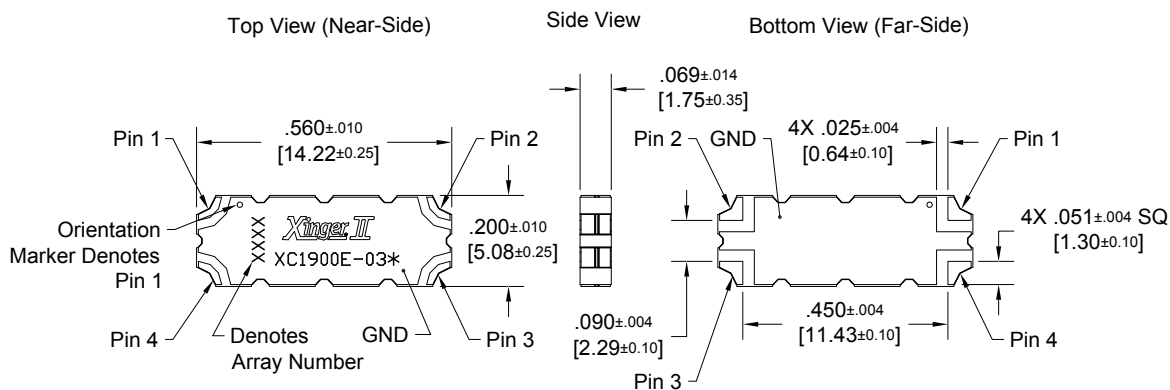
Electrical Specifications **

Features:

- 1700-2000 MHz
- DCS and PCS
- High Power
- Very Low Loss
- Tight Amplitude Balance
- High Isolation
- Production Friendly
- Tape and Reel
- Available in Lead-Free (as illustrated) or Tin-Lead
- Reliable, FIT=0.53

| Frequency | Isolation | Insertion Loss | VSWR | Amplitude Balance |
|-----------|---------------|----------------|-----------------|-------------------|
| MHz | dB Min | dB Max | Max : 1 | dB Max |
| 1700-2000 | 23 | 0.12 | 1.17 | ± 0.13 |
| 1805-1880 | 25 | 0.12 | 1.12 | ± 0.10 |
| 1930-1990 | 25 | 0.12 | 1.12 | ± 0.10 |
| Phase | Power | ΘJC | Operating Temp. | |
| Degrees | Avg. CW Watts | °C/Watt | °C | |
| 90 ± 2.0 | 120 | 36 | -55 to +95 | |
| 90 ± 2.0 | 120 | 36 | -55 to +95 | |
| 90 ± 2.0 | 120 | 36 | -55 to +95 | |

**Specification based on performance of unit properly installed on Anaren Test Board 58492-0001 with small signal applied. Specifications subject to change without notice. Refer to parameter definitions for details.



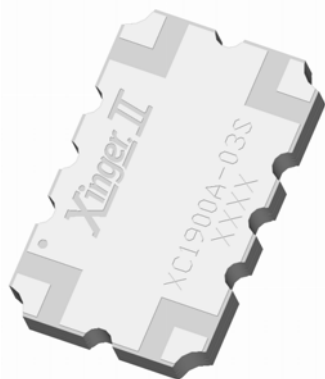
Dimensions are in Inches [Millimeters]
XC1900E-03* Mechanical Outline

*For RoHS Compliant Versions order with S suffix
Tolerances are Non-Cumulative



Xinger II

Hybrid Coupler 3 dB, 90°



Description

The XC1900A-03 is a low profile, high performance 3dB hybrid coupler in a new easy to use, manufacturing friendly surface mount package. It is designed for DCS and PCS band applications. The XC1900A-03 is designed particularly for balanced power and low noise amplifiers, plus signal distribution and other applications where low insertion loss and tight amplitude and phase balance is required. It can be used in high power applications up to 150 Watts.

Parts have been subjected to rigorous qualification testing and they are manufactured using materials with coefficients of thermal expansion (CTE) compatible with common substrates such as FR4, G-10, RF-35, RO4350 and polyimide. Available in both 5 of 6 tin lead (XC1900A-03P) and 6 of 6 tin immersion (XC1900A-03S) RoHS compliant finishes.

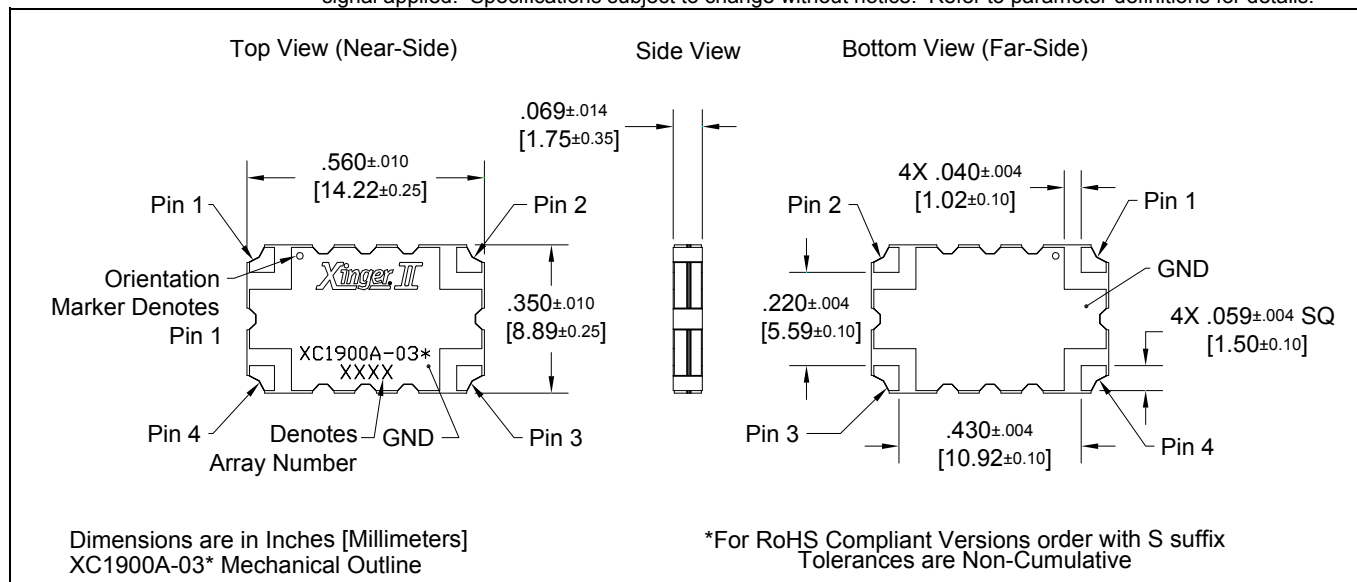
Electrical Specifications **

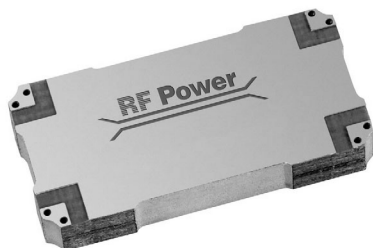
Features:

- 1700-2000 MHz
- DCS and PCS
- High Power
- Very Low Loss
- Tight Amplitude Balance
- High Isolation
- Production Friendly
- Tape and Reel
- Available in Lead-Free (as illustrated) or Tin-Lead
- Reliable, FIT=0.53

| Frequency | Isolation | Insertion Loss | VSWR | Amplitude Balance |
|-----------|---------------|----------------|-----------------|-------------------|
| MHz | dB Min | dB Max | Max : 1 | dB Max |
| 1700-2000 | 25 | 0.15 | 1.15 | ± 0.13 |
| 1805-1880 | 27 | 0.12 | 1.12 | ± 0.10 |
| 1930-1990 | 27 | 0.12 | 1.12 | ± 0.10 |
| Phase | Power | ΘJC | Operating Temp. | |
| Degrees | Avg. CW Watts | °C/Watt | °C | |
| 90 ± 2.0 | 150 | 28 | -55 to +95 | |
| 90 ± 2.0 | 150 | 28 | -55 to +95 | |
| 90 ± 2.0 | 150 | 28 | -55 to +95 | |

**Specification based on performance of unit properly installed on Anaren Test Board 58481-0001 with small signal applied. Specifications subject to change without notice. Refer to parameter definitions for details.





Description

The S03B1960N3 is a low profile 3 dB hybrid coupler in an easy to use surface mount package specially designed for PCS applications. The S03B1960N3 is ideal for balanced amplifiers and signal distribution and can be used in very high power designs. Parts have been run through rigorous qualifications and units are 100% tested. They are manufactured using materials with X and Y thermal expansion coefficients compatible with common substrates.

Features

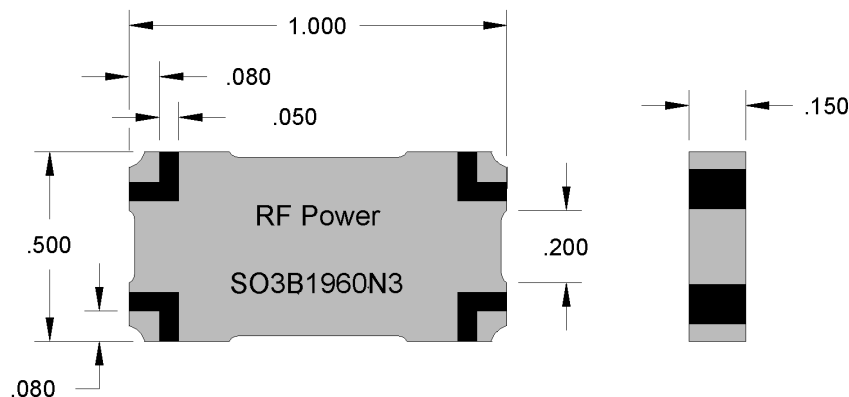
- 1.93 - 1.99 GHz
- 300 Watts
- Low Loss
- High Isolation
- 90° Quadrature
- Surface Mountable
- Tape and Reel
- Convenient Package
- 100% Tested

Electrical Specifications

| Frequency GHz | Isolation dB Min | Insert. Loss dB Max | VSWR Max: 1 |
|---------------------|---------------------------|------------------------|------------------------|
| 1.93 - 1.99 | 20 | 0.15 | 1.25 |
| Amp. Bal. dB Max | Phase Bal. Degrees Max | Temp. °C | Power Avg. CW Watts |
| ±0.25 | ±1.5 | -55 to +85 | 300 |

Specifications subject to change without notice.

Outline Drawing



VER. 3/13/02



Available on Tape and Reel for Pick and Place Manufacturing.

Sales Desk USA: Voice: (800) 544-2414 Fax: (315) 432-9121
Sales Desk Europe: Voice: (+44) 23 92 232392 Fax: (+44) 23 92 251369

Xinger II®

Hybrid Coupler 3 dB, 90°



Description

The XC2100E-03 is a low profile, high performance 3dB hybrid coupler in a new easy to use, manufacturing friendly surface mount package. It is designed for UMTS and other 3G applications. The XC2100E-03 is designed particularly for balanced power and low noise amplifiers, plus signal distribution and other applications where low insertion loss and tight amplitude and phase balance is required. It can be used in high power applications up to 100 watts.

Parts have been subjected to rigorous qualification testing and they are manufactured using materials with coefficients of thermal expansion (CTE) compatible with common substrates such as FR4, G-10, RF-35, RO4350 and polyimide. Available in both 5 of 6 tin lead (XC2100E-03P) and 6 of 6 tin immersion (XC2100E-03S) RoHS compliant finishes.

Electrical Specifications **

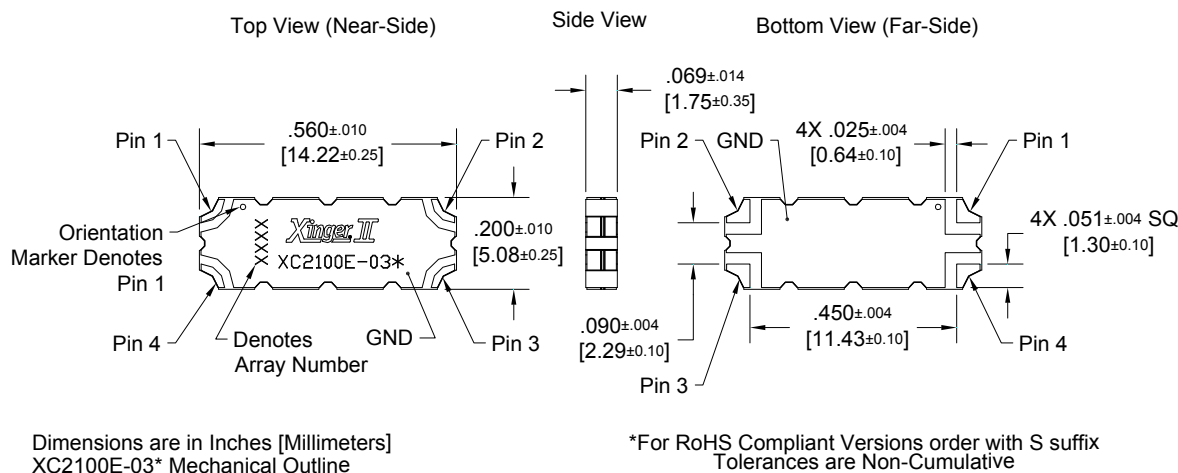
Features:

- 2000-2300 MHz
- UMTS and other 3G
- High Power
- Very Low Loss
- Tight Amplitude Balance
- High Isolation
- Production Friendly
- Tape and Reel
- Available in Lead-Free (as illustrated) or Tin-Lead
- Reliable, FIT=0.53

| Frequency | Isolation | Insertion Loss | VSWR | Amplitude Balance |
|-----------|-----------|----------------|---------|-------------------|
| MHz | dB Min | dB Max | Max : 1 | dB Max |
| 2000-2300 | 23 | 0.12 | 1.17 | ± 0.15 |
| 2110-2170 | 25 | 0.12 | 1.12 | ± 0.10 |

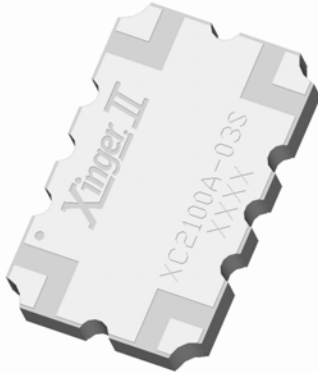
| Phase | Power | ΘJC | Operating Temp. |
|----------|---------------|---------|-----------------|
| Degrees | Avg. CW Watts | °C/Watt | °C |
| 90 ± 2.0 | 95 | 39 | -55 to +95 |
| 90 ± 2.0 | 100 | 39 | -55 to +95 |

**Specification based on performance of unit properly installed on Anaren Test Board 58492-0001 with small signal applied. Specifications subject to change without notice. Refer to parameter definitions for details.



Xinger II

Hybrid Coupler 3 dB, 90°



Description

The XC2100A-03 is a low profile, high performance 3dB hybrid coupler in a new easy to use, manufacturing friendly surface mount package. It is designed for UMTS and other 3G applications. The XC2100A-03 is designed particularly for balanced power and low noise amplifiers, plus signal distribution and other applications where low insertion loss and tight amplitude and phase balance is required. It can be used in high power applications up to 145 Watts.

Parts have been subjected to rigorous qualification testing and they are manufactured using materials with coefficients of thermal expansion (CTE) compatible with common substrates such as FR4, G-10, RF-35, RO4350 and polyimide. Available in both 5 of 6 tin lead (XC2100A-03P) and 6 of 6 tin immersion (XC2100A-03S) RoHS compliant finishes.

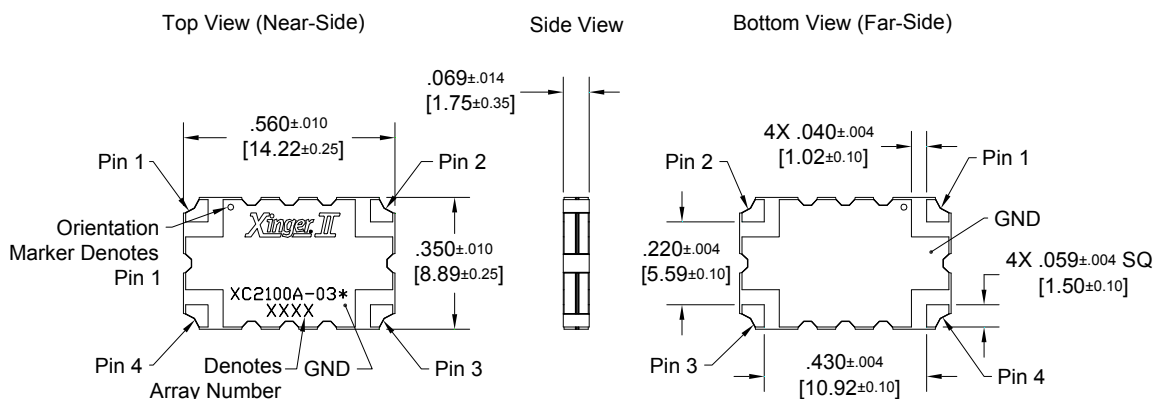
Electrical Specifications **

Features:

- 2000-2300 MHz
- UMTS and other 3G
- High Power
- Very Low Loss
- Tight Amplitude Balance
- High Isolation
- Production Friendly
- Tape and Reel
- Available in Lead-Free (as illustrated) or Tin-Lead
- Reliable, FIT=0.53

| Frequency | Isolation | Insertion Loss | VSWR | Amplitude Balance |
|-----------|---------------|----------------|-----------------|-------------------|
| MHz | dB Min | dB Max | Max : 1 | dB Max |
| 2000-2300 | 23 | 0.15 | 1.15 | ± 0.15 |
| 2110-2170 | 25 | 0.12 | 1.12 | ± 0.10 |
| Phase | Power | ΘJC | Operating Temp. | |
| Degrees | Avg. CW Watts | °C/Watt | °C | |
| 90 ± 2.0 | 105 | 31 | -55 to +95 | |
| 90 ± 2.0 | 145 | 31 | -55 to +95 | |

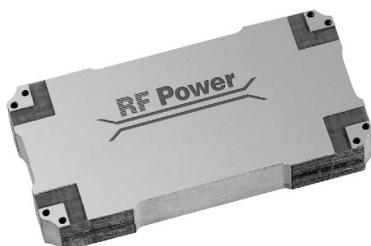
**Specification based on performance of unit properly installed on Anaren Test Board 58481-0001 with small signal applied. Specifications subject to change without notice. Refer to parameter definitions for details.



Dimensions are in Inches [Millimeters]
XC2100A-03* Mechanical Outline

*For RoHS Compliant Versions order with S suffix
Tolerances are Non-Cumulative





Description

The S03B2150N3 is a low profile 3 dB hybrid coupler in an easy to use surface mount package for UMTS and other 3G applications. The S03B2150N3 is ideal for balanced amplifiers and signal distribution and can be used in very high power designs. Parts have been run through rigorous qualifications and units are 100% tested. They are manufactured using materials with X and Y thermal expansion coefficients compatible with common substrates.

Features

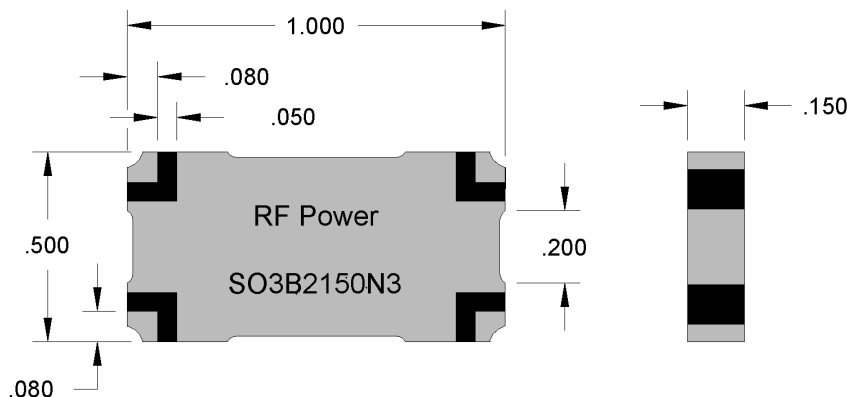
- 2.0 - 2.3 GHz
- 300 Watts
- Low Loss
- High Isolation
- 90° Quadrature
- Surface Mountable
- Tape and Reel
- Convenient Package
- 100% Tested

Electrical Specifications

| Frequency GHz | Isolation dB Min | Insert. Loss dB Max | VSWR Max: 1 |
|---------------------|---------------------------|------------------------|------------------------|
| 2.0 - 2.3 | 20 | 0.15 | 1.25 |
| Amp. Bal. dB Max | Phase Bal. Degrees Max | Temp. °C | Power Avg. CW Watts |
| ±0.25 | ±2.0 | -55 to +85 | 300 |

Specifications subject to change without notice.

Outline Drawing



VER. 3/13/02

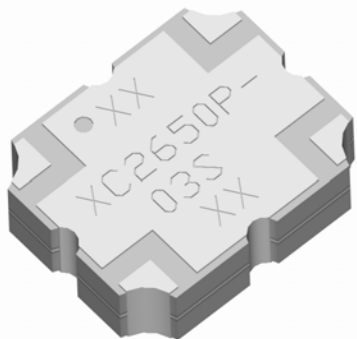


Available on Tape and Reel for Pick and Place Manufacturing.

Sales Desk USA: Voice: (800) 544-2414 Fax: (315) 432-9121
Sales Desk Europe: Voice: (+44) 23 92 232392 Fax: (+44) 23 92 251369

Xinger II

Hybrid Coupler 3 dB, 90°



Description

The XC2650P-03S is a low profile, high performance 3dB hybrid coupler in a new easy to use, manufacturing friendly surface mount package. It is designed for WiMAX applications. The XC2650P-03S is designed particularly for balanced power and low noise amplifiers, plus signal distribution and other applications where low insertion loss and tight amplitude and phase balance is required. It can be used in high power applications up to 50 Watts.

Parts have been subjected to rigorous qualification testing and they are manufactured using materials with coefficients of thermal expansion (CTE) compatible with common substrates such as FR4, G-10, RF-35, and RO4003. Produced with 6 of 6 RoHS compliant tin immersion finish.

Electrical Specifications **

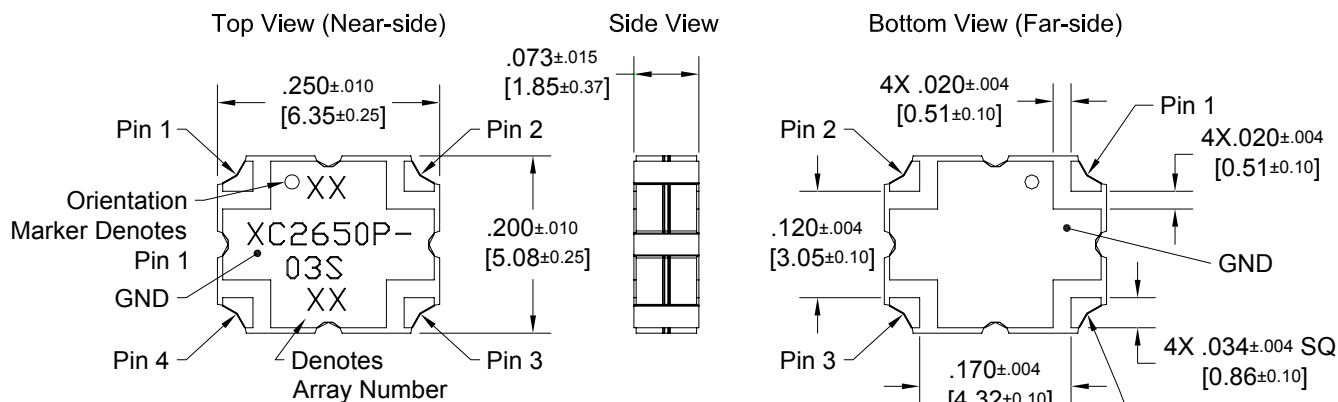
Features:

- 2650-2800 MHz
- WiMAX
- High Power
- Very Low Loss
- Tight Amplitude Balance
- High Isolation
- Production Friendly
- Tape and Reel
- Lead-Free

| Frequency | Isolation | Insertion Loss | VSWR | |
|-------------------|-------------------|---------------------|------------------|------------------|
| MHz | dB Min | dB Max | Max:1 | |
| 2650-2800 | 20 | 0.25 | 1.20 | |
| Amplitude Balance | Phase Balance | Power | ΘJC | Operating Temp. |
| dB Max ±0.15 | Degrees 90±3.0 | Ave. CW Watts 50 | °C/ Watt 60.5 | °C -55 to +85 |

**Specification based on performance of unit properly installed on Anaren Test Board 54147-0001 with small signal applied. Specifications subject to change without notice. Refer to parameter definitions for details.

Mechanical Outline



Dimensions are in Inches [Millimeters]
XC2650P-03S Mechanical Outline

Tolerances are Non-Cumulative



Xinger II

Hybrid Coupler 3 dB, 90°



Description

The XC2500E-03 is a low profile, high performance 3dB hybrid coupler in a new easy to use, manufacturing friendly surface mount package. It is designed for ISM and Wireless LAN applications. The XC2500E-03 is designed particularly for balanced power and low noise amplifiers, plus signal distribution and other applications where low insertion loss and tight amplitude and phase balance is required. It can be used in high power applications up to 80 watts.

Parts have been subjected to rigorous qualification testing and they are manufactured using materials with coefficients of thermal expansion (CTE) compatible with common substrates such as FR4, G-10, RF-35, RO4350 and polyimide.

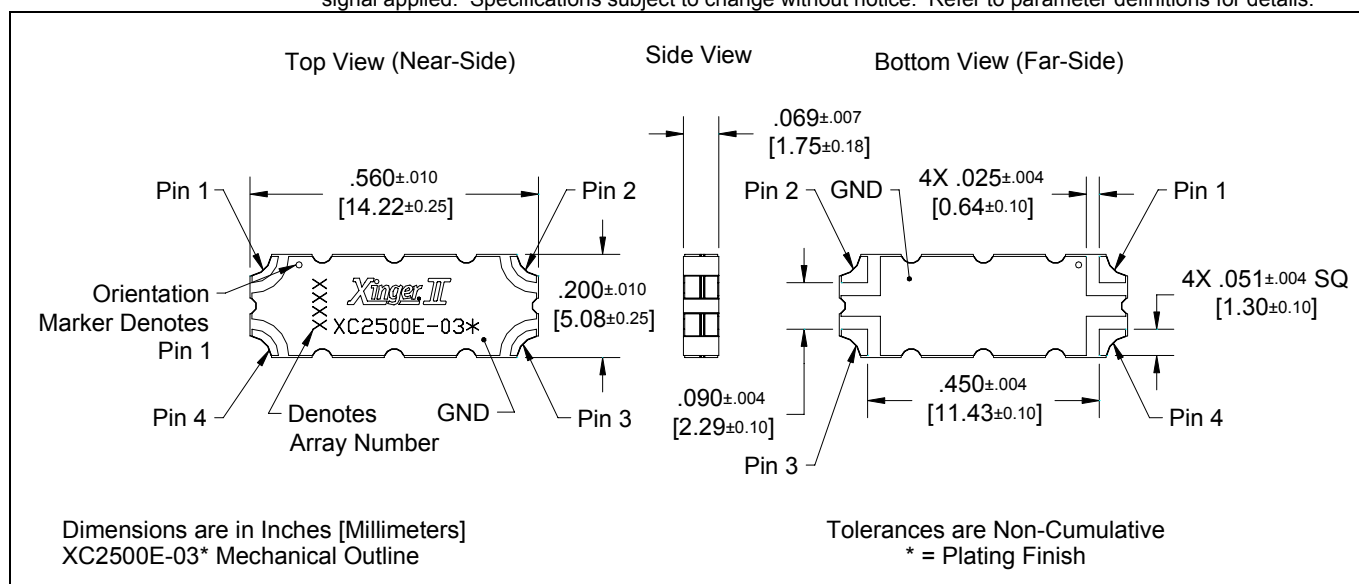
Electrical Specifications **

Features:

- 2300-2700 MHz
- ISM and Wireless LAN
- High Power
- Very Low Loss
- Tight Amplitude Balance
- High Isolation
- Production Friendly
- Tape and Reel
- Available in Lead-Free (as illustrated) or Tin-Lead
- Reliable, FIT=0.53

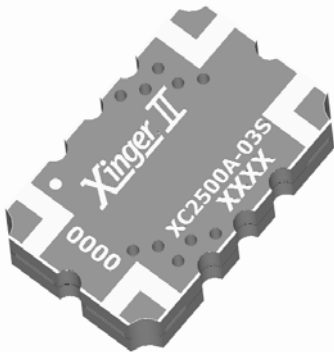
| Frequency | Isolation | Insertion Loss | VSWR | Amplitude Balance |
|-----------|---------------|----------------|-----------------|-------------------|
| MHz | dB Min | dB Max | Max : 1 | dB Max |
| 2300-2700 | 22 | 0.15 | 1.17 | ± 0.15 |
| Phase | Power | ΘJC | Operating Temp. | |
| Degrees | Avg. CW Watts | °C/Watt | °C | |
| 90 ± 3.0 | 80 | 43.0 | -55 to +95 | |

**Specification based on performance of unit properly installed on Anaren Test Board 58492-0001 with small signal applied. Specifications subject to change without notice. Refer to parameter definitions for details.



Xinger II®

Hybrid Coupler 3 dB, 90°



Description

The XC2500A-03S is a low profile, high performance 3dB hybrid coupler in a new easy to use, manufacturing friendly surface mount package. It is designed for WiBro and DMB applications. The XC2500A-03S is designed particularly for balanced power and low noise amplifiers, plus signal distribution and other applications where low insertion loss and tight amplitude and phase balance is required. It can be used in high power applications up to 200 watts.

Parts have been subjected to rigorous qualification testing and they are manufactured using materials with coefficients of thermal expansion (CTE) compatible with common substrates such as FR4, G-10, RF-35, RO4350, and polyimide. Produced with 6 of 6 RoHS compliant tin immersion.

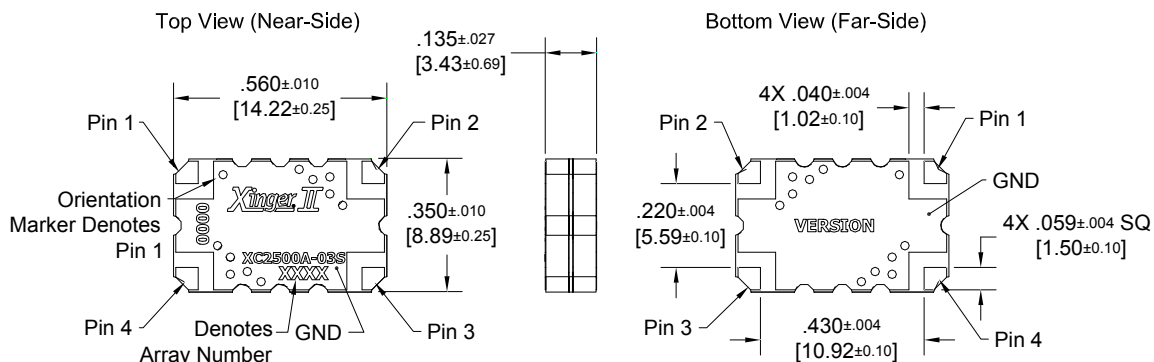
Electrical Specifications **

Features:

- 2300-2700 MHz
- WiBro and DMB
- High Power
- Very Low Loss
- Tight Amplitude Balance
- High Isolation
- Production Friendly
- Tape and Reel
- Lead-Free
- Reliable, FIT= 1.016

| Frequency | Isolation | Insertion Loss | VSWR | Amplitude Balance |
|-----------|---------------|----------------|-----------------|-------------------|
| MHz | dB Min | dB Max | Max : 1 | dB Max |
| 2300-2700 | 25 | 0.13 | 1.14 | ± 0.15 |
| 2300-2400 | 25 | 0.10 | 1.14 | ± 0.15 |
| 2630-2655 | 25 | 0.13 | 1.14 | ± 0.15 |
| Phase | Power | ΘJC | Operating Temp. | |
| Degrees | Avg. CW Watts | °C/Watt | °C | |
| 90 ± 4.0 | 150 | 24.6 | -55 to +85 | |
| 90 ± 4.0 | 200 | 24.6 | -55 to +85 | |
| 90 ± 4.0 | 150 | 24.6 | -55 to +85 | |

**Specification based on performance of unit properly installed on Anaren Test Board 58481-0001 with small signal applied. Specifications subject to change without notice. Refer to parameter definitions for details.



Dimensions are in Inches [Millimeters]
XC2500A-03S Mechanical Outline

Tolerances are Non-Cumulative



Xinger®

Hybrid Couplers 3 dB, 90°



Description

The JP503 Pico Xinger is a low profile, miniature 3dB hybrid coupler in an easy to use surface mount package designed for W-CDMA and other 3G applications. The JP503 is designed for balanced amplifiers, variable phase shifters and attenuators, LNAs, signal distribution and is an ideal solution for the ever-increasing demands of the wireless industry for smaller printed circuit boards and high performance. Parts have been subjected to rigorous qualification testing and units are 100% tested. They are manufactured using materials with x and y thermal expansion coefficients compatible with common substrates. Available in both 5 of 6 tin lead (JP503) and 6 of 6 RoHS compliant tin immersion (JP503S).

Features:

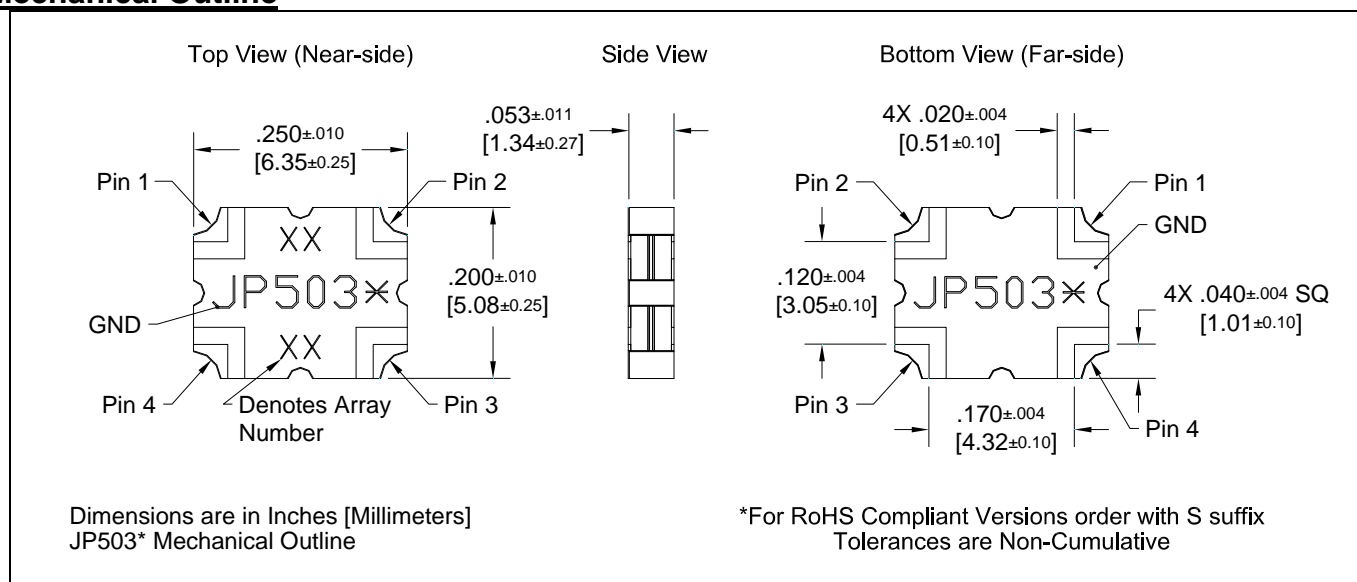
- 2.0 – 2.3 GHz.
- 3G Frequencies
- Low Loss
- High Isolation
- 90° Quadrature
- Surface Mountable
- Tape And Reel
- Available in Lead-Free (as illustrated) or Tin-Lead

ELECTRICAL SPECIFICATIONS**

| Frequency | Isolation | Insertion Loss | VSWR | |
|-------------------|---------------|----------------|---------|-----------------|
| GHz | dB Min | dB Max | Max:1 | |
| 2.0 – 2.3 | 20 | 0.30 | 1.20 | |
| Amplitude Balance | Phase Balance | Power | ⊙JC | Operating Temp. |
| dB Max | Degrees | Ave. CW Watts | °C/Watt | °C |
| ± 0.25 | ± 3 | 25 | 27.5 | -55 to +85 |

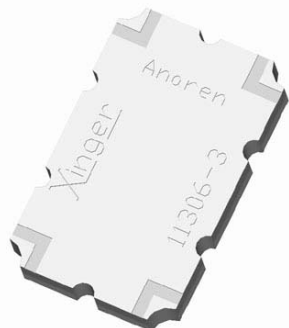
**Specification based on performance of unit properly installed on microstrip printed circuit boards with 50 Ω nominal impedance. Specifications subject to change without notice.

Mechanical Outline



Xinger®

Hybrid Couplers 3 dB, 90°



Description

The 11306-3 is a low profile 3dB hybrid coupler in an easy to use surface mount package covering 2.0 to 4.0 GHz. The 11306-3 is ideal for balanced amplifiers and signal distribution and can be used in most high power designs. Parts have been subjected to rigorous qualification testing and units are 100% tested. They are manufactured using materials with x and y thermal expansion coefficients compatible with common substrates such as FR4, G-10 and polyamide.

Features:

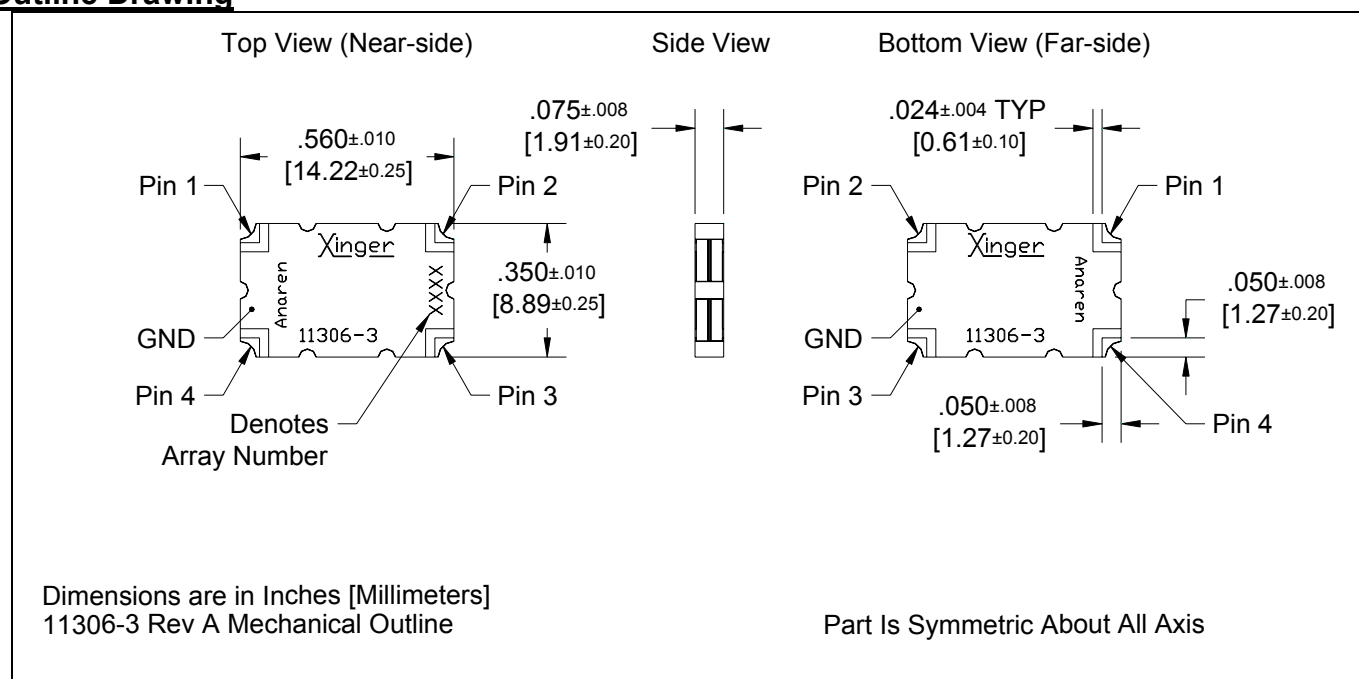
- 2.0 – 4.0 GHz
- Low loss
- High Isolation
- 90° Quadrature
- Surface Mountable
- Tape And Reel
- Convenient Package
- 100% Tested

ELECTRICAL SPECIFICATIONS**

| Frequency | Isolation | Insertion Loss | VSWR | |
|-------------------|---------------|----------------|----------|-----------------|
| GHz | dB Min | dB Max | Max:1 | |
| 2.0 – 4.0 | 20 | 0.35 | 1.30 | |
| Amplitude Balance | Phase Balance | Power | ΘJC | Operating Temp. |
| dB Max | Degrees | Ave. CW Watts | °C/ Watt | °C |
| ± 0.55 | ± 5 | 60 | 24.6 | -55 to +85 |

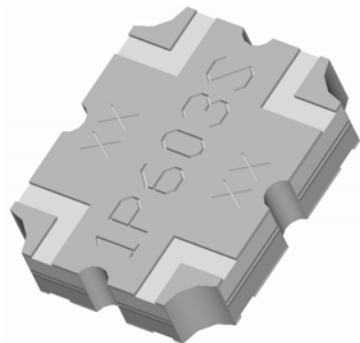
**Specification based on performance of unit properly installed on microstrip printed circuit boards with 50 Ω nominal impedance. Specifications subject to change without notice.

Outline Drawing



Xinger®

Hybrid Couplers 3 dB, 90°



Description

The 1P603 Pico Xinger is a low profile, miniature 3dB hybrid coupler in an easy to use surface mount package designed for W-LAN and MMDS applications. The 1P603 is designed for balanced amplifiers, variable phase shifters and attenuators, LNAs, signal distribution and is an ideal solution for the ever-increasing demands of the wireless industry for smaller printed circuit boards and high performance. Parts have been subjected to rigorous qualification testing and units are 100% tested. They are manufactured using materials with x and y thermal expansion coefficients compatible with common substrates. Available in both 5 of 6 tin lead (1P603) and 6 of 6 RoHS compliant tin immersion (1P603S).

Features:

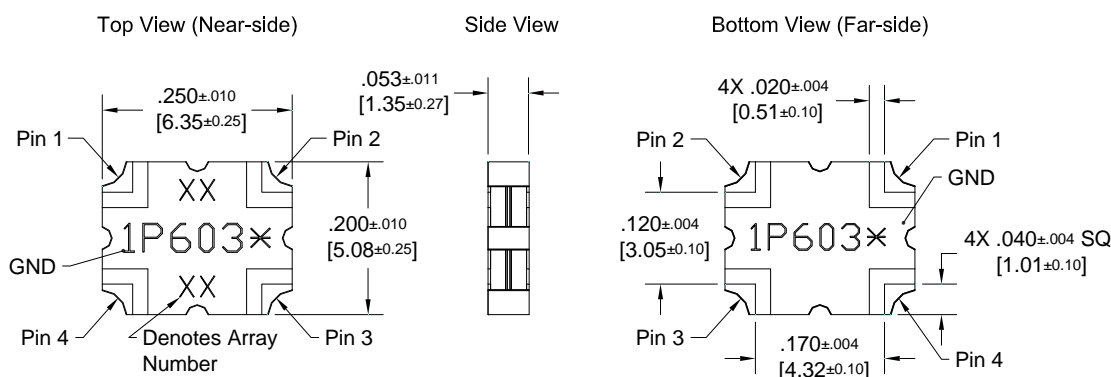
- 2.3 – 2.7 GHz.
- W-LAN and MMDS
- Low Loss
- High Isolation
- 90° Quadrature
- Surface Mountable
- Tape And Reel
- Available in Lead-Free (as illustrated) or Tin-Lead

ELECTRICAL SPECIFICATIONS**

| Frequency | Isolation | Insertion Loss | VSWR | |
|-------------------|---------------|----------------|---------|-----------------|
| GHz | dB Min | dB Max | Max:1 | |
| 2.3 – 2.7 | 20 | 0.30 | 1.20 | |
| Amplitude Balance | Phase Balance | Power | ΘJC | Operating Temp. |
| dB Max | Degrees | Ave. CW Watts | °C/Watt | °C |
| ± 0.25 | ± 3 | 25 | 30.6 | -55 to +85 |

**Specification based on performance of unit properly installed on microstrip printed circuit boards with 50 Ω nominal impedance. Specifications subject to change without notice.

Outline Drawing



Dimensions are in Inches [Millimeters]
1P603* Mechanical Outline

*For RoHS Compliant versions order with S suffix
Tolerances are Non-Cumulative



Xinger®

Micro Xinger 3dB Hybrid Coupler



Description

The 1M803 Micro Xinger® is a low profile, miniature 3dB hybrid coupler in an easy to use surface mount package designed for U-NII, ISM and hyperLAN applications. The 1M803 is designed for balanced amplifiers and signal distribution and is an ideal solution for the ever increasing demands of the wireless industry for smaller printed circuit boards and high performance. Parts have been subjected to rigorous qualification testing and units are 100% tested. They are manufactured using materials with x and y thermal expansion coefficients compatible with common substrates such as FR4 and G-10. Available in both 5 of 6 tin lead (1M803) and 6 of 6 RoHS compliant tin immersion (1M803S).

Features:

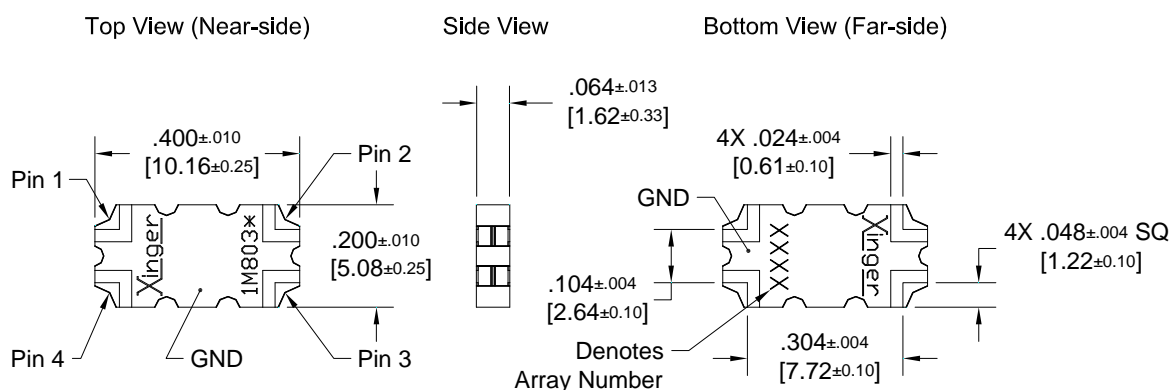
- 5.0 – 6.0 GHz
- Very Low Loss
- High Isolation
- 90° Quadrature
- Surface Mountable
- Tape And Reel
- Available in Lead-Free (as illustrated) or Tin-Lead

ELECTRICAL SPECIFICATIONS**

| Frequency | Isolation | Insertion Loss | VSWR | | |
|-------------------|---------------|----------------|---------|-----------------|--|
| GHz | dB Min | dB Max | Max:1 | | |
| 5.0 – 6.0 | 20 | 0.25 | 1.21 | | |
| Amplitude Balance | Phase Balance | Power | ΘJC | Operating Temp. | |
| dB Max | Degrees | Ave. CW Watts | °C/Watt | °C | |
| ± 0.30 | ± 3 | 20 | 78.1 | -55 to +85 | |

**Specification based on performance of unit properly installed on microstrip printed circuit boards with 50 Ω nominal impedance. Specifications subject to change without notice.

Mechanical Outline



Xinger II

Hybrid Coupler 3 dB, 90°



Description

The XC3500P-03S is a low profile, high performance 3dB hybrid coupler in a new easy to use, manufacturing friendly surface mount package. The XC3500P-03S is designed particularly for balanced power and low noise amplifiers, plus signal distribution and other applications where low insertion loss and tight amplitude and phase balance is required. It can be used in high power applications up to 55 watts.

Parts have been subjected to rigorous qualification testing and they are manufactured using materials with coefficients of thermal expansion (CTE) compatible with common substrates such as FR4, G-10, RF-35, RO4003 and polyimide. Produced with 6 of 6 RoHS compliant tin immersion.

Features:

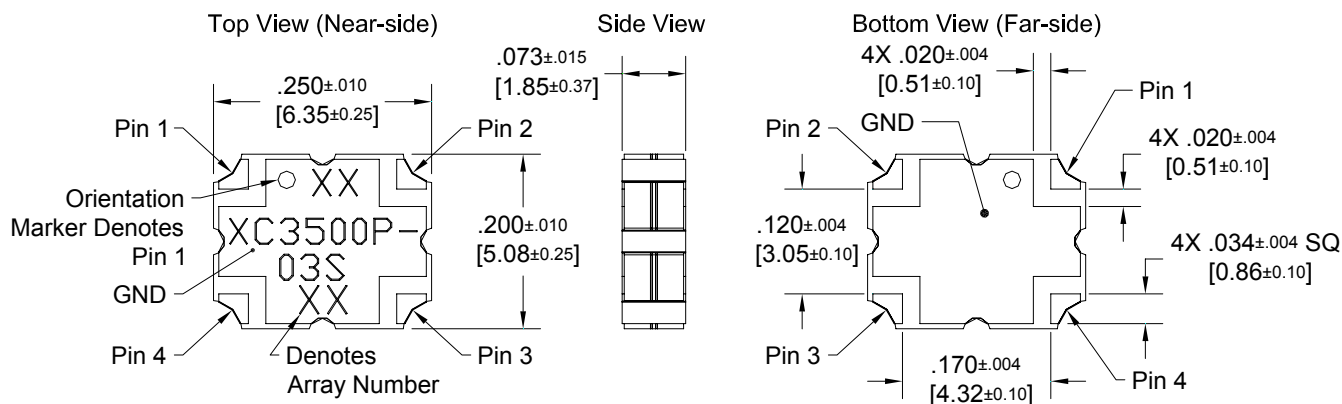
- 3300 – 3800 MHz
- High Power
- Very Low Loss
- Tight Amplitude Balance
- High Isolation
- Production Friendly
- Tape and Reel
- Lead-Free

Electrical Specifications **

| Frequency | Isolation | Insertion Loss | VSWR | Amplitude Balance |
|-----------|---------------|----------------|-----------------|-------------------|
| MHz | dB Min | dB Max | Max : 1 | dB Max |
| 3300-3800 | 21 | 0.25 | 1.20 | ± 0.25 |
| Phase | Power | ΘJC | Operating Temp. | |
| Degrees | Avg. CW Watts | °C/Watt | °C | |
| 90 ± 3.0 | 55 | 61.6 | -55 to +85 | |

**Specification based on performance of unit properly installed on Anaren Test Board 54147-0001 with small signal applied. Specifications subject to change without notice. Refer to parameter definitions for details.

Mechanical Outline



Xinger II

Hybrid Coupler 3 dB, 90°



Description

The XC3500M-03S is a low profile, high performance 3dB hybrid coupler in a new easy to use, manufacturing friendly surface mount package for WiMAX applications. The XC3500M-03S is designed particularly for balanced power and low noise amplifiers and other applications where low insertion loss and tight amplitude and phase balance is required. It can be used in high power applications up to 70 watts.

Parts have been subjected to rigorous qualification testing and they are manufactured using materials with coefficients of thermal expansion (CTE) compatible with common substrates such as FR4, G-10, RF-35, RO4003 and polyimide. Produced with 6 of 6 RoHS compliant tin immersion.

Electrical Specifications **

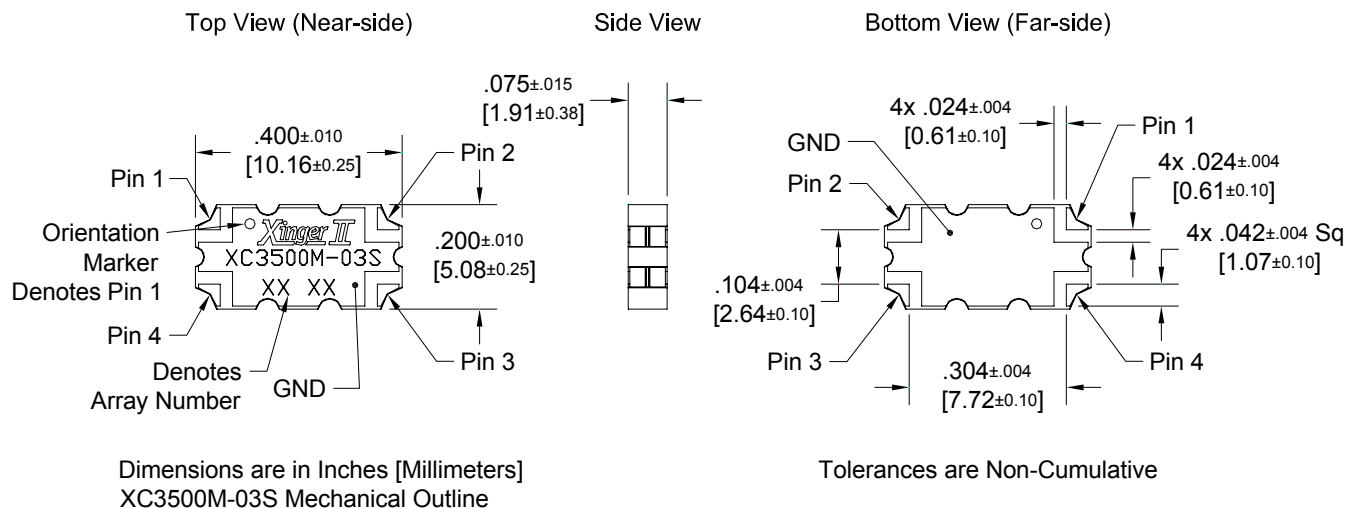
| Frequency | Isolation | Insertion Loss | VSWR | Amplitude Balance |
|---------------|---------------|----------------|-----------------|-------------------|
| MHz | dB Min | dB Max | Max:1 | dB Max |
| 3300-3800 | 21 | 0.25 | 1.20 | ±0.25 |
| Phase Balance | Power | ΘJC | Operating Temp. | |
| Degrees | Ave. CW Watts | °C/ Watt | °C | |
| 90±3.0 | 70 | 56.5 | -55 to +85 | |

Features:

- 3300 - 3800 MHz
- WiMAX
- High Power
- Very Low Loss
- Tight Amplitude Balance
- High Isolation
- Production Friendly
- Tape and Reel
- Lead-Free

**Specification based on performance of unit properly installed on Anaren Test Board 54147-0001 with small signal applied. Specifications subject to change without notice. Refer to parameter definitions for details.

Mechanical Outline



Xinger II

20 dB Directional Coupler



Features:

- 460 - 470 MHz
- High Power
- Very Low Loss
- Tight Coupling
- High Directivity
- Production Friendly
- Tape and Reel
- Lead-Free
- Reliable, FIT=0.41

Description

The XC0450E-20S is a low profile, high performance 20dB directional coupler in a new easy to use, manufacturing friendly surface mount package. The XC0450E-20S is designed particularly for power and frequency detection, as well as for VSWR monitoring, where tightly controlled coupling and low insertion loss is required. It can be used in high power applications up to 100 Watts.

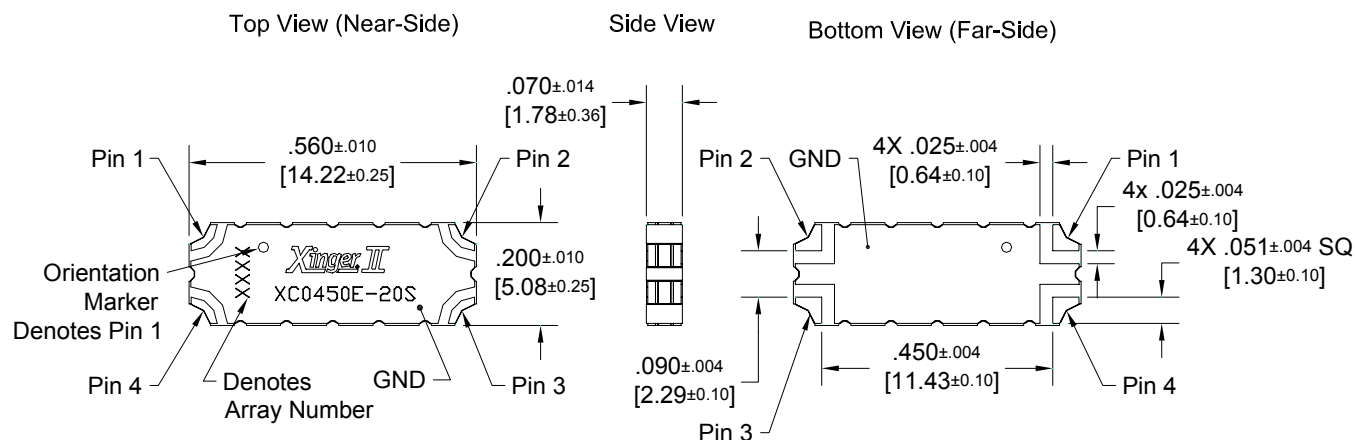
Parts have been subjected to rigorous qualification testing and they are manufactured using materials with coefficients of thermal expansion (CTE) compatible with common substrates such as FR4, G-10, RF-35, RO4350 and polyimide. Produced with 6 of 6 RoHS compliant tin immersion.

Electrical Specifications **

| Frequency | Mean Coupling | Insertion Loss | VSWR | Directivity |
|-----------------------|---------------|----------------|-----------------|-------------|
| MHz | dB | dB Max | Max : 1 | dB Min |
| 460 – 470 | 20.1 ± 1.5 | 0.30 | 1.22 | 17 |
| Frequency Sensitivity | Power | ΘJC | Operating Temp. | |
| dB Max | Avg. CW Watts | °C/Watt | °C | |
| ± 0.20 | 100 | 15.7 | -55 to +85 | |

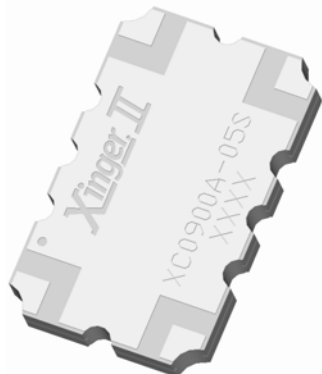
**Specification based on performance of unit properly installed on Anaren Test Board 58493-0001. Refer to Specifications subject to change without notice. Refer to parameter definitions for details.

Mechanical Outline



Xinger II

5 dB Directional Coupler



Description

The XC0900A-05 is a low profile, high performance 5dB directional coupler in a new easy to use, manufacturing friendly surface mount package. It is designed for AMPS band applications. The XC0900A-05 is designed particularly for non-binary split and combine in high power amplifiers, e.g. used along with a 3dB to get a 3-way, plus other signal distribution applications where low insertion loss is required. It can be used in high power applications up to 250 Watts.

Parts have been subjected to rigorous qualification testing and they are manufactured using materials with coefficients of thermal expansion (CTE) compatible with common substrates such as FR4, G-10, RF-35, RO4350, and polyimide. Available in both 5 of 6 tin lead (XC0900A-05P) and 6 of 6 tin immersion (XC0900A-05S) RoHS compliant finishes.

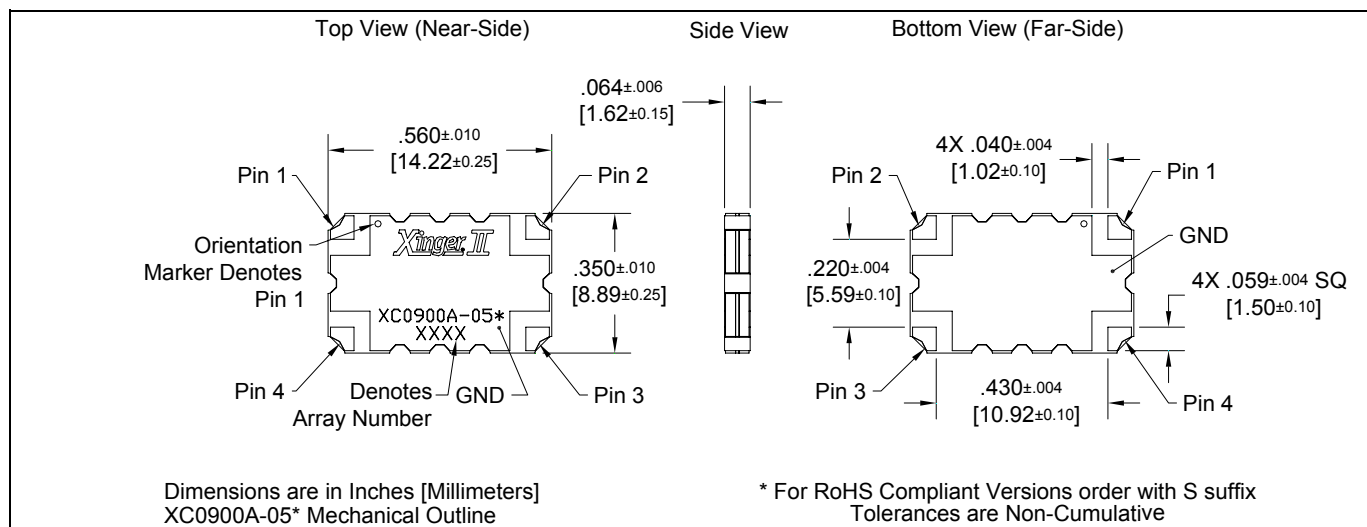
Features:

- 800 – 1000 MHz
- AMPS
- High Power
- Very Low Loss
- Tight Coupling
- High Directivity
- Production Friendly
- Tape and Reel
- Available in Lead-Free (as illustrated) or Tin-Lead
- Reliable, FIT=0.53

Electrical Specifications **

| Frequency | Mean Coupling | Insertion Loss | VSWR | Phase Balance |
|-------------|-----------------------|----------------|---------|-----------------|
| MHz | dB | dB Max | Max : 1 | Degrees |
| 800-1000 | 5.0 ± 0.35 | 0.19 | 1.19 | 90±2.0 |
| 869-894 | 5.0 ± 0.25 | 0.15 | 1.12 | 90±2.0 |
| 925-960 | 5.0 ± 0.25 | 0.15 | 1.12 | 90±2.0 |
| Directivity | Frequency Sensitivity | Power | ΘJC | Operating Temp. |
| dB Min | dB Max | Avg. CW Watts | °C/Watt | °C |
| 21 | ± 0.25 | 200 | 12.5 | -55 to +95 |
| 23 | ± 0.05 | 250 | 12.5 | -55 to +95 |
| 23 | ± 0.05 | 250 | 12.5 | -55 to +95 |

**Specification based on performance of unit properly installed on Anaren Test Board 58481-0001 with small signal applied. Specifications subject to change without notice. Refer to parameter definitions for details.



Xinger II

10 dB Directional Coupler



Description

The XC0900A-10 is a low profile, high performance 10dB directional coupler in a new easy to use, manufacturing friendly surface mount package. It is designed for AMPS band applications. The XC0900A-10 is designed particularly for power and frequency detection, as well as for power injection for example in feed-forward, where tightly controlled coupling and low insertion loss is required. It can be used in high power applications up to 250 Watts.

Parts have been subjected to rigorous qualification testing and they are manufactured using materials with coefficients of thermal expansion (CTE) compatible with common substrates such as FR4, G-10, RF-35, RO4350, and polyimide. Available in both 5 of 6 tin lead (XC0900A-10P) and 6 of 6 tin immersion (XC0900A-10S) RoHS compliant finishes.

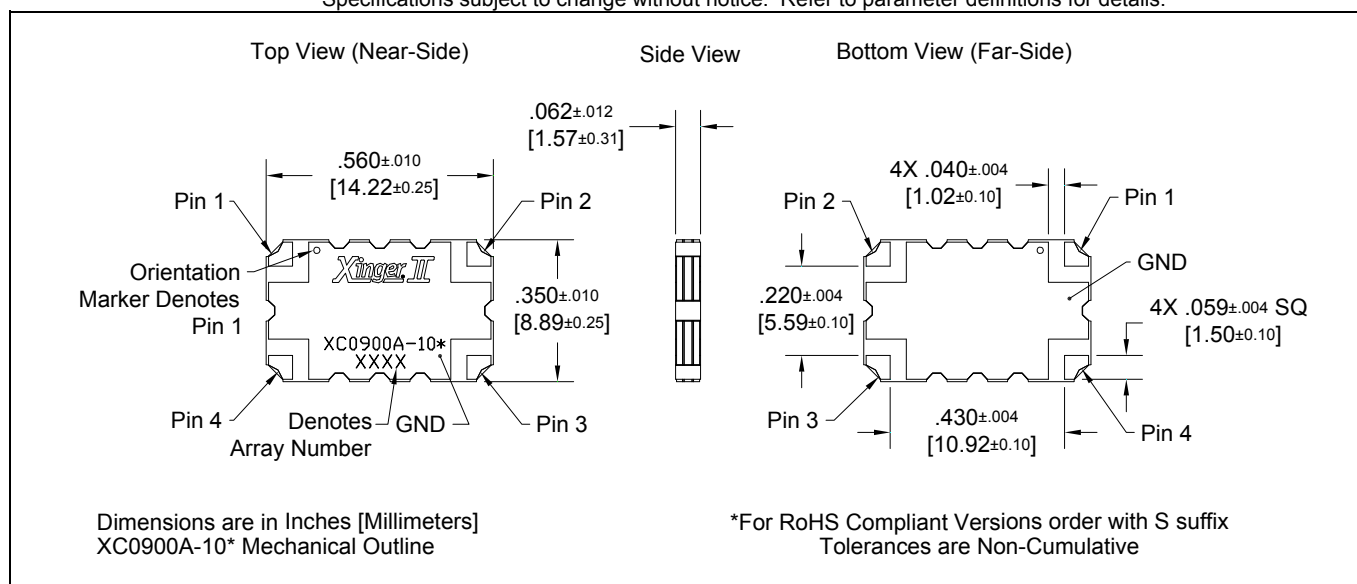
Electrical Specifications **

Features:

- 800 – 1000 MHz
- AMPS
- High Power
- Very Low Loss
- High Directivity
- Tight Coupling
- Production Friendly
- Tape and Reel
- Available in Lead-Free (as illustrated) or Tin-Lead
- Reliable, FIT=0.73

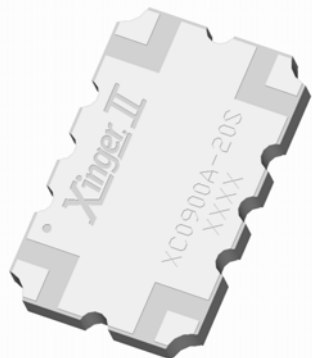
| Frequency | Mean Coupling | Insertion Loss | VSWR | Directivity |
|-----------------------|---------------|----------------|-----------------|-------------|
| MHz | dB | dB Max | Max : 1 | dB Min |
| 800 - 1000 | 10.1 ± 0.60 | 0.16 | 1.19 | 21 |
| 869 - 894 | 10.0 ± 0.50 | 0.14 | 1.12 | 25 |
| 925 - 960 | 10.0 ± 0.50 | 0.14 | 1.12 | 25 |
| Frequency Sensitivity | Power | ΘJC | Operating Temp. | |
| dB Max | Avg. CW Watts | °C/Watt | °C | |
| ± 0.30 | 225 | 13 | -55 to +95 | |
| ± 0.08 | 250 | 13 | -55 to +95 | |
| ± 0.08 | 250 | 13 | -55 to +95 | |

**Specification based on performance of unit properly installed on Anaren Test Board 54606-0003. Refer to Specifications subject to change without notice. Refer to parameter definitions for details.



Xinger II

20 dB Directional Coupler



Description

The XC0900A-20 is a low profile, high performance 20dB directional coupler in a new easy to use, manufacturing friendly surface mount package. It is designed for AMPS band applications. The XC0900A-20 is designed particularly for power and frequency detection, as well as for VSWR monitoring, where tightly controlled coupling and low insertion loss is required. It can be used in high power applications up to 200 Watts.

Parts have been subjected to rigorous qualification testing and they are manufactured using materials with coefficients of thermal expansion (CTE) compatible with common substrates such as FR4, G-10, RF-35, RO4350 and polyimide. Available in both 5 of 6 tin lead (XC0900A-20P) and 6 of 6 tin immersion (XC0900A-20S) RoHS compliant finishes.

Electrical Specifications **

Features:

- 800 – 1000 MHz
- AMPS
- High Power
- Very Low Loss
- Tight Coupling
- High Directivity
- Production Friendly
- Tape and Reel
- Available in Lead-Free (as illustrated) or Tin-Lead
- Reliable, FIT=0.41

| Frequency | Mean Coupling | Insertion Loss | VSWR | Directivity |
|-----------------------|---------------|----------------|-----------------|-------------|
| MHz | dB | dB Max | Max : 1 | dB Min |
| 800 - 1000 | 20.1 ± 0.60 | 0.18 | 1.15 | 23 |
| 700 – 800 | 20.7 ± 1.00 | 0.16 | 1.28 | 18 |
| 869 - 894 | 20.0 ± 0.50 | 0.14 | 1.12 | 25 |
| 925 - 960 | 20.0 ± 0.50 | 0.14 | 1.12 | 25 |
| Frequency Sensitivity | Power | ΘJC | Operating Temp. | |
| dB Max | Avg. CW Watts | °C/Watt | °C | |
| ± 0.20 | 150 | 16 | -55 to +95 | |
| ± 0.40 | 200 | 16 | -55 to +95 | |
| ± 0.05 | 200 | 16 | -55 to +95 | |
| ± 0.05 | 200 | 16 | -55 to +95 | |

**Specification based on performance of unit properly installed on Anaren Test Board 54606-0003. Refer to Specifications subject to change without notice. Refer to parameter definitions for details.



Xinger II

30 dB Directional Coupler

Description

The XC0900B-30S is a low profile, high performance 30dB directional coupler in a new easy to use, manufacturing friendly surface mount package. It is designed for AMPS band applications. The XC0900B-30S is designed particularly for power and frequency detection, as well as for VSWR monitoring, where tightly controlled coupling and low insertion loss is required. It can be used in high power applications up to 385 Watts.

Parts have been subjected to rigorous qualification testing and they are manufactured using materials with coefficients of thermal expansion (CTE) compatible with common substrates such as FR4, G-10, RF-35, RO4350 and polyimide. Produced with 6 of 6 RoHS compliant tin immersion.

Features:

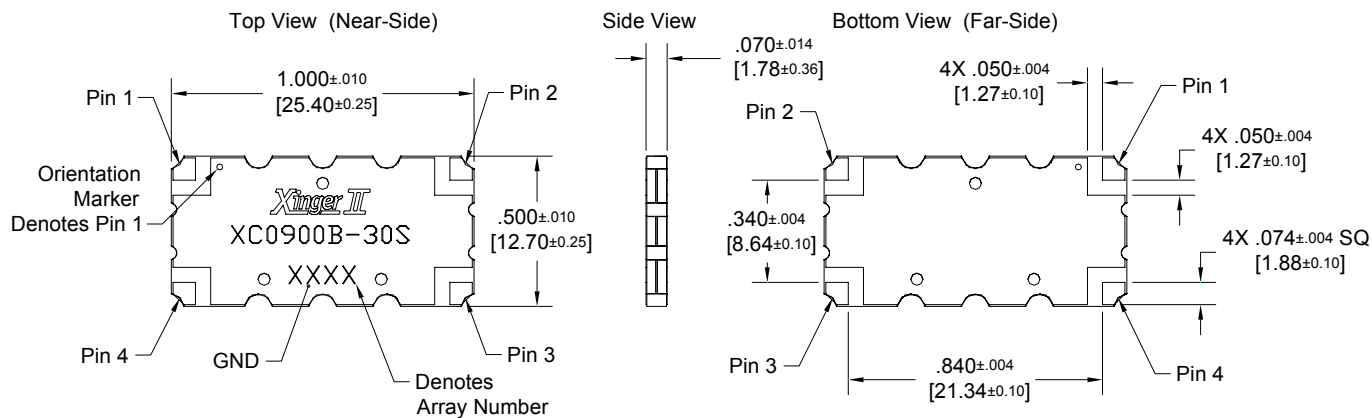
- 800 – 1000 MHz
- AMPS
- High Power
- Very Low Loss
- Tight Coupling
- High Directivity
- Production Friendly
- Tape and Reel
- Lead-Free

Electrical Specifications **

| Frequency | Mean Coupling | Insertion Loss | VSWR | Directivity |
|-----------------------|---------------|----------------|-----------------|-------------|
| MHz | dB | dB Max | Max : 1 | dB Min |
| 800 - 1000 | 29.8 ± 1.0 | 0.10 | 1.15 | 23 |
| 865 - 895 | 29.6 ± 0.8 | 0.09 | 1.12 | 25 |
| 925 - 960 | 29.5 ± 0.8 | 0.09 | 1.12 | 25 |
| Frequency Sensitivity | Power | ΘJC | Operating Temp. | |
| dB Max | Avg. CW Watts | °C/Watt | °C | |
| ± 0.40 | 355 | 11.2 | -55 to +85 | |
| ± 0.12 | 385 | 11.2 | -55 to +85 | |
| ± 0.08 | 355 | 11.2 | -55 to +85 | |

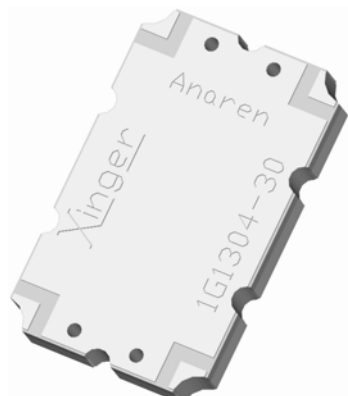
**Specification based on performance of unit properly installed on Anaren Test Board 59331-0001. Refer to Specifications subject to change without notice. Refer to parameter definitions for details.

Mechanical Outline



Xinger®

Directional Couplers 30 dB



Description

The 1G1304-30 is a low profile 30dB directional coupler in an easy to use surface mount package covering the AMPS and GSM bands. The 1G1304-30 is ideal for power and frequency detection as well as VSWR monitoring and can be used in most high power designs. Parts have been subjected to rigorous qualification testing and units are 100% tested. They are manufactured using materials with x and y thermal expansion coefficients compatible with common substrates such as FR4, G-10 and polyamide.

Features:

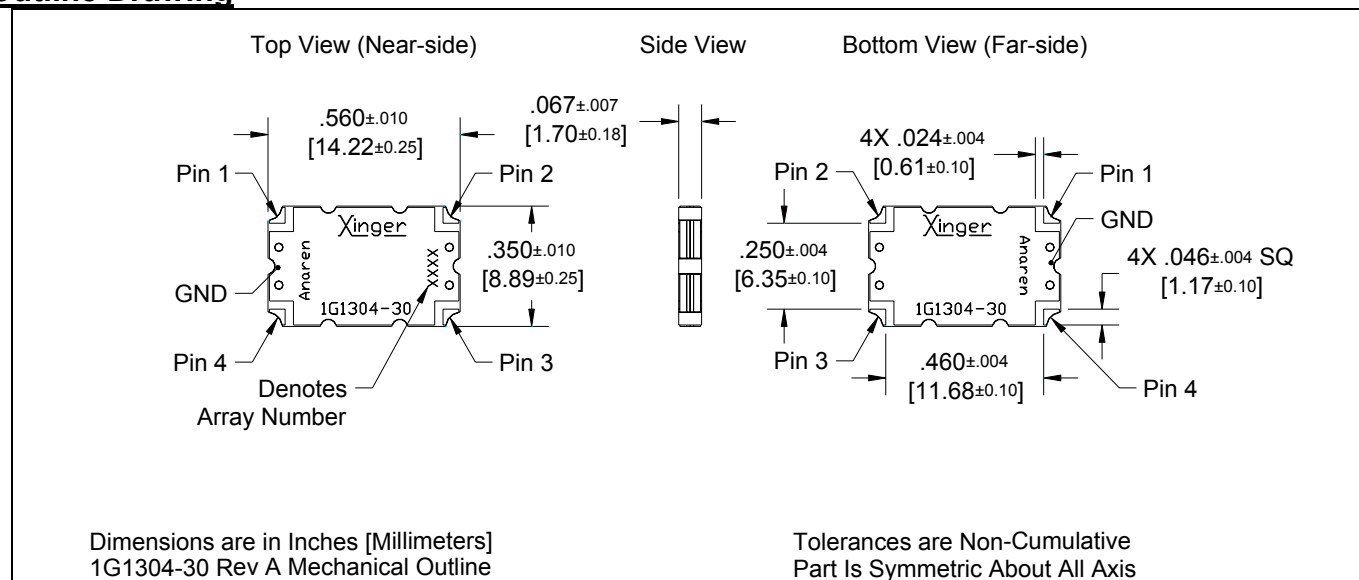
- 800 - 1000 MHz
- Low loss
- High Directivity
- Surface Mountable
- Tape And Reel
- Convenient Package
- 100% Tested
- Lead Free Finish

ELECTRICAL SPECIFICATIONS**

| Frequency | Mean Coupling | Insertion Loss | VSWR | Freq. Sensitivity |
|-------------|----------------|----------------|-----------------|-------------------|
| MHz | dB | dB Max | Max:1 | dB Max |
| 869 - 894 | 30 ± 1.5 | 0.25 | 1.20 | ±0.10 |
| 800 - 1000 | 30 ± 1.5 | 0.25 | 1.27 | ±0.30 |
| Directivity | Power Handling | θJC | Operating Temp. | |
| dB Min | Watts | °C / Watt | °C | |
| 18 | 150 | 20.3 | -55 to +85 | |
| 18 | 150 | 20.3 | -55 to +85 | |

**Specification based on performance of unit properly installed on microstrip printed circuit boards with 50 Ω nominal impedance. Specifications subject to change without notice.

Outline Drawing



Xinger® II

10 dB Directional Coupler



Description

The XC0900P-10S is a low profile, high performance 10dB directional coupler in a new easy to use, manufacturing friendly surface mount package. It is designed for AMPS band applications. The XC0900P-10S is designed particularly for power and frequency detection, as well as for power injection for example in feed-forward, where tightly controlled coupling and low insertion loss is required. It can be used in high power applications up to 55 Watts.

Parts have been subjected to rigorous qualification testing and they are manufactured using materials with coefficients of thermal expansion (CTE) compatible with common substrates such as FR4, G-10, RF-35, RO4350, and polyimide. Produced with 6 Of 6 RoHS compliant tin immersion.

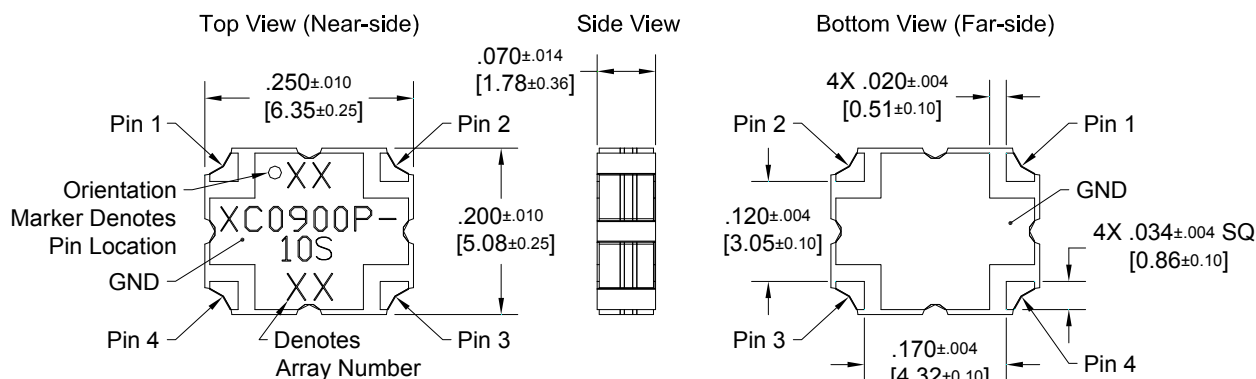
Electrical Specifications **

Features:

- 800 – 1000 MHz
- AMPS
- Very Low Loss
- High Directivity
- Tight Coupling
- Production Friendly
- Tape and Reel
- Lead-Free
- Reliable, FIT=0.49

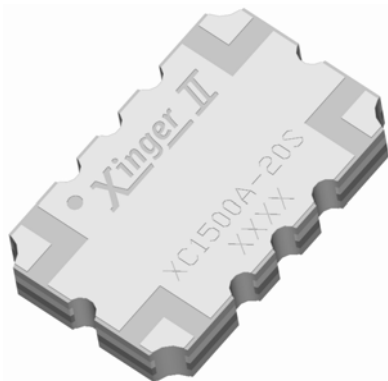
| Frequency | Mean Coupling | Insertion Loss | VSWR | Directivity |
|-----------------------|---------------|----------------|-----------------|-------------|
| MHz | dB | dB Max | Max : 1 | dB Min |
| 800-1000 | 10.2±1.0 | 0.38 | 1.35 | 15 |
| 869-894 | 10±1.0 | 0.28 | 1.2 | 18 |
| 925-960 | 10±1.0 | 0.32 | 1.2 | 18 |
| Frequency Sensitivity | Power | ΘJC | Operating Temp. | |
| dB Max | Avg. CW Watts | °C/Watt | °C | |
| ±0.36 | 45 | 32 | -55 to +85 | |
| ±0.05 | 55 | 32 | -55 to +85 | |
| ±0.05 | 50 | 32 | -55 to +85 | |

**Specification based on performance of unit properly installed on Anaren Test Board 54147-0001. Refer to Specifications subject to change without notice. Refer to parameter definitions for details.



Xinger II

20dB Directional Coupler



Description

The XC1500A-20S is a low profile, high performance 20dB directional coupler in a new easy to use, manufacturing friendly surface mount package. It is designed for AMPS band applications. The XC1500A-20S is designed particularly for power and frequency detection, as well as for VSWR monitoring, where tightly controlled coupling and low insertion loss is required. It can be used in high power applications up to 150 Watts.

Parts have been subjected to rigorous qualification testing and they are manufactured using materials with coefficients of thermal expansion (CTE) compatible with common substrates such as FR4, G-10, RF-35, RO4350 and polyimide. Produced with 6 of 6 RoHS compliant tin immersion finish.

Features:

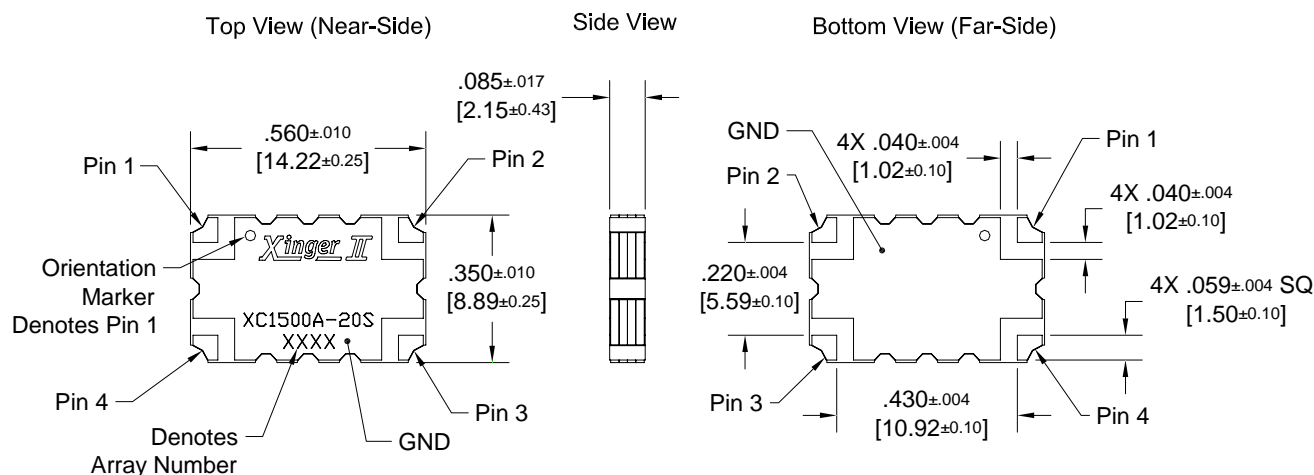
- 1000 - 2000 MHz
- AMPS
- High Power
- Very Low Loss
- Tight Coupling
- High Directivity
- Production Friendly
- Tape and Reel
- Lead-Free

Electrical Specifications **

| Frequency | Mean Coupling | Insertion Loss | VSWR | Directivity |
|-----------------------|---------------|----------------|-----------------|-------------|
| MHz | dB | dB Max | Max : 1 | dB Min |
| 1000-2000 | 20±0.70 | 0.19 | 1.28 | 21.0 |
| Frequency Sensitivity | Power | ΘJC | Operating Temp. | |
| dB Max | Avg. CW Watts | °C/Watt | °C | |
| ±1.25 | 150 | TBD | -55 to +85 | |

**Specification based on performance of unit properly installed on Anaren Test Board 54606-0001. Refer to Specifications subject to change without notice. Refer to parameter definitions for details.

Mechanical Outline



Dimensions are in Inces [Millimeters]
XC1500A-20S Mechanical Outline

Tolerances are Non-Cumulative





The 1P520 Pico Xinger is a low profile, miniature 20dB directional coupler in an easy to use surface mount package designed for DCS and PCS applications. The 1P520 is for power and frequency detection as well as power injection. The 1P520 is an ideal solution for the ever-increasing demands of the wireless industry for smaller printed circuit boards and high performance. Parts have been subjected to rigorous qualification testing and units are 100% tested. They are manufactured using materials with x and y thermal expansion coefficients compatible with common substrates. Available in both 5 of 6 tin lead (1P520) and 6 of 6 RoHS compliant tin immersion (1P520S).

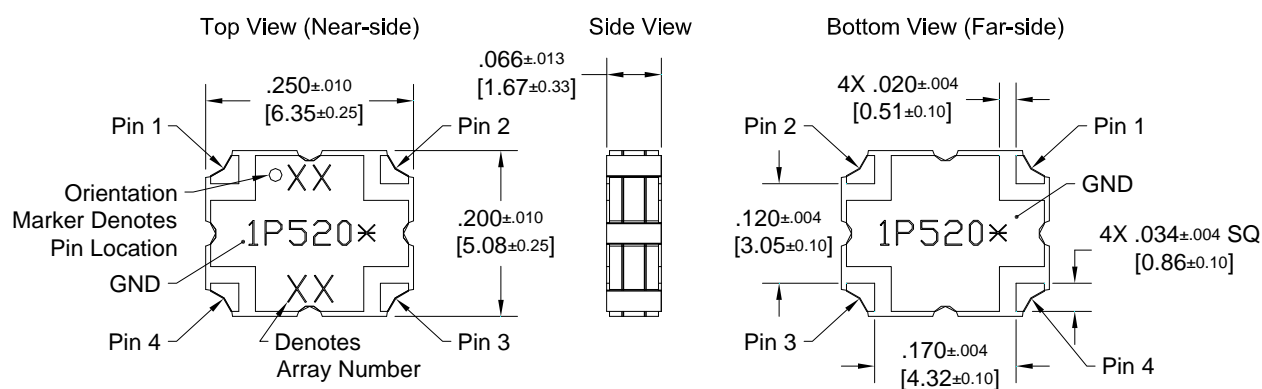
Features:

- **1.7 – 2.0 GHz**
- **DCS and PCS**
- **Very Low Loss**
- **High Directivity**
- **Surface Mountable**
- **Tape and Reel**
- **Available in Lead-Free (as illustrated) or Tin-Lead**

ELECTRICAL SPECIFICATIONS**

| Frequency | Mean Coupling | Insertion Loss | VSWR | Freq. Sensitivity |
|-------------|----------------|----------------|-----------------|-------------------|
| GHz | dB | dB Max | Max : 1 | dB Max |
| 1.7 – 2.0 | 20 ± 0.75 | 0.25 | 1.22 | ± 0.2 |
| Directivity | Power Handling | ⊙JC | Operating Temp. | |
| dB Min | Ave CW Watts | °C / Watt | °C | |
| 20 | 25 | 35 | -55 to +85 | |

**Specification based on performance of unit properly installed on microstrip printed circuit boards with 50 Ω nominal impedance. Specifications subject to change without notice.



Dimensions are in Inches [Millimeters]
1P520* Mechanical Outline

*For RoHS Compliant Versions order with S suffix
Tolerances are Non-Cumulative

Xinger II

5 dB Directional Coupler



Description

The XC1900A-05 is a low profile, high performance 5dB directional coupler in a new easy to use, manufacturing friendly surface mount package. It is designed for DCS and PCS applications. The XC1900A-05 is designed particularly for non-binary split and combine in high power amplifiers, e.g. used along with a 3dB to get a 3-way, plus other signal distribution applications where low insertion loss is required. It can be used in high power applications up to 200 Watts.

Parts have been subjected to rigorous qualification testing and they are manufactured using materials with coefficients of thermal expansion (CTE) compatible with common substrates such as FR4, G-10, RF-35, RO4350, and polyimide. Available in both 5 of 6 tin lead (XC1900A-05P) and 6 of 6 tin immersion (XC1900A-05S) RoHS compliant finishes.

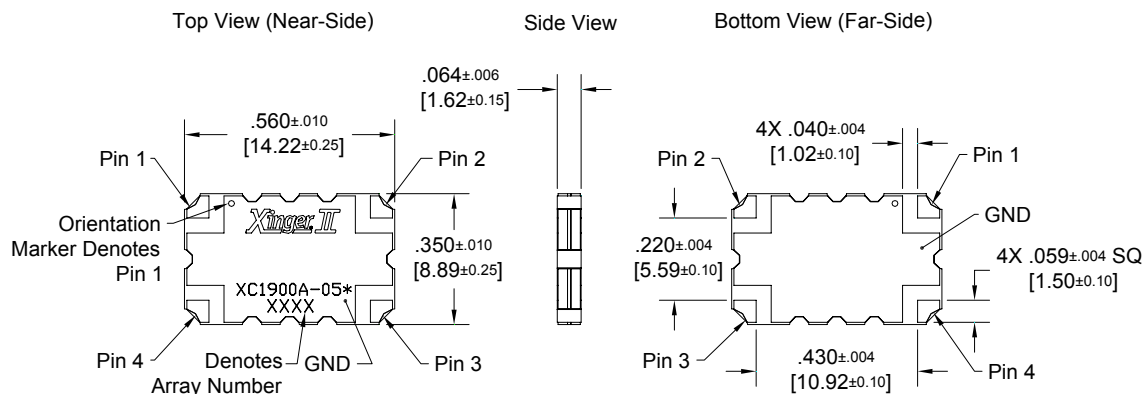
Electrical Specifications **

Features:

- 1700 – 2000 MHz
- DCS and PCS
- High Power
- Very Low Loss
- Tight Coupling
- High Directivity
- Production Friendly
- Tape and Reel
- Available in Lead-Free (as illustrated) or Tin-Lead
- Reliable, FIT=0.53

| Frequency | Mean Coupling | Insertion Loss | VSWR | Phase Balance |
|-------------|-----------------------|----------------|---------|-----------------|
| MHz | dB | dB Max | Max : 1 | Degrees |
| 1700-2000 | 5.0 ± 0.22 | 0.15 | 1.15 | 90±2.0 |
| 1805-1880 | 5.0 ± 0.19 | 0.12 | 1.12 | 90±2.0 |
| 1930-1990 | 5.0 ± 0.19 | 0.12 | 1.12 | 90±2.0 |
| Directivity | Frequency Sensitivity | Power | ΘJC | Operating Temp. |
| dB Min | dB Max | Avg. CW Watts | °C/Watt | °C |
| 23 | ± 0.05 | 200 | 17.5 | -55 to +95 |
| 25 | ± 0.03 | 200 | 17.5 | -55 to +95 |
| 25 | ± 0.03 | 200 | 17.5 | -55 to +95 |

**Specification based on performance of unit properly installed on Anaren Test Board 58481-0001 with small signal applied. Specifications subject to change without notice. Refer to parameter definitions for details.



Dimensions are in Inches [Millimeters]
XC1900A-05* Mechanical Outline

*For RoHS Compliant Versions order with S suffix
Tolerances are Non-Cumulative



10 dB Directional Coupler

20 dB Directional Coupler



Description

The XC1900A-20 is a low profile, high performance 20dB directional coupler in a new easy to use, manufacturing friendly surface mount package. It is designed for DCS and PCS band applications. The XC1900A-20 is designed particularly for power and frequency detection, as well as for VSWR monitoring, where tightly controlled coupling and low insertion loss is required. It can be used in high power applications up to 150 Watts.

Parts have been subjected to rigorous qualification testing and they are manufactured using materials with coefficients of thermal expansion (CTE) compatible with common substrates such as FR4, G-10, RF-35, RO4350, and polyimide. Available in both 5 of 6 tin lead (XC1900A-20P) and 6 of 6 tin immersion (XC1900A-20S) RoHS compliant finishes.

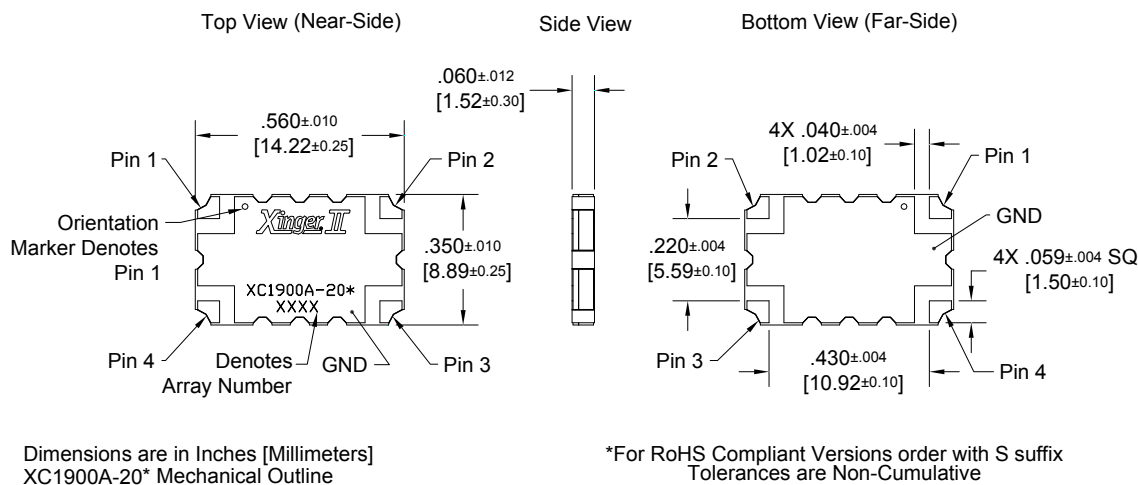
Electrical Specifications **

Features:

- **1700 – 2000 MHz**
- **DCS and PCS**
- **High Power**
- **Very Low Loss**
- **Tight Coupling**
- **High Directivity**
- **Production Friendly**
- **Tape and Reel**
- **Available in Lead-Free (as illustrated) or Tin-Lead**
- **Reliable, FIT=0.41**

| Frequency | Mean Coupling | Insertion Loss | VSWR | Directivity |
|-----------------------|----------------------|----------------|-----------------|---------------|
| <i>MHz</i> | <i>dB</i> | <i>dB Max</i> | <i>Max : 1</i> | <i>dB Min</i> |
| 1700-2000 | 20.1 ± 0.60 | 0.15 | 1.15 | 23 |
| 1805-1880 | 20.0 ± 0.50 | 0.12 | 1.12 | 25 |
| 1930-1990 | 20.0 ± 0.50 | 0.12 | 1.12 | 25 |
| Frequency Sensitivity | Power | ⊙JC | Operating Temp. | |
| <i>dB Max</i> | <i>Avg. CW Watts</i> | <i>°C/Watt</i> | <i>°C</i> | |
| ± 0.12 | 150 | 21.5 | -55 to +95 | |
| ± 0.05 | 150 | 21.5 | -55 to +95 | |
| ± 0.05 | 150 | 21.5 | -55 to +95 | |

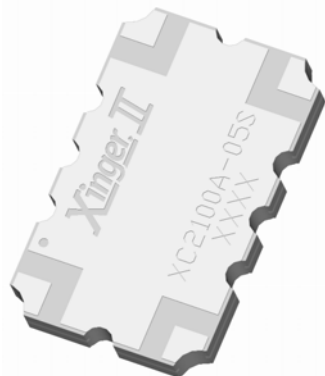
**Specification based on performance of unit properly installed on Anaren Test Board 54606-0003 with small signal applied. Specifications subject to change without notice. Refer to parameter definitions for details.



10 dB Directional Coupler

Xinger II

5 dB Directional Coupler



Description

The XC2100A-05 is a low profile, high performance 5dB directional coupler in a new easy to use, manufacturing friendly surface mount package. It is designed for UMTS and other 3G band applications. The XC2100A-05 is designed particularly for non-binary split and combine in high power amplifiers, e.g. used along with a 3dB to get a 3-way, plus other signal distribution applications where low insertion loss is required. It can be used in high power applications up to 175 Watts.

Parts have been subjected to rigorous qualification testing and they are manufactured using materials with coefficients of thermal expansion (CTE) compatible with common substrates such as FR4, G-10, RF-35, RO4350, and polyimide. Available in both 5 of 6 tin lead (XC2100A-05P) and 6 of 6 tin immersion (XC2100A-05S) RoHS compliant finishes.

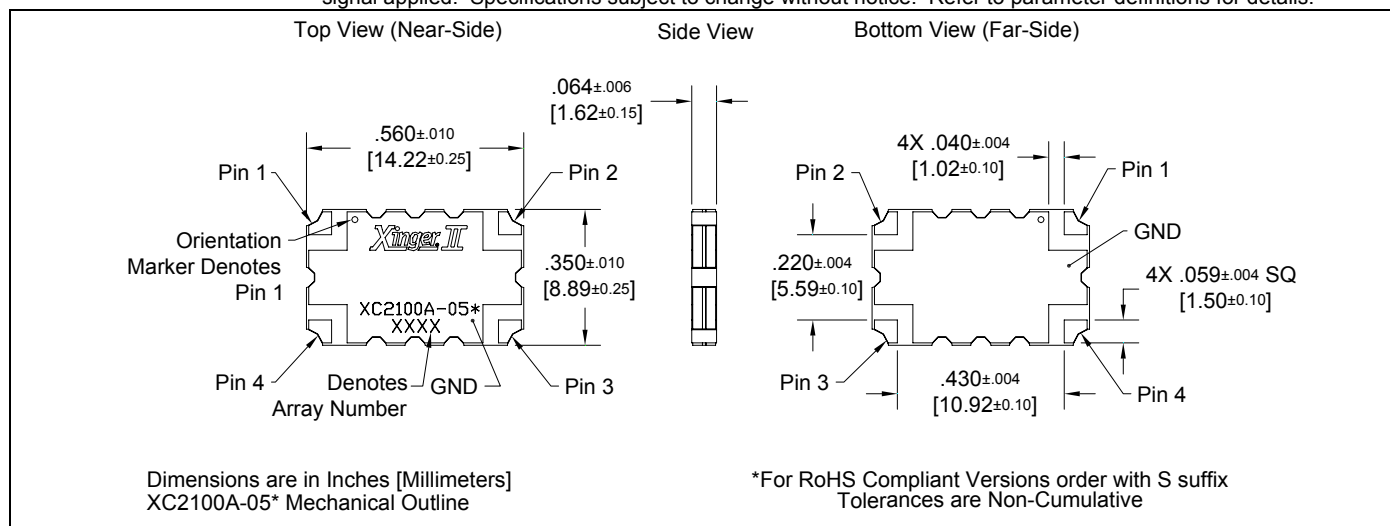
Electrical Specifications **

Features:

- 2000 – 2300 MHz
- UMTS and other 3G
- High Power
- Very Low Loss
- Tight Coupling
- High Directivity
- Production Friendly
- Tape and Reel
- Available in Lead-Free (as illustrated) or Tin-Lead
- Reliable, FIT=0.53

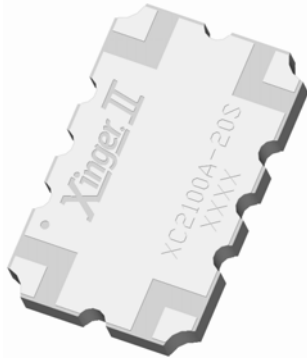
| Frequency | Mean Coupling | Insertion Loss | VSWR | Phase Balance |
|-------------|-----------------------|----------------|---------|-----------------|
| MHz | dB | dB Max | Max : 1 | Degrees |
| 2000-2300 | 5.0 ± 0.22 | 0.15 | 1.15 | 90±2.0 |
| 2110-2170 | 5.0 ± 0.19 | 0.12 | 1.12 | 90±2.0 |
| Directivity | Frequency Sensitivity | Power | ΘJC | Operating Temp. |
| dB Min | dB Max | Avg. CW Watts | °C/Watt | °C |
| 23 | ± 0.05 | 125 | 19 | -55 to +95 |
| 25 | ± 0.03 | 175 | 19 | -55 to +95 |

**Specification based on performance of unit properly installed on Anaren Test Board 58481-0001 with small signal applied. Specifications subject to change without notice. Refer to parameter definitions for details.



Xinger II

20 dB Directional Coupler



Description

The XC2100A-20 is a low profile, high performance 20dB directional coupler in a new easy to use, manufacturing friendly surface mount package. It is designed for UMTS and other 3G applications. The XC2100A-20 is designed particularly for power and frequency detection, as well as for VSWR monitoring, where tightly controlled coupling and low insertion loss is required. It can be used in high power applications up to 150 Watts.

Parts have been subjected to rigorous qualification testing and they are manufactured using materials with coefficients of thermal expansion (CTE) compatible with common substrates such as FR4, G-10, RF-35, RO4350, and polyimide. Available in both 5 of 6 tin lead (XC2100A-20P) and 6 of 6 tin immersion (XC2100A-20S) RoHS compliant finishes.

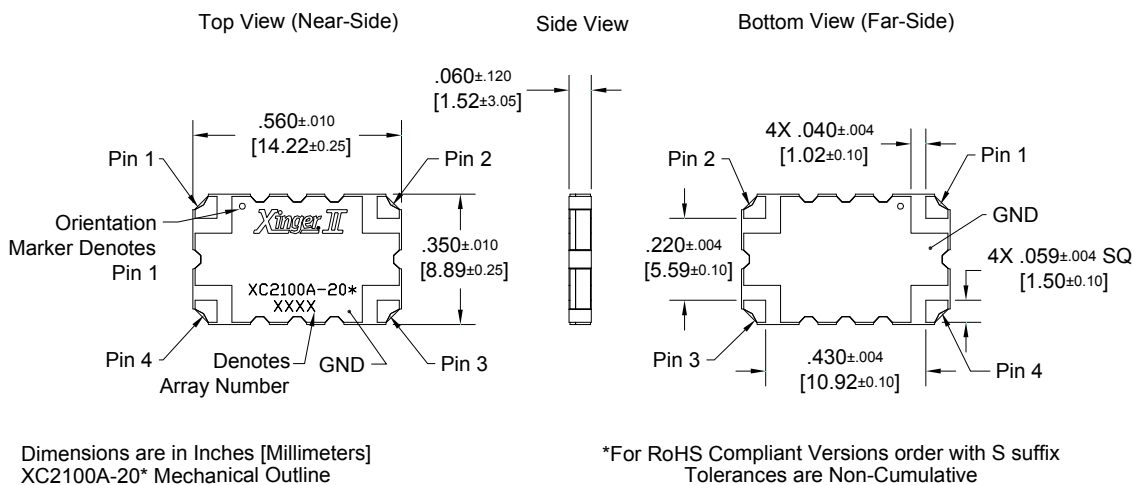
Electrical Specifications **

Features:

- 2000 – 2300 MHz
- UMTS and other 3G
- High Power
- Very Low Loss
- Tight Coupling
- High Directivity
- Production Friendly
- Tape and Reel
- Available in Lead-Free (as illustrated) or Tin-Lead
- Reliable, FIT=0.41

| Frequency | Mean Coupling | Insertion Loss | VSWR | Directivity |
|-----------------------|---------------|----------------|-----------------|-------------|
| MHz | dB | dB Max | Max : 1 | dB Min |
| 2000-2300 | 20.1 ± 0.60 | 0.15 | 1.15 | 23 |
| 2110-2170 | 20.0 ± 0.50 | 0.12 | 1.12 | 25 |
| Frequency Sensitivity | Power | ΘJC | Operating Temp. | |
| dB Max | Avg. CW Watts | °C/Watt | °C | |
| ± 0.12 | 120 | 25 | -55 to +95 | |
| ± 0.05 | 150 | 25 | -55 to +95 | |

**Specification based on performance of unit properly installed on Anaren Test Board 54606-0003 with small signal applied. Specifications subject to change without notice. Refer to parameter definitions for details.



Xinger II

30 dB Directional Coupler



Description

The XC2100A-30 is a low profile, high performance 30dB directional coupler in a new easy to use, manufacturing friendly surface mount package. It is designed for UMTS and other 3G applications. The XC2100A-30 is designed particularly for power and frequency detection, as well as for VSWR monitoring, where tightly controlled coupling and low insertion loss is required. It can be used in high power applications up to 120 Watts.

Parts have been subjected to rigorous qualification testing and they are manufactured using materials with coefficients of thermal expansion (CTE) compatible with common substrates such as FR4, G-10, RF-35, RO4350, and polyimide. Available in both 5 of 6 tin lead (XC2100A-30P) and 6 of 6 tin immersion (XC2100A-30S) RoHS compliant finishes.

Features:

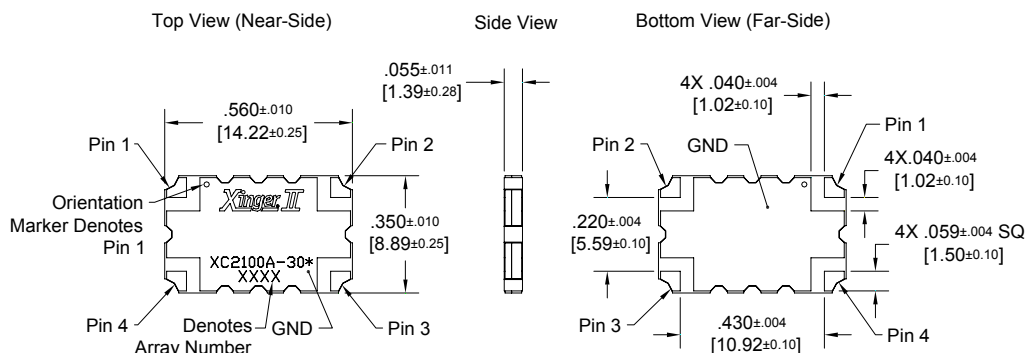
- 1805 – 2300 MHz
- UMTS and other 3G
- High Power
- Very Low Loss
- Tight Coupling
- High Directivity
- Production Friendly
- Tape and Reel
- Available in Lead-Free (as illustrated) or Tin-Lead
- Reliable, FIT=0.41

Electrical Specifications **

| Frequency | Mean Coupling | Insertion Loss | VSWR | Directivity |
|-----------------------|---------------|----------------|-----------------|-------------|
| MHz | dB | dB Max | Max : 1 | dB Min |
| 2000-2300 | 30 ± 0.80 | 0.15 | 1.22 | 20 |
| 2110-2170 | 30 ± 0.60 | 0.12 | 1.17 | 22 |
| 1930-1990 | 30 ± 0.80 | 0.12 | 1.22 | 20 |
| 1805-1880 | 30 ± 0.80 | 0.12 | 1.22 | 20 |
| 1450-1600 | 31 ± 2.00 | 0.12 | 1.22 | 20 |
| Frequency Sensitivity | Power | ΘJC | Operating Temp. | |
| dB Max | Avg. CW Watts | °C/Watt | °C | |
| ± 0.15 | 105 | 32.7 | -55 to +95 | |
| ± 0.10 | 120 | 32.7 | -55 to +95 | |
| ± 0.15 | 120 | 32.7 | -55 to +95 | |
| ± 0.15 | 120 | 32.7 | -55 to +95 | |
| ± 0.25 | 120 | 32.7 | -55 to +95 | |

**Specification based on performance of unit properly installed on Anaren Test Board 54606-0003 with small signal applied. Specifications subject to change without notice. Refer to parameter definitions for details.

Mechanical Outline



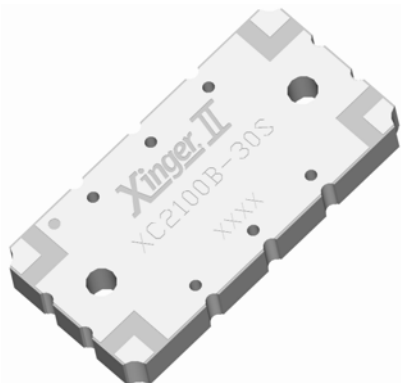
Dimensions are in Inches [Millimeters]
XC2100A-30* Mechanical Outline

*For RoHS Compliant Versions order with S suffix
Tolerances are Non-Cumulative



Xinger II

30 dB Directional Coupler



Description

The XC2100B-30S is a low profile, high performance 30dB directional coupler in a new easy to use, manufacturing friendly surface mount package. It is designed for UMTS, other 3G applications and WiMAX. The XC2100B-30S is designed particularly for power and frequency detection, as well as for VSWR monitoring, where tightly controlled coupling and low insertion loss is required. It can be used in high power applications up to 300 Watts.

Parts have been subjected to rigorous qualification testing and they are manufactured using materials with coefficients of thermal expansion (CTE) compatible with common substrates such as FR4, G-10, RF-35, RO4350, and polyimide. Produced with 6 of 6 RoHS compliant tin immersion finish.

Electrical Specifications **

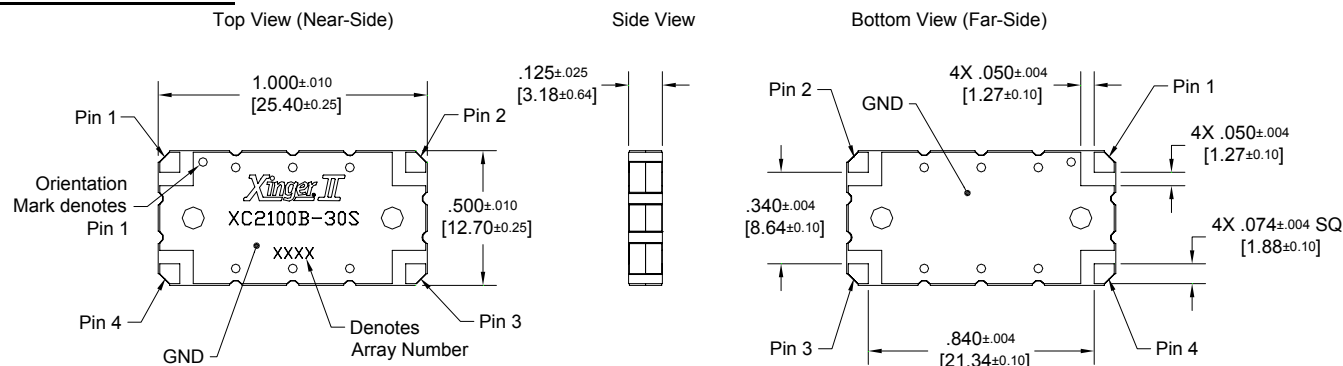
Features:

- 1805 – 2700 MHz
- UMTS and other 3G
- WiMAX
- High Power
- Very Low Loss
- Tight Coupling
- High Directivity
- Production Friendly
- Tape and Reel
- Lead-Free

| Frequency | Mean Coupling | Insertion Loss | VSWR | Directivity |
|-----------------------|---------------|----------------|-----------------|-------------|
| MHz | dB | dB Max | Max : 1 | dB Min |
| 2300 - 2700 | 30.0 ± 1.25 | 0.15 | 1.22 | 18.0 |
| 1805 - 1880 | 29.8 ± 1.00 | 0.12 | 1.22 | 20.0 |
| 1930 - 1990 | 29.8 ± 1.00 | 0.12 | 1.22 | 20.0 |
| 2110 - 2170 | 29.8 ± 1.00 | 0.12 | 1.22 | 20.0 |
| Frequency Sensitivity | Power | ΘJC | Operating Temp. | |
| dB Max | Avg. CW Watts | °C/Watt | °C | |
| ± 0.40 | 150 | 22.3 | -55 to +85 | |
| ± 0.15 | 300 | 22.3 | -55 to +85 | |
| ± 0.10 | 300 | 22.3 | -55 to +85 | |
| ± 0.10 | 300 | 22.3 | -55 to +85 | |

**Specification based on performance of unit properly installed on Anaren Test Board 59331-0001 with small signal applied. Specifications subject to change without notice. Refer to parameter definitions for details.

Mechanical Outline



Dimensions are in Inches [Millimeters]
XC2100B-30S Mechanical Outline

Tolerances are Non-Cumulative



Xinger II®

10 dB Directional Coupler



Description

The XC2100E-10 is a low profile, high performance 10dB directional coupler in a new easy to use, manufacturing friendly surface mount package. It is designed for UMTS and other 3G applications. The XC2100E-10 is designed particularly for power and frequency detection, as well as for power injection for example in feed-forward, where tightly controlled coupling and low insertion loss is required. It can be used in high power applications up to 165 Watts.

Parts have been subjected to rigorous qualification testing and they are manufactured using materials with coefficients of thermal expansion (CTE) compatible with common substrates such as FR4, G-10, RF-35, RO4350, and polyimide. Available in both 5 of 6 tin lead (XC2100E-10P) and 6 of 6 tin immersion (XC2100E-10S) RoHS compliant finishes.

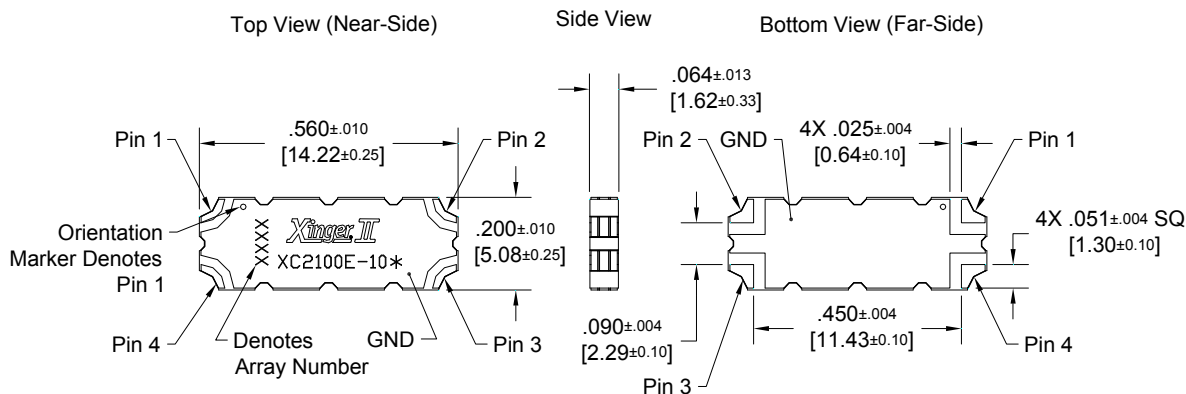
Electrical Specifications **

Features:

- 2000 – 2300 MHz
- UMTS and other 3G
- High Power
- Very Low Loss
- High Directivity
- Tight Coupling
- Production Friendly
- Tape and Reel
- Available in Lead-Free (as illustrated) or Tin-Lead
- Reliable, FIT=0.73

| Frequency | Mean Coupling | Insertion Loss | VSWR | Directivity |
|-----------------------|---------------|----------------|-----------------|-------------|
| MHz | dB | dB Max | Max : 1 | dB Min |
| 2000-2300 | 10.1 ± 0.50 | 0.14 | 1.19 | 21 |
| 2110-2170 | 10.0 ± 0.40 | 0.12 | 1.15 | 23 |
| Frequency Sensitivity | Power | ΘJC | Operating Temp. | |
| dB Max | Avg. CW Watts | °C/Watt | °C | |
| ± 0.10 | 155 | 24 | -55 to +95 | |
| ± 0.05 | 165 | 24 | -55 to +95 | |

**Specification based on performance of unit properly installed on Anaren Test Board 58493-0001 with small signal applied. Specifications subject to change without notice. Refer to parameter definitions for details.



Dimensions are in Inches [Millimeters]
XC2100E-10* Mechanical Outline

*For RoHS Compliant Versions order with S suffix
Tolerances are Non-Cumulative



Xinger®

Pico Xinger 6dB Directional Coupler



Description

The JP506 is a low profile 6dB directional coupler in an easy to use surface mount package covering the WCDMA and other 3G applications. The JP506 is ideal for an inline split/combine amplifiers and for power injection and can be used in most high power designs. Parts have been subjected to rigorous qualification testing and units are 100% tested. They are manufactured using materials with x and y thermal expansion coefficients compatible with common substrates such as FR4, G-10 and polyamide.

Features:

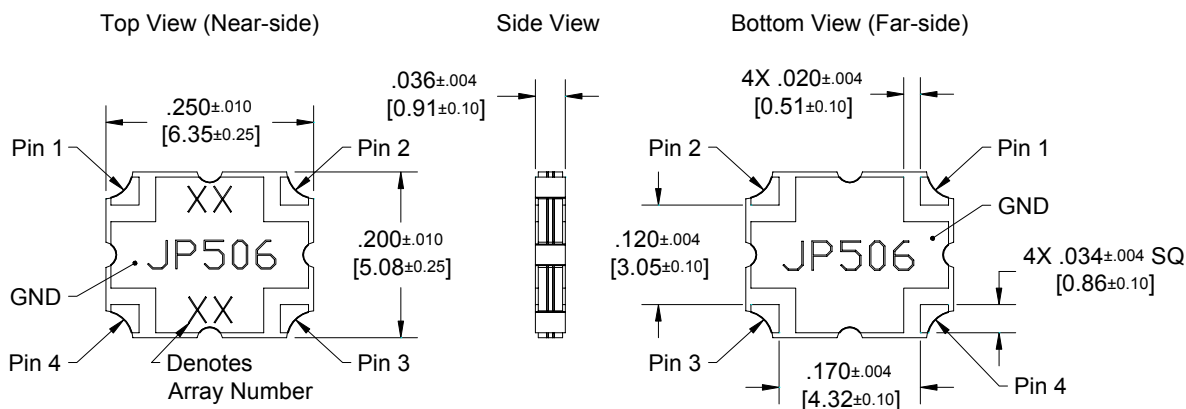
- 2.0 - 2.3GHz
- Low loss
- High Directivity
- Surface Mountable
- Tape And Reel
- Convenient Package
- 100% Tested

ELECTRICAL SPECIFICATIONS**

| Frequency | Mean Coupling | Insertion Loss | VSWR | Freq. Sensitivity |
|---------------|----------------|----------------|-----------------|-------------------|
| GHz | dB | dB Max | Max : 1 | dB Max |
| 1.805 – 1.880 | 6.2 ± 0.5 | 0.30 | 1.22 | ±0.20 |
| 1.93 – 1.99 | 6.0 ± 0.5 | 0.30 | 1.22 | ±0.20 |
| 2.0 – 2.3 | 6.0 ± 0.5 | 0.30 | 1.22 | ±0.20 |
| Directivity | Power Handling | ⊙JC | Operating Temp. | |
| dB Min | Watts | °C / Watt | °C | |
| 18 | 20 | 35.2 | -55 to +85 | |
| 18 | 20 | 35.2 | -55 to +85 | |
| 20 | 20 | 35.2 | -55 to +85 | |

**Specification based on performance of unit properly installed on microstrip printed circuit boards with 50 Ω nominal impedance. Specifications subject to change without notice.

Outline Drawing



Xinger®

Pico Xinger 10dB Directional Coupler



Description

The 1P510 Pico Xinger is a low profile, miniature 10dB directional coupler in an easy to use surface mount package designed for DCS and PCS applications. The 1P510 is for power and frequency detection as well as power injection. The 1P510 is an ideal solution for the ever-increasing demands of the wireless industry for smaller printed circuit boards and high performance. Parts have been subjected to rigorous qualification testing and units are 100% tested. They are manufactured using materials with x and y thermal expansion coefficients compatible with common substrates. Available in both 5 of 6 tin lead (1P510) and 6 of 6 RoHS compliant tin immersion (1P510S).

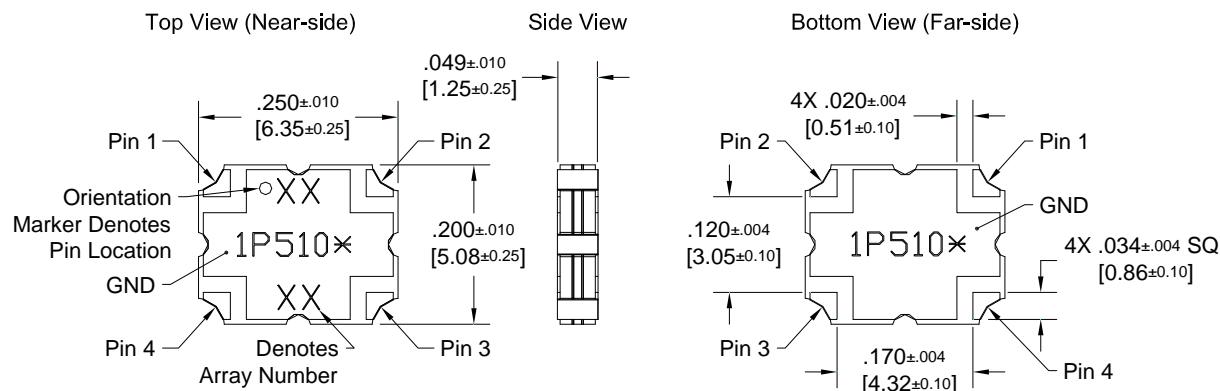
Features:

- 1.7 – 2.0 GHz
- DCS and PCS
- Very Low Loss
- High Directivity
- Surface Mountable
- Tape and Reel
- Available in Lead-Free (as illustrated) or Tin-Lead

ELECTRICAL SPECIFICATIONS**

| Frequency | Mean Coupling | Insertion Loss | VSWR | Freq. Sensitivity |
|-------------|----------------|----------------|-----------------|-------------------|
| GHz | dB | dB Max | Max : 1 | dB Max |
| 1.7 – 2.0 | 10 ± 0.75 | 0.25 | 1.22 | ± 0.2 |
| Directivity | Power Handling | ΘJC | Operating Temp. | |
| dB Min | Ave CW Watts | °C / Watt | °C | |
| 20 | 20 | 44 | -55 to +85 | |

**Specification based on performance of unit properly installed on microstrip printed circuit boards with 50 Ω nominal impedance. Specifications subject to change without notice.



Dimensions are in Inches [Millimeters]
1P510* Mechanical Outline

*For RoHS Compliant Versions order with S suffix
Tolerances are Non-Cumulative



Xinger®

Pico Xinger 10dB Directional Coupler



Description

The JP510 Pico Xinger is a low profile, miniature 10dB directional coupler in an easy to use surface mount package designed for UMTS and WCDMA applications. The JP510 is for power and frequency detection as well as power injection. The JP510 is an ideal solution for the ever-increasing demands of the wireless industry for smaller printed circuit boards and high performance. Parts have been subjected to rigorous qualification testing and units are 100% tested. They are manufactured using materials with x and y thermal expansion coefficients compatible with common substrates.

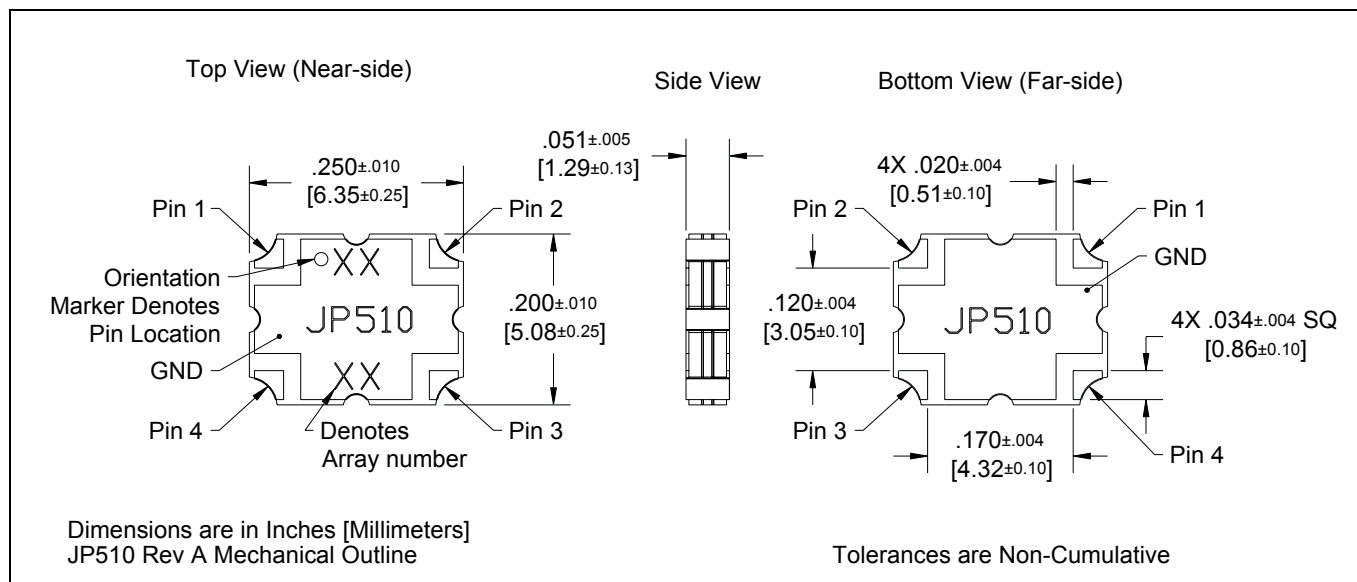
Features:

- 2.0 – 2.3 GHz
- UMTS and WCDMA
- Very Low Loss
- High Directivity
- Surface Mountable
- Tape and Reel
- New Pico-Package
- 100% Tested

ELECTRICAL SPECIFICATIONS**

| Frequency | Mean Coupling | Insertion Loss | VSWR | Freq. Sensitivity |
|-------------|----------------|----------------|-----------------|-------------------|
| GHz | dB | dB Max | Max : 1 | dB Max |
| 2.0 – 2.3 | 10 ± 0.75 | 0.25 | 1.22 | ± 0.2 |
| Directivity | Power Handling | θJC | Operating Temp. | |
| dB Min | Ave CW Watts | °C / Watt | °C | |
| 20 | 20 | 44 | -55 to +85 | |

**Specification based on performance of unit properly installed on microstrip printed circuit boards with 50 Ω nominal impedance. Specifications subject to change without notice.



Xinger®

Pico Xinger 20dB Directional Coupler



Description

The JP520 Pico Xinger is a low profile, miniature 20dB directional coupler in an easy to use surface mount package designed for UMTS and WCDMA applications. The JP520 is for power and frequency detection as well as power injection. The JP520 is an ideal solution for the ever-increasing demands of the wireless industry for smaller printed circuit boards and high performance. Parts have been subjected to rigorous qualification testing and units are 100% tested. They are manufactured using materials with x and y thermal expansion coefficients compatible with common substrates. Available in both 5 of 6 tin lead (JP520) and 6 of 6 RoHS compliant tin immersion (JP520S).

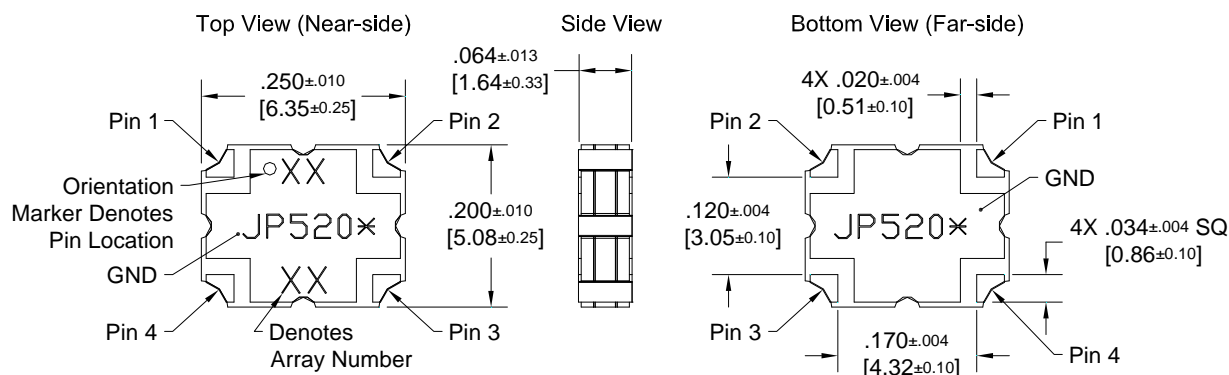
Features:

- 2.0 – 2.3 GHz
- UMTS and WCDMA
- Very Low Loss
- High Directivity
- Surface Mountable
- Tape and Reel
- Available in Lead-Free (as illustrated) or Tin-Lead

ELECTRICAL SPECIFICATIONS**

| Frequency | Mean Coupling | Insertion Loss | VSWR | Freq. Sensitivity |
|-------------|----------------|----------------|-----------------|-------------------|
| GHz | dB | dB Max | Max : 1 | dB Max |
| 2.0 – 2.3 | 20 ± 0.75 | 0.25 | 1.22 | ± 0.2 |
| Directivity | Power Handling | θJC | Operating Temp. | |
| dB Min | Ave CW Watts | °C / Watt | °C | |
| 20 | 25 | 35 | -55 to +85 | |

**Specification based on performance of unit properly installed on microstrip printed circuit boards with 50 Ω nominal impedance. Specifications subject to change without notice.



Dimensions are in Inches [Millimeters]
JP520* Mechanical Outline

*For RoHS Compliant Versions order with S suffix
Tolerances are Non-Cumulative



Xinger II®

10 dB Directional Coupler



Description

The XC2500E-10 is a low profile, high performance 10dB directional coupler in a new easy to use, manufacturing friendly surface mount package. It is designed for WiMAX band applications. The XC2500E-10 is designed particularly for power and frequency detection, as well as for power injection for example in feed-forward, where tightly controlled coupling and low insertion loss is required. It can be used in high power applications up to 145 Watts. Available in both 5 of 6 tin lead (XC2500E-10P) and 6 of 6 tin immersion (XC2500E-10S) RoHS compliant finishes.

Parts have been subjected to rigorous qualification testing and they are manufactured using materials with coefficients of thermal expansion (CTE) compatible with common substrates such as FR4, G-10, RF-35, RO4350, and polyimide.

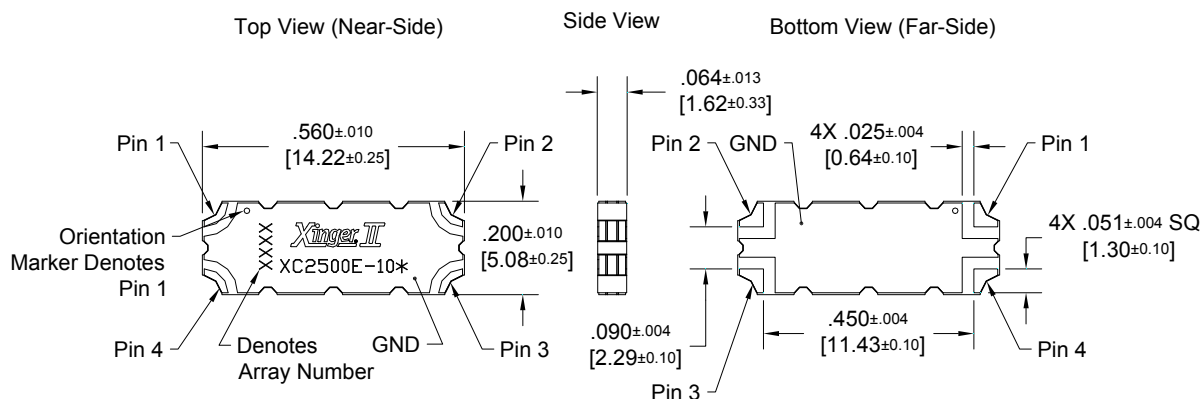
Electrical Specifications **

Features:

- 2300 – 2700 MHz
- WiMAX
- High Power
- Very Low Loss
- High Directivity
- Tight Coupling
- Production Friendly
- Tape and Reel
- Available in Lead-Free (as illustrated) or Tin-Lead
- Reliable, FIT=0.73

| Frequency | Mean Coupling | Insertion Loss | VSWR | Directivity |
|-----------------------|---------------|----------------|-----------------|-------------|
| MHz | dB | dB Max | Max : 1 | dB Min |
| 2300-2700 | 10.0 ± 0.50 | 0.14 | 1.19 | 21 |
| Frequency Sensitivity | Power | ΘJC | Operating Temp. | |
| dB Max | Avg. CW Watts | °C/Watt | °C | |
| ± 0.10 | 145 | 28 | -55 to +95 | |

**Specification based on performance of unit properly installed on Anaren Test Board 58493-0001 with small signal applied. Specifications subject to change without notice. Refer to parameter definitions for details.



Dimensions are in Inches [Millimeters]
XC2500E-10* Mechanical Outline

*For RoHS Compliant Versions order with S suffix
Tolerances are Non-Cumulative



Xinger® II



Features:

- 2300-2700 MHz
- AMPS
- High Power
- Very Low Loss
- Tight Coupling
- High Directivity
- Production Friendly
- Tape and Reel
- Lead-Free

Description

The XC2500P-20S is a low profile, high performance 20dB directional coupler in a new easy to use, manufacturing friendly surface mount package. It is designed for AMPS band applications. The XC2500P-20S is designed particularly for power and frequency detection, as well as for VSWR monitoring, where tightly controlled coupling and low insertion loss is required. It can be used in high power applications up to 20 Watts.

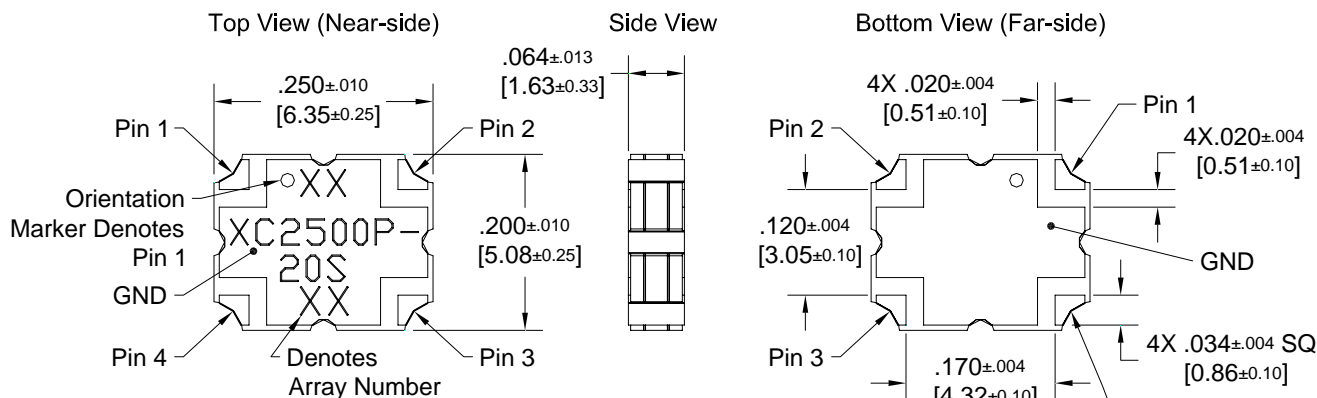
Parts have been subjected to rigorous qualification testing and they are manufactured using materials with coefficients of thermal expansion (CTE) compatible with common substrates such as FR4, G-10, RF-35, RO4003 and polyimide. Produced with 6 of 6 RoHS compliant tin immersion finish.

Electrical Specifications **

| Frequency | Mean Coupling | Insertion Loss | VSWR | Directivity |
|-----------------------|---------------|----------------|-----------------|-------------|
| MHz | dB | dB Max | Max : 1 | dB Min |
| 2300-2700 | 20±1.0 | 0.20 | 1.20 | 20 |
| Frequency Sensitivity | Power | ΘJC | Operating Temp. | |
| dB Max | Avg. CW Watts | °C/Watt | °C | |
| ±0.30 | 20 | TBD | -55 to +85 | |

**Specification based on performance of unit properly installed on Anaren Test Board 54147-0001. Refer to Specifications subject to change without notice. Refer to parameter definitions for details.

Mechanical Outline



Dimensions are in Inches [Millimeters]
XC2500P-20S Mechanical Outline

Tolerances are Non-Cumulative



Xinger®

Pico Xinger 10dB Directional Coupler



Description

The 1P610 Pico Xinger is a low profile, miniature 10dB directional coupler in an easy to use surface mount package designed for MMDS and WLAN applications. The 1P610 is for power and frequency detection as well as power injection. The 1P610 is an ideal solution for the ever-increasing demands of the wireless industry for smaller printed circuit boards and high performance. Parts have been subjected to rigorous qualification testing and units are 100% tested. They are manufactured using materials with x and y thermal expansion coefficients compatible with common substrates. Produced with 6 of 6 RoHS compliant tin immersion. Available in both 5 of 6 tin lead (1P610) and 6 of 6 RoHS compliant tin immersion (1P610S).

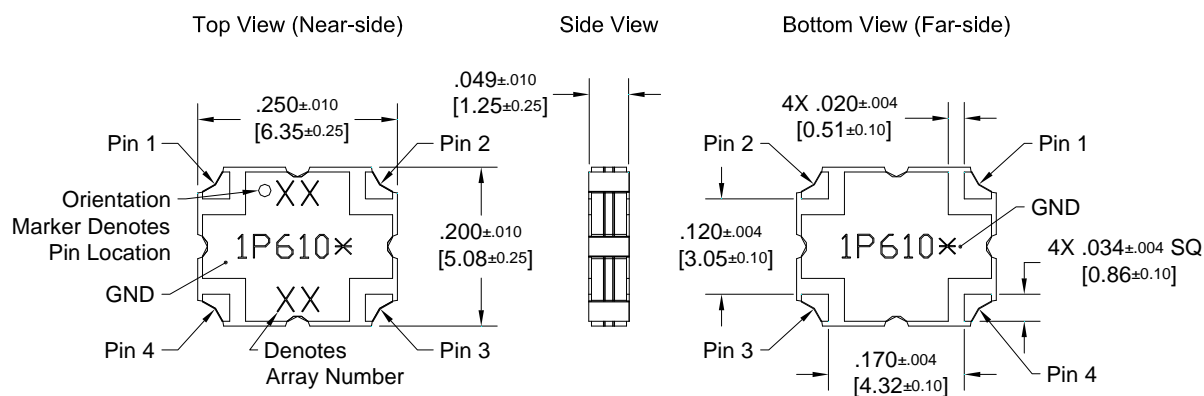
Features:

- 2.3 – 2.7 GHz
- MMDS and WLAN
- Very Low Loss
- High Directivity
- Surface Mountable
- Tape and Reel
- Available in Lead-Free (as illustrated) or Tin-Lead

ELECTRICAL SPECIFICATIONS**

| Frequency | Mean Coupling | Insertion Loss | VSWR | Freq. Sensitivity |
|-------------|----------------|----------------|-----------------|-------------------|
| GHz | dB | dB Max | Max : 1 | dB Max |
| 2.3 – 2.7 | 10 ± 0.75 | 0.25 | 1.22 | ± 0.2 |
| Directivity | Power Handling | θJC | Operating Temp. | |
| dB Min | Ave CW Watts | °C / Watt | °C | |
| 20 | 20 | 44 | -55 to +85 | |

**Specification based on performance of unit properly installed on microstrip printed circuit boards with 50 Ω nominal impedance. Specifications subject to change without notice.



Dimensions are in Inches [Millimeters]
1P610* Rev A Mechanical Outline

*For RoHS Compliant Versions order with S suffix
Tolerances are Non-Cumulative



Xinger®

Pico Xinger 20dB Directional Coupler



Description

The 1P620 Pico Xinger is a low profile, miniature 20dB directional coupler in an easy to use surface mount package designed for MMDS and WLAN applications. The 1P620 is for power and frequency detection as well as power injection. The 1P620 is an ideal solution for the ever-increasing demands of the wireless industry for smaller printed circuit boards and high performance. Parts have been subjected to rigorous qualification testing and units are 100% tested. They are manufactured using materials with x and y thermal expansion coefficients compatible with common substrates. Available in both 5 of 6 tin lead (1P620) and 6 of 6 RoHS compliant tin immersion (1P620S).

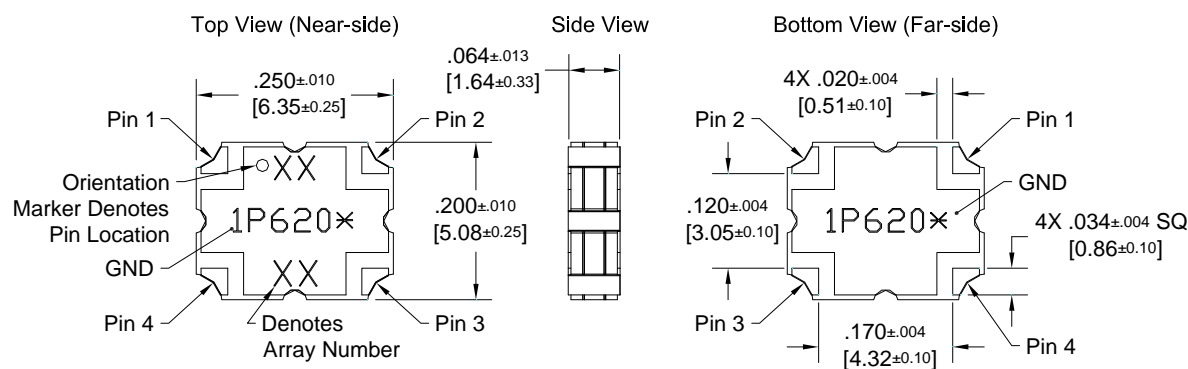
Features:

- 2.3 – 2.7 GHz
- MMDS and WLAN
- Very Low Loss
- High Directivity
- Surface Mountable
- Tape And Reel
- Available in Lead-Free (as illustrated) or Tin-Lead

ELECTRICAL SPECIFICATIONS**

| Frequency | Mean Coupling | Insertion Loss | VSWR | Freq. Sensitivity |
|-------------|----------------|----------------|-----------------|-------------------|
| GHz | dB | dB Max | Max : 1 | dB Max |
| 2.3 – 2.7 | 20 ± 0.75 | 0.25 | 1.22 | ± 0.2 |
| Directivity | Power Handling | θJC | Operating Temp. | |
| dB Min | Watts | °C / Watt | °C | |
| 20 | 25 | 35 | -55 to +85 | |

**Specification based on performance of unit properly installed on microstrip printed circuit boards with 50 Ω nominal impedance. Specifications subject to change without notice.



Dimensions are in Inches [Millimeters]
1P620* Rev A Mechanical Outline

*For RoHS Compliant Versions order with S suffix
Tolerances are Non-Cumulative



Xinger® II

20dB Directional Coupler



Features:

- 3300-3800 MHz
- AMPS
- High Power
- Very Low Loss
- Tight Coupling
- High Directivity
- Production Friendly
- Tape and Reel
- Lead-Free

Description

The XC3500P-20S is a low profile, high performance 20dB directional coupler in a new easy to use, manufacturing friendly surface mount package. It is designed for AMPS band applications. The XC3500P-20S is designed particularly for power and frequency detection, as well as for VSWR monitoring, where tightly controlled coupling and low insertion loss is required. It can be used in high power applications up to 45 Watts.

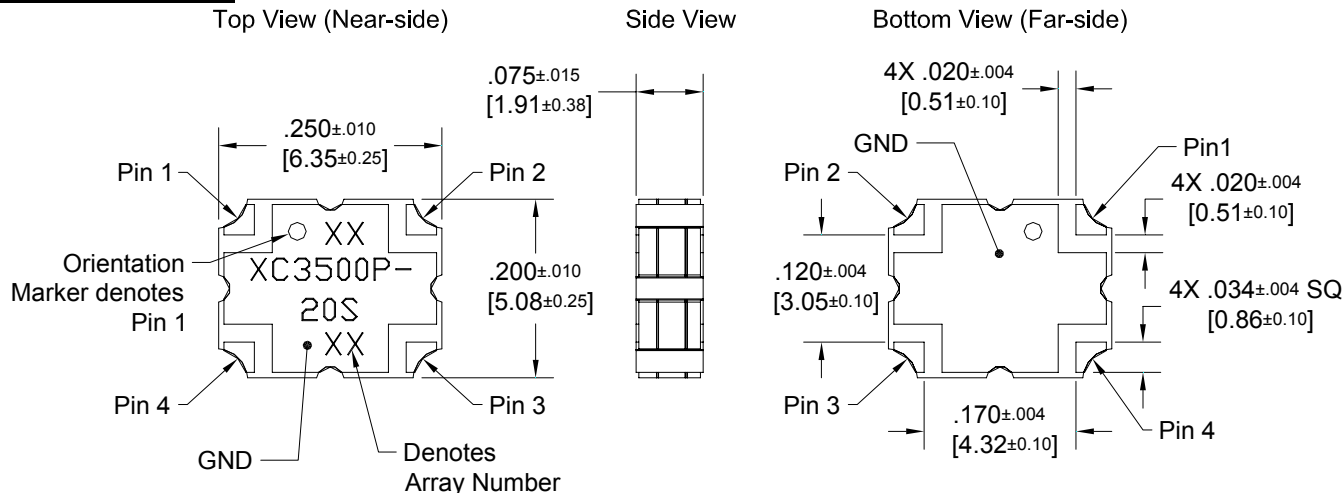
Parts have been subjected to rigorous qualification testing and they are manufactured using materials with coefficients of thermal expansion (CTE) compatible with common substrates such as FR4, G-10, RF-35, RO4003 and polyimide. Produced with 6 of 6 RoHS compliant tin immersion finish.

Electrical Specifications **

| Frequency | Mean Coupling | Insertion Loss | VSWR | Directivity |
|-----------------------|---------------|----------------|-----------------|-------------|
| MHz | dB | dB Max | Max : 1 | dB Min |
| 3300-3800 | 20±1.0 | 0.20 | 1.20 | 20 |
| Frequency Sensitivity | Power | ΘJC | Operating Temp. | |
| dB Max | Avg. CW Watts | °C/Watt | °C | |
| ±0.30 | 45 | 40.3 | -55 to +85 | |

**Specification based on performance of unit properly installed on Anaren Test Board 54147-0001. Refer to Specifications subject to change without notice. Refer to parameter definitions for details.

Mechanical Outline



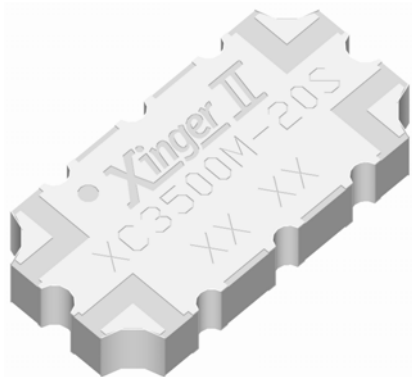
Dimensions are in Inches [Millimeters]
XC3500P-20S Mechanical Outline

Tolerances are Non-Cumulative



Xinger II

20dB Directional Coupler



Description

The XC3500M-20S is a low profile, high performance 20dB directional coupler in a new easy to use, manufacturing friendly surface mount package. It is designed for WiMAX applications. The XC3500M-20S is designed particularly for power and frequency detection, as well as for VSWR monitoring, where tightly controlled coupling and low insertion loss is required. It can be used in high power applications up to 80 Watts.

Parts have been subjected to rigorous qualification testing and they are manufactured using materials with coefficients of thermal expansion (CTE) compatible with common substrates such as FR4, G-10, RF-35, RO4003 and polyimide. Produced with 6 of 6 RoHS compliant tin immersion.

Features:

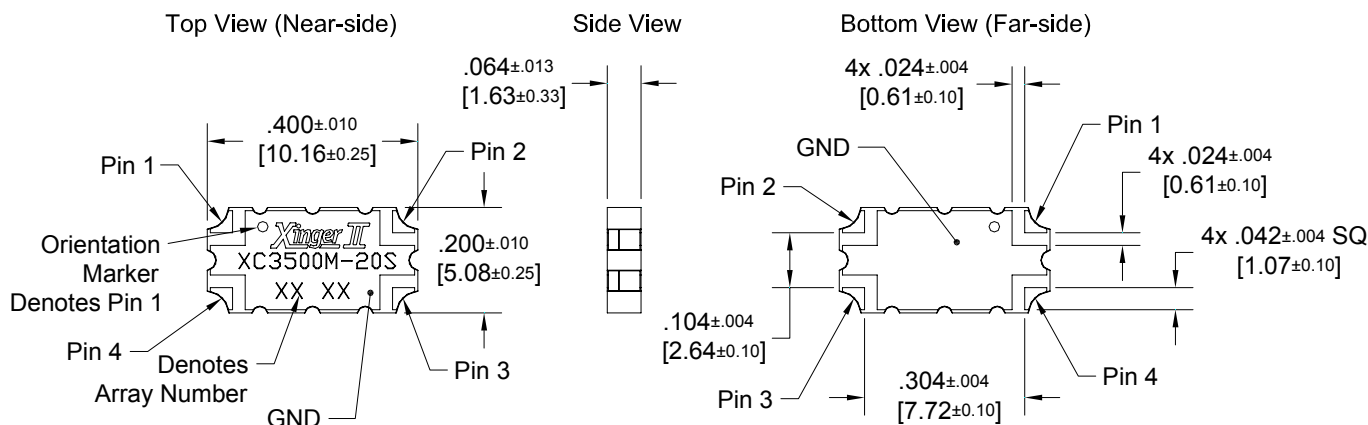
- 3300 - 3800 MHz
- WiMAX
- High Power
- Very Low Loss
- Tight Amplitude Balance
- High Isolation
- Production Friendly
- Tape and Reel
- Lead-Free

Electrical Specifications **

| Frequency | Mean Coupling | Insertion Loss | VSWR | Directivity |
|-----------------------|---------------|----------------|-----------------|-------------|
| MHz | dB | dB Max | Max : 1 | dB Min |
| 3300-3800 | 20 ±1.0 | 0.20 | 1.20 | 21 |
| Frequency Sensitivity | Power | ⊙JC | Operating Temp. | |
| dB Max | Avg. CW Watts | °C/Watt | °C | |
| ± 0.30 | 80 | 31.0 | -55 to +85 | |

**Specification based on performance of unit properly installed on Anaren Test Board 51991-0001 with small signal applied. Specifications subject to change without notice. Refer to parameter definitions for details.

Mechanical Outline



Dimensions are in Inches [Millimeters]
XC3500M-20S Mechanical Outline

Tolerances are Non-Cumulative





The 1M710 Micro Xinger® is a low profile, miniature 10dB directional coupler in an easy to use surface mount package designed for ISM and LMDS applications. The 1M710 is for power and frequency detection as well as power injection and is an ideal solution for the ever-increasing demands of the wireless industry for smaller printed circuit boards and high performance. Parts have been subjected to rigorous qualification testing and units are 100% tested. They are manufactured using materials with x and y thermal expansion coefficients compatible with common substrates such as FR4, G-10 and polyamide. Available in both 5 of 6 tin lead (1M710) and 6 of 6 RoHS compliant tin immersion (1M710S).

Features:

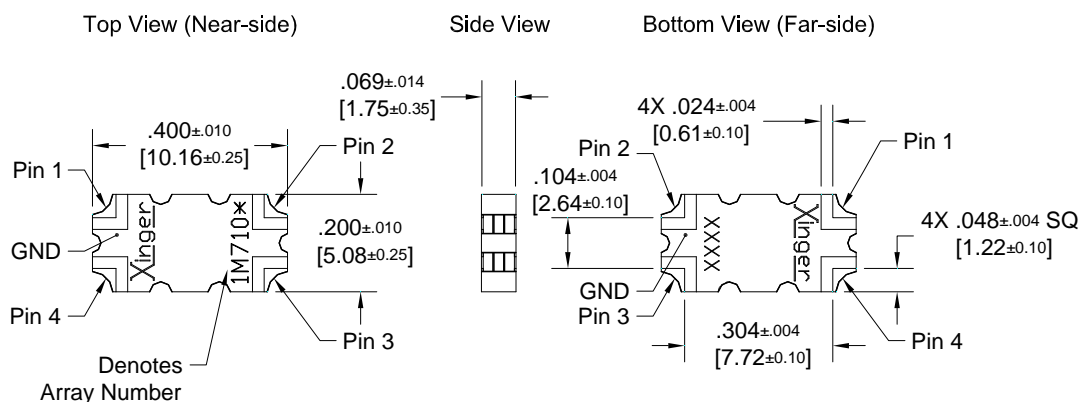
- **3.3 – 3.7 GHz**
- **Very Low Loss**
- **High Directivity**
- **Surface Mountable**
- **Tape And Reel**
- **Available in Lead-Free (as illustrated) or Tin-Lead**

ELECTRICAL SPECIFICATIONS**

| Frequency | Mean Coupling | Insertion Loss | VSWR | Freq. Sensitivity |
|-------------|----------------|----------------|-----------------|-------------------|
| GHz | dB | dB Max | Max : 1 | dB Max |
| 3.3 – 3.7 | 10.5 ± 0.8 | 0.25 | 1.20 | ± 0.2 |
| Directivity | Power Handling | ⊙JC | Operating Temp. | |
| dB Min | Watts | °C / Watt | °C | |
| 20 | 22 | 34.4 | -55 to +85 | |

**Specification based on performance of unit properly installed on microstrip printed circuit boards with 50 Ω nominal impedance. Specifications subject to change without notice.

Outline Drawing



Dimensions are in Inches [Millimeters]
1M710* Rev A Mechanical Outline

*For RoHS Compliant Versions order with S suffix
Tolerances are Non-Cumulative

Xinger®

Micro Xinger 10dB Directional Coupler



Description

The 1M810 Micro Xinger® is a low profile, miniature 10dB directional coupler in an easy to use surface mount package designed for U-NII, ISM and hyperLAN applications. The 1M810 is for power and frequency detection as well as power injection and is an ideal solution for the ever-increasing demands of the wireless industry for smaller printed circuit boards and high performance. Parts have been subjected to rigorous qualification testing and units are 100% tested. They are manufactured using materials with x and y thermal expansion coefficients compatible with common substrates such as FR4, G-10 and polyamide. Available in both 5 of 6 tin lead (1M810) and 6 of 6 RoHS compliant tin immersion (1M810S).

Features:

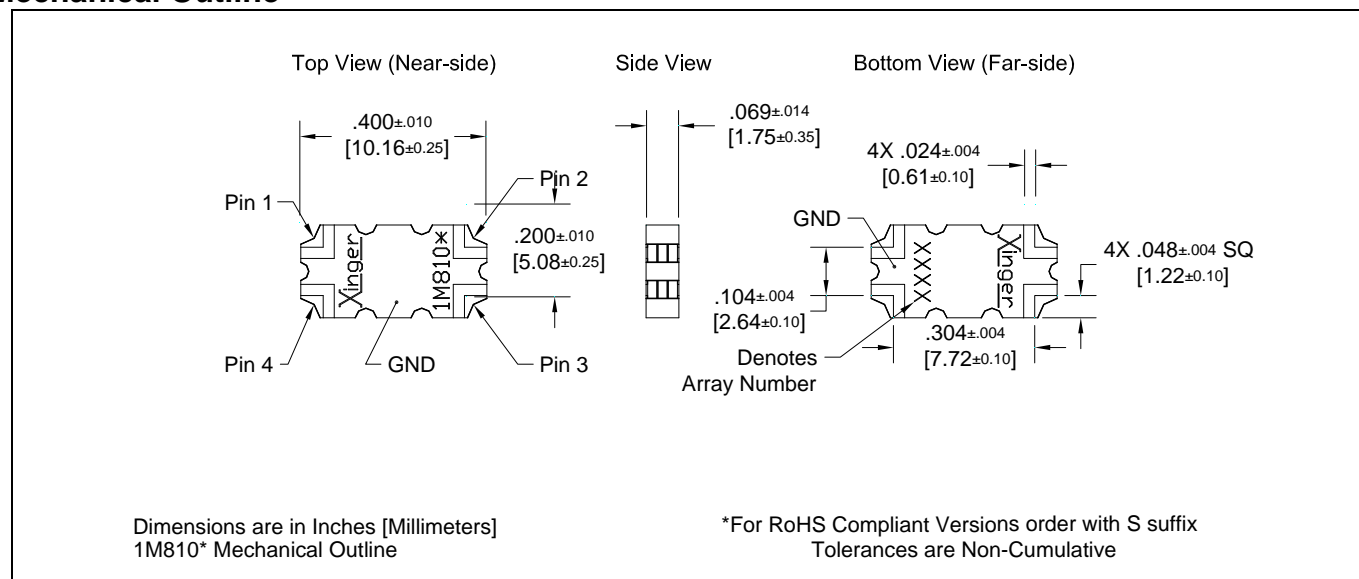
- 5.0 – 6.0 GHz
- Very Low Loss
- High Directivity
- Surface Mountable
- Tape And Reel
- Available in Lead-Free (as illustrated) or Tin-Lead

ELECTRICAL SPECIFICATIONS**

| Frequency | Mean Coupling | Insertion Loss | VSWR | Freq. Sensitivity |
|-------------|----------------|----------------|-----------------|-------------------|
| GHz | dB | dB Max | Max : 1 | dB Max |
| 5.0 – 6.0 | 10.0 ± .75 | 0.30 | 1.33 | ± .30 |
| Directivity | Power Handling | ⊙JC | Operating Temp. | |
| dB Min | Watts | °C / Watt | °C | |
| 18 | 15 | 23.8 | -55 to +85 | |

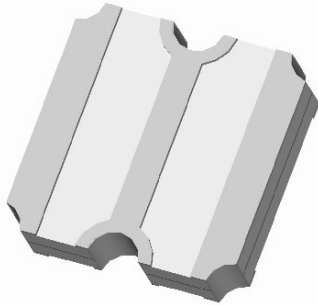
**Specification based on performance of unit properly installed on microstrip printed circuit boards with 50 Ω nominal impedance. Specifications subject to change without notice.

Mechanical Outline



Xinger®

SMT Crossover



Description

The X2A is a low profile crossover to intersect an RF and DC circuit trace in an easy to use surface mount package designed for frequencies up to 6 GHz. The X2A is ideal for any application where an RF circuit must intersect with a DC circuit without resorting to a multilayer PCB. Parts have been subjected to rigorous qualification testing and units are 100% tested. They are manufactured using materials with x and y thermal expansion coefficients compatible with common substrates such as FR4, G-10 and polyamide.

Features:

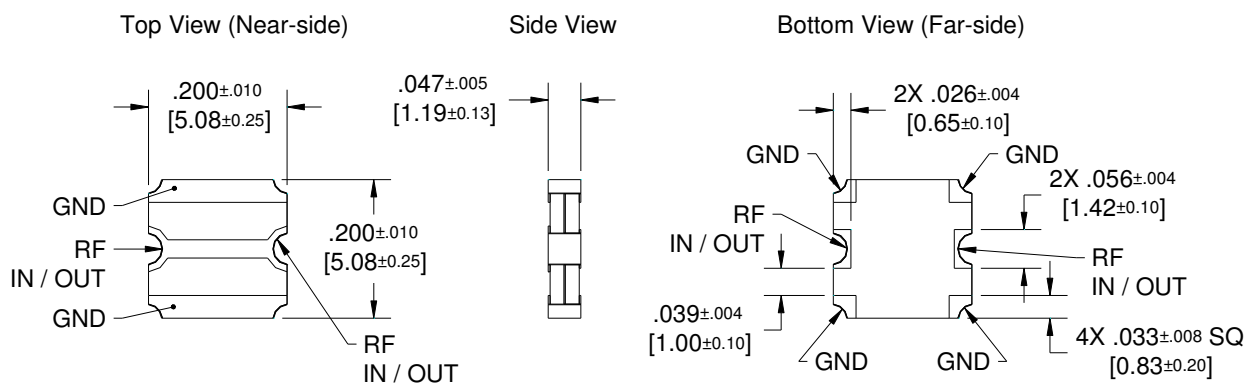
- DC – 6.0 GHz
- RF – DC Crossover
- Low Loss
- DC Isolation
- Surface Mountable
- Tape And Reel
- Convenient Package
- 100 % Tested

ELECTRICAL SPECIFICATIONS**

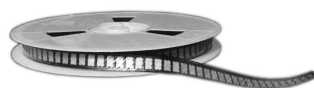
| Frequency | Port Impedance | Return Loss | Operating Temp. °C |
|----------------|----------------|-------------|-----------------------|
| GHz | Ohms | dB Min | |
| DC – 2.5 | 50 | 20 | |
| 2.5 – 4.0 | 50 | 20 | |
| 4.0 – 6.0 | 50 | 15 | |
| Insertion Loss | Power | θJC | °C / Watt |
| dB Max | Watts | | |
| 0.05 | 30 | 250.9 | |
| 0.10 | 15 | 250.9 | |
| 0.15 | 10 | 250.9 | -55 to +85 |

**Specification based on performance of unit properly installed on microstrip printed circuit boards with 50 Ω nominal impedance. Specifications subject to change without notice.

Outline Drawing

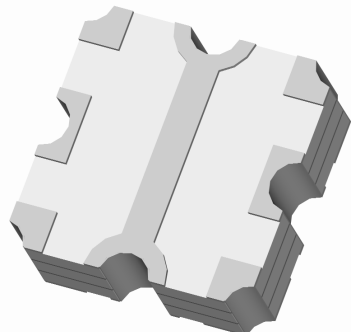


Dimensions are in Inches [Millimeters]
X2A Mechanical Outline



Xinger®

SMT Crossover



Description

The X2B is a low profile crossover to intersect an RF and RF circuit trace in an easy to use surface mount package designed for frequencies up to 6 GHz. The X2B is ideal for any application where an RF circuit must intersect with another RF circuit without resorting to a multilayer PCB. Parts have been run through rigorous qualification testing and units are 100% tested. They are manufactured using materials with x and y thermal expansion coefficients compatible with common substrates such as FR4, G-10 and polyamide.

Features:

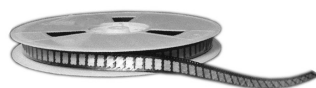
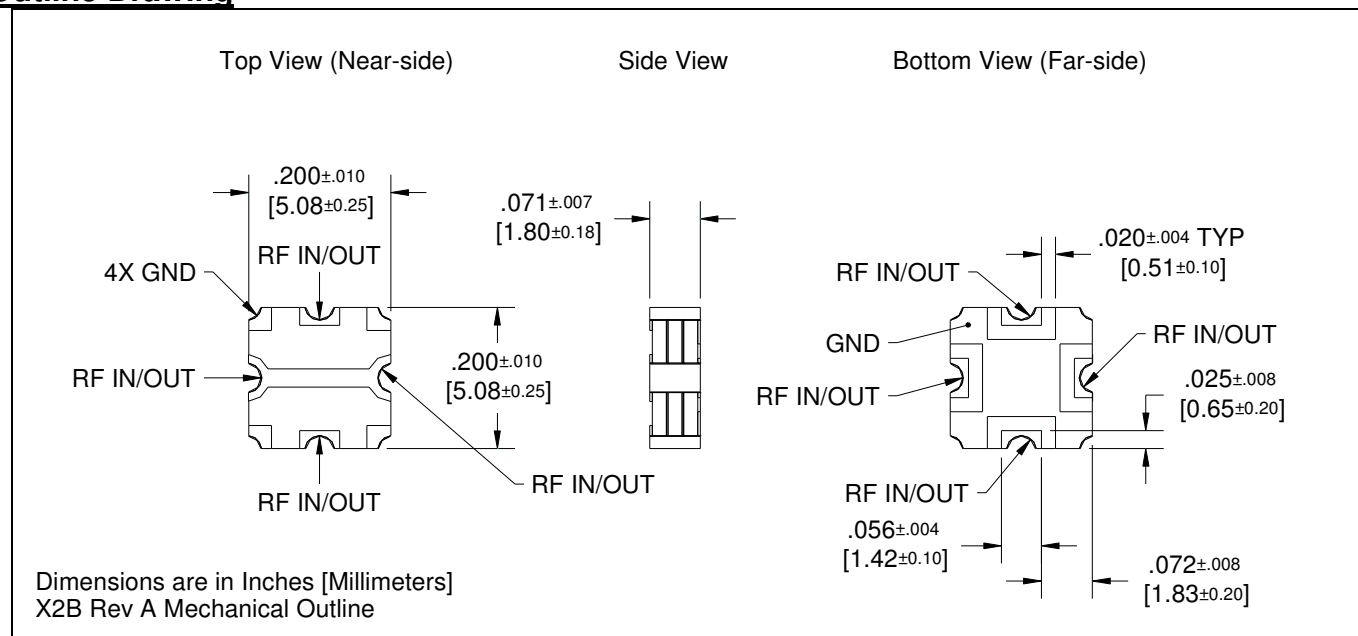
- DC – 6.0 GHz
- RF – RF Crossover
- Low Loss
- High Isolation
- Surface Mountable
- Tape And Reel
- Convenient Package
- 100% Tested

ELECTRICAL SPECIFICATIONS**

| Frequency | Port Impedance | Return Loss | Isolation |
|----------------|----------------|-------------|-----------------|
| GHz | Ohms | dB Min | DB Min |
| DC – 2.5 | 50 | 20 | 50 |
| 2.5 – 3.6 | 50 | 18 | 30 |
| 3.6 – 6.0 | 50 | 15 | 20 |
| Insertion Loss | Power | θJC | Operating Temp. |
| dB Max | Watts | °C / Watt | °C |
| 0.05 | 30 | 143.4 | -55 to +85 |
| 0.10 | 15 | 143.4 | -55 to +85 |
| 0.20 | 10 | 143.4 | -55 to +85 |

**Specification based on performance of unit properly installed on microstrip printed circuit boards with 50 Ω nominal impedance. Specifications subject to change without notice.

Outline Drawing



Xinger®

Balun Transformers

Description

The 3A325 is a low profile balanced to unbalanced transformer in an easy to use surface mount package covering TV broadcast applications. The 3A325 has an unbalanced port impedance of 50Ω and balanced port impedances of 25Ω to ground with 50Ω balance between outputs. This eases the matching of the push-pull amplifier's power transistors which have low impedance levels. The output ports have equal amplitude (-3dB) with 180° phase differential.



Features

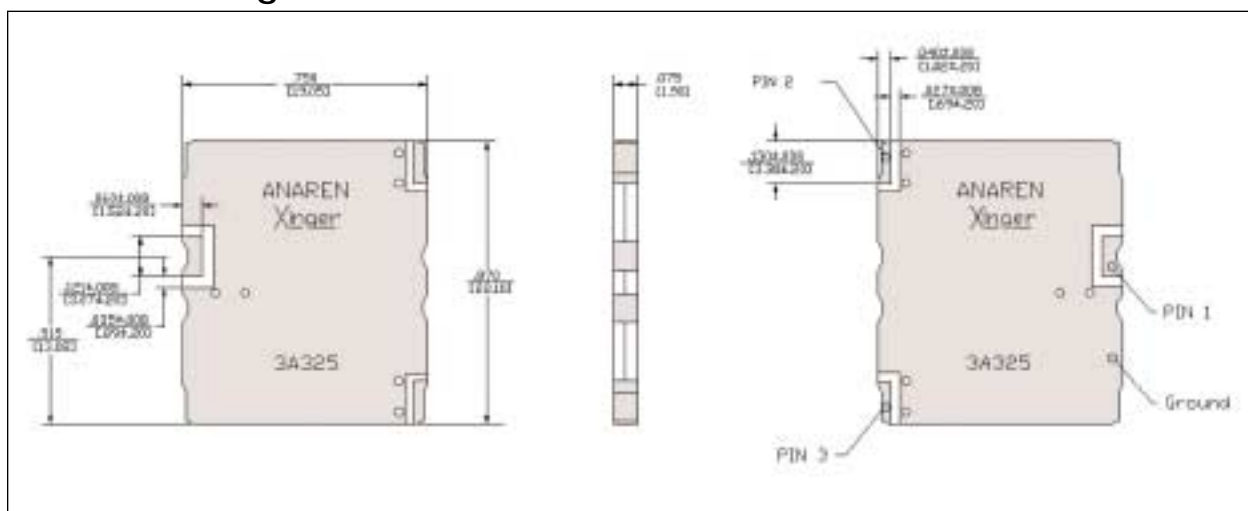
- 470 - 860 MHz
- 25Ω Balanced Port Impedance
- Low Insertion Loss
- High Power
- Input to Output DC Isolation
- Surface Mountable
- Tape And Reel
- Convenient Package

Electrical Specifications

| Frequency MHz | Port Impedance Unbalanced | Port Impedance Balanced to Ground |
|--------------------------|----------------------------------|--------------------------------------|
| 470 - 860 | 50Ω | 25Ω |
| Return Loss dB Min | Amplitude Bal. dB (p-p) | Phase Balance degrees |
| 10 | 0.40 | 180 ± 5.0 |
| Insertion Loss dB Max | Θ _{JC} °C/diss. Watt | Power Watts Ave/CW |
| 0.35 | 4.4 | 275 |

Specifications subject to change without notice.

Outline Drawing

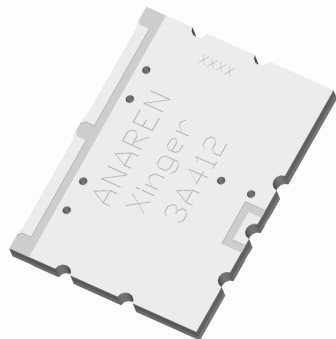


Available on Tape and Reel for Pick and Place Manufacturing.

Sales Desk USA: Voice: (800) 544-2414 Fax: (315) 432-9121
Sales Desk Europe: Voice: (+44) 23 92 232392 Fax: (+44) 23 92 251369

Xinger®

Balun Transformers 50Ω to 12.5Ω Balanced



Description

The 3A412 is a low profile balanced to unbalanced transformer designed for push-pull amplifiers in an easy to use surface mount package for AMPS and GSM. These compact Xinger® surface mount baluns are ideal for high volume manufacturing and are more reliable and repeatable than traditional baluns. The 3A412 has an unbalanced port impedance of 50Ω and balanced port impedances of 12.5Ω to ground with a 25Ω balance between outputs. This eases the matching of the push-pull amplifier's power transistors, which have low impedance levels. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The Xinger® balun is a result of years of research and development culminating with a solution so unique, a patent is pending on the design approach. The 3A412 is available on tape and reel for pick and place high volume manufacturing.

Features:

- 800 – 1000 MHz
- 180° Transformer
- 50 Ohm to 2 x 12.5+j Ohm
- Low Insertion Loss
- High Power
- Even Order Suppression
- Input to Output DC Isolation
- Surface Mountable
- Tape & Reel
- Convenient Package

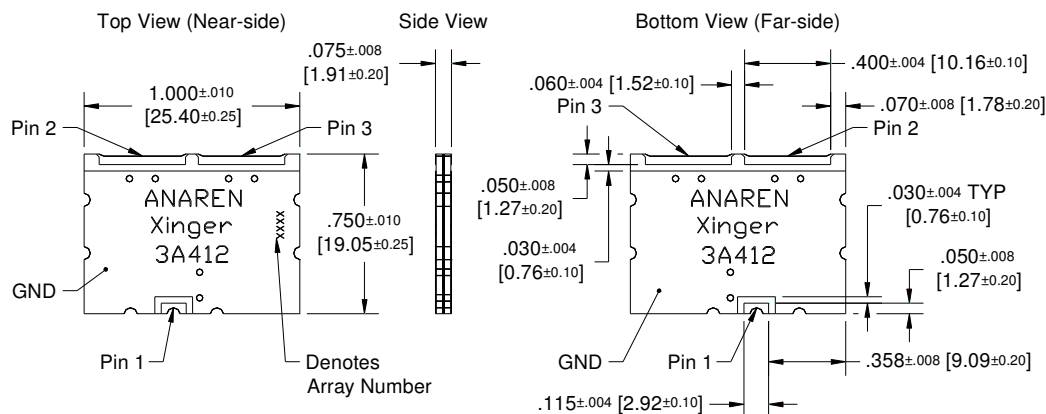
ELECTRICAL SPECIFICATIONS***

| Frequency | Unbalanced Port Impedance | Balanced Port Impedance* | Return Loss | Insertion Loss |
|-------------------|---------------------------|--------------------------|-------------|-----------------|
| MHz | Ohms | Ohms | dB min | dB max |
| 800-1000 | 50 | 12.5+j | 15 | 0.48 |
| 869-894 | 50 | 12.5+j | 15 | 0.35 |
| 925-960 | 50 | 12.5+j | 15 | 0.40 |
| Amplitude Balance | Phase Balance | Power Handling | θJC | Operating Temp. |
| dB max | Degrees max | Watts | °C / Watt | °C |
| 0.40 | 180± 5.0 | 250 | 3.8 | -55 to +85 |
| 0.40 | 180± 5.0 | 250 | 3.8 | -55 to +85 |
| 0.40 | 180± 5.0 | 250 | 3.8 | -55 to +85 |

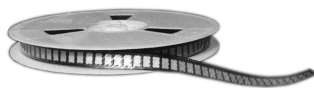
***Specification based on performance of unit properly installed on microstrip printed circuit boards with 50 Ω nominal impedance. Specifications subject to change without notice.

**Insertion Loss excludes reflected power. * 12.5Ω reference to ground

Outline Drawing

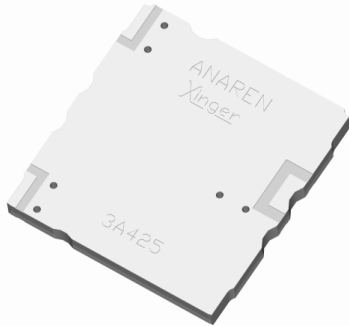


Dimensions are in Inches [Millimeters]
3A412 Rev A Mechanical Outline



Xinger®

Xinger Balun 50Ω to 25Ω Balanced



Description

The 3A425 is a low profile balanced to unbalanced transformer designed for push-pull amplifiers in an easy to use surface mount package covering GSM, D-AMPS and NMT900 applications. These compact Xinger® surface mount baluns are ideal for high volume manufacturing and are more reliable and repeatable than traditional baluns. The 3A425 has an unbalanced port impedance of 50Ω and balanced port impedances of 25Ω to ground with a 50Ω balance between outputs. This eases the matching of the push-pull amplifier's power transistors, which have low impedance levels. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The Xinger® balun is a result of years of research and development culminating with a solution so unique, a patent is pending on the design approach. The 3A425 is available on tape and reel for pick and place high volume manufacturing.

Features:

- 800 – 1000 MHz
- 180° Transformer
- 50 Ohm to 25 Ohm
- Broad Band
- Low Insertion Loss
- High Power
- Even Order Harmonic Suppression
- Input to Output DC Isolation
- Surface Mountable
- Tape & Reel
- Convenient Package

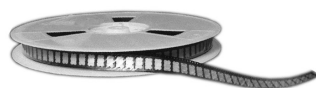
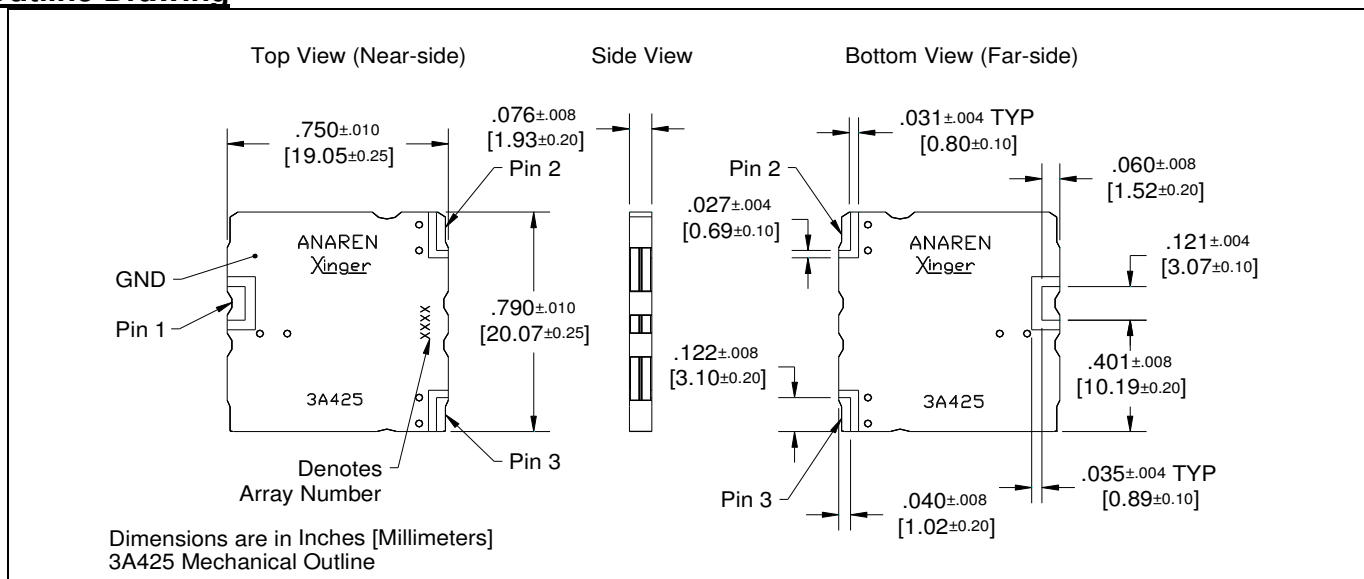
ELECTRICAL SPECIFICATIONS***

| Frequency | Unbalanced Port Impedance | Balanced Port Impedance* | Return Loss | Insertion Loss** |
|-------------------|---------------------------|--------------------------|-------------|------------------|
| MHz | Ohms | Ohms | dB min | dB max |
| 800 - 1000 | 50 | 50 | 15 | 0.35 |
| Amplitude Balance | Phase Balance | Power Handling | θJC | Operating Temp. |
| dB max | Degrees max | Watts | °C / Watt | °C |
| 0.4 | 180± 5.0 | 250 | 5.3 | -55 to +85 |

***Specification based on performance of unit properly installed on microstrip printed circuit boards with 50 Ω nominal impedance. Specifications subject to change without notice.

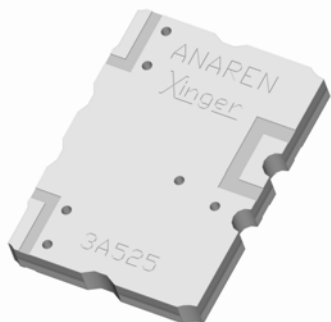
**Insertion Loss excludes reflected power. * 25Ω reference to ground

Outline Drawing



Xinger®

Balun Transformers 50Ω to 25Ω Balanced



Description

The 3A525 is a low profile balanced to unbalanced transformer in an easy to use surface mount package covering Japanese PDC, DCS and PCS receive push-pull amplifier and mixer applications. The 3A525 has an unbalanced impedance of 50Ω and a balanced port impedances of 25Ω to ground with 50Ω balance between outputs. This eases the matching of the push-pull amplifier's power transistors which have low impedance levels. The output ports have equal amplitude (-3 dB) with 180° phase differential. The 3A525 is available on tape and reel for pick and place high volume manufacturing.

Features:

- 1.5 – 1.9 GHz
- 180° Transformer
- 50 Ohm to 2 x 25 Ohm
- Low Insertion Loss
- High Power
- Input to Output DC Isolation
- Surface Mountable
- Tape & Reel
- Convenient Package

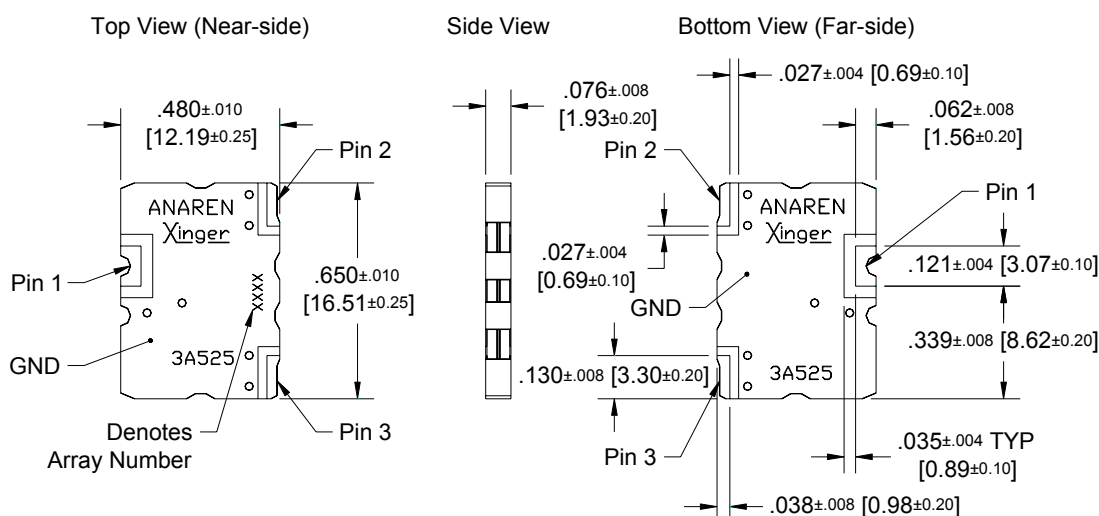
ELECTRICAL SPECIFICATIONS***

| Frequency | Unbalanced Port Impedance | Balanced Port Impedance* | Return Loss | Insertion Loss** |
|-------------------|---------------------------|--------------------------|-------------|------------------|
| GHz | Ohms | Ohms | dB min | dB max |
| 1.5 – 1.9 | 50 | 25 | 15 | 0.35 |
| Amplitude Balance | Phase Balance | Power Handling | ⊙JC | Operating Temp. |
| dB max | Degrees max | Watts | °C / Watt | °C |
| 0.40 | 180± 5.0 | 150 | 7.2 | -55 to +85 |

***Specification based on performance of unit properly installed on microstrip printed circuit boards with 50 Ω nominal impedance. Specifications subject to change without notice.

**Insertion Loss excludes reflected power. * 25Ω reference to ground

Outline Drawing



Balun Transformers

Description

The 3A625 is a low profile balanced to unbalanced transformer in an easy to use surface mount package covering W-LAN and MMDS push-pull amplifier applications. The 3A625 has an unbalanced impedance of 50Ω and balanced port impedances of 25Ω to ground with 50Ω balance between outputs. This eases the matching of the push-pull amplifier's power transistors which have low impedance levels. The output ports have equal amplitude (-3dB) with 180° phase differential.



Features

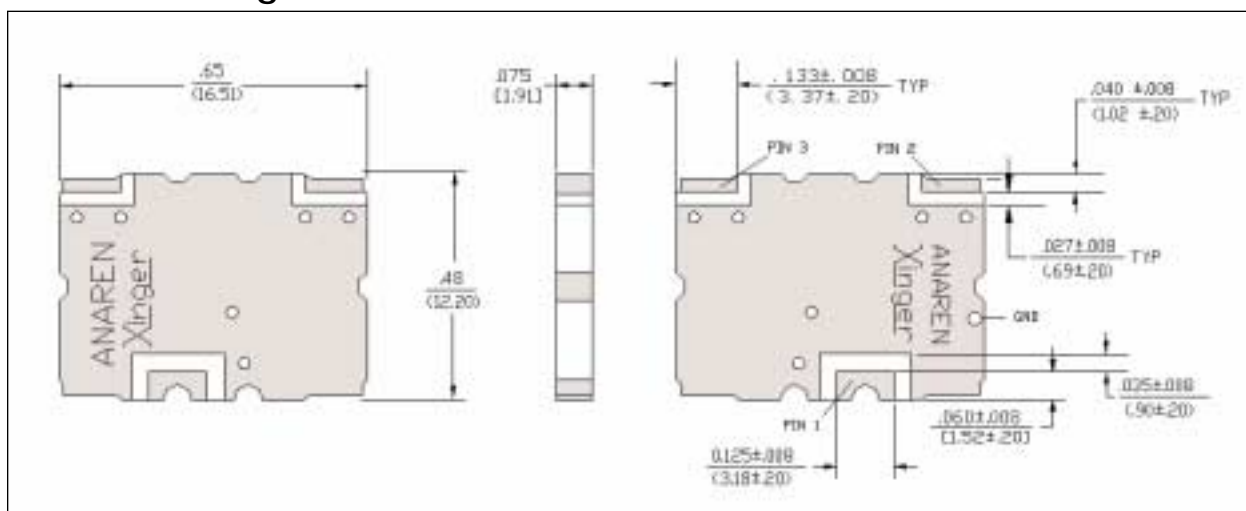
- 2.3 - 2.7 GHz
- Low Insertion Loss
- High Power
- Even Order Suppression
- Input to Output DC Isolation
- Surface Mountable
- Tape And Reel
- Convenient Package

Electrical Specifications

| Frequency GHz | Port Impedance Unbalanced | Port Impedance Balanced to Ground |
|--------------------------|----------------------------------|--------------------------------------|
| 2.3 - 2.7 | 50Ω | 25Ω |
| Return Loss dB Min | Amplitude Bal. dB (p-p) | Phase Balance degrees |
| 15 | 0.40 | 180 ± 5.0 |
| Insertion Loss dB Max | Θ _{JC} °C/diss. Watt | Power Watts Ave/CW |
| 0.35 | 15.8 | 150 |

Specifications subject to change without notice.

Outline Drawing

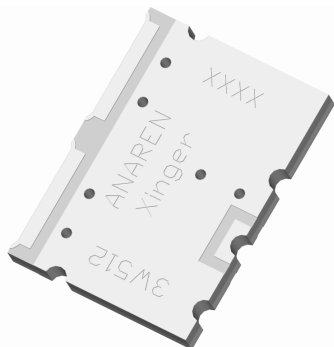


Available on Tape and Reel for Pick and Place Manufacturing.

Sales Desk USA: Voice: (800) 544-2414 Fax: (315) 432-9121
Sales Desk Europe: Voice: (+44) 23 92 232392 Fax: (+44) 23 92 251369

Xinger®

Balun 50Ω to 12.5Ω Balanced



Description

The 3W512 is a low profile balanced to unbalanced transformer designed for push-pull amplifiers in an easy to use surface mount package for PCS, DCS, and UMTS. These compact Xinger® surface mount baluns are ideal for high volume manufacturing and are more reliable and repeatable than traditional baluns. The 3W512 has an unbalanced port impedance of 50Ω and balanced port impedances of 12.5Ω to ground with a 25Ω balance between outputs. This eases the matching of the push-pull amplifier's power transistors, which have low impedance levels. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The Xinger® balun is a result of years of research and development culminating with a solution so unique, a patent is pending on the design approach. The 3W512 is available on tape and reel for pick and place high volume manufacturing.

Features:

- 1.8 – 2.2 GHz
- 180° Transformer
- 50 Ohm to 12.5+j5.5 Ohm
- Broad Band
- Low Insertion Loss
- High Power
- Even Order Suppression
- Input to Output DC Isolation
- Surface Mountable
- Tape & Reel
- Convenient Package

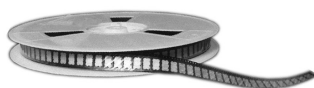
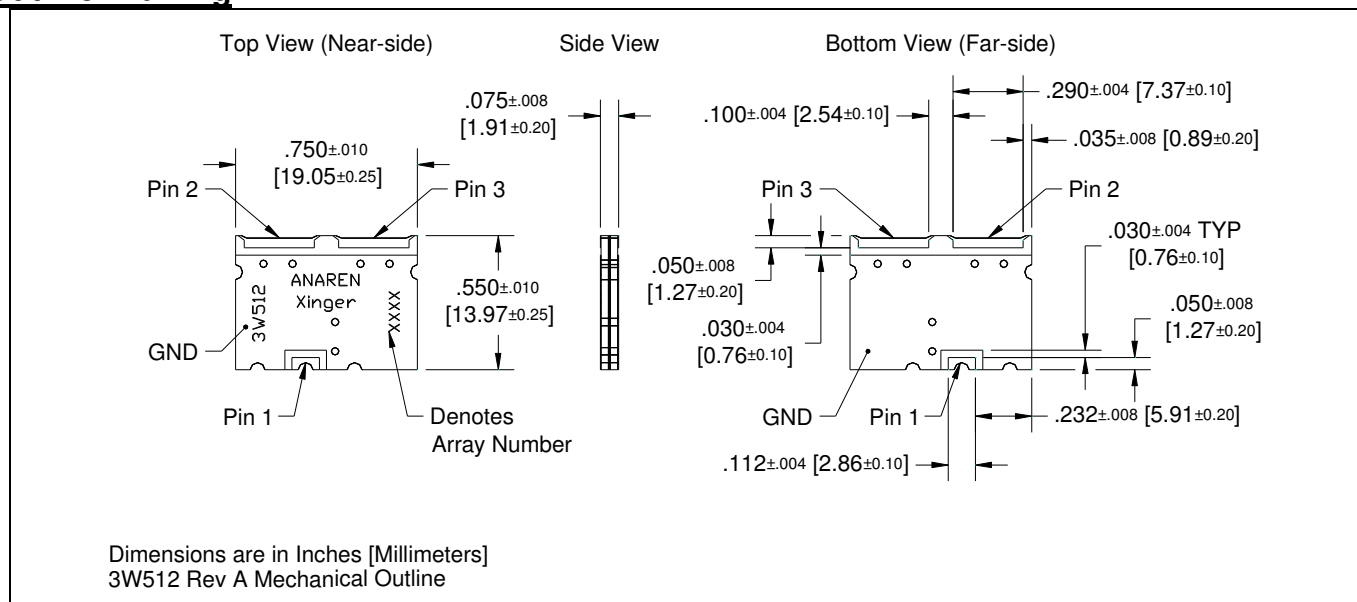
ELECTRICAL SPECIFICATIONS***

| Frequency | Unbalanced Port Impedance | Balanced Port Impedance* | Return Loss | Insertion Loss** |
|-------------------|---------------------------|--------------------------|-------------|------------------|
| GHz | Ohms | Ohms | dB Min | dB max |
| 1.8 – 2.2 | 50 | 12.5+j5.5 | 15 | 0.40 |
| Amplitude Balance | Phase Balance | Power Handling | ⊙JC | Operating Temp. |
| dB max | Degrees max | Watts | °C / Watt | °C |
| 0.40 | 180± 5.0 | 150 | 11.3 | -55 to +85 |

**Specification based on performance of unit properly installed on microstrip printed circuit boards with 50 Ω nominal impedance. Specifications subject to change without notice.

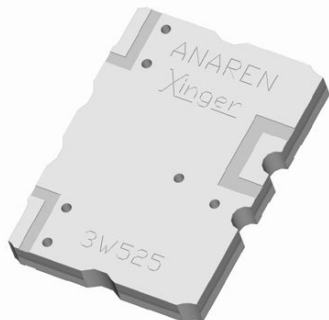
* 50Ω reference to ground

Outline Drawing



Xinger®

Balun Transformers 50Ω to 25Ω Balanced



Description

The 3W525 is a low profile balanced to unbalanced transformer designed for push-pull amplifiers in an easy to use surface mount package for PCS and DCS applications. These compact Xinger® surface mount baluns are ideal for high volume manufacturing and are more reliable and repeatable than traditional baluns. The 3W525 has an unbalanced port impedance of 50Ω and balanced port impedances of 25Ω to ground with a 50Ω balance between outputs. This eases the matching of the push-pull amplifier's power transistors, which have low impedance levels. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The Xinger® balun is a result of years of research and development culminating with a solution so unique, a patent is pending on the design approach. The 3W525 is available on tape and reel for pick and place high volume manufacturing.

Features:

- 1.8 – 2.5 GHz
- 180° Transformer
- 50 Ohm to 2 x 25 Ohm
- Low Insertion Loss
- High Power
- Even Order Suppression
- Input to Output DC Isolation
- Surface Mountable
- Tape & Reel
- Convenient Package

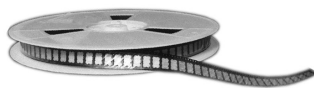
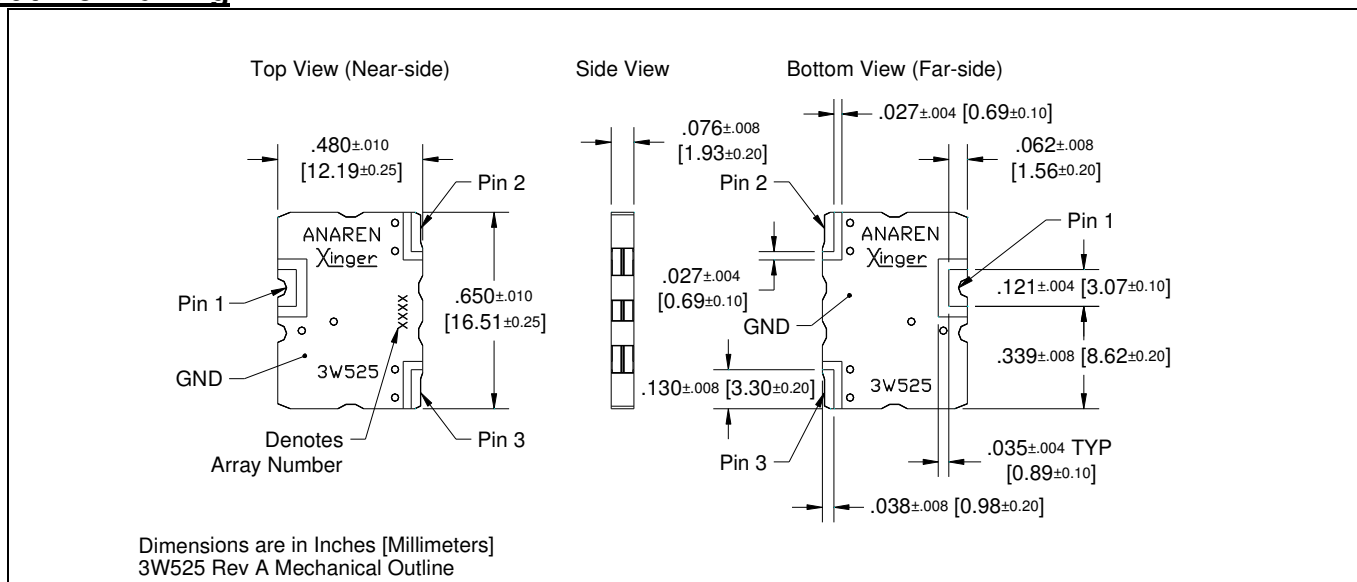
ELECTRICAL SPECIFICATIONS***

| Frequency | Unbalanced Port Impedance | Balanced Port Impedance* | Return Loss | Insertion Loss** |
|-------------------|---------------------------|--------------------------|-------------|------------------|
| GHz | Ohms | Ohms | dB min | dB max |
| 1.8 – 2.5 | 50 | 25 | 15 | 0.38 |
| 1.805-2.170 | 50 | 25 | 15 | 0.35 |
| Amplitude Balance | Phase Balance | Power Handling | θJC | Operating Temp. |
| dB max | Degrees max | Watts | °C / Watt | °C |
| 0.40 | 180± 5.0 | 150 | 11.3 | -55 to +85 |
| 0.40 | 180± 5.0 | 150 | 11.3 | -55 to +85 |

***Specification based on performance of unit properly installed on microstrip printed circuit boards with 50 Ω nominal impedance. Specifications subject to change without notice.

**Insertion Loss excludes reflected power. * 25Ω reference to ground

Outline Drawing



Consumer Components Selection Matrix

| .080 x .050 (2mm x 1.25mm) Surface Mount Balun Transformers | | | | | | | |
|---|-----------------|--|--------------------------------------|---------------------|------------------------|-------------------|--------------------|
| Model Number | Frequency [MHz] | Unbalanced Port Impedance [Ω] | Balanced Port Impedance [Ω] | Insertion Loss [dB] | Amplitude Balance [dB] | Phase Balance [°] | RL Unbalanced [dB] |
| B0225J7575A00 | 200 - 2500 | 75 | 75 | 1.10 | 3.20 | 40 | 14 |
| B0310J50100A00 | 330 - 1000 | 50 | 100 | 2.00 | 1.50 | 25 | 8.7 |
| B0922J7575A00 | 900 - 2200 | 75 | 75 | 1.20 | 1.40 | 9 | 7.9 |
| B0922J7575A50 | 900 - 2200 | 75 | 75 | 1.10 | 1.40 | 9 | 12 |
| BD0810J50100A00 | 800 - 1000 | 50 | 100 | 0.95 | 0.40 | 2 | 13 |
| BD0810J50150A00 | 800 - 1000 | 50 | 150 | 1.10 | 0.60 | 6 | 13.3 |
| BD0810J50200A00 | 800 - 1000 | 50 | 200 | 1.00 | 1.10 | 8 | 14.5 |
| BD0826J50200A00 | 800 - 2600 | 50 | 200 | 1.50 | 1.30 | 7 | 8.5 |
| BD1222J50200A00 | 1200 - 2200 | 50 | 200 | 0.60 | 0.90 | 6 | 14 |
| BD1631J50100A00 | 1600 - 3100 | 50 | 100 | 1.00 | 1.00 | 5 | 10 |
| BD2130J5050A00 | 2100 - 3000 | 50 | 50 | 1.20 | 1.00 | 5 | 10 |
| BD1722J50100A00 | 1700 - 2200 | 50 | 100 | 1.20 | 1.20 | 6 | 9 |
| BD1722J50150A00 | 1700 - 2200 | 50 | 150 | 0.70 | 1.00 | 7 | 18 |
| BD1722J50200A00 | 1700 - 2200 | 50 | 200 | 0.70 | 0.90 | 8 | 15 |
| BD2425J5050A00 | 2400 - 2500 | 50 | 50 | 0.90 | 0.50 | 5 | 14 |
| BD2425J50100A00 | 2400 - 2500 | 50 | 100 | 0.75 | 0.50 | 5 | 14 |
| BD2425J50200A00 | 2400 - 2500 | 50 | 200 | 0.80 | 0.50 | 6 | 9.5 |
| BD2425J50350A00 | 2400 - 2500 | 50 | 350 | 1.30 | 0.60 | 10 | 10 |
| BD2040J50100A00 | 2000 - 4000 | 50 | 100 | 1.00 | 1.10 | 17 | 10.5 |

| .060 x .030 (1.5mm x .8mm) Surface Mount Balun Transformers | | | | | | | |
|---|-----------------|--|--------------------------------------|---------------------|------------------------|-------------------|--------------------|
| Model Number | Frequency [MHz] | Unbalanced Port Impedance [Ω] | Balanced Port Impedance [Ω] | Insertion Loss [dB] | Amplitude Balance [dB] | Phase Balance [°] | RL Unbalanced [dB] |
| BD2326L50150A00 | 2300 - 2600 | 50 | 150 | 1.10 | 1.00 | 10 | 12 |
| BD2326L50200A00 | 2300 - 2600 | 50 | 200 | 1.10 | 0.80 | 9 | 12 |
| BD3150L50100A00 | 3100 - 5000 | 50 | 100 | 1.10 | 0.90 | 9 | 9.5 |
| BD3150L50200A00 | 3100 - 5000 | 50 | 200 | 1.20 | 1.30 | 11 | 11 |
| BD4859L5075A00 | 4800 - 5900 | 50 | 75 | 1.30 | 1.30 | 6 | 9 |
| BD4859L50100A00 | 4800 - 5900 | 50 | 100 | 1.10 | 1.10 | 8 | 9.2 |
| BD4859L50150A00 | 4800 - 5900 | 50 | 150 | 1.00 | 1.30 | 10 | 11 |
| BD4859L50200A00 | 4800 - 5900 | 50 | 200 | 1.40 | 1.40 | 10 | 8 |

| .040 x .040 (1mm x 1mm) Surface Mount Balun Transformers | | | | | | | |
|--|-----------------|--|--------------------------------------|---------------------|------------------------|-------------------|--------------------|
| Model Number | Frequency [MHz] | Unbalanced Port Impedance [Ω] | Balanced Port Impedance [Ω] | Insertion Loss [dB] | Amplitude Balance [dB] | Phase Balance [°] | RL Unbalanced [dB] |
| BD2425N5075A00 | 2400 - 2500 | 50 | 75 | 0.90 | 0.90 | 3 | 14 |
| BD2425N50100A00 | 2400 - 2500 | 50 | 100 | 0.70 | 0.60 | 3 | 18 |
| BD2425N50200A00 | 2400 - 2500 | 50 | 200 | 0.70 | 1.00 | 6 | 21 |
| BD2425P50100A00 | 2400 - 2500 | 50 | 100 | 0.60 | 0.90 | 6 | 16 |
| BD3150N50100A00 | 3100 - 5000 | 50 | 100 | 0.70 | 1.30 | 7 | 16 |
| BD4859N5050A00 | 4800 - 5900 | 50 | 50 | 0.70 | 1.20 | 7 | 16 |
| BD4859N5075A00 | 4800 - 5900 | 50 | 75 | 0.50 | 1.00 | 9 | 15 |
| BD4859N50100A00 | 4800 - 5900 | 50 | 100 | 0.60 | 1.50 | 8 | 15 |
| BD4859N50150A00 | 4800 - 5900 | 50 | 150 | 0.60 | 1.40 | 10 | 12 |
| BD4859N50200A00 | 4800 - 5900 | 50 | 200 | 0.50 | 0.80 | 9 | 18 |

| .10 x .08 (2.5mm x 2mm) Surface Mount Low Frequency Broadband Balun Transformer | | | | | | | |
|---|-----------------|--|--------------------------------------|---------------------|------------------------|-------------------|--------------------|
| Model Number | Frequency [MHz] | Unbalanced Port Impedance [Ω] | Balanced Port Impedance [Ω] | Insertion Loss [dB] | Amplitude Balance [dB] | Phase Balance [°] | RL Unbalanced [dB] |
| B0011E75300A00 | 50 - 1000 | 75 | 300 | 1.60 | 1.50 | 15 | 9 |

| .100 x .080 (2.5mm x 2mm) Surface Mount Filter Balun Transformer | | | | | | | |
|--|-----------------|--|--------------------------------------|---------------------|----------------------|-----------------------|---------|
| Model Number | Frequency [MHz] | Unbalanced Port Impedance [Ω] | Balanced Port Impedance [Ω] | Insertion Loss [dB] | Attenuation 930 MHz. | Attenuation 1910 MHz. | RL [dB] |
| FB2425E50100A00 | 2400 - 2500 | 50 | 100 | 2.60 | 45dB | 18dB | 9.5 |

Consumer Components Selection Matrix

| .080 x .050 (2mm x 1.25mm) Surface Mount 2 Way Power Splitters | | | | | | | | |
|--|-----------------|-----------------------------------|------------------------------------|---------------------|------------------------|-------------------|------------------|----------------|
| Model Number | Frequency [MHz] | Input Port Impedance [Ω] | Output Port Impedance [Ω] | Insertion Loss [dB] | Amplitude Balance [dB] | Phase Balance [°] | Return Loss [dB] | Isolation [dB] |
| PD0409J7575S2 | 400 - 900 | 75 | 75 | 0.60 | 0.60 | 3 | 10 | 8.2 |
| PD0810J5050S2 | 800 - 1000 | 50 | 50 | 0.60 | 0.80 | 4 | 14 | 17 |
| PD0922J5050D2 | 900 - 2200 | 50 | 50 | 0.70 | 0.40 | 3 | 9.3 | 10.5 |
| PD0922J5075D2 | 900 - 2200 | 50 | 75 | 0.70 | 0.30 | 3 | 11 | 12 |
| PD0922J7575D2 | 900 - 2200 | 75 | 75 | 1.00 | 0.70 | 3 | 9.5 | 14 |
| PD1722J5050D2 | 1700 - 2200 | 50 | 50 | 0.70 | 0.30 | 3 | 11 | 17 |
| PD2328J5050S2 | 2300 - 2800 | 50 | 50 | 0.50 | 0.30 | 2 | 15 | 17 |
| PD3150J5050S2 | 3100 - 5000 | 50 | 50 | 1.30 | 0.40 | 2 | 6.8 | 13 |
| PD4859J5050S2 | 4800 - 5900 | 50 | 50 | 1.00 | 0.30 | 4 | 7.9 | 14 |
| PD6080J5050S2 | 6000 - 8000 | 50 | 50 | 0.90 | 0.50 | 5 | 9 | 12 |

| .080 x .050 (2mm x 1.25mm) Surface Mount 3 Way Power Splitters | | | | | | | | |
|--|-----------------|-----------------------------------|------------------------------------|---------------------|------------------------|-------------------|------------------|----------------|
| Model Number | Frequency [MHz] | Input Port Impedance [Ω] | Output Port Impedance [Ω] | Insertion Loss [dB] | Amplitude Balance [dB] | Phase Balance [°] | Return Loss [dB] | Isolation [dB] |
| PD1722J5050S3 | 1700 - 2200 | 50 | 50 | 1.30 | 0.90 | 12 | 9 | 14 |

| .080 x .050 (2mm x 1.25mm) Surface Mount 3 dB Hybrid Couplers | | | | | | | |
|---|-----------------|---------------------|------------------|----------------|------------------------|-------------------|--|
| Model Number | Frequency [MHz] | Insertion Loss [dB] | Return Loss [dB] | Isolation [dB] | Amplitude Balance [dB] | Phase Balance [°] | |
| C0810J5003A00 | 800 - 1000 | 0.60 | 21 | 18 | 0.90 | 90 \pm 7 | |
| C1720J5003A00 | 1700 - 2000 | 0.40 | 21 | 24 | 1.00 | 90 \pm 5 | |
| C2023J5003A00 | 2000 - 2300 | 0.40 | 18 | 21 | 0.80 | 90 \pm 6 | |
| C2327J5003A00 | 2300 - 2700 | 0.40 | 15 | 18 | 0.90 | 90 \pm 8 | |
| C3337J5003A00 | 3300 - 3700 | 0.30 | 15 | 18 | 1.00 | 90 \pm 7 | |

| .060 x .030 (1.5mm x 0.8mm) Surface Mount RF Crossovers & Jumpers | | | | |
|---|-----------------|-----------------------------|---------------------|--------------------|
| Model Number | Frequency [MHz] | Port Impedance [Ω] | Insertion Loss [dB] | RL Unbalanced [dB] |
| X0060L5050A00 | 0 - 6000 | 50 | 0.15 | 16 |
| J0060L5050A00 | 0 - 6000 | 50 | 0.15 | 16 |
| X0060L7575A00 | 0 - 2500 | 75 | 0.15 | 19 |
| J0060L7575A00 | 0 - 2500 | 75 | 0.20 | 19 |

Nomenclature Chart

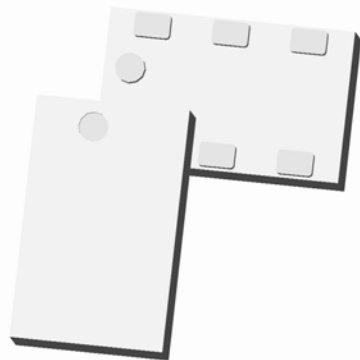
XX XXXX X - XX XXX X XX

| Function | Frequency (MHz) | Size (Inches) | Unbalanced Impedance | Balanced Impedance or Coupling | Plating Finish |
|----------------------------|--------------------|-------------------------|----------------------|--------------------------------|----------------|
| B = Balun | 0110 = 100 - 1000 | A = 0.15 x 0.15 | 50 = 50 Ohm | 25 = 25 Ohms Balanced | A = Gold |
| BD = Balun + DC | 0810 = 900 - 1000 | D = 0.32 x 0.34 | 75 = 75 Ohm | 30 = 30 Ohms Balanced | |
| C = Coupler | 0922 = 950 - 2150 | E = 0.10 x 0.08 | | 50 = 50 Ohms Balanced | |
| DD = Differential Diplexer | 0826 = 800 - 2600 | G = 0.20 x 0.16 | | 75 = 75 Ohms Balanced | |
| F = Filter | 1222 = 1200 - 2200 | H = 0.08 x 0.08 | | 100 = 100 Ohms Balanced | |
| FB = Filter Balun | 1416 = 1400 - 1600 | J = 0.08 x 0.05 | | 150 = 150 Ohms Balanced | |
| J = RF Jumper | 1722 = 1700 - 2200 | K = 0.06 x 0.06 | | 200 = 200 Ohms Balanced | |
| TF = Triple Filter | 2326 = 2300 - 2600 | L = 0.06 x 0.03 | | 300 = 300 Ohms Balanced | |
| X = RF Crossover | 2425 = 2400 - 2500 | M = 0.05 x 0.05 | | 400 = 400 Ohms Balanced | |
| | 3150 = 3100 - 5000 | N = 0.04 x 0.04 | | | |
| | 3436 = 3400 - 3600 | P = 0.04 x 0.04 x 0.018 | | 03 = 3 dB Hybrid | |
| | 4859 = 4800 - 5900 | R = 0.04 x 0.02 | | 10 = 10 dB Directional | |
| | 5153 = 5100 - 5300 | S = 0.04 x 0.06 | | 20 = 20 dB Directional | |
| | 5159 = 5100 - 5900 | T = 0.03 x 0.05 | | | |
| | 5759 = 5700 - 5900 | | | | |

Note: These tables are for reference only. Please review complete data sheet for actual specification data.

Xinger®

Ultra Low Profile 0805 Balun 75Ω to 75Ω Balanced



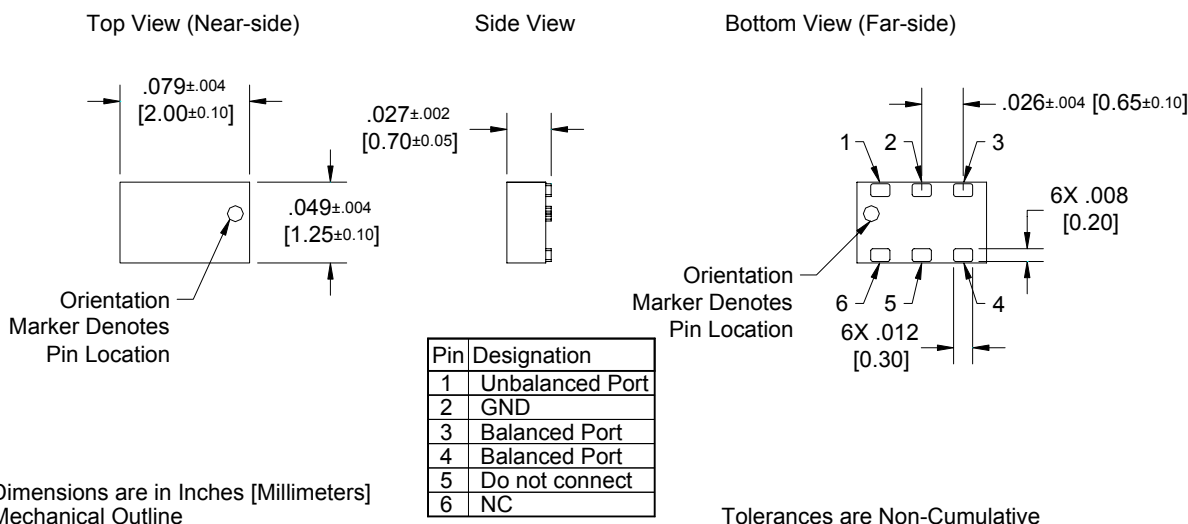
Description

The B0225J7575A00 is a low profile sub-miniature balanced to unbalanced transformer designed for differential inputs and output locations on next generation wireless chipsets in an easy to use surface mount package covering the DVB-T, DVB-C and DVB-S broadcast frequencies. The B0225J7575A00 is ideal for high volume manufacturing and is higher performance than traditional wire wound and lumped element baluns. The B0225J7575A00 has an unbalanced port impedance of 75Ω and a 75Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The B0225J7575A00 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

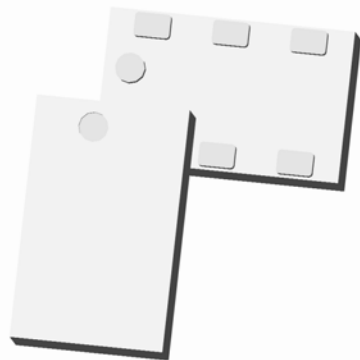
| Features: | Parameter | Broadband | | | Narrowband | | | 25°C Unit |
|--|---------------------------|-----------|-----|------|------------|-----|-----|-----------|
| | | Min | Typ | Max | Min | Typ | Max | |
| <ul style="list-style-type: none"> • 200 – 2500 MHz • 0.7mm Height Profile • 75 Ohm to 2 x 37.5 Ohm • DVB-T, DVB-C & DVB-S • Low Insertion Loss • Input to Output DC Isolation • Surface Mountable • Tape & Reel • Non-conductive Surface • RoHS Compliant | Frequency | 200 | | 2500 | 350 | | 550 | MHz |
| | Unbalanced Port Impedance | | 75 | | | 75 | | Ω |
| | Balanced Port Impedance | | 75 | | | 75 | | Ω |
| | Return Loss | 14 | 16 | | 17 | 20 | | dB |
| | Insertion Loss* | | 0.9 | 1.1 | | 0.4 | 0.5 | dB |
| | Amplitude Balance | | 3.0 | 3.2 | | 1.4 | 1.6 | dB |
| | Phase Balance | | 38 | 40 | | 24 | 26 | Degrees |
| | CMRR | | 8 | | | 13 | | dB |
| | Power Handling | | | 0.5 | | | 0.5 | Watts |
| | Operating Temperature | -55 | | +85 | -55 | | +85 | °C |

* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C) Outline Drawing



Xinger®

Ultra Low Profile 0805 Balun 50Ω to 100Ω Balanced



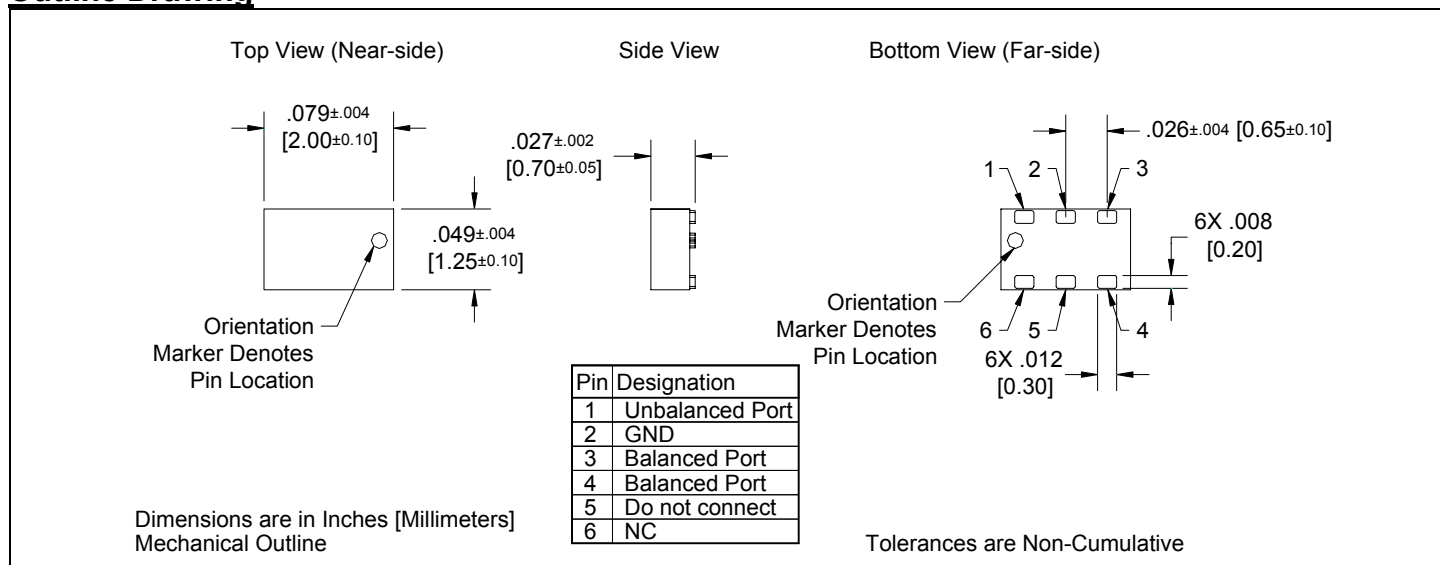
Description

The B0310J50100A00 is a low profile sub-miniature balanced to unbalanced transformer designed for differential inputs and output locations. The B0310J50100A00 is ideal for high volume manufacturing and is higher performance than traditional ceramic and lumped element baluns. The B0310J50100A00 has an unbalanced port impedance of 50Ω and a 100Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern semiconductors. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The B0310J50100A00 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

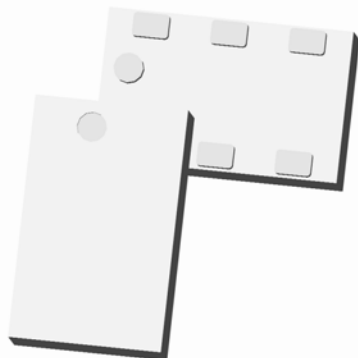
| Features: | Parameter | Broadband | | | Narrowband | | | 25°C |
|--|---------------------------|-----------|-----|------|------------|------|-----|---------|
| | | Min | Typ | Max | Min | Typ | Max | |
| <ul style="list-style-type: none"> 300 – 1000 MHz 0.7mm Height Profile 50 Ohm to 2 x 50 Ohm Low Insertion Loss Surface Mountable Tape & Reel Non-conductive Surface RoHS Compliant | Frequency | 330 | | 1000 | 460 | | 470 | MHz |
| | Unbalanced Port Impedance | | 50 | | | 50 | | Ω |
| | Balanced Port Impedance | | 100 | | | 100 | | Ω |
| | Return Loss | 8.7 | 10 | | 10 | 11.5 | | dB |
| | Insertion Loss* | | 1.0 | 2.0 | | 0.8 | 0.9 | dB |
| | Amplitude Balance | | 1.3 | 1.5 | | 0.8 | 0.9 | dB |
| | Phase Balance | | 23 | 25 | | 15 | 17 | Degrees |
| | CMRR | | 13 | | | 17 | | dB |
| | Power Handling | | | 0.5 | | | 0.5 | Watts |
| | Operating Temperature | -55 | | +85 | -55 | | +85 | °C |

Outline Drawing



Xinger®

Ultra Low Profile 0805 Balun 75Ω to 75Ω Balanced



Description

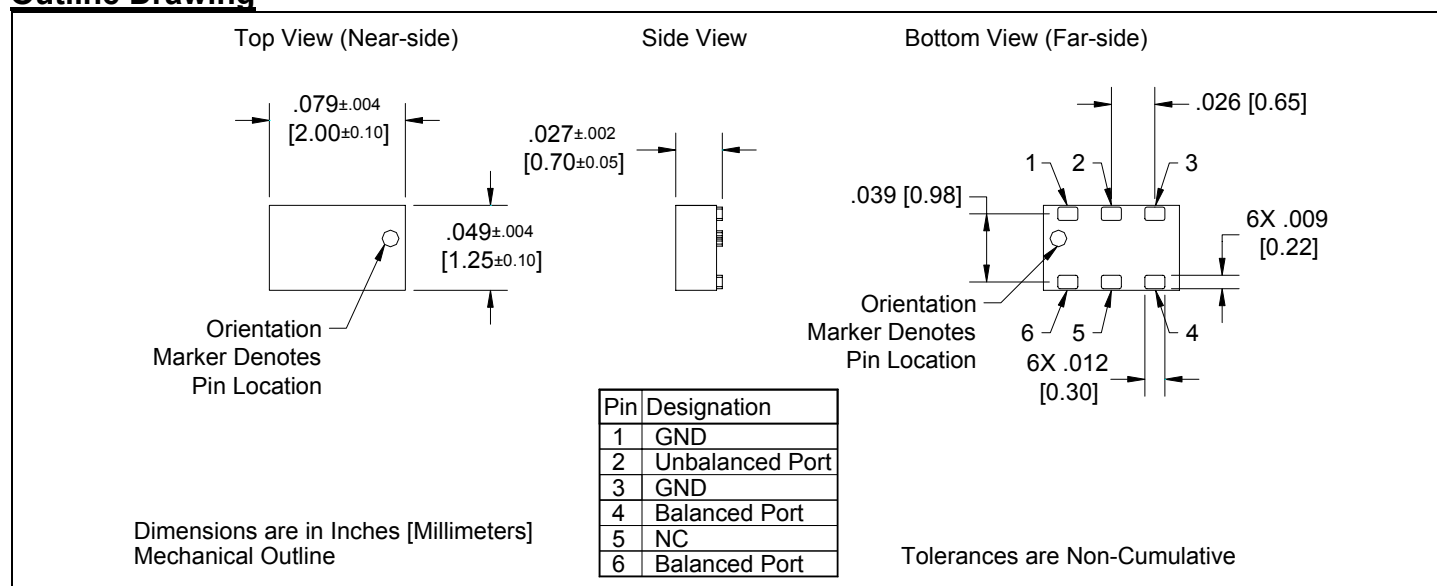
The B0922J7575A00 is a low cost, low profile sub-miniature unbalanced to balanced transformer designed for differential inputs and output locations on modern chipsets in an easy to use surface mount package covering dual polarized commercial Satellite bands 950 MHz – 1450 MHz & 1650 MHz – 2150 MHz. The B0922J7575A00 is ideal for high volume manufacturing and delivers higher performance than traditional wire wound baluns. The B0922J7575A00 has an unbalanced port impedance of 75Ω and a 75Ω balanced port impedance*. This transformation enables single ended signals to be applied to differential ports on modern integrated chipsets. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The B0922J7575A00 is available on tape and reel for pick and place high volume manufacturing.

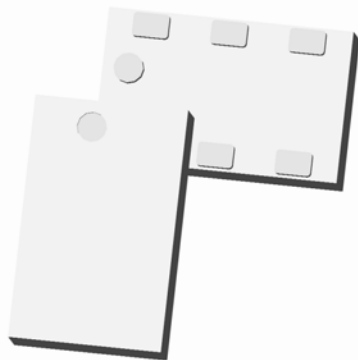
Detailed Electrical Specifications: Specifications subject to change without notice.

| Features: | Parameter | ROOM (25°C) | | | Unit |
|---|---------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| <ul style="list-style-type: none"> 950 – 2150 MHz 0.7mm Height Profile 75 Ohm to 2 x 37.5 Ohm Low Insertion Loss Sat LNB Chipset Compliant Input to Output DC Isolation Surface Mountable Tape & Reel Non-conductive Surface RoHS Compliant | Frequency | 950 | | 2150 | MHz |
| | Unbalanced Port Impedance | | 75 | | Ω |
| | Balanced Port Impedance | | 75 | | Ω |
| | Return Loss | 7.9 | 9.6 | | dB |
| | Insertion Loss* | | 0.8 | 1.2 | dB |
| | Amplitude Balance | | 0.4 | 1.4 | dB |
| | Phase Balance | | 3 | 9 | Degrees |
| | CMRR | | 26 | | dB |
| | Power Handling | | | 2 | Watts |
| | Operating Temperature | -55 | | +85 | °C |

* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing





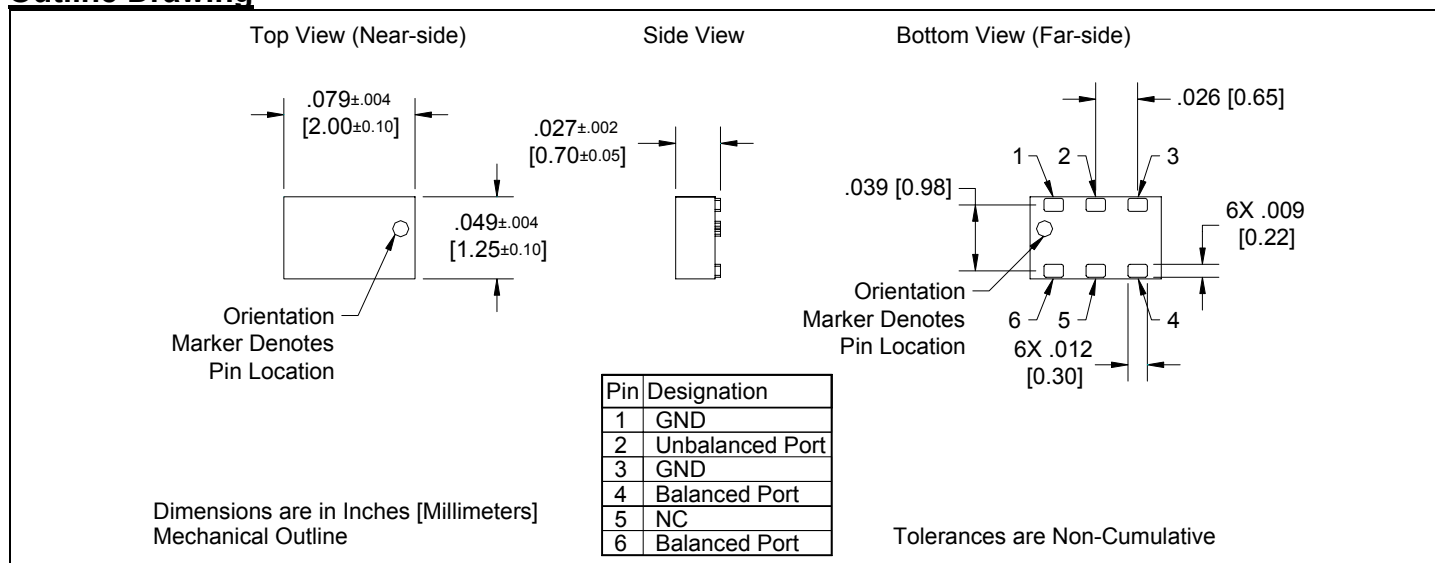
The B0922J7575A50 is a low cost, low profile sub-miniature unbalanced to balanced transformer designed for differential inputs and output locations on modern chipsets in an easy to use surface mount package covering dual polarized commercial Satellite bands 950 MHz – 1450 MHz & 1650 MHz – 2150 MHz. The B0922J7575A50 is ideal for high volume manufacturing and delivers higher performance than traditional wire wound baluns. The B0922J7575A50 has an unbalanced port impedance of 75Ω and a 75Ω balanced port impedance*. This transformation enables single ended signals to be applied to differential ports on modern integrated chipsets. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The B0922J7575A50 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

| Features: | | ROOM (25°C) | | | Unit |
|--------------------------------|---------------------------|-------------|------|------|---------|
| | Parameter | Min. | Typ. | Max | |
| • 950 – 2150 MHz | Frequency | 950 | | 2150 | MHz |
| • 0.7mm Height Profile | Unbalanced Port Impedance | | 75 | | Ω |
| • 75 Ohm to 2 x 37.5 Ohm | Balanced Port Impedance | | 75 | | Ω |
| • Low Insertion Loss | Return Loss | 12 | 15 | | dB |
| • Sat LNB Chipset Compliant | Insertion Loss* | | 0.8 | 1.1 | dB |
| • Input to Output DC Isolation | Amplitude Balance | | 1.0 | 1.4 | dB |
| • Surface Mountable | Phase Balance | | 3 | 9 | Degrees |
| • Tape & Reel | CMRR | | 25 | | dB |
| • Non-conductive Surface | Power Handling | | | 2 | Watts |
| • RoHS Compliant | Operating Temperature | -55 | | +85 | °C |

* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®

Ultra Low Profile 0805 Balun 50Ω to 100Ω Balanced

Description

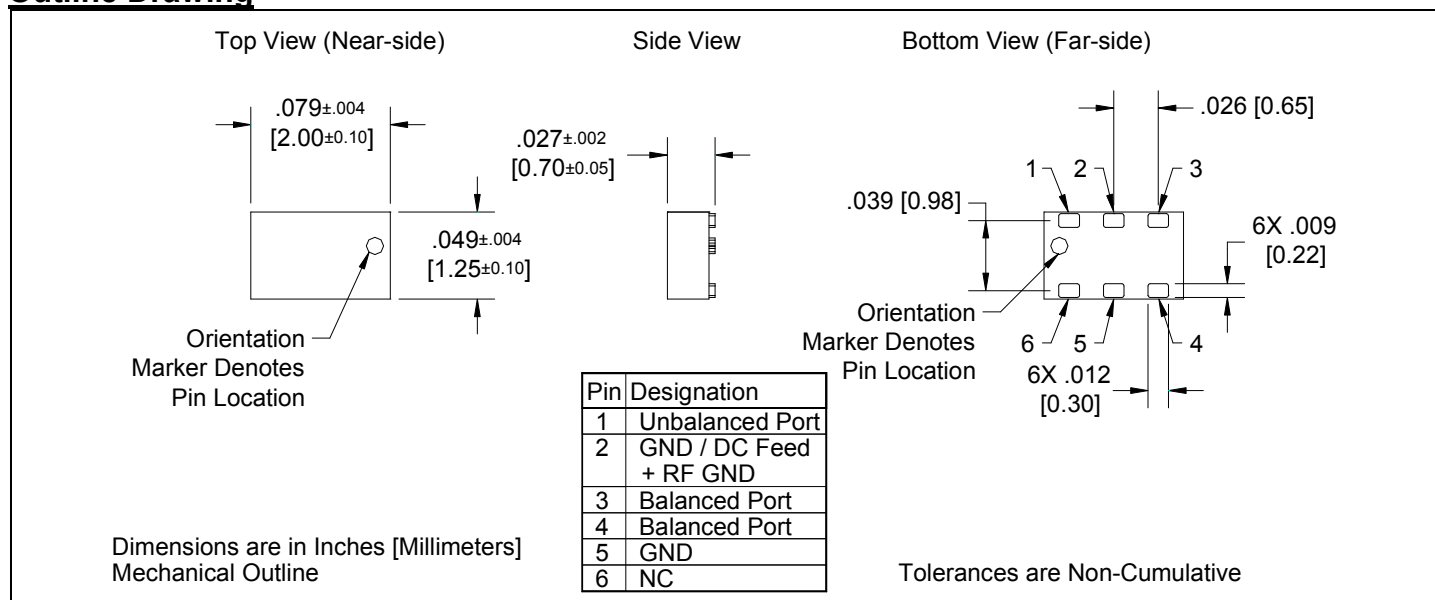
The BD0810J50100A00 is a low profile sub-miniature balanced to unbalanced transformer designed for differential inputs and output locations on next generation wireless chipsets in an easy to use surface mount package covering the GSM frequency. The BD0810J50100A00 is ideal for high volume manufacturing and is higher performance than traditional ceramic and lumped element baluns. The BD0810J50100A00 has an unbalanced port impedance of 50Ω and a 100Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern semiconductors. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD0810J50100A00 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

| Features: | Parameter | ROOM (25°C) | | | Unit |
|---|---------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| <ul style="list-style-type: none"> 800 – 1000 MHz 0.7mm Height Profile 50 Ohm to 2 x 50 Ohm GSM Low Insertion Loss Input to Output DC Isolation Surface Mountable Tape & Reel Non-conductive Surface RoHS Compliant | Frequency | 800 | | 1000 | MHz |
| | Unbalanced Port Impedance | | 50 | | Ω |
| | Balanced Port Impedance | | 100 | | Ω |
| | Return Loss | 13 | 15 | | dB |
| | Insertion Loss* | | 0.70 | 0.95 | dB |
| | Amplitude Balance | | 0.2 | 0.4 | dB |
| | Phase Balance | | 1 | 2 | Degrees |
| | CMRR | | 39 | | dB |
| | Power Handling | | | 2 | Watts |
| | Operating Temperature | -55 | | +85 | °C |

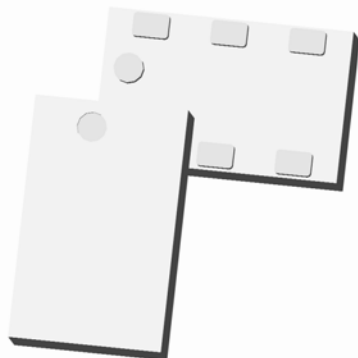
* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®

Ultra Low Profile 0805 Balun 50Ω to 150Ω Balanced



Description

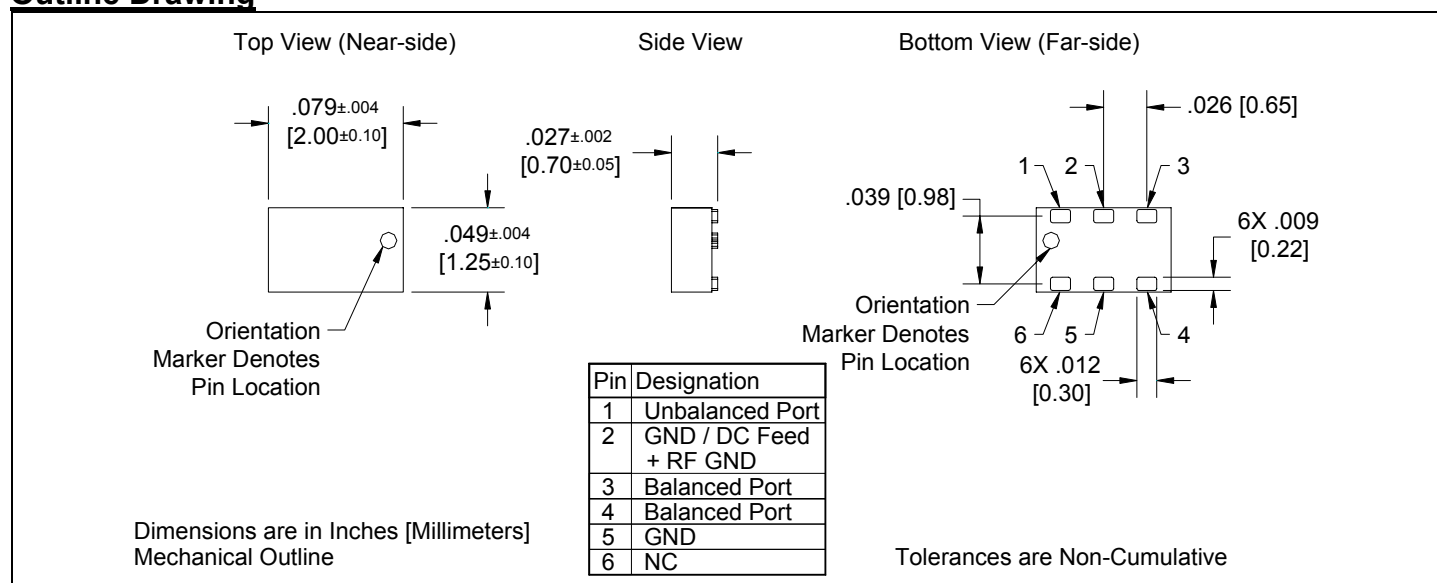
The BD0810J50150A00 is a low profile sub-miniature balanced to unbalanced transformer designed for differential inputs and output locations on next generation wireless chipsets in an easy to use surface mount package covering the GSM frequency. The BD0810J50150A00 is ideal for high volume manufacturing and is higher performance than traditional ceramic, and lumped element baluns. The BD0810J50150A00 has an unbalanced port impedance of 50Ω and a 150Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern semiconductors. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD0810J50150A00 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

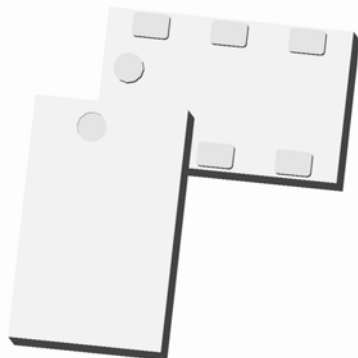
| Features: | Parameter | ROOM (25°C) | | | Unit |
|---|---------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| <ul style="list-style-type: none"> 800 – 1000 MHz 0.7mm Height Profile 50 Ohm to 2 x 75 Ohm GSM Low Insertion Loss Input to Output DC Isolation Surface Mountable Tape & Reel Non-conductive Surface RoHS Compliant | Frequency | 800 | | 1000 | MHz |
| | Unbalanced Port Impedance | | 50 | | Ω |
| | Balanced Port Impedance | | 150 | | Ω |
| | Return Loss | 13.3 | 19.6 | | dB |
| | Insertion Loss* | | 0.9 | 1.1 | dB |
| | Amplitude Balance | | 0.2 | 0.6 | dB |
| | Phase Balance | | 2.5 | 6 | Degrees |
| | CMRR | | 33 | | dB |
| | Power Handling | | | 2 | Watts |
| | Operating Temperature | -55 | | +85 | °C |

* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®



Ultra Low Profile 0805 Balun 50Ω to 200Ω Balanced

Description

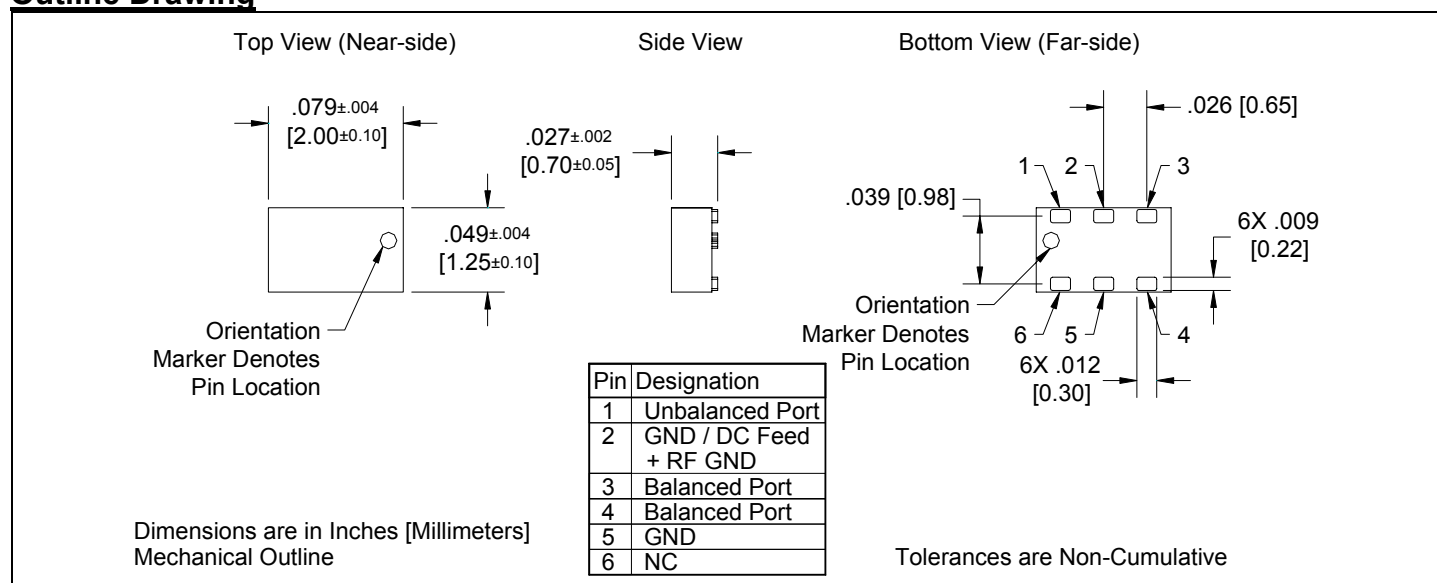
The BD0810J50200A00 is a low profile sub-miniature balanced to unbalanced transformer designed for differential inputs and output locations on next generation wireless chipsets in an easy to use surface mount package covering the GSM frequency. The BD0810J50200A00 is ideal for high volume manufacturing and is higher performance than traditional ceramic and lumped element baluns. The BD0810J50200A00 has an unbalanced port impedance of 50Ω and a 100Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern semiconductors. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD0810J50200A00 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

| Features: | Parameter | ROOM (25°C) | | | Unit |
|--|---------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| <ul style="list-style-type: none"> 800 – 1000 MHz 0.7mm Height Profile 50 Ohm to 2 x 100 Ohm GSM Low Insertion Loss Input to Output DC Isolation Surface Mountable Tape & Reel Non-conductive Surface RoHS Compliant | Frequency | 800 | | 1000 | MHz |
| | Unbalanced Port Impedance | | 50 | | Ω |
| | Balanced Port Impedance | | 200 | | Ω |
| | Return Loss | 14.5 | 19 | | dB |
| | Insertion Loss* | | 0.7 | 1.0 | dB |
| | Amplitude Balance | | 0.6 | 1.1 | dB |
| | Phase Balance | | 5 | 8 | Degrees |
| | CMRR | | 26 | | dB |
| | Power Handling | | | 2 | Watts |
| | Operating Temperature | -55 | | +85 | °C |

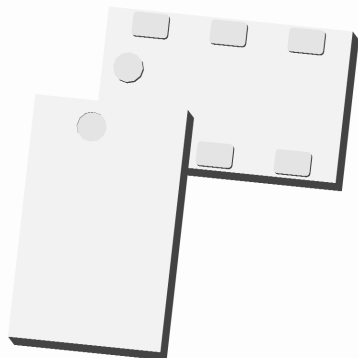
* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®

Ultra Low Profile 0805 Balun 50Ω to 200Ω Balanced



Description

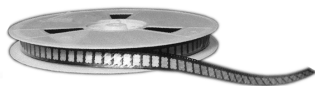
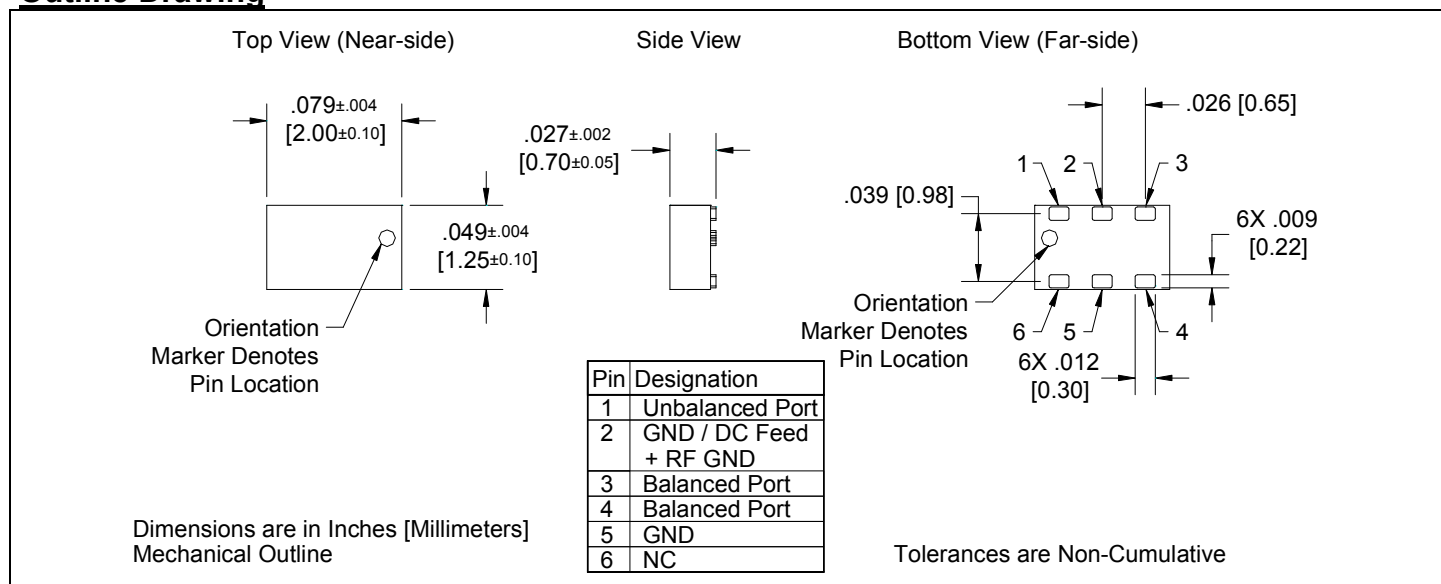
The BD0826J50200A00 is a low profile sub-miniature balanced to unbalanced transformer designed for differential inputs and output locations on next generation wireless chipsets in an easy to use surface mount package covering the GSM, DCS, PCS, UMTS, CDMA and 802.11 b+g+n frequencies. The BD0826J50200A00 is ideal for high volume manufacturing and is higher performance than traditional ceramic, and lumped element baluns. The BD0826J50200A00 has an unbalanced port impedance of 50Ω and a 200Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern integrated chipsets. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD0826J50200A00 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

| Features: | Parameter | ROOM (25°C) | | | Unit |
|--|---------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| <ul style="list-style-type: none"> 800 – 2600 MHz 0.7mm Height Profile 50 Ohm to 2 x 100 Ohm GSM/DCS/PCS/UMTS/CDMA Low Insertion Loss Input to Output DC Isolation Surface Mountable Tape & Reel Non-conductive Surface RoHS Compliant | Frequency | 800 | | 2600 | MHz |
| | Unbalanced Port Impedance | | 50 | | Ω |
| | Balanced Port Impedance | | 200 | | Ω |
| | Return Loss | 8.5 | 13 | | dB |
| | Insertion Loss* | | 1.2 | 1.5 | dB |
| | Amplitude Balance | | 0.4 | 1.3 | dB |
| | Phase Balance | | 3 | 7 | Degrees |
| | CMRR | | 30 | | dB |
| | Power Handling | | | 2 | Watts |
| | Operating Temperature | -55 | | +85 | °C |

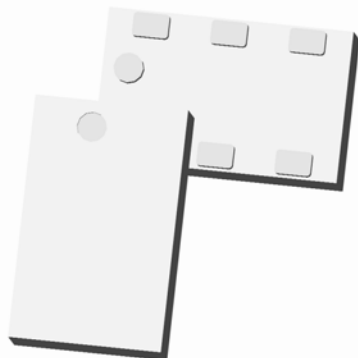
* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®

Ultra Low Profile 0805 Balun 50Ω to 200Ω Balanced



Description

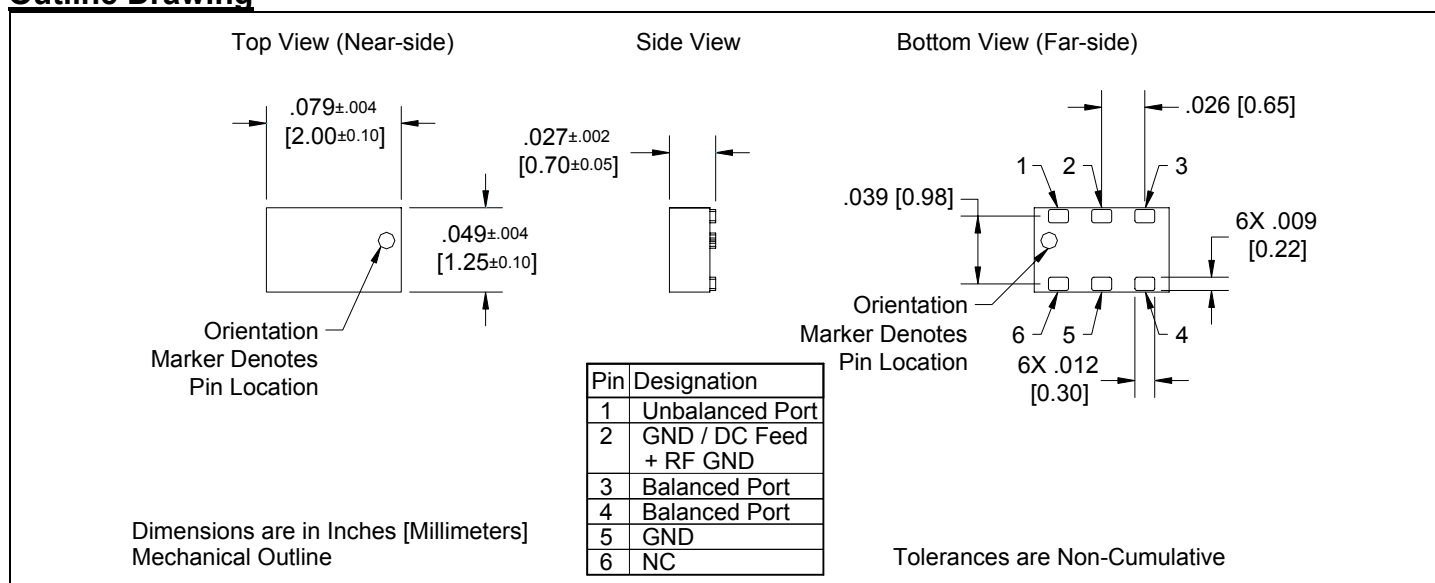
The BD1222J50200A00 is a low profile sub-miniature balanced to unbalanced transformer designed for differential inputs and output locations on next generation wireless chipsets in an easy to use surface mount package covering the DCS, PCS, UMTS and CDMA frequencies. The BD1222J50200A00 is ideal for high volume manufacturing and is higher performance than traditional ceramic and lumped element baluns. The BD1222J50200A00 has an unbalanced port impedance of 50Ω and a 200Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern semiconductors. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD1222J50200A00 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

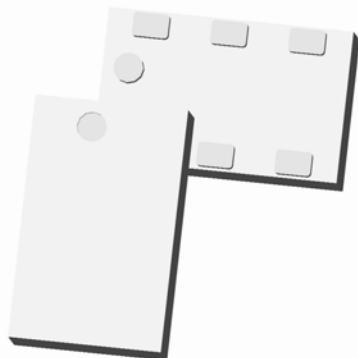
| Features: | Parameter | ROOM (25°C) | | | Unit |
|---|---------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| <ul style="list-style-type: none"> 1200 – 2200 MHz 0.7mm Height Profile 50 Ohm to 2 x 100 Ohm DCS/PCS/UMTS/CDMA Low Insertion Loss Input to Output DC Isolation Surface Mountable Tape & Reel Non-conductive Surface RoHS Compliant | Frequency | 1200 | | 2200 | MHz |
| | Unbalanced Port Impedance | | 50 | | Ω |
| | Balanced Port Impedance | | 200 | | Ω |
| | Return Loss | 14 | 18 | | dB |
| | Insertion Loss* | | 0.4 | 0.6 | dB |
| | Amplitude Balance | | 0.4 | 0.9 | dB |
| | Phase Balance | | 2 | 6 | Degrees |
| | CMRR | | 30 | | dB |
| | Power Handling | | | 2 | Watts |
| | Operating Temperature | -55 | | +85 | °C |

* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®



Ultra Low Profile 0805 Balun 50Ω to 100Ω Balanced

Description

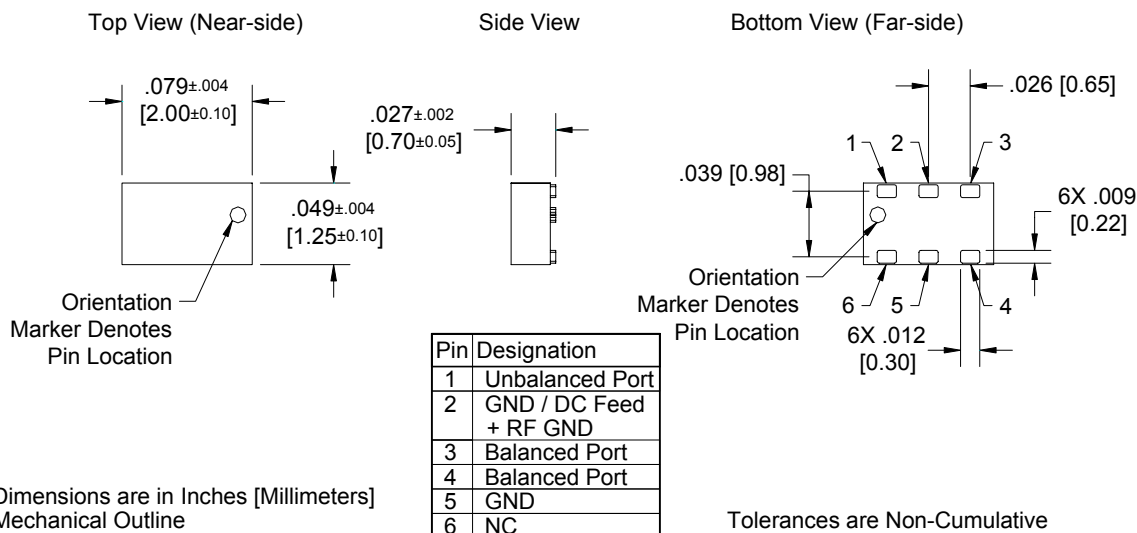
The BD1631J50100A00 is a low profile sub-miniature balanced to unbalanced transformer designed for differential inputs and output locations on next generation wireless chipsets in an easy to use surface mount package covering 802.11b+g+n, GSM, DCS, PCS and UMTS. The BD1631J50100A00 is ideal for high volume manufacturing and is higher performance than traditional ceramic and lumped element baluns. The BD1631J50100A00 has an unbalanced port impedance of 50Ω and a 100Ω balanced port impedance*. This transformation enables single ended signals to be applied to differential ports on modern semiconductors. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD1631J50100A00 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications*: Specifications subject to change without notice.

| Features: | Parameter | ROOM (25°C) | | | | | | Unit |
|---|-----------------------|-------------|------|------|------|------|-----|---------|
| | | Min. | Typ. | Max | Min. | Typ. | Max | |
| <ul style="list-style-type: none"> 1.6 – 3.1 GHz 0.7mm Height Profile 50 Ohm to 2 x 50 Ohm 802.11 b & g +n Compliant Low Insertion Loss DCS, PCS & UMTS Compliant Input to Output DC Isolation Surface Mountable Tape & Reel Non-conductive Surface RoHS Compliant | Frequency | 2.0 | | 2.5 | 1.6 | | 3.1 | GHz |
| | Unbalanced Port Imp. | | 50 | | | 50 | | Ω |
| | Balanced Port Imp.** | | 100 | | | 100 | | Ω |
| | Return Loss | 12 | 17.5 | | 10 | 13 | | dB |
| | Insertion Loss*** | | 0.6 | 0.75 | | 0.75 | 1.0 | dB |
| | Amplitude Balance | | 0.35 | 0.65 | | 0.7 | 1.0 | dB |
| | Phase Balance | | ±2 | ±5 | | ±2 | ±5 | Degrees |
| | Power Handling | | | 2 | | | 2 | Watts |
| | Operating Temperature | -55 | | +85 | -55 | | +85 | °C |

* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®

Ultra Low Profile 0805 Balun 50Ω to 50Ω Balanced

Description

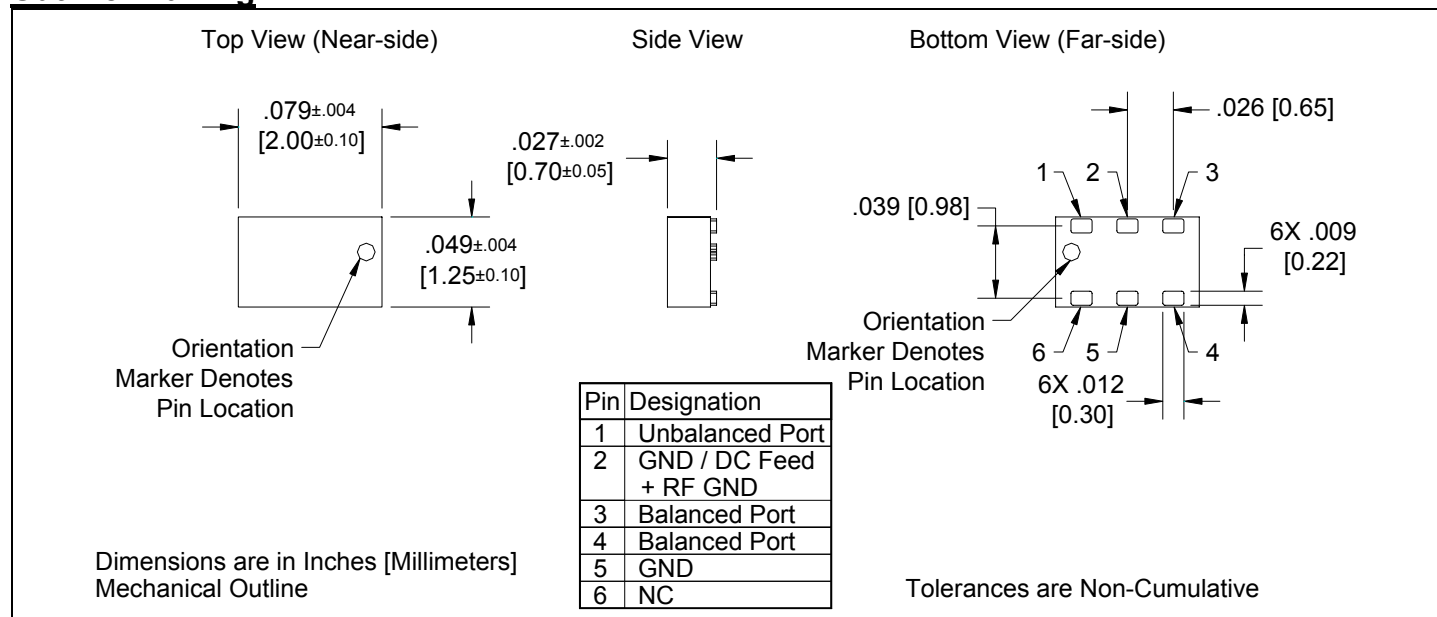
The BD2130J5050A00 is a low profile sub-miniature balanced to unbalanced transformer designed for differential inputs and output locations on next generation wireless chipsets in an easy to use surface mount package covering 802.11b+g+n. The BD2130J5050A00 is ideal for high volume manufacturing and is higher performance than traditional ceramic and lumped element baluns. The BD2130J5050A00 has an unbalanced port impedance of 50Ω and a 50Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern semiconductors. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD2130J5050A00 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications*: Specifications subject to change without notice.

| Features: | Parameter | ROOM (25°C) | | | | | | Unit |
|--------------------------------|-----------------------|-------------|------|------|------|------|-----|---------|
| | | Min. | Typ. | Max | Min. | Typ. | Max | |
| • 2.1 – 3.0 GHz | Frequency | 2.4 | | 2.5 | 2.1 | | 3.0 | GHz |
| • 0.7mm Height Profile | Unbalanced Port Imp. | | 50 | | | 50 | | Ω |
| • 50 Ohm to 2 x 25 Ohm | Balanced Port Imp.** | | 50 | | | 50 | | Ω |
| • 802.11 b & g +n Compliant | Return Loss | 12 | 17 | | 10 | 12 | | dB |
| • Low Insertion Loss | Insertion Loss*** | | 0.75 | 0.9 | | 1.0 | 1.2 | dB |
| • DCS, PCS & UMTS | Amplitude Balance | | 0.45 | 0.65 | | 0.7 | 1.0 | dB |
| • Input to Output DC Isolation | Phase Balance | | 2 | 5 | | 2 | 5 | Degrees |
| • Surface Mountable | Power Handling | | | 2 | | | 2 | Watts |
| • Tape & Reel | Operating Temperature | -55 | | +85 | -55 | | +85 | °C |
| • Non-conductive Surface | | | | | | | | |
| • RoHS Compliant | | | | | | | | |

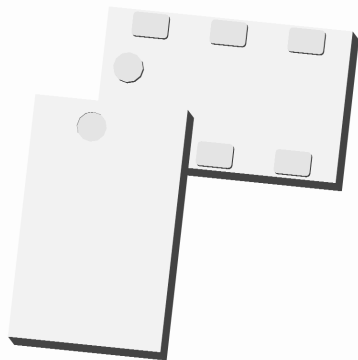
* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®

Ultra Low Profile 0805 Balun 50Ω to 100Ω Balanced



Description

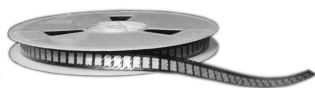
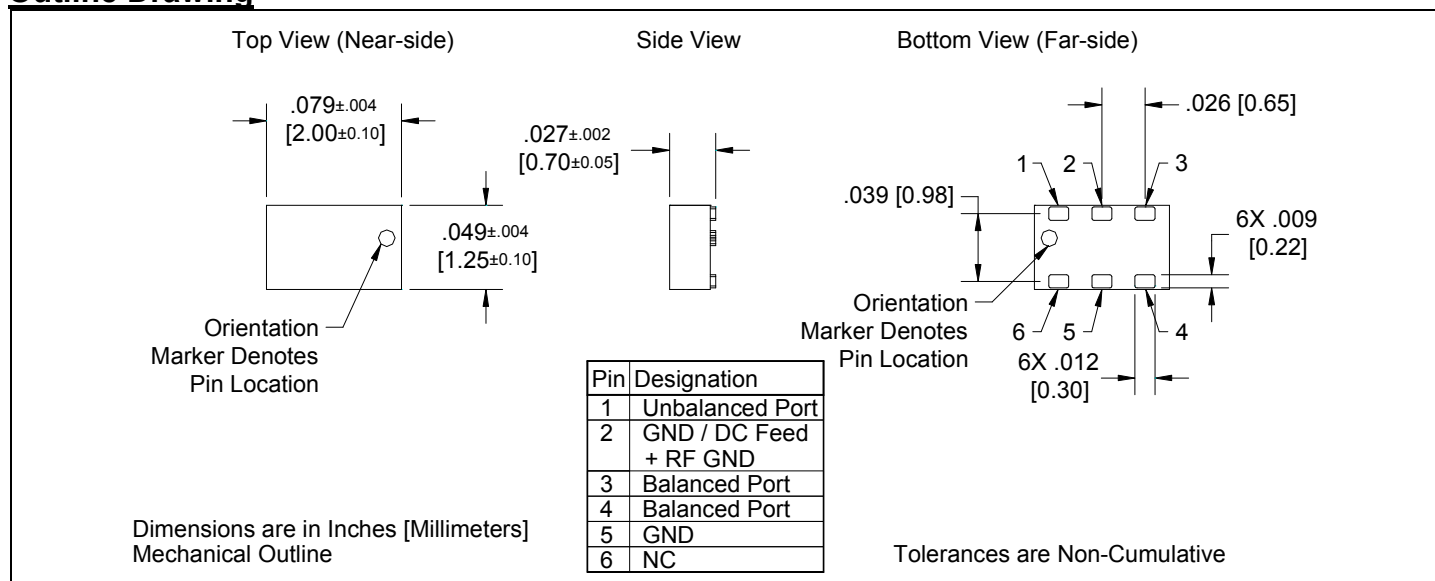
The BD1722J50100A00 is a low profile sub-miniature balanced to unbalanced transformer designed for differential inputs and output locations on next generation wireless chipsets in an easy to use surface mount package covering the DCS, PCS, UMTS and CDMA frequencies. The BD1722J50100A00 is ideal for high volume manufacturing and is higher performance than traditional ceramic, and lumped element baluns. The BD1722J50100A00 has an unbalanced port impedance of 50Ω and a 100Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern semiconductors. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD1722J50100A00 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

| Features: | Parameter | ROOM (25°C) | | | Unit |
|--|---------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| <ul style="list-style-type: none"> 1700 – 2200 MHz 0.7mm Height Profile 50 Ohm to 2 x 50 Ohm DCS/PCS/UMTS/CDMA Low Insertion Loss Input to Output DC Isolation Surface Mountable Tape & Reel Non-conductive Surface RoHS Compliant | Frequency | 1700 | | 2200 | MHz |
| | Unbalanced Port Impedance | | 50 | | Ω |
| | Balanced Port Impedance | | 100 | | Ω |
| | Return Loss | 9 | 13 | | dB |
| | Insertion Loss* | | 0.9 | 1.2 | dB |
| | Amplitude Balance | | 0.4 | 1.2 | dB |
| | Phase Balance | | 4 | 6 | Degrees |
| | CMRR | | 29 | | dB |
| | Power Handling | | | 2 | Watts |
| | Operating Temperature | -55 | | +85 | °C |

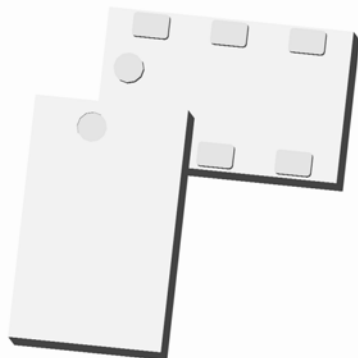
* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®

Ultra Low Profile 0805 Balun 50Ω to 150Ω Balanced



Description

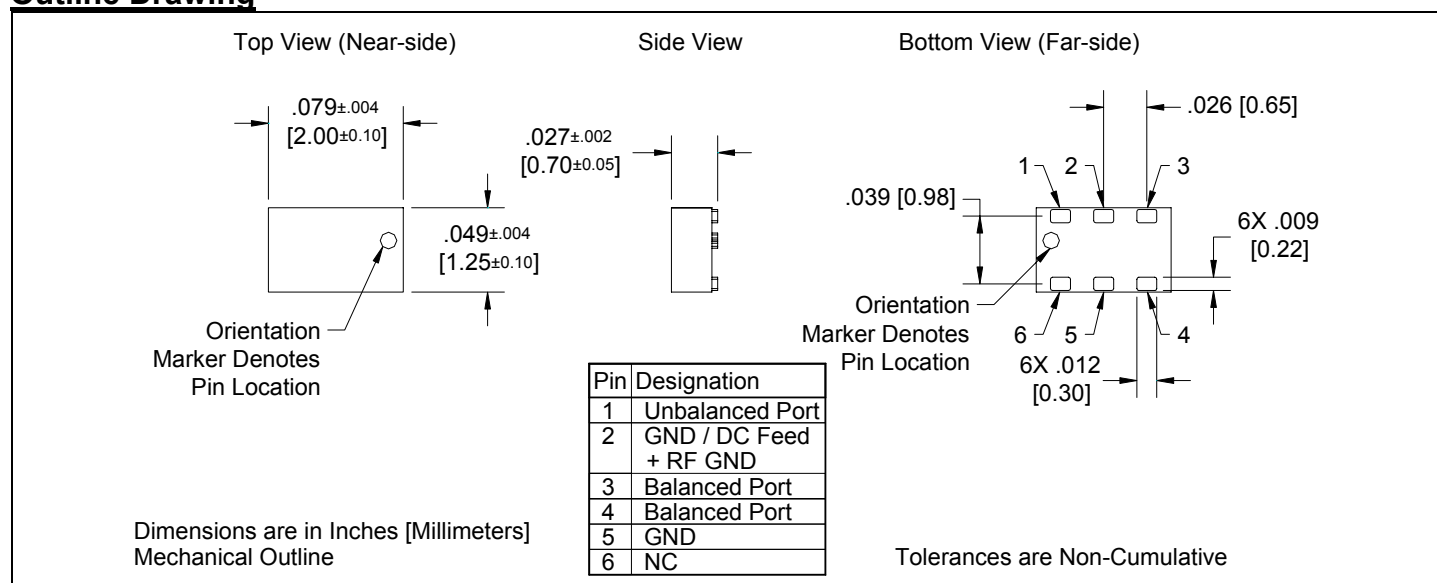
The BD1722J50150A00 is a low profile sub-miniature balanced to unbalanced transformer designed for differential inputs and output locations on next generation wireless chipsets in an easy to use surface mount package covering the DCS, PCS, UMTS and CDMA frequencies. The BD1722J50150A00 is ideal for high volume manufacturing and is higher performance than traditional ceramic and lumped element baluns. The BD1722J50150A00 has an unbalanced port impedance of 50Ω and a 150Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern semiconductors. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD1722J50150A00 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

| Features: | Parameter | ROOM (25°C) | | | Unit |
|--|---------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| <ul style="list-style-type: none"> 1700 – 2200 MHz 0.7mm Height Profile 50 Ohm to 2 x 75 Ohm DCS/PCS/UMTS/CDMA Low Insertion Loss Input to Output DC Isolation Surface Mountable Tape & Reel Non-conductive Surface RoHS Compliant | Frequency | 1700 | | 2200 | MHz |
| | Unbalanced Port Impedance | | 50 | | Ω |
| | Balanced Port Impedance | | 150 | | Ω |
| | Return Loss | 18 | 24 | | dB |
| | Insertion Loss* | | 0.5 | 0.7 | dB |
| | Amplitude Balance | | 0.5 | 1.0 | dB |
| | Phase Balance | | 3 | 7 | Degrees |
| | CMRR | | 30 | | dB |
| | Power Handling | | | 2 | Watts |
| | Operating Temperature | -55 | | +85 | °C |

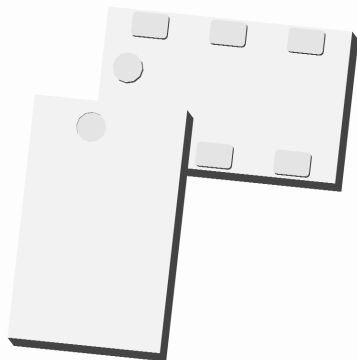
* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®

Ultra Low Profile 0805 Balun 50Ω to 200Ω Balanced



Description

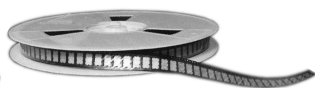
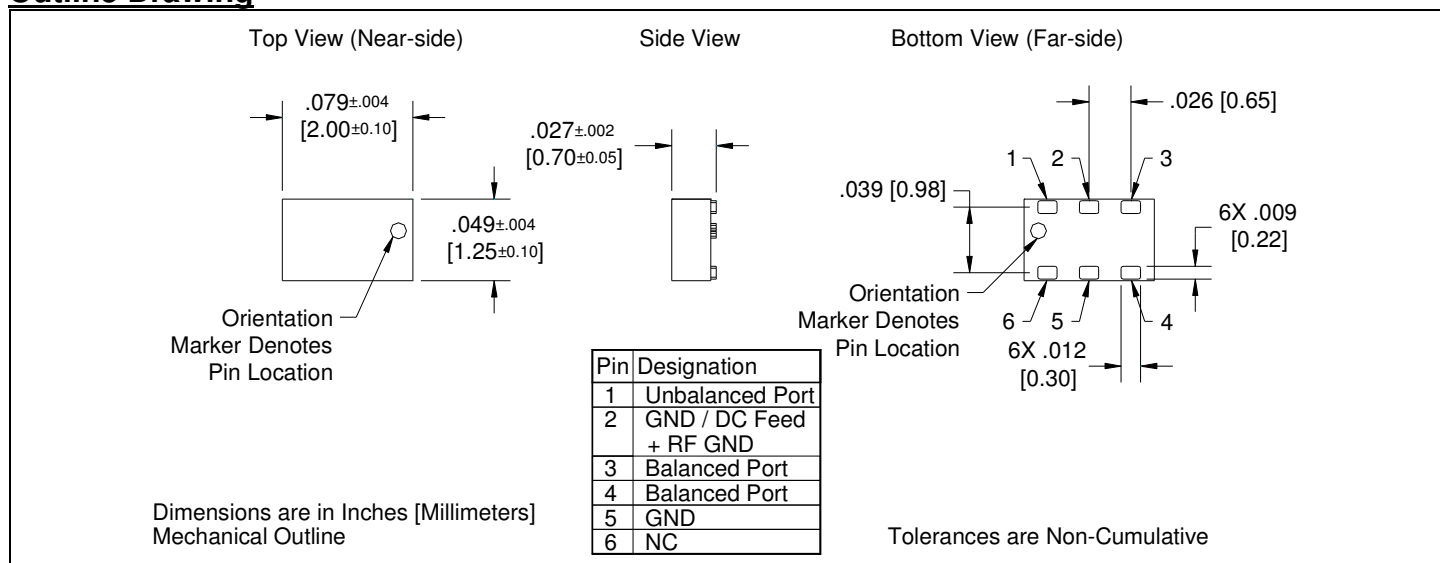
The BD1722J50200A00 is a low profile sub-miniature balanced to unbalanced transformer designed for differential inputs and output locations on next generation wireless chipsets in an easy to use surface mount package covering the DCS, PCS, UMTS and CDMA frequencies. The BD1722J50200A00 is ideal for high volume manufacturing and is higher performance than traditional ceramic and lumped element baluns. The BD1722J50200A00 has an unbalanced port impedance of 50Ω and a 200Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern semiconductors. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD1722J50200A00 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications*: Specifications subject to change without notice.

| Features: | Parameter | ROOM (25°C) | | | Unit |
|--|---------------------------|-------------|------|-----|-----------|
| | | Min. | Typ. | Max | |
| <ul style="list-style-type: none"> 1.7 – 2.2 GHz 0.7mm Height Profile 50 Ohm to 2 x 100 Ohm DCS/PCS/ UMTS/CDMA Low Insertion Loss Input to Output DC Isolation Surface Mountable Tape & Reel Non-conductive Surface RoHS Compliant | Frequency | 1.7 | | 2.2 | GHz |
| | Unbalanced Port Impedance | | 50 | | Ω |
| | Balanced Port Impedance** | | 200 | | Ω |
| | Return Loss | 15 | 20 | | dB |
| | Insertion Loss*** | | 0.5 | 0.7 | dB |
| | Amplitude Balance | | 0.6 | 0.9 | dB |
| | Phase Balance | | 4 | 8 | Degrees |
| | Power Handling | | | 0.5 | Watts |
| | Thermal Resistance | | | TBD | °C / Watt |
| | Operating Temperature | -55 | | +85 | °C |

* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®

Ultra Low Profile 0805 Balun 50Ω to 50Ω Balanced

Description

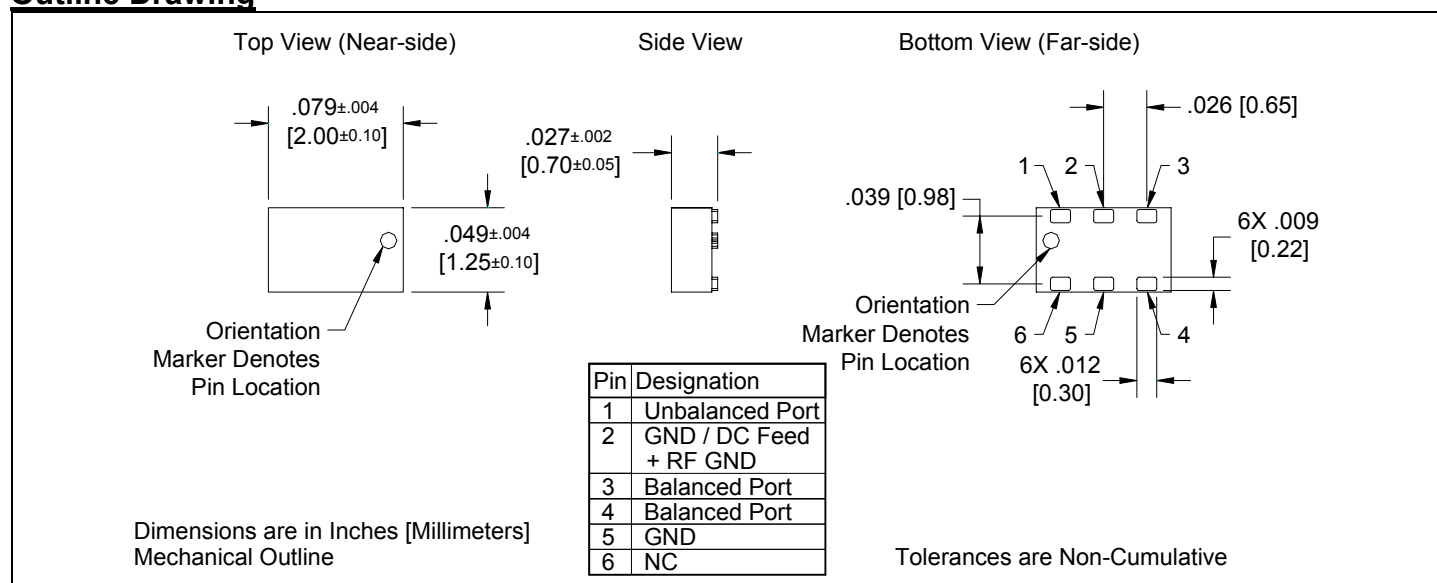
The BD2425J5050A00 is a low profile sub-miniature balanced to unbalanced transformer designed for differential inputs and output locations on next generation wireless chipsets in an easy to use surface mount package covering 802.11b+g+n. The BD2425J5050A00 is ideal for high volume manufacturing and is higher performance than traditional ceramic and lumped element baluns. The BD2425J5050A00 has an unbalanced port impedance of 50Ω and a 50Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern semiconductors. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD2425J5050A00 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

| Features: | Parameter | ROOM (25°C) | | | Unit |
|--|---------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| <ul style="list-style-type: none"> 2400 – 2400 MHz 0.7mm Height Profile 50 Ohm to 2 x 25 Ohm 802.11 b+g +n Compliant Low Insertion Loss Input to Output DC Isolation Surface Mountable Tape & Reel Non-conductive Surface RoHS Compliant | Frequency | 2400 | | 2500 | MHz |
| | Unbalanced Port Impedance | | 50 | | Ω |
| | Balanced Port Impedance | | 50 | | Ω |
| | Return Loss | 14 | 17 | | dB |
| | Insertion Loss* | | 0.8 | 0.9 | dB |
| | Amplitude Balance | | 0.35 | 0.5 | dB |
| | Phase Balance | | 1 | 5 | Degrees |
| | CMRR | | | | dB |
| | Power Handling | | | 2 | Watts |
| | Operating Temperature | -55 | | +85 | °C |

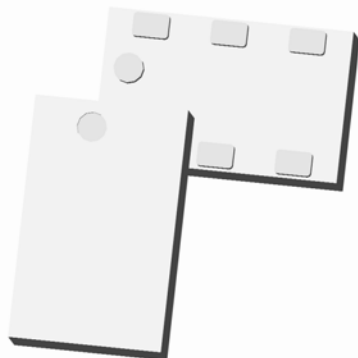
* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®

Ultra Low Profile 0805 Balun 50Ω to 100Ω Balanced



Description

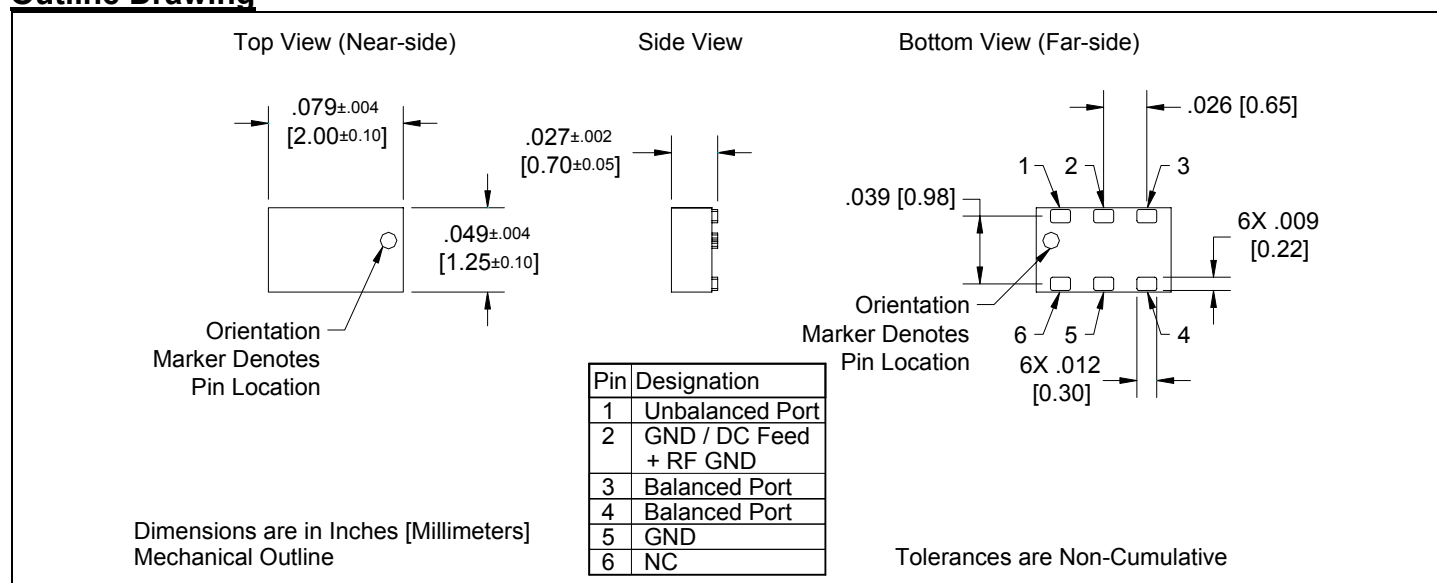
The BD2425J50100A00 is a low profile sub-miniature balanced to unbalanced transformer designed for differential inputs and output locations on next generation wireless chipsets in an easy to use surface mount package covering 802.11b+g+n. The BD2425J50100A00 is ideal for high volume manufacturing and is higher performance than traditional ceramic and lumped element baluns. The BD2425J50100A00 has an unbalanced port impedance of 50Ω and a 100Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern semiconductors. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD2425J50100A00 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

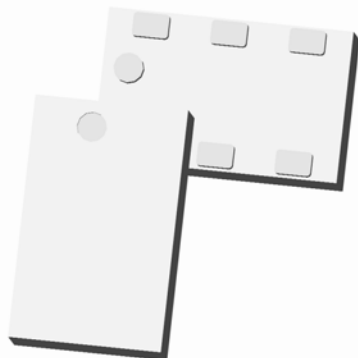
| Features: | Parameter | ROOM (25°C) | | | Unit |
|--|---------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| <ul style="list-style-type: none"> 2400 – 2400 MHz 0.7mm Height Profile 50 Ohm to 2 x 50 Ohm 802.11 b+g +n Compliant Low Insertion Loss Input to Output DC Isolation Surface Mountable Tape & Reel Non-conductive Surface RoHS Compliant | Frequency | 2400 | | 2500 | MHz |
| | Unbalanced Port Impedance | | 50 | | Ω |
| | Balanced Port Impedance | | 100 | | Ω |
| | Return Loss | 14 | 22 | | dB |
| | Insertion Loss* | | 0.55 | 0.75 | dB |
| | Amplitude Balance | | 0.3 | 0.5 | dB |
| | Phase Balance | | 2 | 5 | Degrees |
| | CMRR | | | | dB |
| | Power Handling | | | 2 | Watts |
| | Operating Temperature | -55 | | +85 | °C |

* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®



Ultra Low Profile 0805 Balun 50Ω to 200Ω Balanced

Description

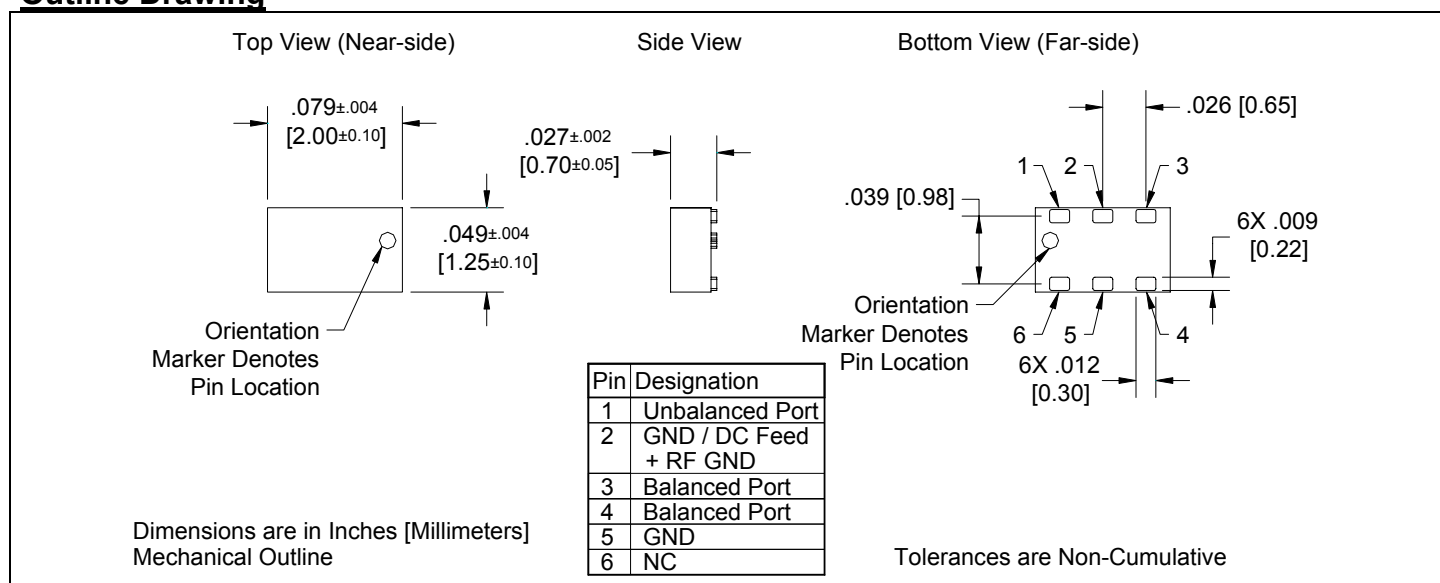
The BD2425J50200A00 is a low profile sub-miniature balanced to unbalanced transformer designed for differential inputs and output locations on next generation wireless chipsets in an easy to use surface mount package covering the GSM frequencies. The BD2425J50200A00 is ideal for high volume manufacturing and is higher performance than traditional ceramic and lumped element baluns. The BD2425J50200A00 has an unbalanced port impedance of 50Ω and a 200Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern semiconductors. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD2425J50200A00 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

| Features: | Parameter | ROOM (25°C) | | | Unit |
|---|---------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| <ul style="list-style-type: none"> 2400 – 2400 MHz 0.7mm Height Profile 50 Ohm to 2 x 100 Ohm 802.11 b+g +n Compliant Low Insertion Loss Input to Output DC Isolation Surface Mountable Tape & Reel Non-conductive Surface RoHS Compliant | Frequency | 2400 | | 2500 | MHz |
| | Unbalanced Port Impedance | | 50 | | Ω |
| | Balanced Port Impedance | | 200 | | Ω |
| | Return Loss | 9.5 | 12.2 | | dB |
| | Insertion Loss* | | 0.6 | 0.8 | dB |
| | Amplitude Balance | | 0.1 | 0.5 | dB |
| | Phase Balance | | 2 | 6 | Degrees |
| | CMRR | | 37 | | dB |
| | Power Handling | | | 2 | Watts |
| | Operating Temperature | -55 | | +85 | °C |

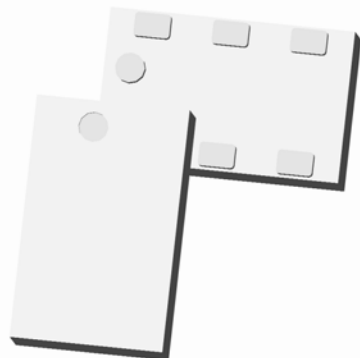
* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®

Ultra Low Profile 0805 Balun 50Ω to 350Ω Balanced



Description

The BD2425J50350A00 is a low profile sub-miniature balanced to unbalanced transformer designed for differential inputs and output locations on next generation wireless chipsets in an easy to use surface mount package covering the 2.4GHz ISM, WLAN, Bluetooth and WiMAX frequencies. The BD2425J50350A00 is ideal for high volume manufacturing and is higher performance than traditional ceramic and lumped element baluns. The BD2425J50350A00 has an unbalanced port impedance of 50Ω and a 350Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern semiconductors. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD2425J50350A00 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

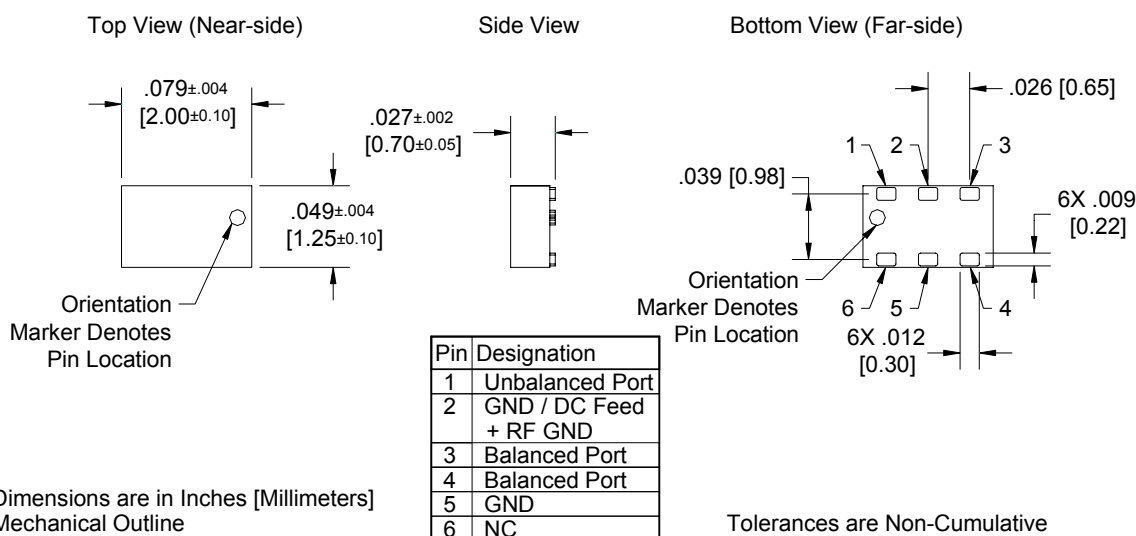
Features:

- 2400 – 2400 MHz
- 0.7mm Height Profile
- 50 Ohm to 2 x 175 Ohm
- 802.11 b, g +n Compliant
- Ideal impedance for CMOS transceivers
- Low Insertion Loss
- Input to Output DC Isolation
- Bluetooth, Zigbee and 2.4GHz ISM compliant
- Tape & Reel
- Non-conductive Surface
- RoHS Compliant

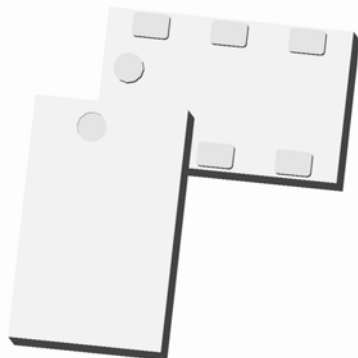
| Parameter | ROOM (25°C) | | | Unit |
|---------------------------|-------------|------|------|-----------|
| | Min. | Typ. | Max | |
| Frequency | 2400 | | 2500 | MHz |
| Unbalanced Port Impedance | | 50 | | Ω |
| Balanced Port Impedance | | 350 | | Ω |
| Return Loss | 10 | 12 | | dB |
| Insertion Loss* | | 1.1 | 1.3 | dB |
| Amplitude Balance | | 0.1 | 0.6 | dB |
| Phase Balance | | 5° | 10° | Degrees |
| CMRR | | 28 | | dB |
| Power Handling | | | TBD | Watts |
| Thermal Resistance | -55 | | +85 | °C / Watt |
| Operating Temperature | 800 | | 1000 | °C |

* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®



Ultra Low Profile 0805 Balun 50Ω to 100Ω Balanced

Description

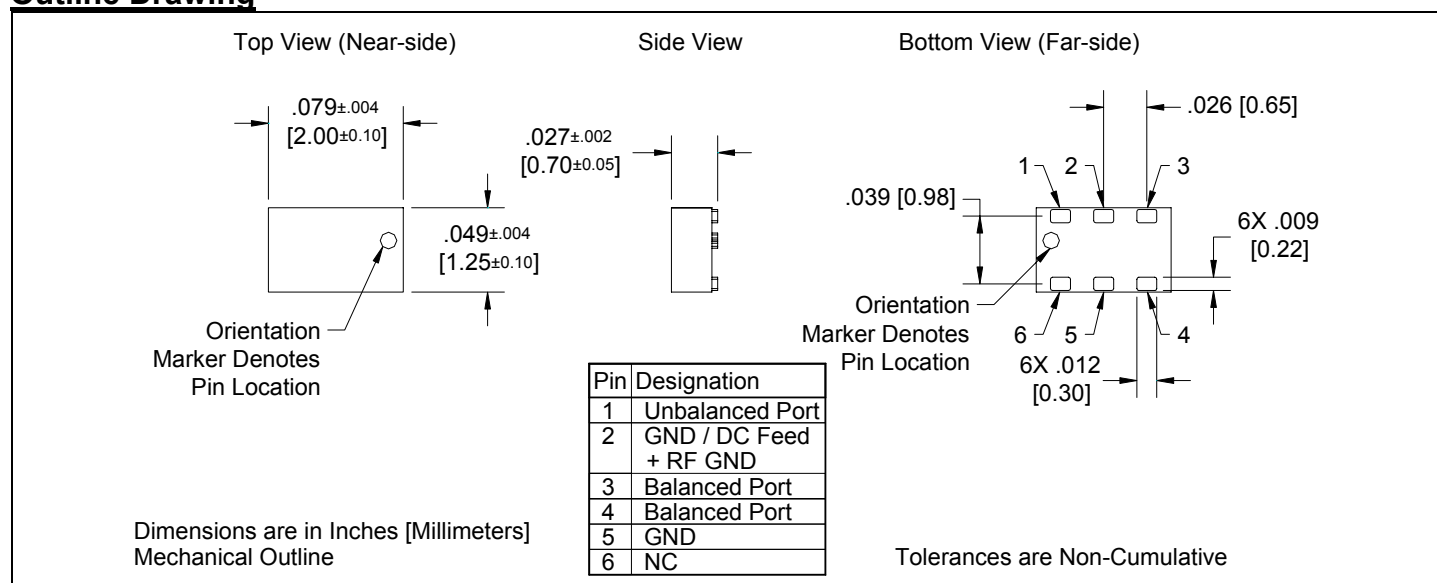
The BD2040J50100A00 is a low profile sub-miniature balanced to unbalanced transformer designed for differential inputs and output locations on next generation wireless chipsets in an easy to use surface mount package covering multiple ISM bands. The BD2040J50100A00 is ideal for high volume manufacturing and is higher performance than traditional ceramic and lumped element baluns. The BD2040J50100A00 has an unbalanced port impedance of 50Ω and a 100Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern semiconductors. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD2040J50100A00 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

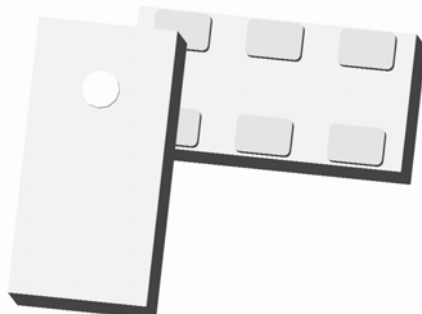
| Features: | Parameter | ROOM (25°C) | | | Unit |
|---|---------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| <ul style="list-style-type: none"> 2000 – 4000 MHz 0.7mm Height Profile 50 Ohm to 2 x 50 Ohm Multiple ISM bands Low Insertion Loss Input to Output DC Isolation Surface Mountable Tape & Reel Non-conductive Surface RoHS Compliant | Frequency | 2000 | | 4000 | MHz |
| | Unbalanced Port Impedance | | 50 | | Ω |
| | Balanced Port Impedance | | 100 | | Ω |
| | Return Loss | 10.5 | 13 | | dB |
| | Insertion Loss* | | 0.9 | 1.0 | dB |
| | Amplitude Balance | | 0.5 | 1.1 | dB |
| | Phase Balance | | 12 | 17 | Degrees |
| | CMRR | | 19 | | dB |
| | Power Handling | | | 2 | Watts |
| | Operating Temperature | -55 | | +85 | °C |

* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®



Ultra Small Low Profile 0603 Balun 50Ω to 150Ω Balanced

Description

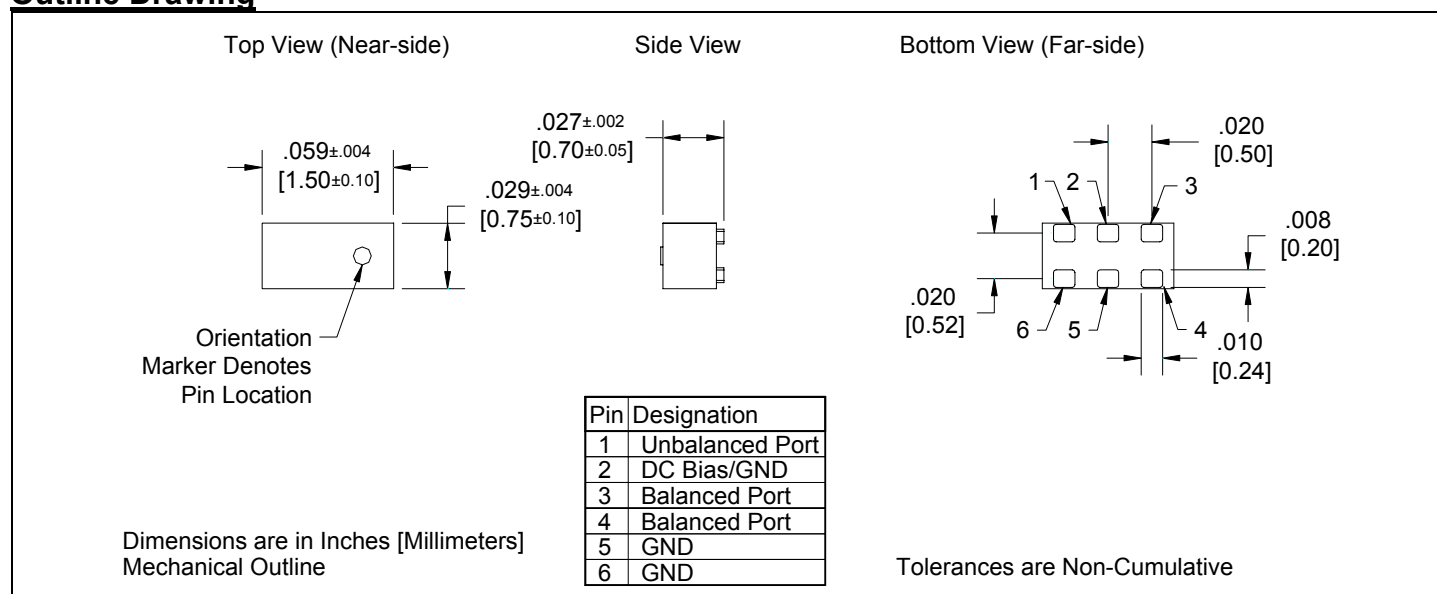
The BD2326L50150A00 is an ultra-small low profile balanced to unbalanced transformer designed for differential inputs and output locations on next generation wireless chipsets in an easy to use surface mount package covering 802.11b+g+n. The BD2326L50150A00 is ideal for high volume manufacturing and is higher performance than traditional ceramic baluns. The BD2326L50150A00 has an unbalanced port impedance of 50Ω and a 150Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern integrated chipsets. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD2326L50150A00 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

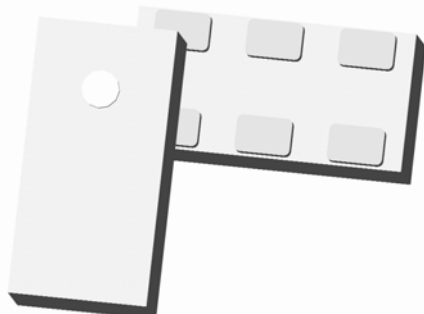
| Features: | Parameter | ROOM (25°C) | | | Unit |
|--|---------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| <ul style="list-style-type: none"> 2300 – 2600 MHz 0.7mm Height Profile 50 Ohm to 2 x 75 Ohm 802.11 b+g +n Compliant Low Insertion Loss Input to Output DC Isolation Surface Mountable Tape & Reel Non-conductive Surface RoHS Compliant | Frequency | 2300 | | 2600 | MHz |
| | Unbalanced Port Impedance | | 50 | | Ω |
| | Balanced Port Impedance | | 150 | | Ω |
| | Return Loss | 12 | 17 | | dB |
| | Insertion Loss* | | 0.8 | 1.1 | dB |
| | Amplitude Balance | | 0.5 | 1.0 | dB |
| | Phase Balance | | 4 | 10 | Degrees |
| | CMRR | | 29 | | dB |
| | Power Handling | | | 2 | Watts |
| | Operating Temperature | -55 | | +85 | °C |

* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®



Ultra Small Low Profile 0603 Balun 50Ω to 200Ω Balanced

Description

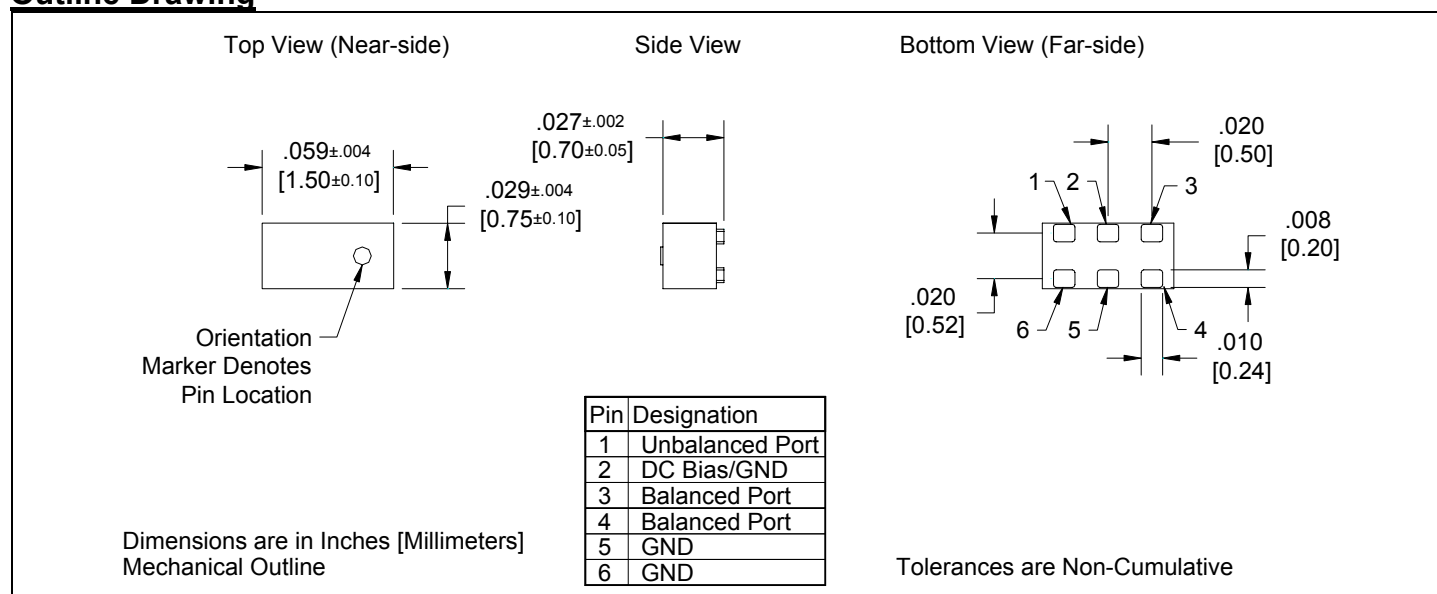
The BD2326L50200A00 is an ultra-small low profile balanced to unbalanced transformer designed for differential inputs and output locations on next generation wireless chipsets in an easy to use surface mount package covering 802.11b+g+n. The BD2326L50200A00 is ideal for high volume manufacturing and is higher performance than traditional ceramic baluns. The BD2326L50200A00 has an unbalanced port impedance of 50Ω and a 200Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern integrated chipsets. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD2326L50200A00 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

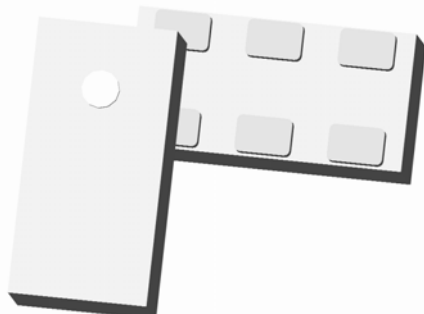
| Features: | Parameter | ROOM (25°C) | | | Unit |
|---|---------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| <ul style="list-style-type: none"> 2300 – 2600 MHz 0.7mm Height Profile 50 Ohm to 2 x 100 Ohm 802.11 b+g +n Compliant Low Insertion Loss Input to Output DC Isolation Surface Mountable Tape & Reel Non-conductive Surface RoHS Compliant | Frequency | 2300 | | 2600 | MHz |
| | Unbalanced Port Impedance | | 50 | | Ω |
| | Balanced Port Impedance | | 200 | | Ω |
| | Return Loss | 12 | 18 | | dB |
| | Insertion Loss* | | 0.9 | 1.1 | dB |
| | Amplitude Balance | | 0.4 | 0.8 | dB |
| | Phase Balance | | 3 | 9 | Degrees |
| | CMRR | | 29 | | dB |
| | Power Handling | | | 2 | Watts |
| | Operating Temperature | -55 | | +85 | °C |

* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®



Ultra Small Low Profile 0603 Balun 50Ω to 100Ω Balanced

Description

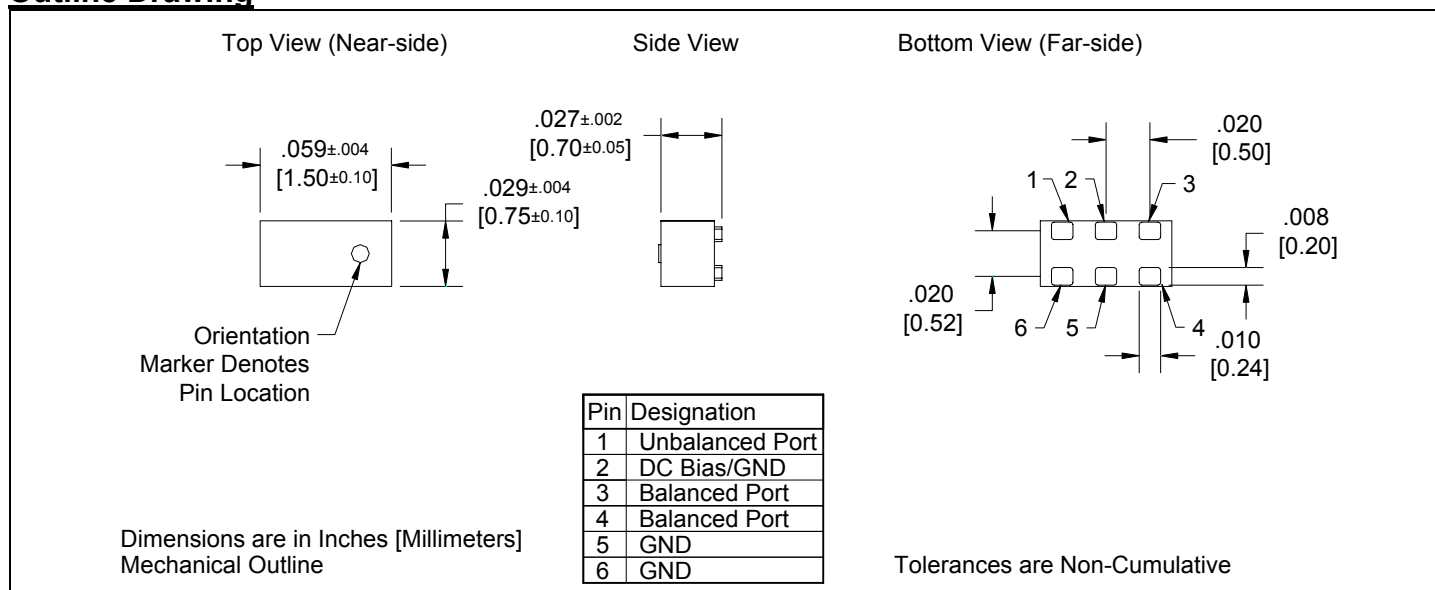
The BD3150L50100A00 is an ultra-small low profile balanced to unbalanced transformer designed for differential inputs and output locations on next generation wireless chipsets in an easy to use surface mount package covering the MMDS and the low end of the UWB frequency ranges. The BD3150L50100A00 is ideal for high volume manufacturing and is higher performance than traditional ceramic baluns. The BD3150L50100A00 has an unbalanced port impedance of 50Ω and a 100Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern integrated chipsets. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD3150L50100A00 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

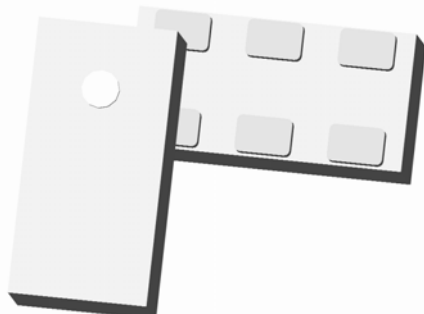
| Features: | Parameter | ROOM (25°C) | | | Unit |
|---|---------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| <ul style="list-style-type: none"> 3100 – 5000 MHz 0.7mm Height Profile 50 Ohm to 2 x 50 Ohm UWB & MMDS Low Insertion Loss Input to Output DC Isolation Surface Mountable Tape & Reel Non-conductive Surface RoHS Compliant | Frequency | 3100 | | 5000 | MHz |
| | Unbalanced Port Impedance | | 50 | | Ω |
| | Balanced Port Impedance | | 100 | | Ω |
| | Return Loss | 9.5 | 12 | | dB |
| | Insertion Loss* | | 0.8 | 1.1 | dB |
| | Amplitude Balance | | 0.5 | 0.9 | dB |
| | Phase Balance | | 4.0 | 9.0 | Degrees |
| | CMRR | | 28 | | dB |
| | Power Handling | | | 2 | Watts |
| | Operating Temperature | -55 | | +85 | °C |

* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®



Ultra Small Low Profile 0603 Balun 50Ω to 200Ω Balanced

Description

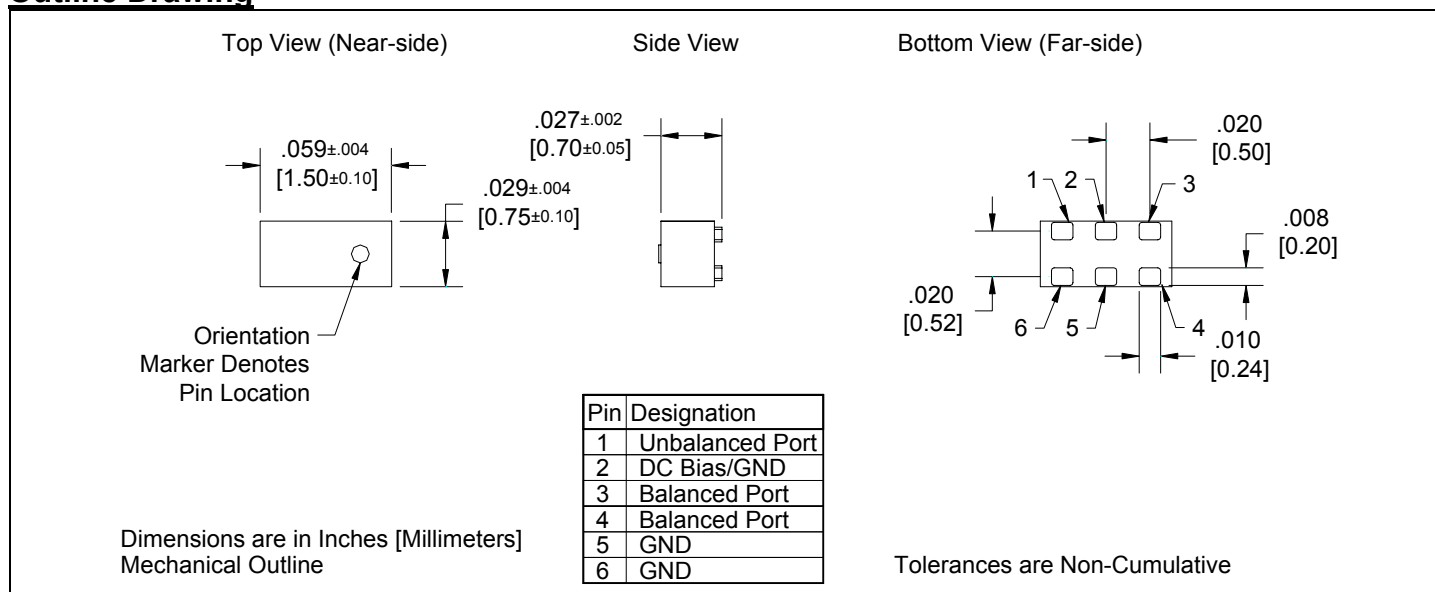
The BD3150L50200A00 is an ultra-small low profile balanced to unbalanced transformer designed for differential inputs and output locations on next generation wireless chipsets in an easy to use surface mount package covering the MMDS and the low end of the UWB frequency ranges. The BD3150L50200A00 is ideal for high volume manufacturing and is higher performance than traditional ceramic baluns. The BD3150L50200A00 has an unbalanced port impedance of 50Ω and a 200Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern integrated chipsets. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD3150L50200A00 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

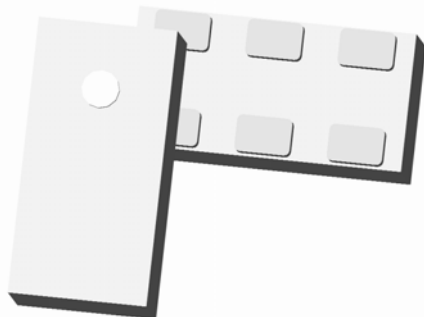
| Features: | Parameter | ROOM (25°C) | | | Unit |
|--|---------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| <ul style="list-style-type: none"> 3100 – 5000 MHz 0.7mm Height Profile 50 Ohm to 2 x 100 Ohm UWB & MMDS Low Insertion Loss Input to Output DC Isolation Surface Mountable Tape & Reel Non-conductive Surface RoHS Compliant | Frequency | 3100 | | 5000 | MHz |
| | Unbalanced Port Impedance | | 50 | | Ω |
| | Balanced Port Impedance | | 200 | | Ω |
| | Return Loss | 11 | 14 | | dB |
| | Insertion Loss* | | 0.9 | 1.2 | dB |
| | Amplitude Balance | | 0.7 | 1.3 | dB |
| | Phase Balance | | 5 | 11 | Degrees |
| | CMRR | | 25 | | dB |
| | Power Handling | | | 2 | Watts |
| | Operating Temperature | -55 | | +85 | °C |

* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®



Ultra Small Low Profile 0603 Balun 50Ω to 75Ω Balanced

Description

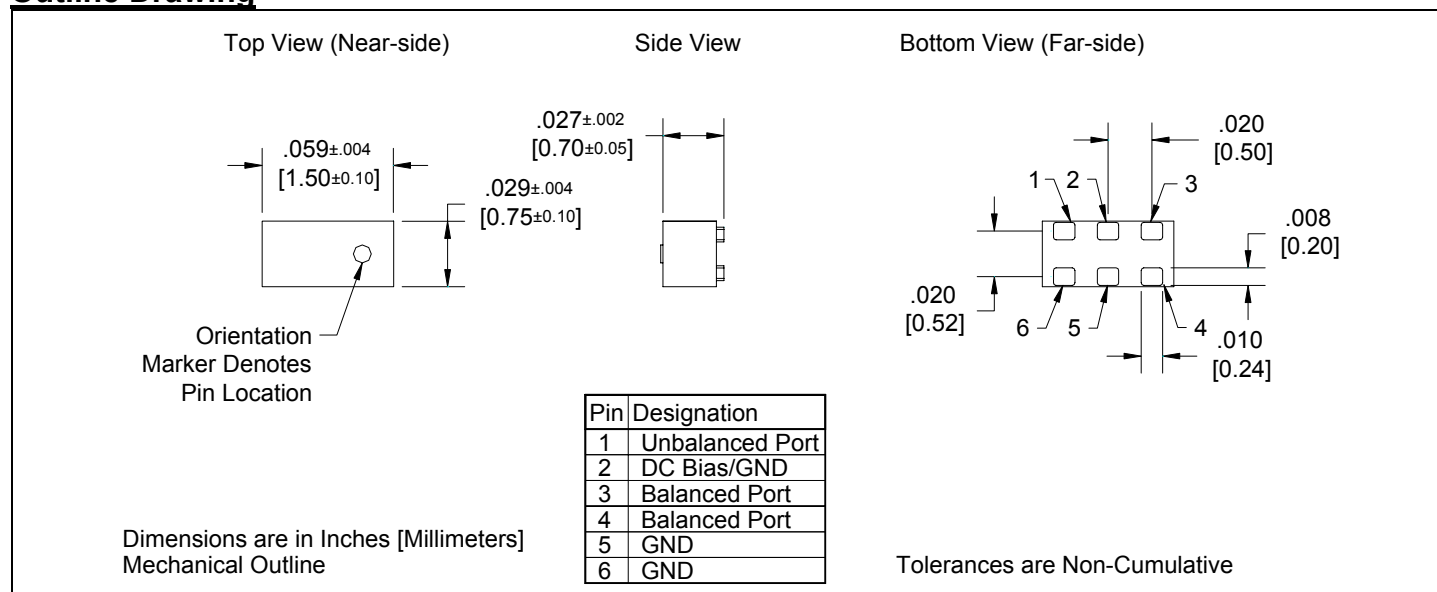
The BD4859L5075A00 is an ultra-small low profile balanced to unbalanced transformer designed for differential inputs and output locations on next generation wireless chipsets in an easy to use surface mount package covering 802.11a Uni-Band II and Uni-Band III and the Japanese ISM band (4.9GHz). The BD4859L5075A00 is ideal for high volume manufacturing and is higher performance than traditional ceramic baluns. The BD4859L5075A00 has an unbalanced port impedance of 50Ω and a 75Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern integrated chipsets. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD4859L5075A00 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

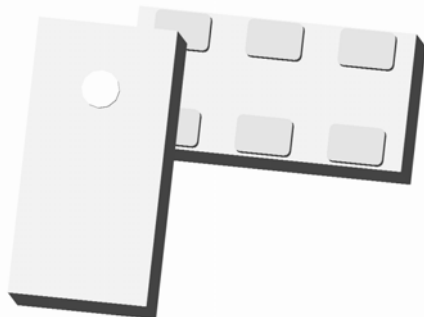
| Features: | Parameter | ROOM (25°C) | | | Unit |
|---|---------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| <ul style="list-style-type: none"> 4800 – 5900 MHz 0.7mm Height Profile 50 Ohm to 2 x 37 Ohm Covers 802.11a Uni-Band II & III Low Insertion Loss Input to Output DC Isolation Surface Mountable Tape & Reel Non-conductive Surface RoHS Compliant | Frequency | 4800 | | 5900 | MHz |
| | Unbalanced Port Impedance | | 50 | | Ω |
| | Balanced Port Impedance | | 75 | | Ω |
| | Return Loss | 9 | 13 | | dB |
| | Insertion Loss* | | 0.9 | 1.3 | dB |
| | Amplitude Balance | | 0.5 | 1.3 | dB |
| | Phase Balance | | 2 | 6.0 | Degrees |
| | CMRR | | 31 | | dB |
| | Power Handling | | | 2 | Watts |
| | Operating Temperature | -55 | | +85 | °C |

* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®



Ultra Small Low Profile 0603 Balun 50Ω to 100Ω Balanced

Description

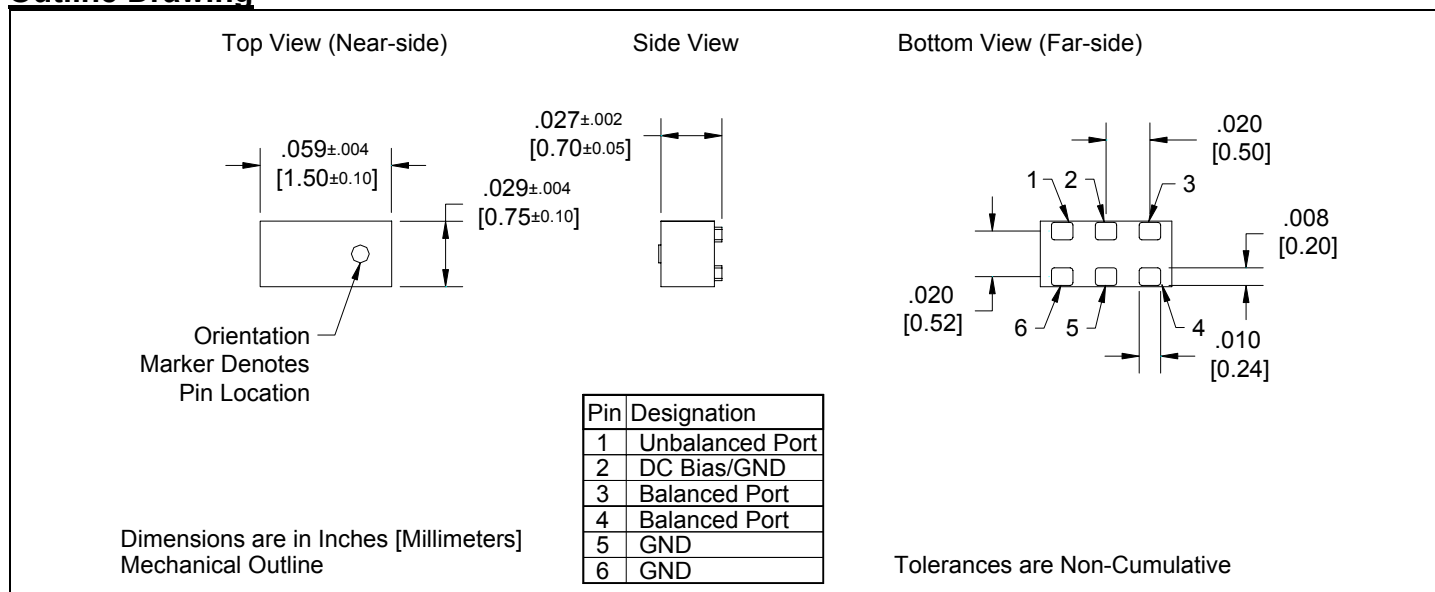
The BD4859L50100A00 is an ultra-small low profile balanced to unbalanced transformer designed for differential inputs and output locations on next generation wireless chipsets in an easy to use surface mount package covering 802.11a Uni-Band II and Uni-Band III and the Japanese ISM band (4.9GHz). The BD4859L50100A00 is ideal for high volume manufacturing and is higher performance than traditional ceramic baluns. The BD4859L50100A00 has an unbalanced port impedance of 50Ω and a 100Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern integrated chipsets. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD4859L50100A00 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

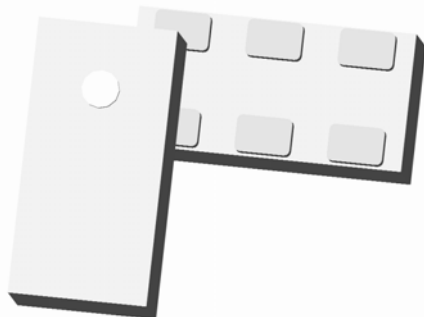
| Features: | Parameter | ROOM (25°C) | | | Unit |
|---|---------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| <ul style="list-style-type: none"> 4800 – 5900 MHz 0.7mm Height Profile 50 Ohm to 2 x 50 Ohm Covers 802.11a Uni-Band II & III Low Insertion Loss Input to Output DC Isolation Surface Mountable Tape & Reel Non-conductive Surface RoHS Compliant | Frequency | 4800 | | 5900 | MHz |
| | Unbalanced Port Impedance | | 50 | | Ω |
| | Balanced Port Impedance | | 100 | | Ω |
| | Return Loss | 9.2 | 13 | | dB |
| | Insertion Loss* | | 0.8 | 1.1 | dB |
| | Amplitude Balance | | 0.4 | 1.1 | dB |
| | Phase Balance | | 3 | 8 | Degrees |
| | CMRR | | 30 | | dB |
| | Power Handling | | | 2 | Watts |
| | Operating Temperature | -55 | | +85 | °C |

* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®



Ultra Small Low Profile 0603 Balun 50Ω to 150Ω Balanced

Description

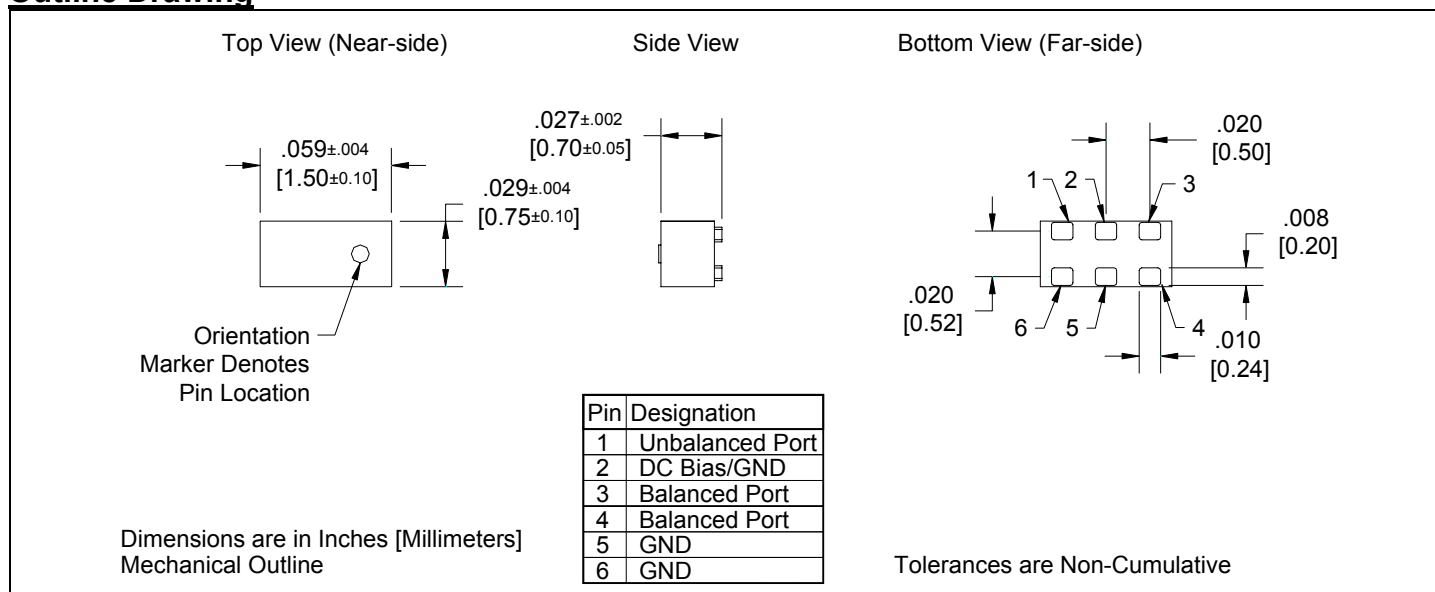
The BD4859L50150A00 is an ultra-small low profile balanced to unbalanced transformer designed for differential inputs and output locations on next generation wireless chipsets in an easy to use surface mount package covering 802.11a Uni-Band II and Uni-Band III and the Japanese ISM band (4.9GHz). The BD4859L50150A00 is ideal for high volume manufacturing and is higher performance than traditional ceramic baluns. The BD4859L50150A00 has an unbalanced port impedance of 50Ω and a 150Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern integrated chipsets. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD4859L50150A00 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

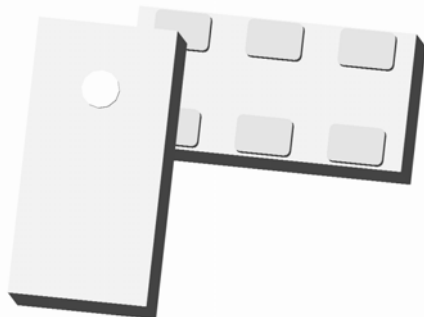
| Features: | Parameter | ROOM (25°C) | | | Unit |
|---|---------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| <ul style="list-style-type: none"> 4800 – 5900 MHz 0.7mm Height Profile 50 Ohm to 2 x 75 Ohm Covers 802.11a Uni-Band II & III Low Insertion Loss Input to Output DC Isolation Surface Mountable Tape & Reel Non-conductive Surface RoHS Compliant | Frequency | 4800 | | 5900 | MHz |
| | Unbalanced Port Impedance | | 50 | | Ω |
| | Balanced Port Impedance | | 150 | | Ω |
| | Return Loss | 11 | 14 | | dB |
| | Insertion Loss* | | 0.8 | 1.0 | dB |
| | Amplitude Balance | | 0.5 | 1.3 | dB |
| | Phase Balance | | 4 | 10 | Degrees |
| | CMRR | | 28 | | dB |
| | Power Handling | | | 2 | Watts |
| | Operating Temperature | -55 | | +85 | °C |

* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®



Ultra Small Low Profile 0603 Balun 50Ω to 200Ω Balanced

Description

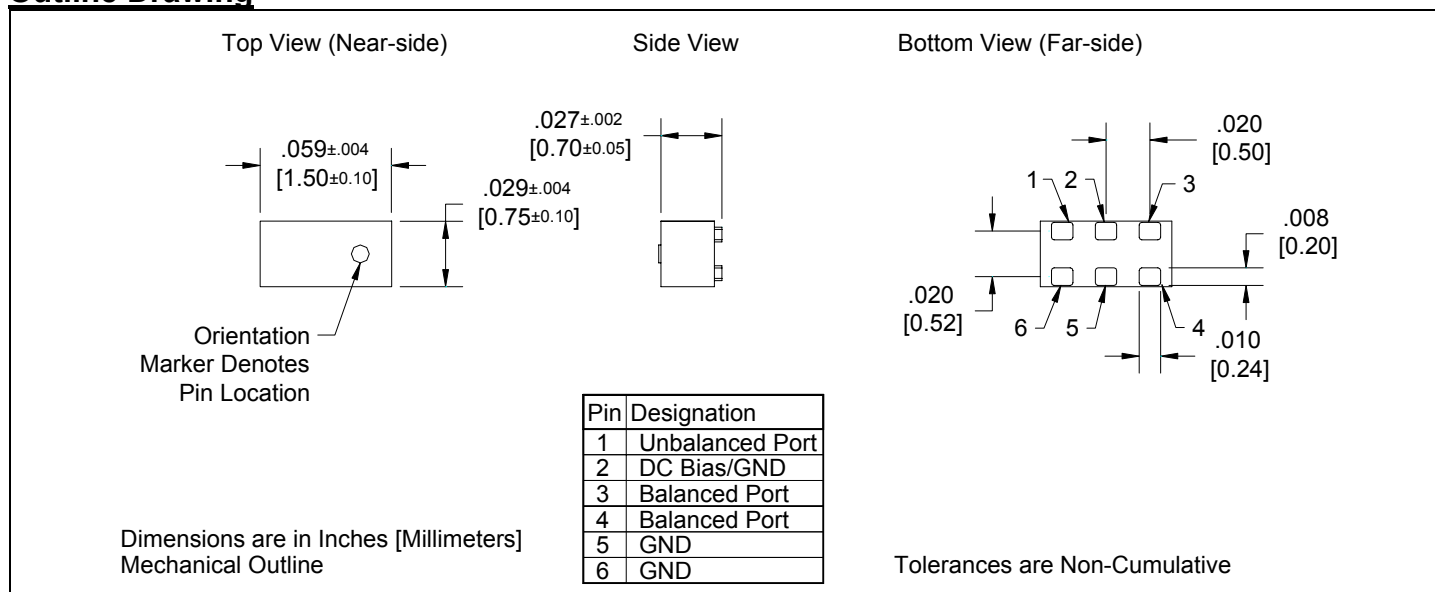
The BD4859L50200A00 is an ultra-small low profile balanced to unbalanced transformer designed for differential inputs and output locations on next generation wireless chipsets in an easy to use surface mount package covering 802.11a Uni-Band II and Uni-Band III and the Japanese ISM band (4.9GHz). The BD4859L50200A00 is ideal for high volume manufacturing and is higher performance than traditional ceramic baluns. The BD4859L50200A00 has an unbalanced port impedance of 50Ω and a 200Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern integrated chipsets. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD4859L50200A00 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

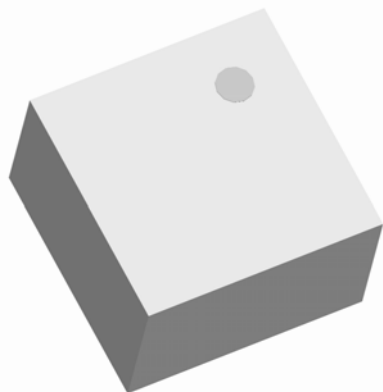
| Features: | Parameter | ROOM (25°C) | | | Unit |
|--|---------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| <ul style="list-style-type: none"> 4800 – 5900 MHz 0.7mm Height Profile 50 Ohm to 2 x 100 Ohm Covers 802.11a Uni-Band II & III Low Insertion Loss Input to Output DC Isolation Surface Mountable Tape & Reel Non-conductive Surface RoHS Compliant | Frequency | 4800 | | 5900 | MHz |
| | Unbalanced Port Impedance | | 50 | | Ω |
| | Balanced Port Impedance | | 200 | | Ω |
| | Return Loss | 8 | 10.7 | | dB |
| | Insertion Loss* | | 1.1 | 1.4 | dB |
| | Amplitude Balance | | 0.8 | 1.4 | dB |
| | Phase Balance | | 4 | 10 | Degrees |
| | CMRR | | 26 | | dB |
| | Power Handling | | | 2 | Watts |
| | Operating Temperature | -55 | | +85 | °C |

* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®



Ultra Low Profile 0404 Balun 50Ω to 75Ω Balanced

Description

The BD2425N5075A00 is a low cost, low profile sub-miniature unbalanced to balanced transformer designed for differential inputs and output locations on modern chipsets in an easy to use surface mount package. The BD2425N5075A00 is ideal for high volume manufacturing and delivers higher performance than traditional ceramic baluns. The BD2425N5075A00 has an unbalanced port impedance of 50Ω and a 75Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern integrated chipsets. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD2425N5075A00 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

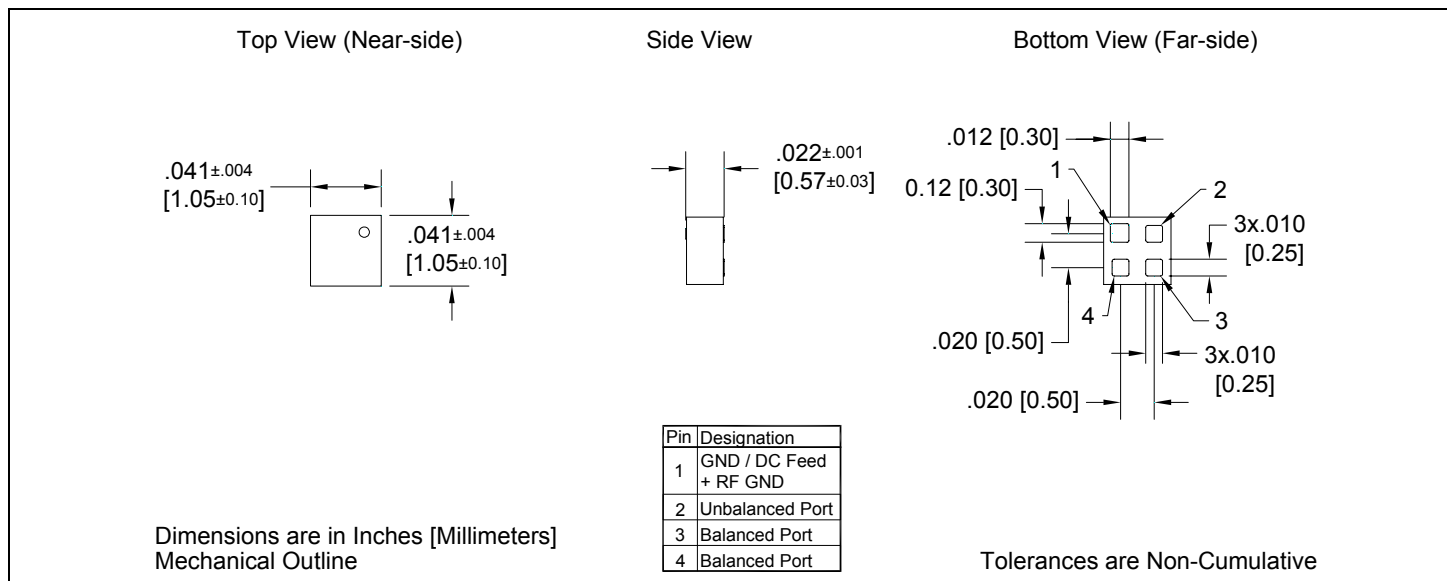
Features:

- 2400 – 2500 MHz
- 0.65mm Height Profile
- 50 Ohm to 2 x 37.5 Ohm
- Low Insertion Loss
- 802.11 b+g
- MIMO b+g
- Bluetooth
- Zigbee
- Surface Mountable
- Tape & Reel
- Non-conductive
- RoHS Compliant

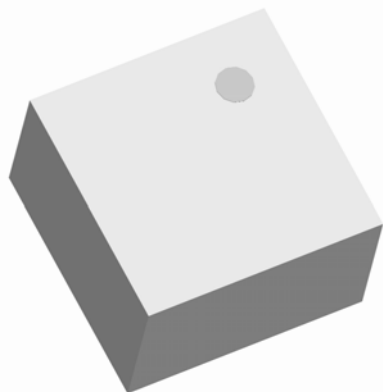
| Parameter | ROOM (25°C) | | | Unit |
|---------------------------|-------------|------|------|---------|
| | Min. | Typ. | Max | |
| Frequency | 2400 | | 2500 | MHz |
| Unbalanced Port Impedance | | 50 | | Ω |
| Balanced Port Impedance | | 75 | | Ω |
| Return Loss | 14 | 18 | | dB |
| Insertion Loss* | | 0.7 | 0.9 | dB |
| Amplitude Balance | | 0.3 | 0.9 | dB |
| Phase Balance | | 1 | 3 | Degrees |
| CMRR | | 35 | | dB |
| Power Handling | | | 1 | Watts |
| Operating Temperature | -55 | | +85 | °C |

* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®



Ultra Low Profile 0404 Balun 50Ω to 100Ω Balanced

Description

The BD2425N50100A00 is a low cost, low profile sub-miniature unbalanced to balanced transformer designed for differential inputs and output locations on modern chipsets in an easy to use surface mount package. The BD2425N50100A00 is ideal for high volume manufacturing and delivers higher performance than traditional ceramic baluns. The BD2425N50100A00 has an unbalanced port impedance of 50Ω and a 100Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern integrated chipsets. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD2425N50100A00 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

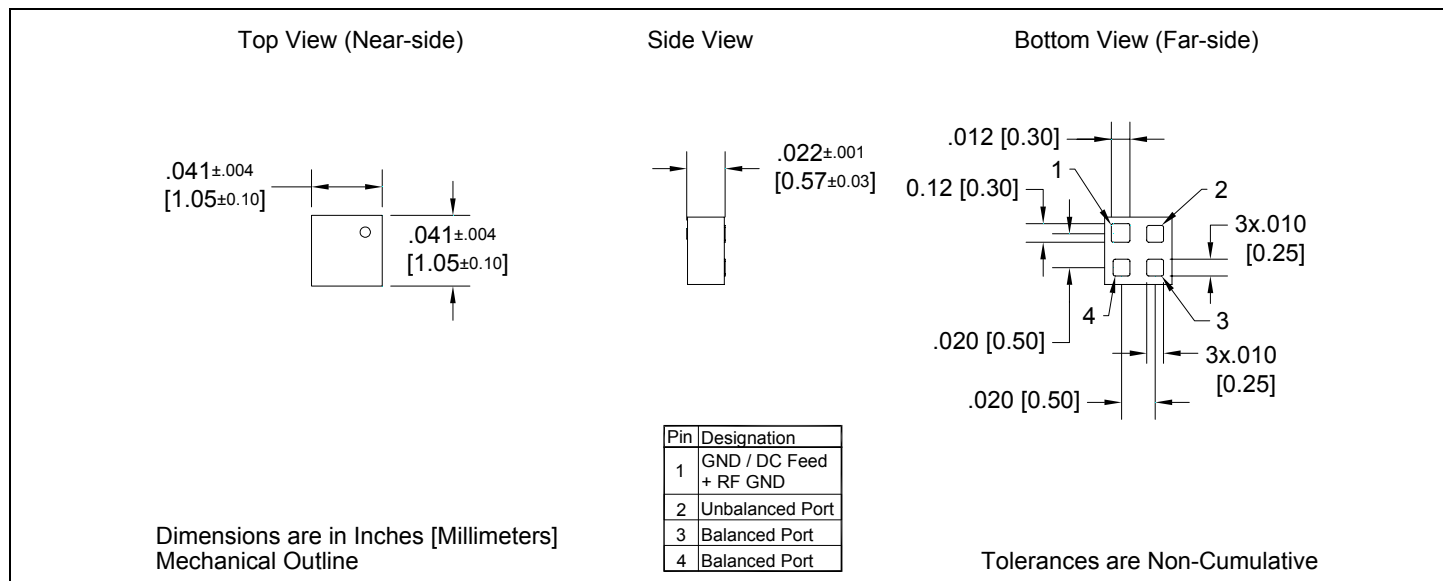
Features:

- 2400 – 2500 MHz
- 0.57 mm Height Profile
- 50 Ohm to 2 x 50 Ohm
- Low Insertion Loss
- 802.11 b+g
- MIMO b+g
- Bluetooth
- Zigbee
- Surface Mountable
- Tape & Reel
- Non-conductive
- RoHS Compliant

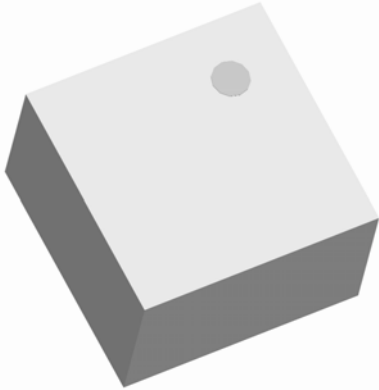
| Parameter | ROOM (25°C) | | | Unit |
|---------------------------|-------------|------|------|---------|
| | Min. | Typ. | Max | |
| Frequency | 2400 | | 2500 | MHz |
| Unbalanced Port Impedance | | 50 | | Ω |
| Balanced Port Impedance | | 100 | | Ω |
| Return Loss | 18 | 25 | | dB |
| Insertion Loss* | | 0.6 | 0.7 | dB |
| Amplitude Balance | | 0.2 | 0.6 | dB |
| Phase Balance | | 1 | 3 | Degrees |
| CMRR | | 37 | | dB |
| Power Handling | | | 1 | Watts |
| Operating Temperature | -55 | | +85 | °C |

* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®



Ultra Low Profile 0404 Balun 50Ω to 200Ω Balanced

Description

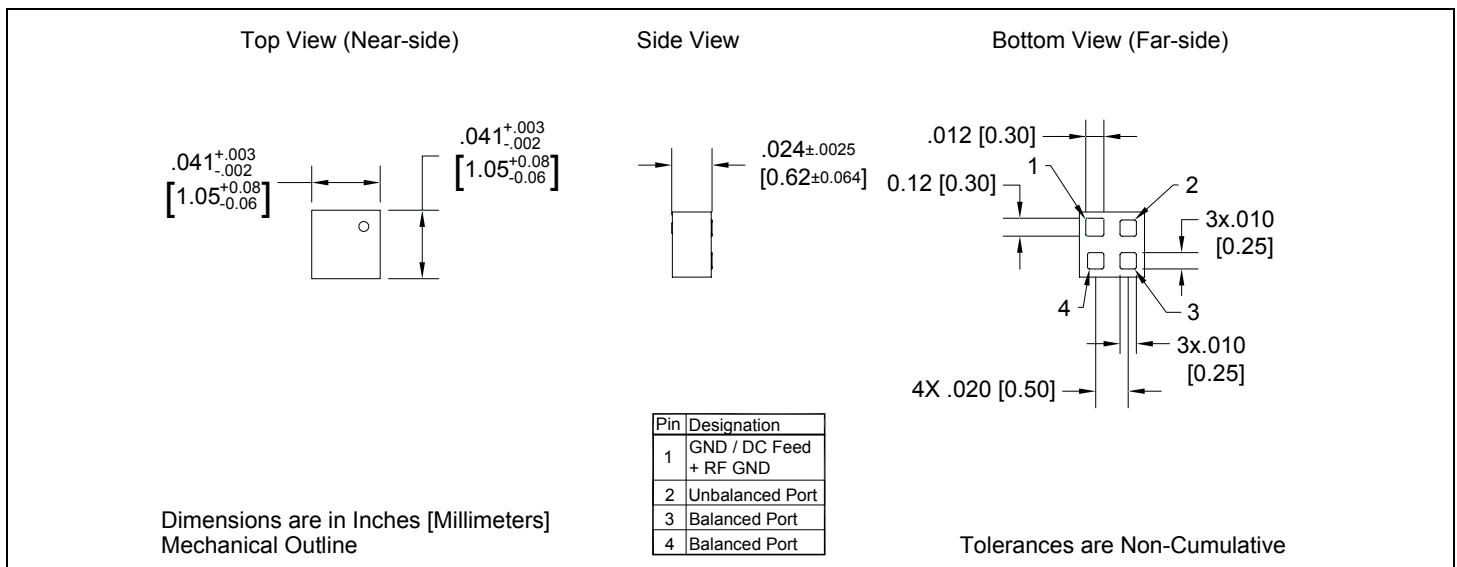
The BD2425N50200A00 is a low cost, low profile sub-miniature unbalanced to balanced transformer designed for differential inputs and output locations on modern chipsets in an easy to use surface mount package. The BD2425N50200A00 is ideal for high volume manufacturing and delivers higher performance than traditional ceramic baluns. The BD2425N50200A00 has an unbalanced port impedance of 50Ω and a 200Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern integrated chipsets. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD2425N50200A00 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

| Features: | Parameter | ROOM (25°C) | | | Unit |
|-------------------------|---------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| • 2400 – 2500 MHz | Frequency | 2400 | | 2500 | MHz |
| • 0.65mm Height Profile | Unbalanced Port Impedance | | 50 | | Ω |
| • 50 Ohm to 2 x 100 Ohm | Balanced Port Impedance | | 200 | | Ω |
| • Low Insertion Loss | Return Loss | 21 | 27 | | dB |
| • 802.11 b+g | Insertion Loss* | | 0.6 | 0.7 | dB |
| • MIMO b+g | Amplitude Balance | | 0.5 | 1.0 | dB |
| • Bluetooth | Phase Balance | | 2 | 6 | Degrees |
| • Zigbee | CMRR | | 29 | | dB |
| • Surface Mountable | Power Handling | | | 1 | Watts |
| • Tape & Reel | Operating Temperature | -55 | | +85 | °C |
| • Non-conductive | | | | | |
| • RoHS Compliant | | | | | |

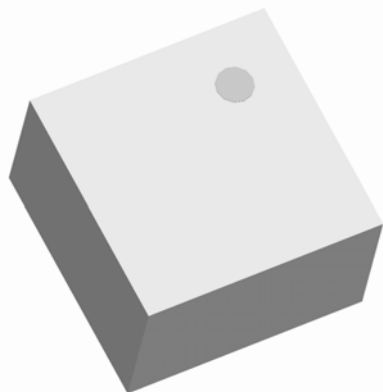
* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®

Nano Profile 0404 Balun 50Ω to 100Ω Balanced



Description

The BD2425P50100A00 is a low cost, nano profile sub-miniature unbalanced to balanced transformer designed for differential inputs and output locations on modern chipsets in an easy to use surface mount package. The BD2425P50100A00 has been developed for placement inside highly integrated, over moldable packaging solutions where overall module height is of greatest concern. Ideal for high volume manufacturing and delivers higher performance than traditional ceramic baluns in a sub 0.5mm height profile. The BD2425P50100A00 has an unbalanced port impedance of 50Ω and a 100Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern integrated chipsets. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD2425P50100A00 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

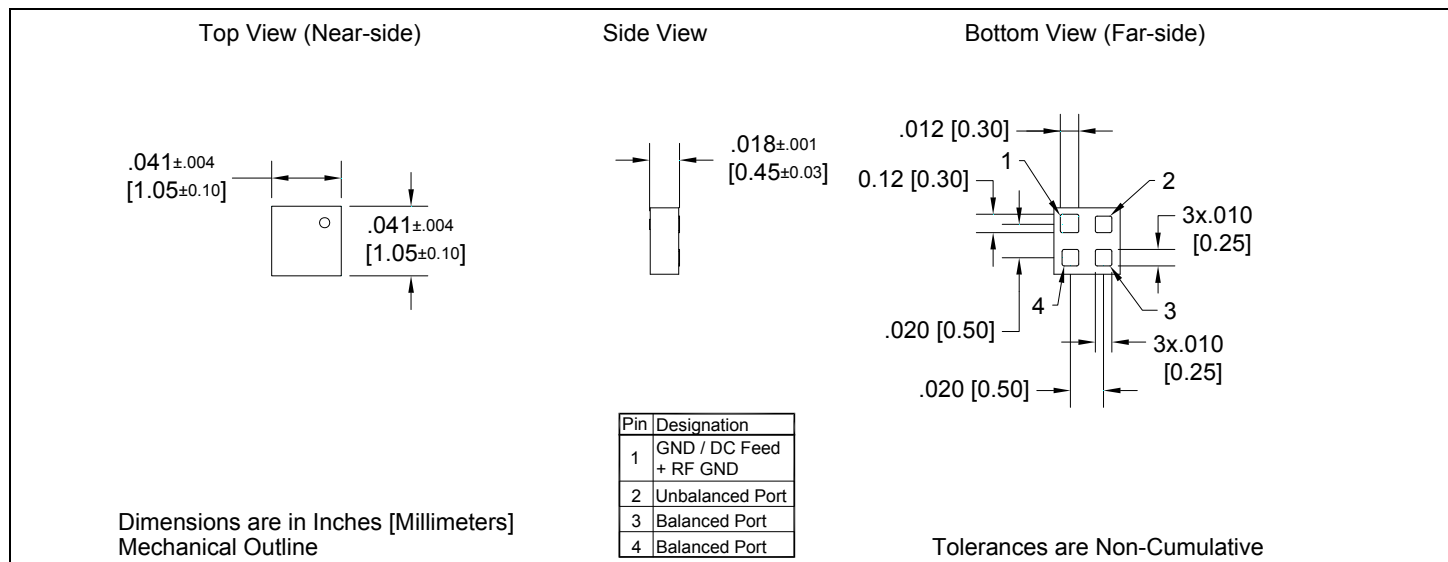
Features:

- 2400 – 2500 MHz
- 0.45mm Height Profile
- 50 Ohm to 2 x 50 Ohm
- Low Insertion Loss
- 802.11 b+g
- MIMO b+g
- Bluetooth
- Zigbee
- Proprietary Ultra Low Power Radio
- Surface Mountable
- Tape & Reel
- RoHS Compliant

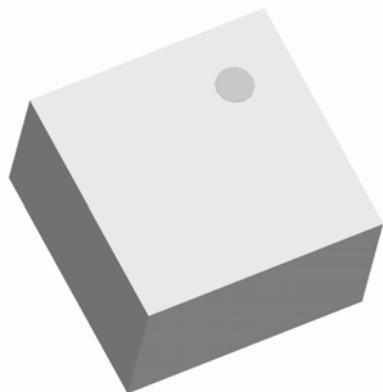
| Parameter | ROOM (25°C) | | | Unit |
|---------------------------|-------------|------|------|---------|
| | Min. | Typ. | Max | |
| Frequency | 2400 | | 2500 | MHz |
| Unbalanced Port Impedance | | 50 | | Ω |
| Balanced Port Impedance | | 100 | | Ω |
| Return Loss | 16 | 25 | | dB |
| Insertion Loss* | | 0.6 | 0.9 | dB |
| Amplitude Balance | | 0.9 | 1.5 | dB |
| Phase Balance | | 6 | 9 | Degrees |
| CMRR | | 24 | | dB |
| Power Handling | | | 1 | Watts |
| Operating Temperature | -55 | | +85 | °C |

* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®



Ultra Low Profile 0404 Balun 50Ω to 100Ω Balanced

Description

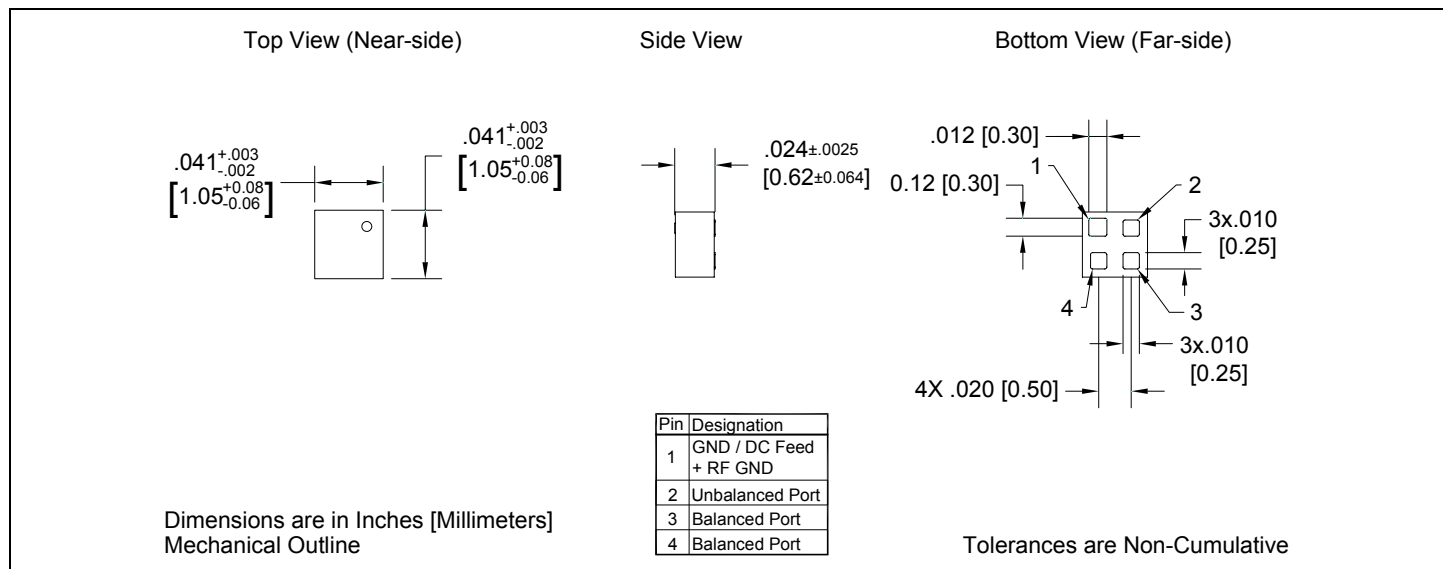
The BD3150N50100A00 is a low cost, low profile sub-miniature unbalanced to balanced transformer designed for differential inputs and output locations on modern chipsets in an easy to use surface mount package covering the MMDS and the low end of the UWB frequency range. The BD3150N50100A00 is ideal for high volume manufacturing and delivers higher performance than traditional ceramic baluns. The BD3150N50100A00 has an unbalanced port impedance of 50Ω and a 100Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern integrated chipsets. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD3150N50100A00 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

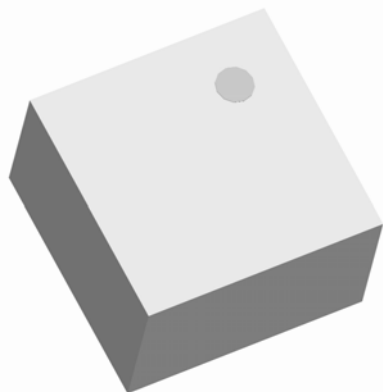
| Features: | Parameter | ROOM (25°C) | | | Unit |
|--------------------------|---------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| • 3100 – 5000 MHz | Frequency | 3100 | | 5000 | MHz |
| • 0.65mm Height Profile | Unbalanced Port Impedance | | 50 | | Ω |
| • 50 Ohm to 2 x 50 Ohm | Balanced Port Impedance | | 100 | | Ω |
| • Low Insertion Loss | Return Loss | 16 | 21 | | dB |
| • UWB & MMDS | Insertion Loss* | | 0.6 | 0.7 | dB |
| • Surface Mountable | Amplitude Balance | | 0.8 | 1.3 | dB |
| • Tape & Reel | Phase Balance | | 3 | 7 | Degrees |
| • Non-conductive Surface | CMRR | | 26 | | dB |
| • RoHS Compliant | Power Handling | | | 1 | Watts |
| | Operating Temperature | -55 | | +85 | °C |

* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®



Ultra Low Profile 0404 Balun 50Ω to 50Ω Balanced

Description

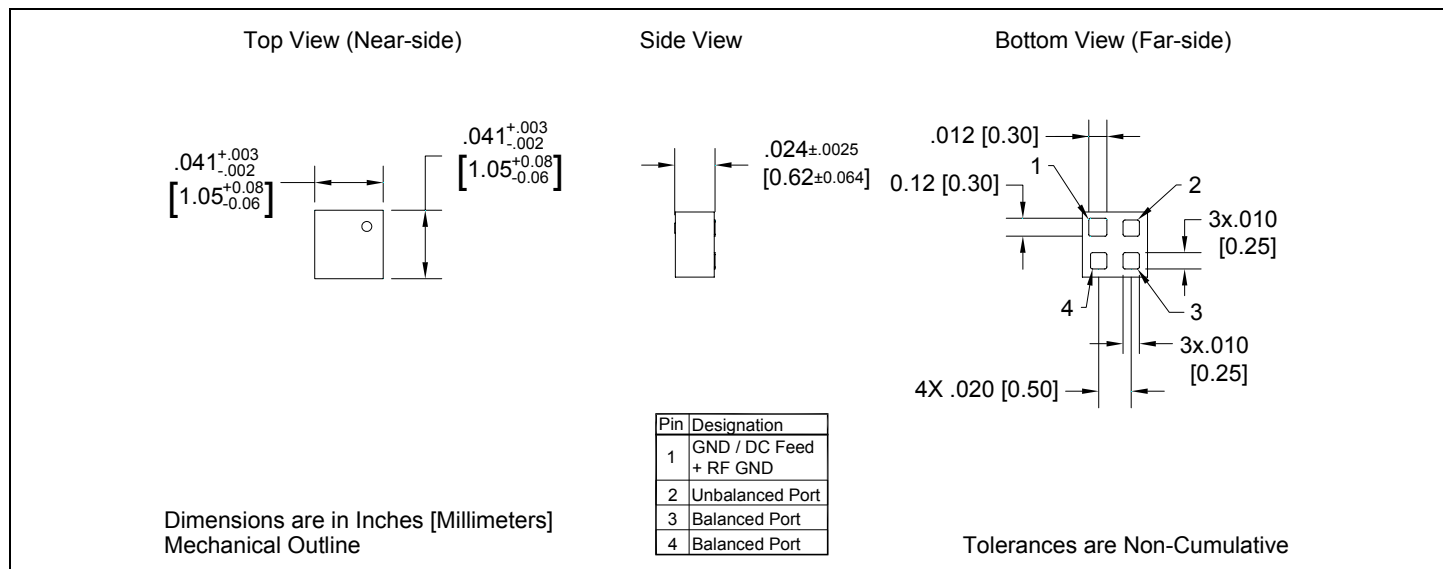
The B4859N5050A00 is a low cost, low profile sub-miniature unbalanced to balanced transformer designed for differential inputs and output locations on modern chipsets in an easy to use surface mount package covering 802.11a Uni-Band II & III and the Japanese ISM band (4.9 GHz). The B4859N5050A00 is ideal for high volume manufacturing and delivers higher performance than traditional ceramic baluns. The B4859N5050A00 has an unbalanced port impedance of 50Ω and a 50Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern integrated chipsets. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The B4859N5050A00 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

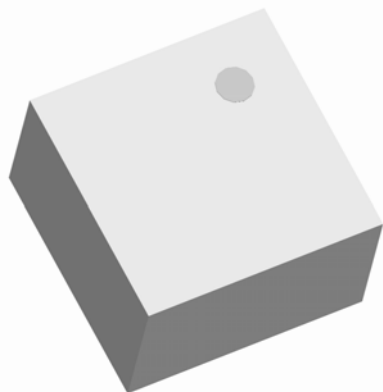
| Features: | Parameter | ROOM (25°C) | | | Unit |
|-----------------------------|---------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| • 4800 – 5900 MHz | Frequency | 4800 | | 5900 | MHz |
| • 0.65mm Height Profile | Unbalanced Port Impedance | | 50 | | Ω |
| • 50 Ohm to 2 x 25 Ohm | Balanced Port Impedance | | 50 | | Ω |
| • Low Insertion Loss | Return Loss | 16 | 22 | | dB |
| • 802.11a Uni-Band II & III | Insertion Loss* | | 0.5 | 0.7 | dB |
| • Home Cordless Compliant | Amplitude Balance | | 0.7 | 1.2 | dB |
| • Surface Mountable | Phase Balance | | 3 | 7 | Degrees |
| • Tape & Reel | CMRR | | 27 | | dB |
| • Non-conductive Surface | Power Handling | | | 1 | Watts |
| • RoHS Compliant | Operating Temperature | -55 | | +85 | °C |

* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®



Ultra Low Profile 0404 Balun 50Ω to 75Ω Balanced

Description

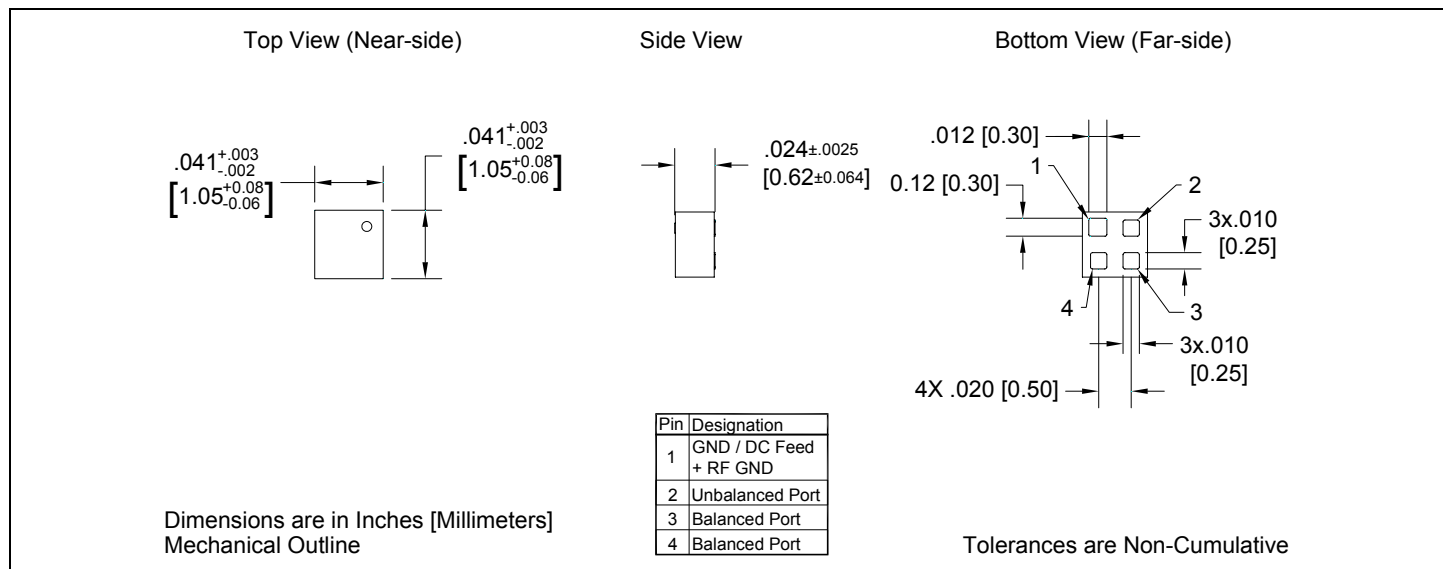
The BD4859N5075A00 is a low cost, low profile sub-miniature unbalanced to balanced transformer designed for differential inputs and output locations on modern chipsets in an easy to use surface mount package covering 802.11a Uni-Band II & III and the Japanese ISM band (4.9 GHz). The BD4859N5075A00 is ideal for high volume manufacturing and delivers higher performance than traditional ceramic baluns. The BD4859N5075A00 has an unbalanced port impedance of 50Ω and a 75Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern integrated chipsets. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD4859N5075A00 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

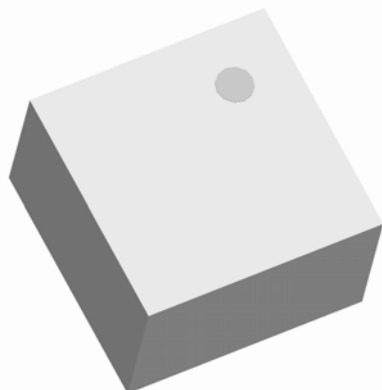
| Features: | Parameter | ROOM (25°C) | | | Unit |
|-----------------------------|---------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| • 4800 – 5900 MHz | Frequency | 4800 | | 5900 | MHz |
| • 0.65mm Height Profile | Unbalanced Port Impedance | | 50 | | Ω |
| • 50 Ohm to 2 x 37.5 Ohm | Balanced Port Impedance | | 75 | | Ω |
| • Low Insertion Loss | Return Loss | 15 | 20 | | dB |
| • 802.11a Uni-Band II & III | Insertion Loss* | | 0.3 | 0.5 | dB |
| • Home Cordless Compliant | Amplitude Balance | | 0.5 | 1.0 | dB |
| • Surface Mountable | Phase Balance | | 4 | 9 | Degrees |
| • Tape & Reel | CMRR | | 28 | | dB |
| • Non-conductive Surface | Power Handling | | | 1 | Watts |
| • RoHS Compliant | Operating Temperature | -55 | | +85 | °C |

* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®



Ultra Low Profile 0404 Balun 50Ω to 100Ω Balanced

Description

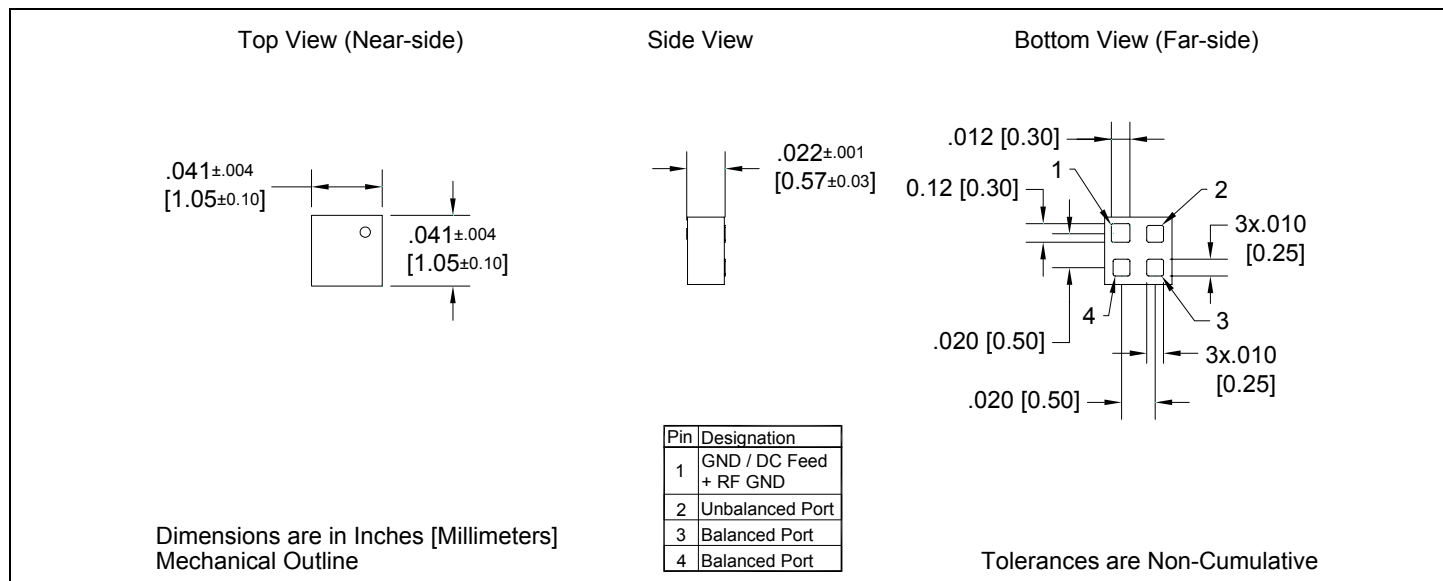
The BD4859N50100A00 is a low cost, low profile sub-miniature unbalanced to balanced transformer designed for differential inputs and output locations on modern chipsets in an easy to use surface mount package covering 802.11a Uni-Band II & III and the Japanese ISM band (4.9 GHz). The BD4859N50100A00 is ideal for high volume manufacturing and delivers higher performance than traditional ceramic baluns. The BD4859N50100A00 has an unbalanced port impedance of 50Ω and a 100Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern integrated chipsets. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD4859N50100A00 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

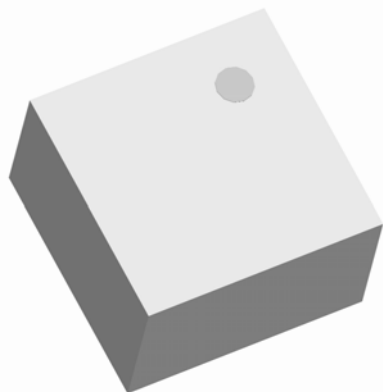
| Features: | Parameter | ROOM (25°C) | | | Unit |
|-----------------------------|---------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| • 4800 – 5900 MHz | Frequency | 4800 | | 5900 | MHz |
| • 0.57 mm Height Profile | Unbalanced Port Impedance | | 50 | | Ω |
| • 50 Ohm to 2 x 50 Ohm | Balanced Port Impedance | | 100 | | Ω |
| • Low Insertion Loss | Return Loss | 15 | 20 | | dB |
| • 802.11a Uni-Band II & III | Insertion Loss* | | 0.4 | 0.6 | dB |
| • Home Cordless Compliant | Amplitude Balance | | 0.9 | 1.5 | dB |
| • Surface Mountable | Phase Balance | | 3 | 8 | Degrees |
| • Tape & Reel | CMRR | | 26 | | dB |
| • Non-conductive Surface | Power Handling | | | 1 | Watts |
| • RoHS Compliant | Operating Temperature | -55 | | +85 | °C |

* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®



Ultra Low Profile 0404 Balun 50Ω to 150Ω Balanced

Description

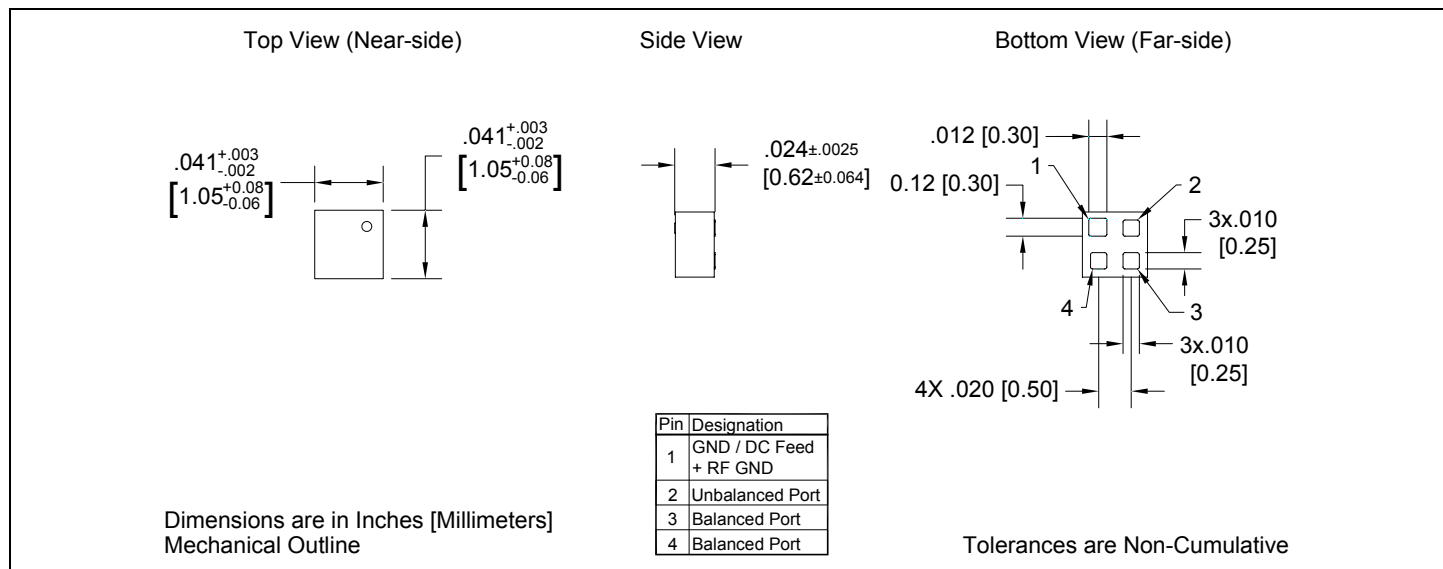
The BD4859N50150A00 is a low cost, low profile sub-miniature unbalanced to balanced transformer designed for differential inputs and output locations on modern chipsets in an easy to use surface mount package covering 802.11a Uni-Band II & III and the Japanese ISM band (4.9 GHz). The BD4859N50150A00 is ideal for high volume manufacturing and delivers higher performance than traditional ceramic baluns. The BD4859N50150A00 has an unbalanced port impedance of 50Ω and a 150Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern integrated chipsets. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD4859N50150A00 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

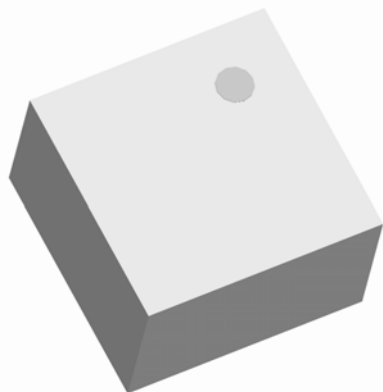
| Features: | Parameter | ROOM (25°C) | | | Unit |
|--|---------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| <ul style="list-style-type: none"> 4800 – 5900 MHz 0.65mm Height Profile 50 Ohm to 2 x 75 Ohm Low Insertion Loss 802.11a Uni-Band II & III Home Cordless Compliant Surface Mountable Tape & Reel Non-conductive Surface RoHS Compliant | Frequency | 4800 | | 5900 | MHz |
| | Unbalanced Port Impedance | | 50 | | Ω |
| | Balanced Port Impedance | | 150 | | Ω |
| | Return Loss | 12 | 17 | | dB |
| | Insertion Loss* | | 0.4 | 0.6 | dB |
| | Amplitude Balance | | 0.8 | 1.4 | dB |
| | Phase Balance | | 4 | 10 | Degrees |
| | CMRR | | 26 | | dB |
| | Power Handling | | | 1 | Watts |
| | Operating Temperature | -55 | | +85 | °C |

* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®



Ultra Low Profile 0404 Balun 50Ω to 200Ω Balanced

Description

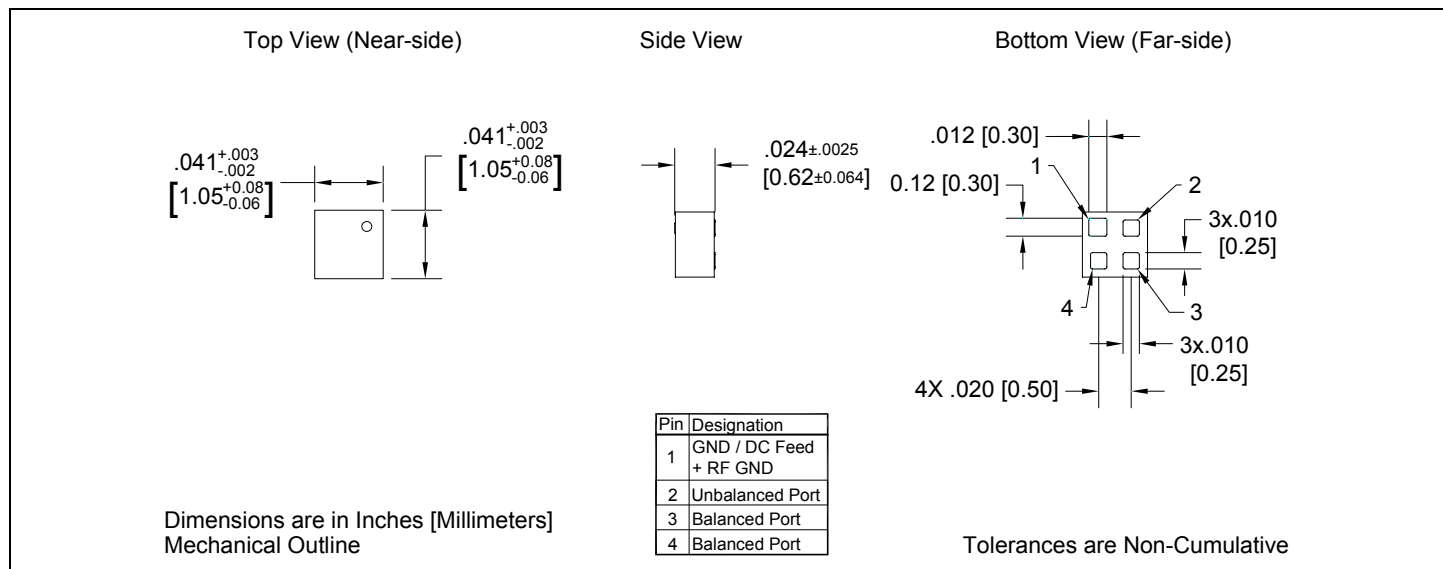
The BD4859N50200A00 is a low cost, low profile sub-miniature unbalanced to balanced transformer designed for differential inputs and output locations on modern chipsets in an easy to use surface mount package covering 802.11a Uni-Band II & III and the Japanese ISM band (4.9 GHz). The BD4859N50200A00 is ideal for high volume manufacturing and delivers higher performance than traditional ceramic baluns. The BD4859N50200A00 has an unbalanced port impedance of 50Ω and a 200Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern integrated chipsets. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD4859N50200A00 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

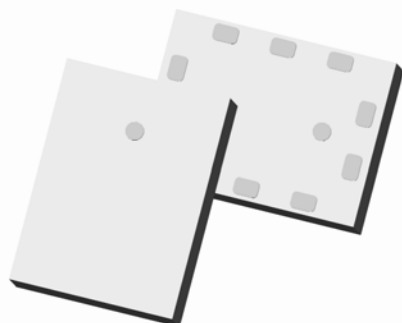
| Features: | Parameter | ROOM (25°C) | | | Unit |
|-----------------------------|---------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| • 4800 – 5900 MHz | Frequency | 4800 | | 5900 | MHz |
| • 0.65mm Height Profile | Unbalanced Port Impedance | | 50 | | Ω |
| • 50 Ohm to 2 x 100 Ohm | Balanced Port Impedance | | 200 | | Ω |
| • Low Insertion Loss | Return Loss | 18 | 23 | | dB |
| • 802.11a Uni-Band II & III | Insertion Loss* | | 0.4 | 0.5 | dB |
| • Home Cordless Compliant | Amplitude Balance | | 0.3 | 0.8 | dB |
| • Surface Mountable | Phase Balance | | 4 | 9 | Degrees |
| • Tape & Reel | CMRR | | 29 | | dB |
| • Non-conductive Surface | Power Handling | | | 1 | Watts |
| • RoHS Compliant | Operating Temperature | -55 | | +85 | °C |

* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®



Ultra Low Profile 1008 Balun 75Ω to 300Ω Balanced

Description

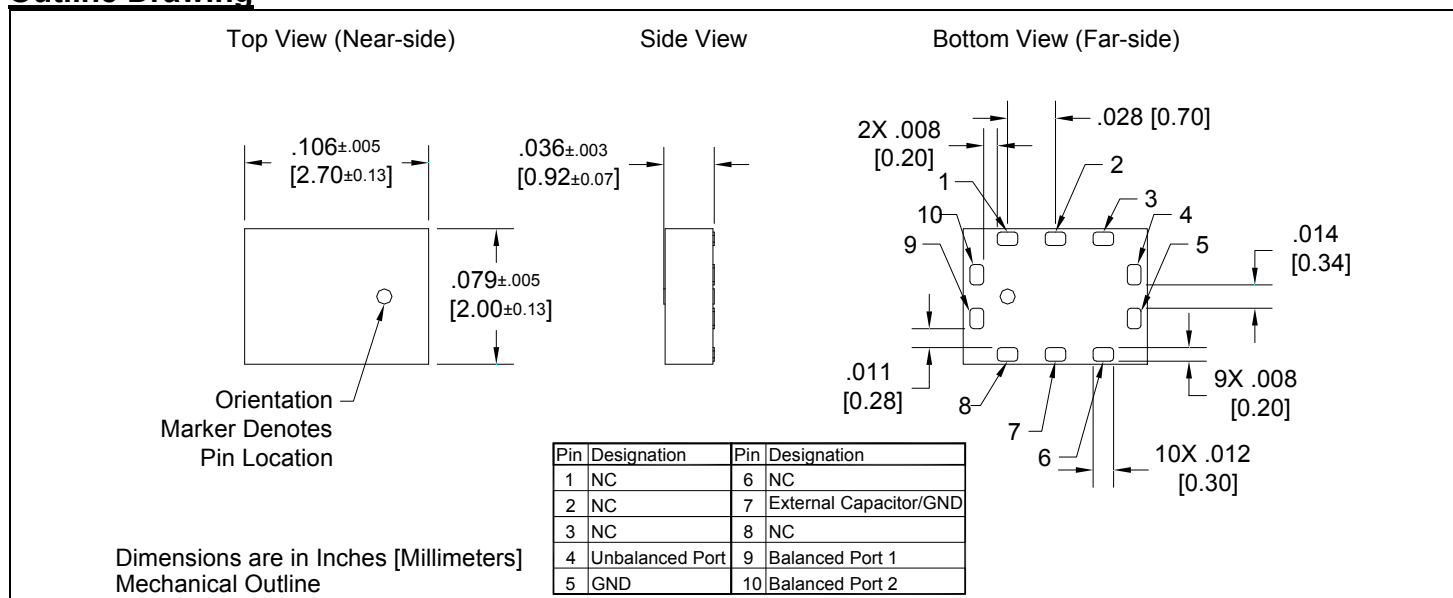
The B0011E75300A00 is a low profile sub-miniature balanced to unbalanced transformer designed for differential inputs and output locations on next generation digital TV chipsets in an easy to use surface mount package. The B0011E75300A00 is ideal for high volume manufacturing and is higher performance than traditional wire wound baluns. The B0011E75300A00 has an unbalanced port impedance of 75Ω and a 300Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern semiconductors. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The B0011E75300A00 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

| Features: | Parameter | ROOM (25°C) | | | Unit |
|--------------------------|---------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| • 48 – 1080 MHz | Frequency | 48 | | 1080 | MHz |
| • 1.0 mm Height Profile | Unbalanced Port Impedance | | 75 | | Ω |
| • 75 Ohm to 2 x 150 Ohm | Balanced Port Impedance | | 300 | | Ω |
| • Broadcast TV | Return Loss | 9 | 11 | | dB |
| • Low Insertion Loss | Insertion Loss* | | 1.3 | 1.6 | dB |
| • Surface Mountable | Amplitude Balance | | 0.6 | 1.5 | dB |
| • Tape & Reel | Phase Balance | | 6 | 15 | Degrees |
| • Non-conductive Surface | CMRR | | 28 | | dB |
| • RoHS Compliant | Power Handling | | | TBD | Watts |
| | Operating Temperature | -55 | | +85 | °C |

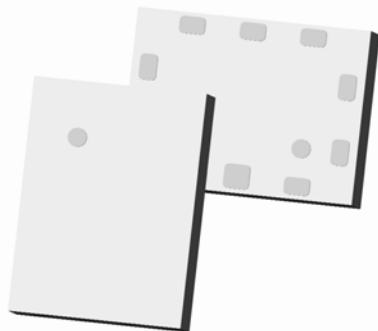
* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.15 dB higher at +85 °C). All performances stated for recommended operation with external circuitry.

Outline Drawing



Xinger®

Ultra Low Profile Filter Balun 50Ω to 100Ω Balanced



Description

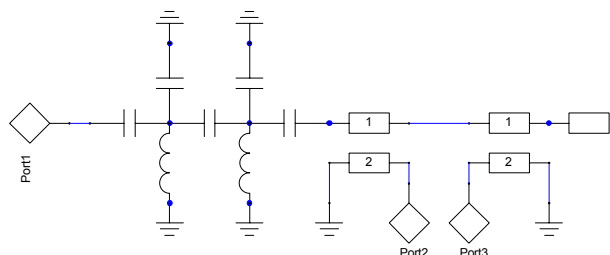
The FB2425E50100A00 is a low cost, low profile sub-miniature unbalanced to balanced transformer designed for differential inputs and output locations on next generation wireless chipsets in an easy to use surface mount package covering wireless LAN (802.11b/g/n) and Bluetooth frequencies (2400 MHz – 2500 MHz). The FB2425E50100A00 is ideal for high volume manufacturing and is in a lower profile unit than traditional ceramic parts. The FB2425E50100A00 has an unbalanced port impedance of 50Ω and a 100Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern semiconductors. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The FB2425E50100A00 is available on tape and reel for high volume pick and place manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

| Features: | Parameter | ROOM (25°C) | | | Unit |
|--|---------------------------|-------------|------|-----|-----------|
| | | Min. | Typ. | Max | |
| <ul style="list-style-type: none"> 2.4 – 2.5 GHz. Low Height Profile 50 Ohm to 2 x 50 Ohm 802.11b + g + n Compliant Medium Power No DC Decoupling Capacitors Required Input to Output DC Isolation Surface Mountable Tape & Reel Integral Filter Integrated Bandpass Filter Inverted Balun Configuration Non-conductive Surface RoHS Compliant | Frequency | 2.4 | | 2.5 | GHz |
| | Unbalanced Port Impedance | | 50 | | Ω |
| | Balanced Port Impedance | | 100 | | Ω |
| | Return Loss | 9.5 | 14 | | dB |
| | Insertion Loss* | | 2.3 | 2.6 | dB |
| | Amplitude Balance | | 0.5 | 1.0 | dB |
| | Phase Balance | | 63 | 65 | Degrees |
| | Attenuation @ 930 MHz. | 45 | 52 | | dB |
| | Attenuation @ 1500 MHz. | 45 | 52 | | dB |
| | Attenuation @ 1910 MHz. | 18 | 22 | | dB |
| | Attenuation @ 4800 MHz. | 23 | 25 | | dB |
| | Attenuation @ 5000 MHz. | 25 | 27 | | dB |
| | Power Handling | | | 0.5 | Watts |
| | Thermal Resistance | | | TBD | °C / Watt |
| | Operating Temperature | -55 | | +85 | °C |

* Insertion Loss stated at room temperature (2.8 dB Max at +85 °C)

Pin Configuration



The internal configuration of the Ultra low profile filter balun is diagramed to the left. A lumped element filter is located in front of the unbalanced input of the balun. The unbalanced port is terminated in an open-circuit and the two balanced ports are connected to ground.

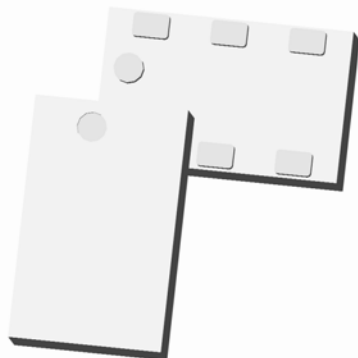
The use of differential circuits is increasing in highly integrated circuits, because of its inherent noise immunity properties. Differential circuits have superior performance when looking at properties like cross coupling, immunity to external noise sources and power supply noise. When designing power amplifiers differential circuits also help minimize 2nd and 3rd order intermodulation products.

The construction of the filter balun is bonded multi-layered stripline made of low loss dielectric material with plated through vias connecting the internal circuitry to the external printed circuit board, similar to that of the other hybrids and directional couplers



Xinger®

Ultra Low Profile 0805 Power Divider 75Ω to 75Ω



Description

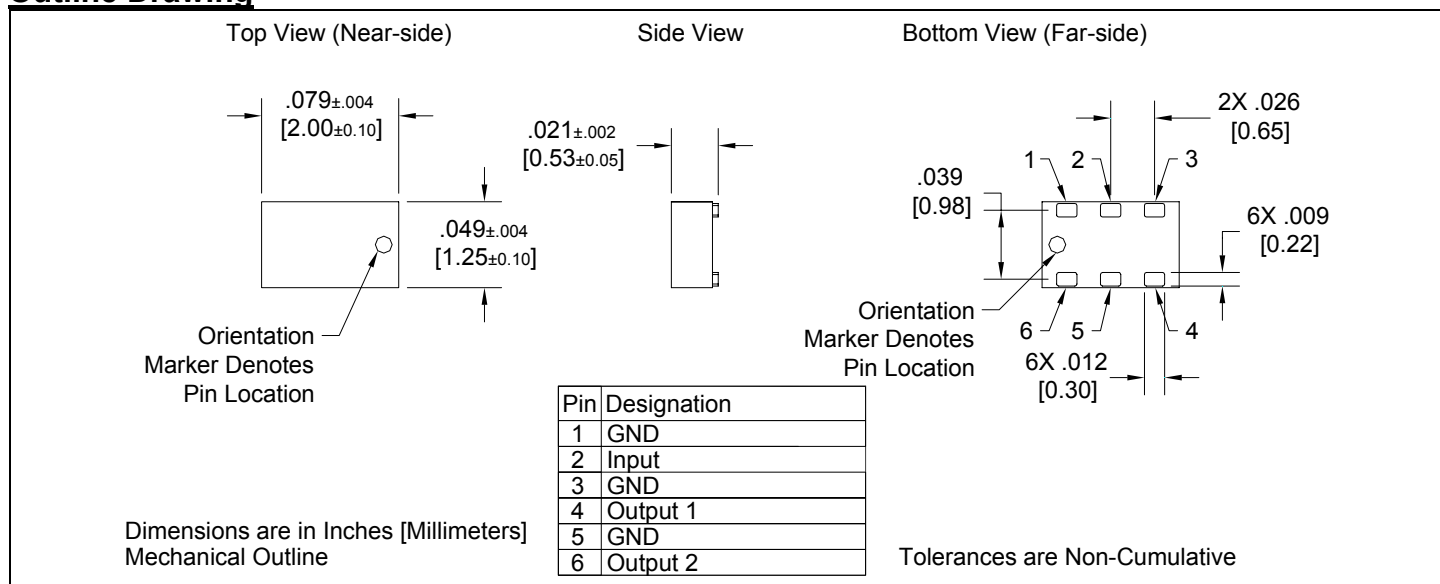
The PD0409J7575S2 is a low profile, sub-miniature Wilkinson power divider in an easy to use surface mount package. The PD0409J7575S2 is ideal for high volume manufacturing and delivers higher performances than traditional printed and lumped element solutions. The PD0409J7575S2 is matched to 75 Ω and has a height profile of 0.5 mm which is ideal for high level integrations in the following markets: GSM, WCDMA, DVB-H (Europe) and Terrestrial TV. The PD0409J7575S2 does not include the resistive element and therefore, requires an external resistor for operation. The PD0409J7575S2 is available on tape and reel for high volume manufacturing pick and place.

Detailed Electrical Specifications: Specifications subject to change without notice.

| Features: | Parameter | ROOM (25°C) | | | Unit |
|-----------------------------------|--------------------------|-------------|------|-----|---------|
| | | Min. | Typ. | Max | |
| • 400-900 MHz | Frequency | 400 | | 900 | MHz |
| • 9.3 dB Isolation (output ports) | Input Port Impedance | | 75 | | Ω |
| • Good Return Loss | Output Port Impedance | | 75 | | Ω |
| • 0.5mm Height Profile | Return Loss | 10 | 12 | | dB |
| • 75Ω Input / 75Ω Outputs | Insertion Loss* | | 0.5 | 0.6 | dB |
| • Low Insertion Loss | Amplitude Balance | | 0.1 | 0.6 | dB |
| • Surface Mountable | Phase Balance | | 1 | 3 | Degrees |
| • Tape & Reel | Isolation (Output Ports) | 8.2 | 9.3 | | dB |
| • Non-conductive Surface | Power Handling | | | 2 | Watts |
| • RoHS Compliant | Operating Temperature | -55 | | +85 | °C |
| • External Resistor Required | | | | | |

* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®

Ultra Low Profile 0805 Power Divider 50Ω to 50Ω

Description

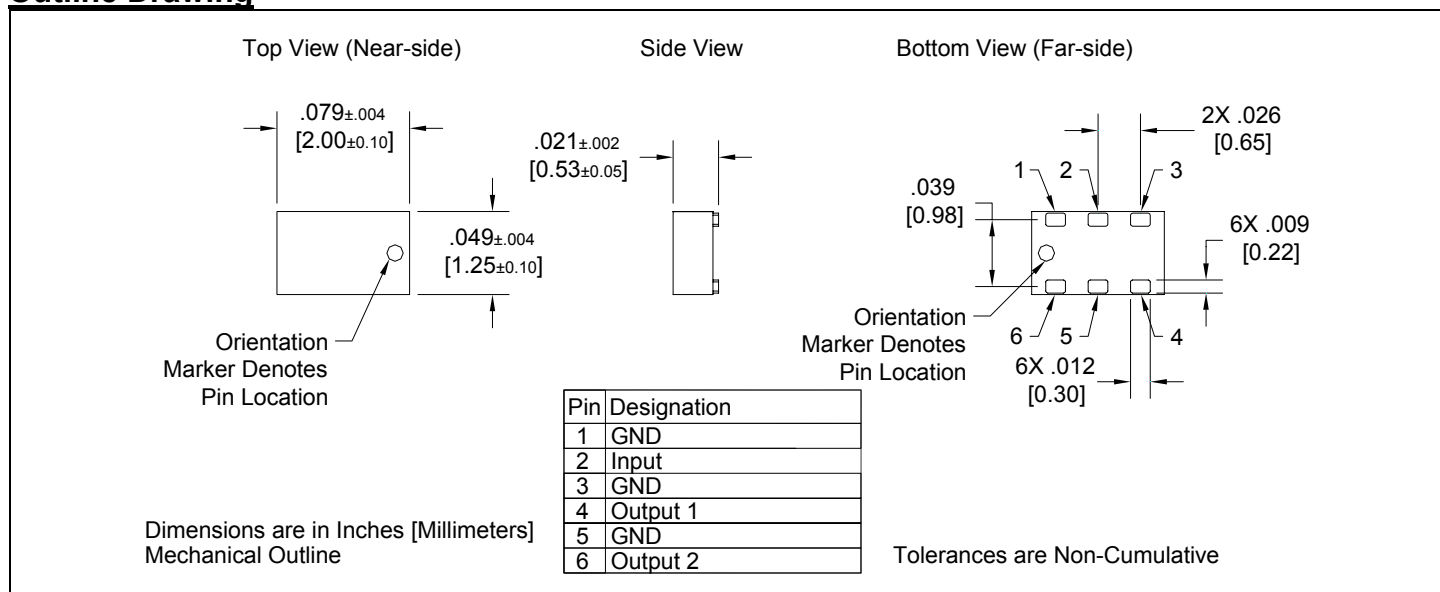
The PD0810J5050S2 is a low profile, sub-miniature Wilkinson power divider in an easy to use surface mount package. The PD0810J5050S2 is ideal for high volume manufacturing and delivers higher performances than traditional printed and lumped element solutions. The PD0810J5050S2 is matched to 50 Ω and has a height profile of 0.5 mm which is ideal for high level integrations in the following markets: GSM, WCDMA, Home Cordless, and RFID. The PD0810J5050S2 does not include the resistive element and therefore, requires an external resistor for operation. The PD0810J5050S2 is available on tape and reel for high volume manufacturing pick and place.

Detailed Electrical Specifications: Specifications subject to change without notice.

| Features: | Parameter | ROOM (25°C) | | | Unit |
|---|--------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| <ul style="list-style-type: none"> 800-1000 MHz 21 dB Isolation (output ports) 0.5mm Height Profile 50Ω Input / 50Ω Outputs Low Insertion Loss Surface Mountable Tape & Reel Non-conductive Surface RoHS Compliant External Resistor required | Frequency | 800 | | 1000 | MHz |
| | Input Port Impedance | | 50 | | Ω |
| | Output Port Impedance | | 50 | | Ω |
| | Return Loss | 14 | 19 | | dB |
| | Insertion Loss* | | 0.5 | 0.6 | dB |
| | Amplitude Balance | | 0.3 | 0.8 | dB |
| | Phase Balance | | 1 | 4 | Degrees |
| | Isolation (Output Ports) | 17 | 21 | | dB |
| | Power Handling | | | 2 | Watts |
| | Operating Temperature | -55 | | +85 | °C |

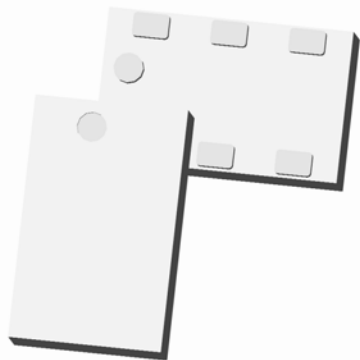
* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®

Ultra Low Profile 0805 Power Divider 50Ω to 50Ω



Description

The PD0922J5050D2 is a low profile, sub-miniature Wilkinson power divider in an easy to use surface mount package. The PD0922J5050D2 is ideal for high volume manufacturing and delivers higher performances than traditional printed and lumped element solutions. The PD0922J5050D2 is matched to 50 Ω and has a height profile of 0.8 mm which is ideal for high level integrations. The PD0922J5050D2 uses a 2 section Wilkinson design which results in increased isolation performance. The PD0922J5050D2 does not include the resistive elements and therefore, requires two external resistors for operation. The PD0922J5050D2 is available on tape and reel for high volume manufacturing pick and place.

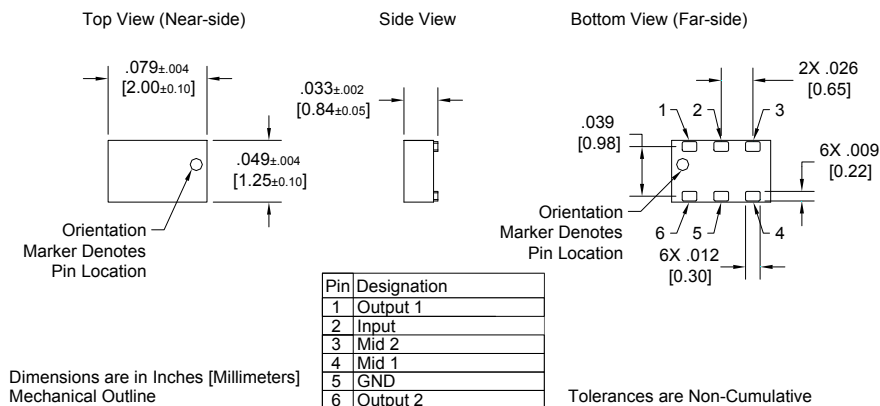
Addressable Markets: **DVB-S, DVB-H (USA), GSM, DCS, PCS, CDMA, WiMAX, 802.11b & g, Bluetooth, ZigBee and GPS**

Detailed Electrical Specifications: Specifications subject to change without notice.

| Features: | Parameter | ROOM (25°C) | | | Unit |
|---------------------------------|--------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| • 950 – 2150 MHz | Frequency | 950 | | 2150 | MHz |
| • 12dB Isolation (output ports) | Input Port Impedance | | 50 | | Ω |
| • Low Return Loss | Output Port Impedance | | 50 | | Ω |
| • 0.8mm Height Profile | Return Loss | 9.4 | 11 | | dB |
| • 50Ω Outputs/Inputs | Insertion Loss* | | 0.6 | 0.7 | dB |
| • External resistors required | Amplitude Balance | | <0.1 | 0.4 | dB |
| • Low Insertion Loss | Phase Balance | | 1 | 3 | Degrees |
| • Surface Mountable | Isolation (Output Ports) | 11 | 12 | | dB |
| • Tape & Reel | Power Handling | | | | Watts |
| • Non-conductive Surface | Operating Temperature | -55 | | +85 | °C |
| • RoHS Compliant | | | | | |

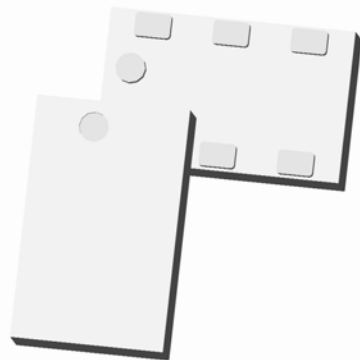
* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®

Ultra Low Profile 0805 Power Divider 50Ω to 75Ω



Description

The PD0922J5075D2 is a low profile, sub-miniature Wilkinson power divider in an easy to use surface mount package and is ideal for high volume manufacturing while delivering higher performances than traditional printed and lumped element solutions. It has been designed for the following markets: DVB-S, GSM, DCS, PCS, WCDMA, GPS, 802.11a/g, Bluetooth, and Zigbee USA.

The PD0922J5075D2 is matched to 50Ω at the input and 75Ω at the outputs and has a height profile of 0.8 mm. A two section Wilkinson design results in increased isolation performance. Two external resistors are required for operation. Components are available on tape and reel for high volume manufacturing pick and place.

All Xinger components are constructed from ceramic filled PTFE composites which possess excellent electrical and mechanical stability having X and Y thermal coefficient of expansion (CTE) of 17 ppm/°C.

Detailed Electrical Specifications: Specifications subject to change without notice.

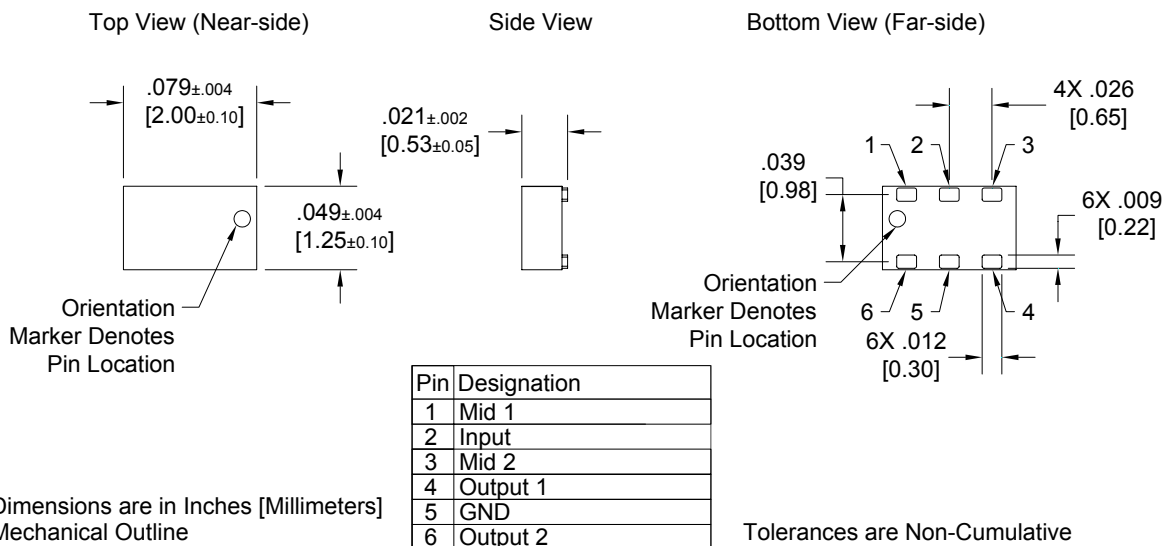
Features:

- 950 – 2150 MHz
- 14 dB Isolation (output ports)
- Good Return Loss
- 0.8mm Height Profile
- 50Ω Input/ 75Ω Output
- External resistors required
- Low Insertion Loss
- Surface Mountable
- Tape & Reel
- Non-conductive Surface
- RoHS Compliant

| Parameter | ROOM (25°C) | | | Unit |
|--------------------------|-------------|------|------|---------|
| | Min. | Typ. | Max | |
| Frequency | 950 | | 2150 | MHz |
| Input Port Impedance | | 50 | | Ω |
| Output Port Impedance | | 75 | | Ω |
| Return Loss | 11 | 13 | | dB |
| Insertion Loss* | | 0.5 | 0.7 | dB |
| Amplitude Balance | | 0.1 | 0.3 | dB |
| Phase Balance | | 1 | 3 | Degrees |
| Isolation (Output Ports) | 12 | 14 | | dB |
| Power Handling | | | 2 | Watts |
| Operating Temperature | -55 | | +85 | °C |

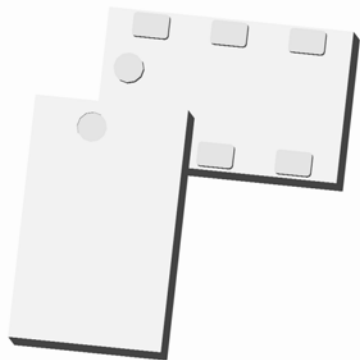
* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®

Ultra Low Profile 0805 Power Divider 75Ω to 75Ω



Description

The PD0922J7575D2 is a low profile, sub-miniature Wilkinson power divider in an easy to use surface mount package and is ideal for high volume manufacturing while delivering higher performances than traditional printed and lumped element solutions. It has been designed for the following markets: DVB-S, GSM, DCS, PCS, WCDMA, GPS, 802.11a+g, Bluetooth, and Zigbee USA.

The PD0922J7575D2 is matched to 75Ω and has a height profile of 0.8 mm. A two section Wilkinson design results in increased isolation performance. Two external resistors are required for operation. Components are available on tape and reel for high volume manufacturing pick and place.

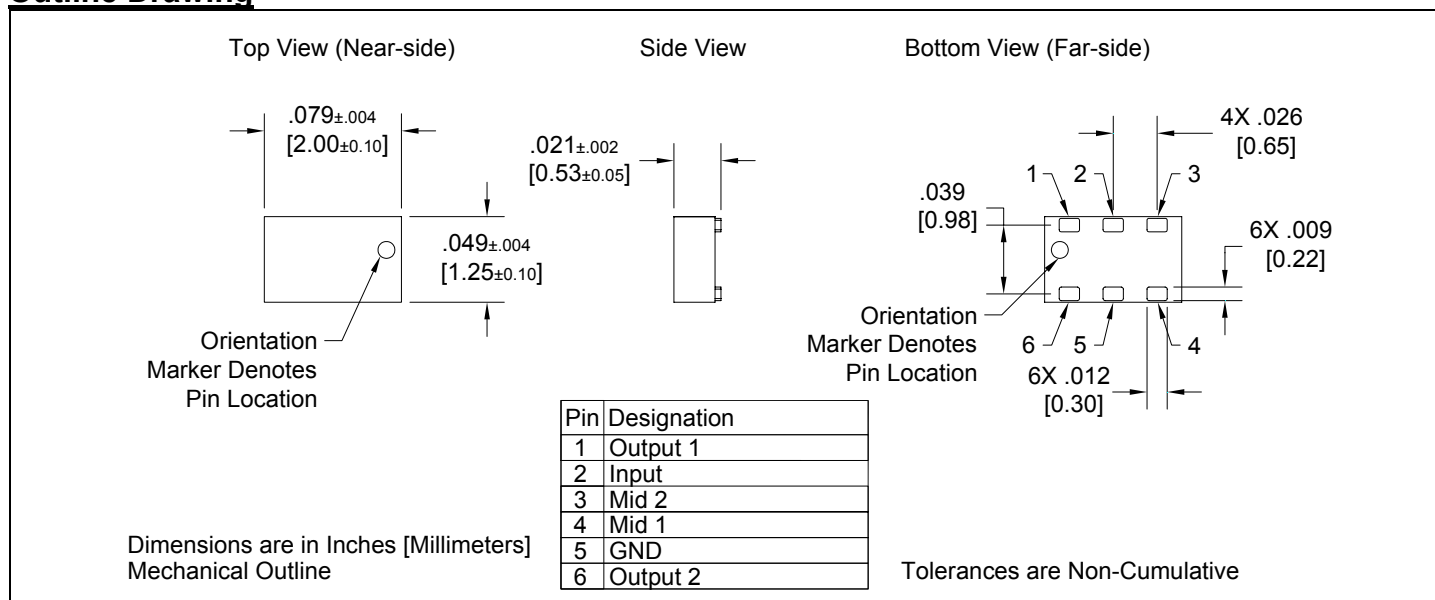
All Xinger components are constructed from ceramic filled PTFE composites which possess excellent electrical and mechanical stability having X and Y thermal coefficient of expansion (CTE) of 17 ppm/°C.

Detailed Electrical Specifications: Specifications subject to change without notice.

| Features: | Parameter | ROOM (25°C) | | | Unit |
|----------------------------------|--------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| • 950 – 2150 MHz | Frequency | 950 | | 2150 | MHz |
| • 16 dB Isolation (output ports) | Input Port Impedance | | 75 | | Ω |
| • Good Return Loss | Output Port Impedance | | 75 | | Ω |
| • 0.8mm Height Profile | Return Loss | 9.5 | 11 | | dB |
| • 75Ω Outputs/Inputs | Insertion Loss* | | 0.8 | 1.0 | dB |
| • External resistors required | Amplitude Balance | | 0.4 | 0.7 | dB |
| • Low Insertion Loss | Phase Balance | | 2 | 3 | Degrees |
| • Surface Mountable | Isolation (Output Ports) | 14 | 16 | | dB |
| • Tape & Reel | Power Handling | | | 2 | Watts |
| • Non-conductive Surface | Operating Temperature | -55 | | +85 | °C |
| • RoHS Compliant | | | | | |

* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®

Ultra Low Profile 0805 Power Divider 50Ω to 50Ω

Description

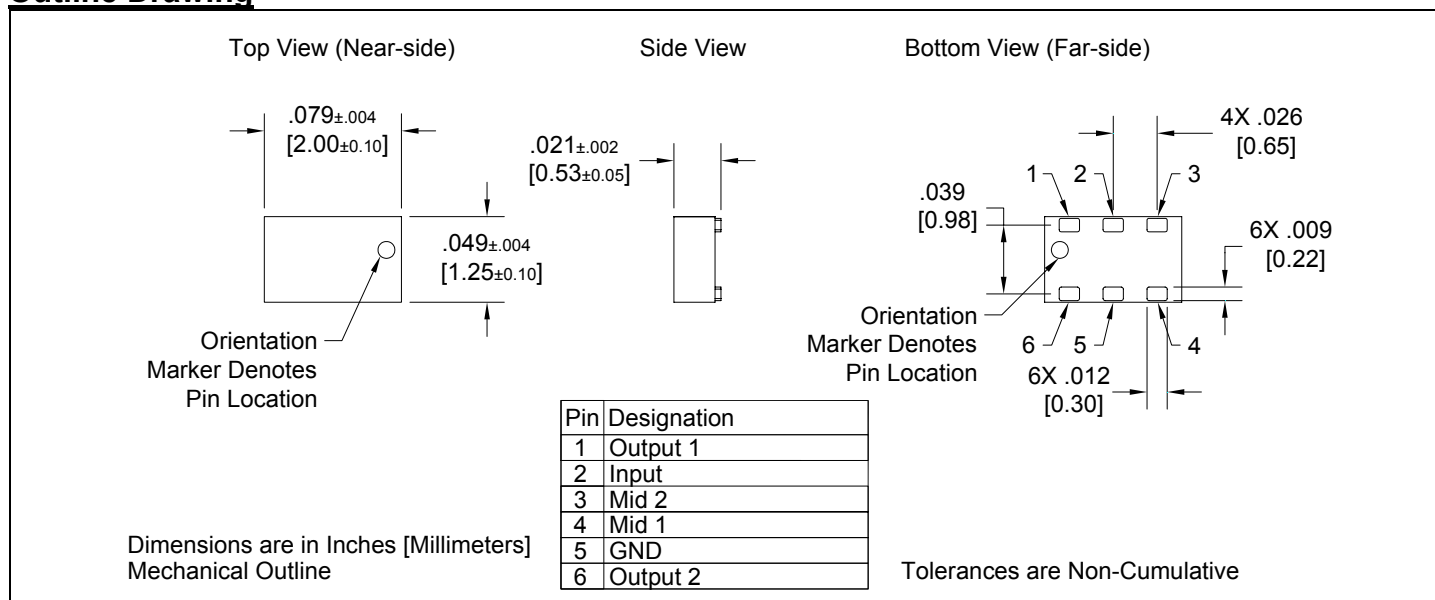
The PD1722J5050D2 is a low profile, sub-miniature Wilkinson power divider in an easy to use surface mount package. The PD1722J5050D2 is ideal for high volume manufacturing and delivers higher performances than traditional printed and lumped element solutions. The PD1722J5050D2 is matched to 50 Ω and has a height profile of 0.5 mm which is ideal for high level integrations in the following markets: WCDMA, and GSM. The PD1722J5050D2 does not include the resistive element and therefore, requires an external resistor for operation. The PD1722J5050D2 is available on tape and reel for high volume manufacturing pick and place.

Detailed Electrical Specifications: Specifications subject to change without notice.

| Features: | Parameter | ROOM (25°C) | | | Unit |
|---|--------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| <ul style="list-style-type: none"> 1700-2200 MHz 19 dB Isolation (output ports) 0.5mm Height Profile 50Ω Input / 50Ω Outputs Low Insertion Loss Surface Mountable Tape & Reel Non-conductive Surface RoHS Compliant External resistors required | Frequency | 1700 | | 2200 | MHz |
| | Input Port Impedance | | 50 | | Ω |
| | Output Port Impedance | | 50 | | Ω |
| | Return Loss | 11 | 14 | | dB |
| | Insertion Loss* | | 0.5 | 0.7 | dB |
| | Amplitude Balance | | 0.1 | 0.3 | dB |
| | Phase Balance | | 1 | 3 | Degrees |
| | Isolation (Output Ports) | 17 | 19 | | dB |
| | Power Handling | | | 2 | Watts |
| | Operating Temperature | -55 | | +85 | °C |

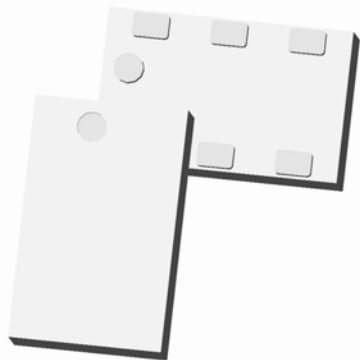
* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®

Ultra Low Profile 0805 Power Divider 50Ω to 50Ω



Description

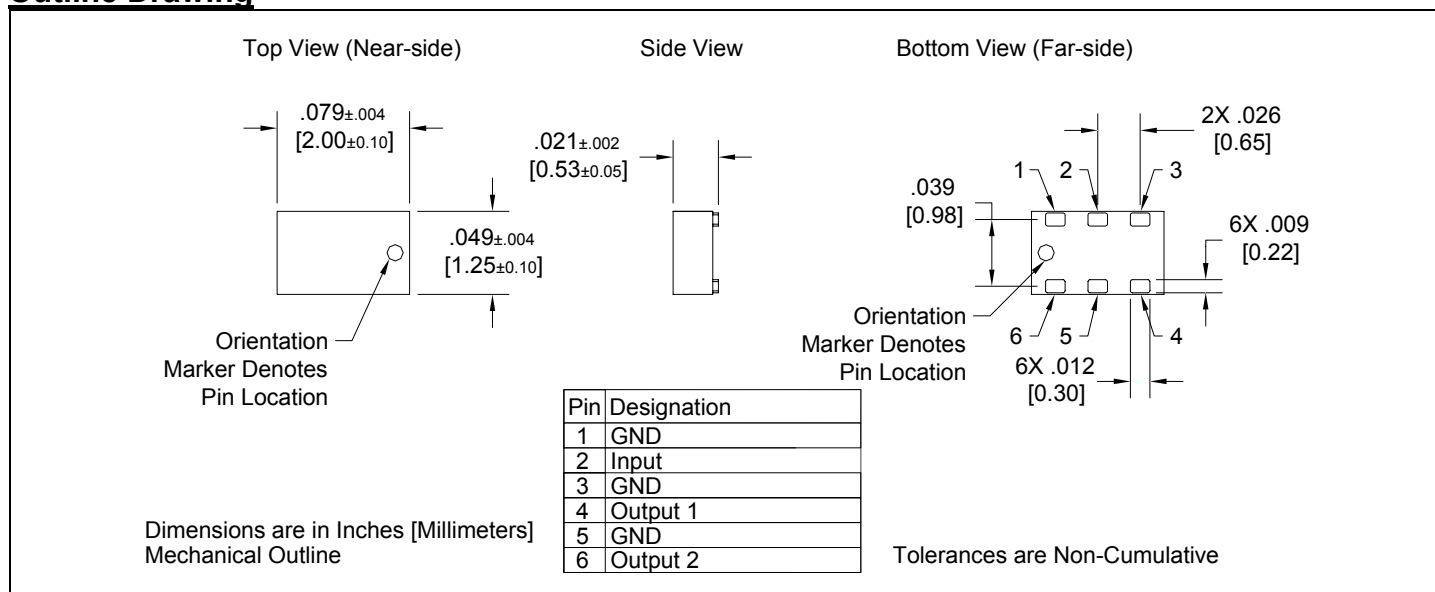
The PD2328J5050S2 is a low profile, sub-miniature Wilkinson power divider in an easy to use surface mount package. The PD2328J5050S2 is ideal for high volume manufacturing and delivers higher performances than traditional printed and lumped element solutions. The PD2328J5050S2 is matched to 50 Ω and has a height profile of 0.5 mm which is ideal for high level integrations in the following markets: WiMAX, 802.11b & g, Bluetooth, ZigBee, and XM & Sirius radio. The PD2328J5050S2 does not include the resistive element and therefore, requires an external resistor for operation. The PD2328J5050S2 is available on tape and reel for high volume manufacturing pick and place.

Detailed Electrical Specifications: Specifications subject to change without notice.

| Features: | Parameter | ROOM (25°C) | | | Unit |
|--|--------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| <ul style="list-style-type: none"> 2300-2800 MHz 21 dB Isolation (output ports) Good Return Loss 0.5mm Height Profile 50Ω Input / 50Ω Outputs Low Insertion Loss Surface Mountable Tape & Reel Non-conductive Surface RoHS Compliant External Resistor Required | Frequency | 2300 | | 2800 | MHz |
| | Input Port Impedance | | 50 | | Ω |
| | Output Port Impedance | | 50 | | Ω |
| | Return Loss | 15 | 19 | | dB |
| | Insertion Loss* | | 0.3 | 0.5 | dB |
| | Amplitude Balance | | 0.1 | 0.3 | dB |
| | Phase Balance | | 1 | 2 | Degrees |
| | Isolation (Output Ports) | 17 | 21 | | dB |
| | Power Handling | | | 2 | Watts |
| | Operating Temperature | -55 | | +85 | °C |

* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®

Ultra Low Profile 0805 Power Divider 50Ω to 50Ω

Description

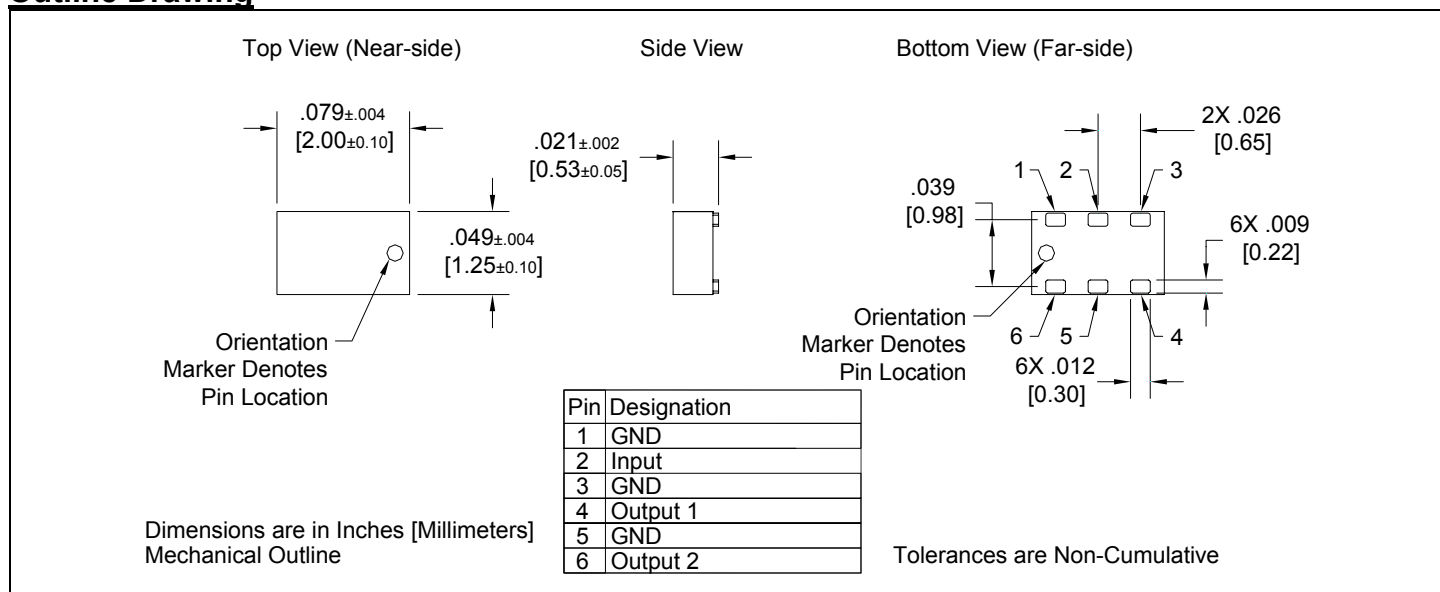
The PD3150J5050S2 is a low profile, sub-miniature Wilkinson power divider in an easy to use surface mount package. The PD3150J5050S2 is ideal for high volume manufacturing and delivers higher performances than traditional printed and lumped element solutions. The PD3150J5050S2 is matched to 50Ω and has a height profile of 0.5 mm which is ideal for high level integrations in the following markets: : DVB-S, GSM, DCS, PCS, WCDMA and GPS, 802.11a+g, Bluetooth, and Zigbee USA. The PD3150J5050S2 does not include the resistive element and therefore, requires an external resistor for operation. The PD3150J5050S2 is available on tape and reel for high volume manufacturing pick and place.

Detailed Electrical Specifications: Specifications subject to change without notice.

| Features: | Parameter | ROOM (25°C) | | | Unit |
|----------------------------------|--------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| • 3100-5000 MHz | Frequency | 3100 | | 5000 | MHz |
| • 15 dB Isolation (output ports) | Input Port Impedance | | 50 | | Ω |
| • 0.5mm Height Profile | Output Port Impedance | | 50 | | Ω |
| • 50Ω Input / 50Ω Outputs | Return Loss | 6.8 | 8.6 | | dB |
| • Low Insertion Loss | Insertion Loss* | | 1.0 | 1.3 | dB |
| • Surface Mountable | Amplitude Balance | | 0.1 | 0.4 | dB |
| • Tape & Reel | Phase Balance | | 1 | 2 | Degrees |
| • Non-conductive Surface | Isolation (Output Ports) | 13 | 15 | | dB |
| • RoHS Compliant | Power Handling | | | 2 | Watts |
| • External Resistor required | Operating Temperature | -55 | | +85 | °C |

* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®

Ultra Low Profile 0805 Power Divider 50Ω to 50Ω

Description

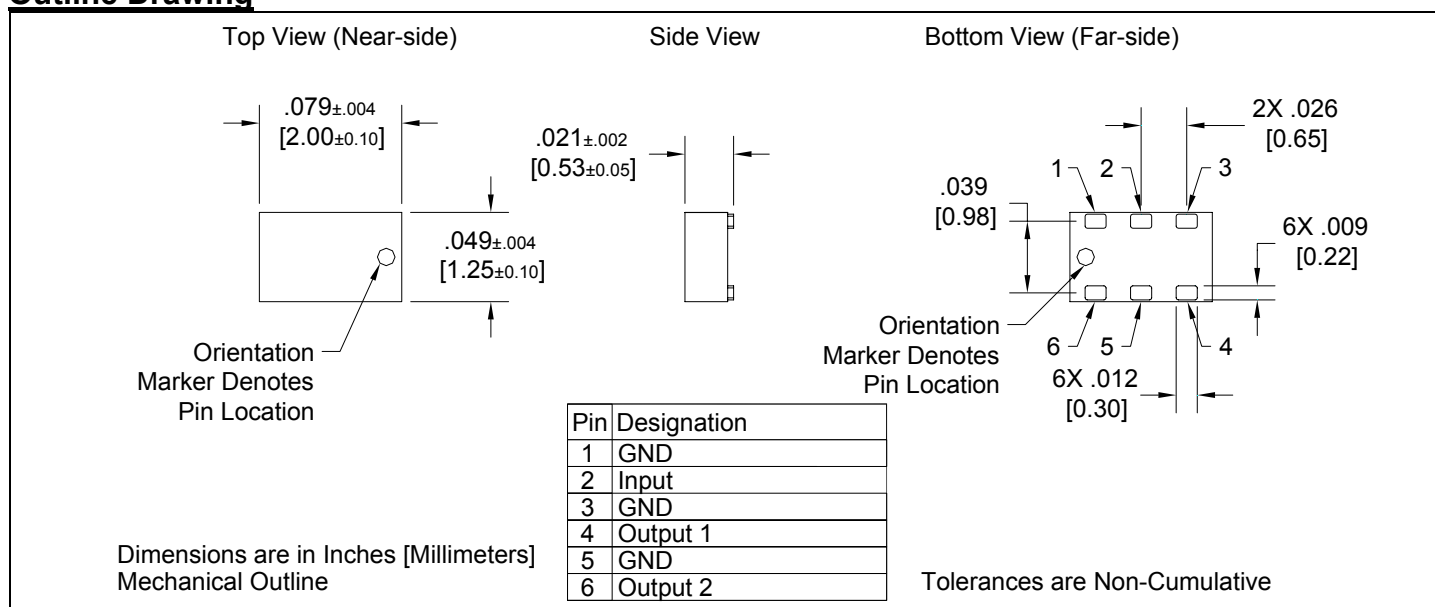
The PD4859J5050S2 is a low profile, sub-miniature Wilkinson power divider in an easy to use surface mount package. The PD4859J5050S2 is ideal for high volume manufacturing and delivers higher performances than traditional printed and lumped element solutions. The PD4859J5050S2 is matched to 50 Ω and has a height profile of 0.5 mm which is ideal for high level integrations in the following markets: 802.11a, WiMax, and home cordless. The PD4859J5050S2 does not include the resistive element and therefore, requires an external resistor for operation. The PD4859J5050S2 is available on tape and reel for high volume manufacturing pick and place.

Detailed Electrical Specifications: Specifications subject to change without notice.

| Features: | Parameter | ROOM (25°C) | | | Unit |
|----------------------------------|--------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| • 4800-5900 MHz | Frequency | 4800 | | 5900 | MHz |
| • 18 dB Isolation (output ports) | Input Port Impedance | | 50 | | Ω |
| • Good Return Loss | Output Port Impedance | | 50 | | Ω |
| • 0.5mm Height Profile | Return Loss | 7.9 | 10.3 | | dB |
| • 50 Ohm Input / 50Ω Outputs | Insertion Loss* | | 0.7 | 1.0 | dB |
| • Low Insertion Loss | Amplitude Balance | | 0.1 | 0.3 | dB |
| • Surface Mountable | Phase Balance | | 1 | 4 | Degrees |
| • Tape & Reel | Isolation (Output Ports) | 14 | 18 | | dB |
| • Non-conductive Surface | Power Handling | | | 2 | Watts |
| • RoHS Compliant | Operating Temperature | -55 | | +85 | °C |
| • External Resistor Required | | | | | |

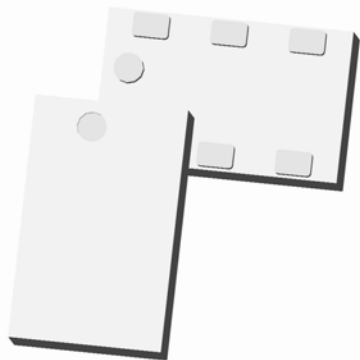
* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®

Ultra Low Profile 0805 Power Divider 50Ω to 50Ω



Description

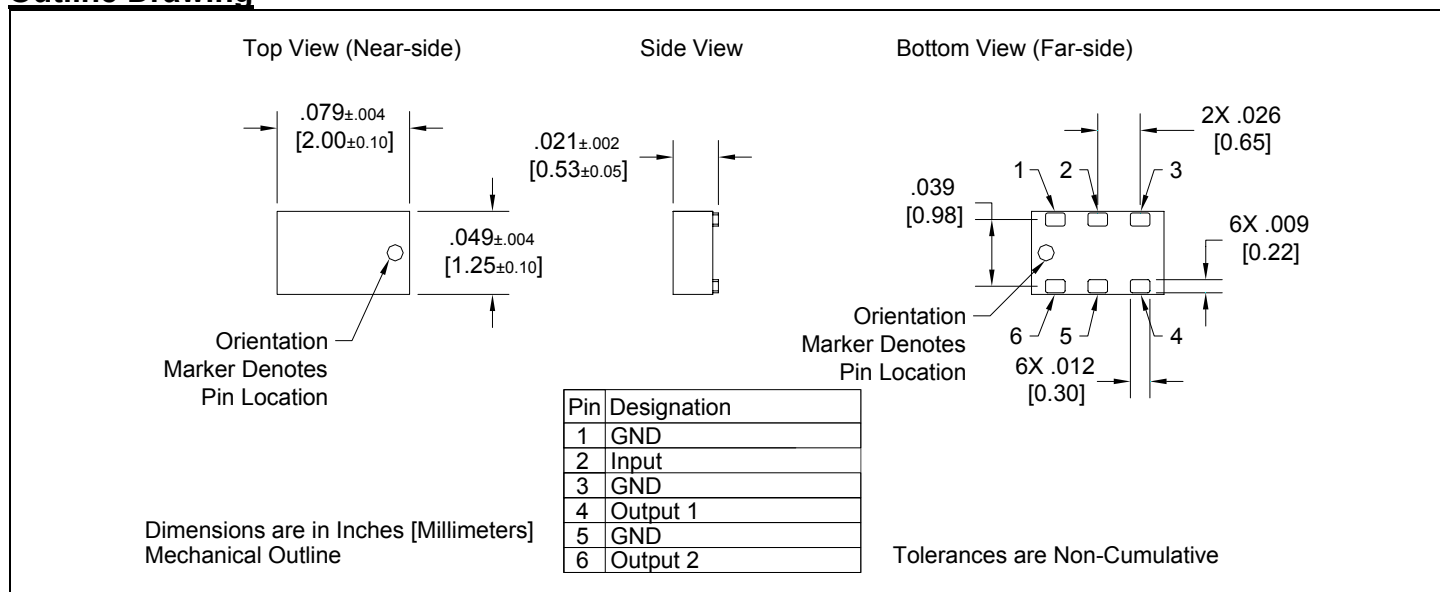
The PD6080J5050S2 is a low profile, sub-miniature Wilkinson power divider in an easy to use surface mount package. The PD6080J5050S2 is ideal for high volume manufacturing and delivers higher performances than traditional printed and lumped element solutions. The PD6080J5050S2 is matched to 50 Ω and has a height profile of 0.5 mm which is ideal for high level integrations in the following markets: RFID, fixed satellite, and mobile satellite. The PD6080J5050S2 does not include the resistive element and therefore, requires an external resistor for operation. The PD6080J5050S2 is available on tape and reel for high volume manufacturing pick and place.

Detailed Electrical Specifications: Specifications subject to change without notice.

| Features: | Parameter | ROOM (25°C) | | | Unit |
|--|--------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| <ul style="list-style-type: none"> 6000-8000 MHz 15 dB Isolation (output ports) Good Return Loss 0.5mm Height Profile 50Ω Input / 50Ω Outputs Low Insertion Loss Surface Mountable Tape & Reel Non-conductive Surface RoHS Compliant | Frequency | 6000 | | 8000 | MHz |
| | Input Port Impedance | | 50 | | Ω |
| | Output Port Impedance | | 50 | | Ω |
| | Return Loss | 9 | 12 | | dB |
| | Insertion Loss* | | 0.6 | 0.9 | dB |
| | Amplitude Balance | | 0.2 | 0.5 | dB |
| | Phase Balance | | 2 | 5 | Degrees |
| | Isolation (Output Ports) | 12 | 15 | | dB |
| | Power Handling | | | 2 | Watts |
| | Operating Temperature | -55 | | +85 | °C |

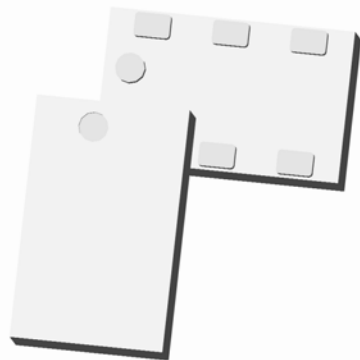
* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®

Ultra Low Profile 0805 Power Divider 3 Way 50Ω to 50Ω



Description

The PD1722J5050S3 is a low profile, sub-miniature Wilkinson power divider in an easy to use surface mount package and is ideal for high volume manufacturing while delivering higher performances than traditional printed and lumped element solutions. It has been designed for the DCS, PCS, UMTS and CDMA markets. The PD1722J5050S3 is matched to 50 Ω and has a height profile of 0.84 mm. Three external resistors are required for operation. Components are available on tape and reel for high volume manufacturing pick and place.

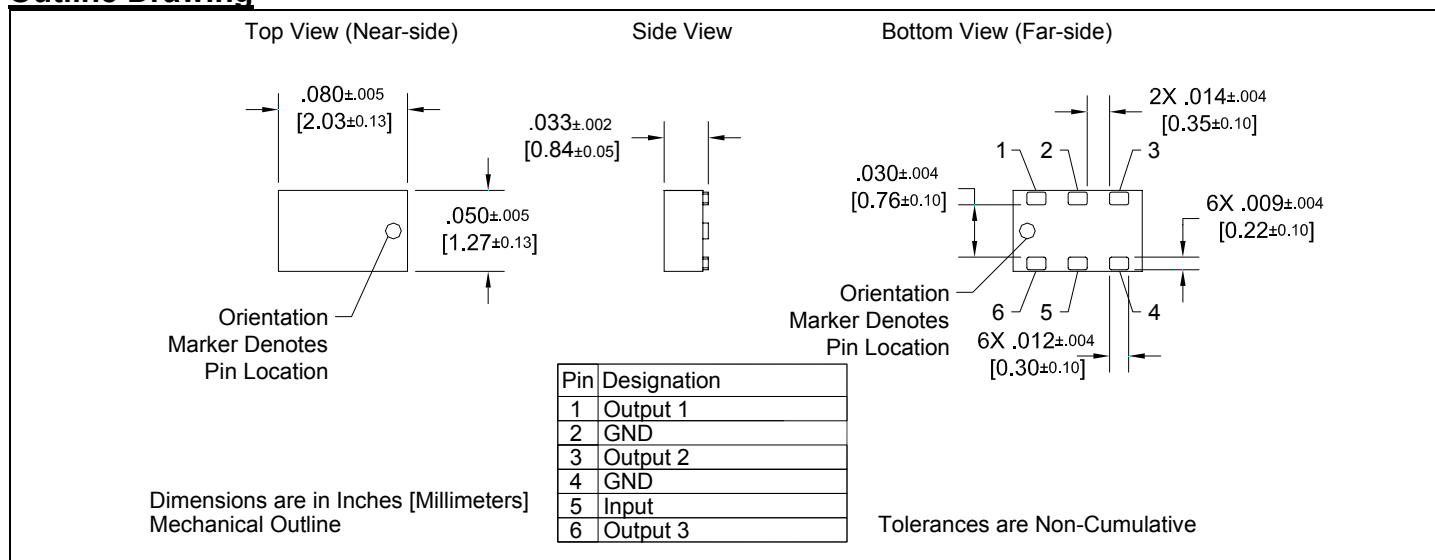
This components is constructed from ceramic filled PTFE composites which possess excellent electrical and mechanical stability having X and Y thermal coefficient of expansion (CTE) of 17 ppm/°C.

Detailed Electrical Specifications: Specifications subject to change without notice.

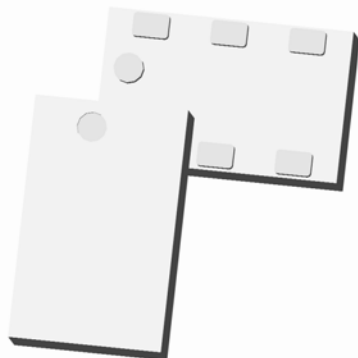
| Features: | Parameter | ROOM (25°C) | | | Unit |
|---|--------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| <ul style="list-style-type: none"> 1700 – 2200 MHz 0.84 mm Height Profile 50Ω Outputs/Inputs DCS/PCS/UMTS/CDMA External resistors required Low Insertion Loss Surface Mountable Tape & Reel Non-conductive Surface RoHS Compliant | Frequency | 1700 | | 2200 | MHz |
| | Input Port Impedance | | 50 | | Ω |
| | Output Port Impedance | | 50 | | Ω |
| | Return Loss | 9 | 11 | | dB |
| | Insertion Loss* | | 0.9 | 1.3 | dB |
| | Amplitude Balance | | 0.5 | 0.9 | dB |
| | Phase Balance | | 9 | 12 | Degrees |
| | Isolation (Output Ports) | 14 | 17 | | dB |
| | Power Handling | | | 1 | Watts |
| | Operating Temperature | -55 | | +85 | °C |

* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®



Ultra Low Profile 0805 3 dB, 90° Hybrid Coupler

Description

The C0810J5003A00 is a low cost, low profile sub-miniature high performance 3 dB coupler in an easy to use surface mount package. It is designed for 800 – 1000MHz applications including: GSM, WCDMA, CDMA and 900MHz ISM applications. The C0810J5003A00 is ideal for balanced power and low noise amplifiers, plus signal distribution and other applications where low insertion loss and tight amplitude and phase balance are required. The C0810J5003A00 is available on tape and reel for pick and place high volume manufacturing.

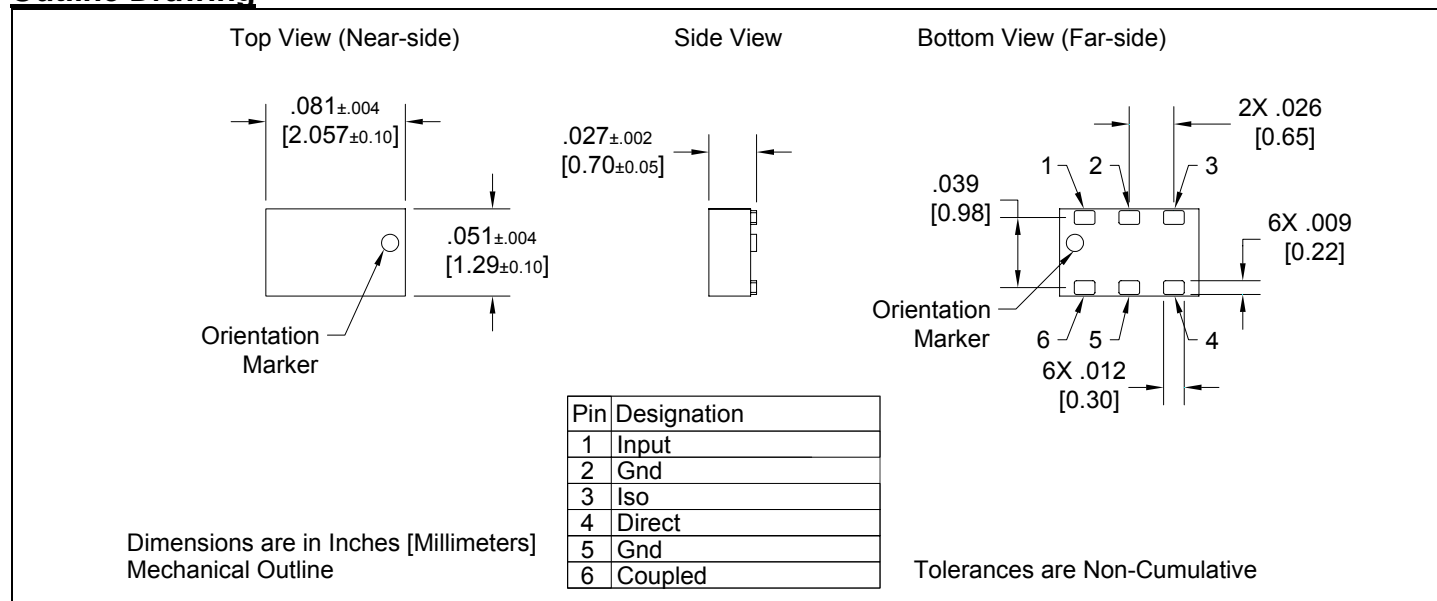
All of the Xinger components are constructed from ceramic filled PTFE composites which possess excellent electrical and mechanical stability having X and Y thermal coefficient of expansion (CTE) of 17 ppm/°C.

Detailed Electrical Specifications: Specifications subject to change without notice.

| Features: | Parameter | ROOM (25°C) | | | Unit |
|--|---------------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| <ul style="list-style-type: none"> 800 – 1000 MHz 0.7mm Height Profile GSM, WCDMA & 900 MHz ISM Low Insertion Loss High Isolation Surface Mountable Tape & Reel Non-conductive Surface RoHS Compliant | Frequency | 800 | | 1000 | MHz |
| | Port Impedance | | 50 | | Ω |
| | Return Loss | 21 | 31 | | dB |
| | Isolation | 18 | 23 | | dB |
| | Insertion Loss* | | 0.5 | 0.6 | dB |
| | Amplitude Balance | | 0.6 | 0.9 | dB |
| | Phase Balance (relative to 90°) | | 4 | 7 | Degrees |
| | Power Handling | | | 4.0 | Watts |
| | Operating Temperature | -55 | | +85 | °C |

* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

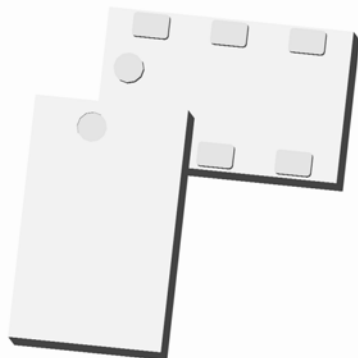
Outline Drawing



All of the Xinger components are constructed from ceramic filled PTFE composites which possess excellent electrical and mechanical stability having X and Y thermal coefficient of expansion (CTE) of 17 ppm/°C.

| Parameter | ROOM (25°C) | | | Unit |
|---------------------------------|-------------|------|------|----------|
| | Min. | Typ. | Max | |
| Frequency | 1700 | | 2000 | MHz |
| Port Impedance | | 50 | | Ω |
| Return Loss | 21 | 27 | | dB |
| Isolation | 24 | 36 | | dB |
| Insertion Loss* | | 0.3 | 0.4 | dB |
| Amplitude Balance | | 0.2 | 1.0 | dB |
| Phase Balance (relative to 90°) | | 1 | 5 | Degrees |
| Power Handling | | | 4.0 | Watts |
| Operating Temperature | -55 | | +85 | °C |

Xinger®



Ultra Low Profile 0805 3 dB, 90° Hybrid Coupler

Description

The C2023J503A00 is a low cost, low profile sub-miniature high performance 3 dB coupler in an easy to use surface mount package. It is designed for WiMax, WiBro, UMTS, and IMT2000 applications. The C2023J503A00 is ideal for balanced power and low noise amplifiers, plus signal distribution and other applications where low insertion loss and tight amplitude and phase balance are required. The C2023J503A00 is available on tape and reel for pick and place high volume manufacturing.

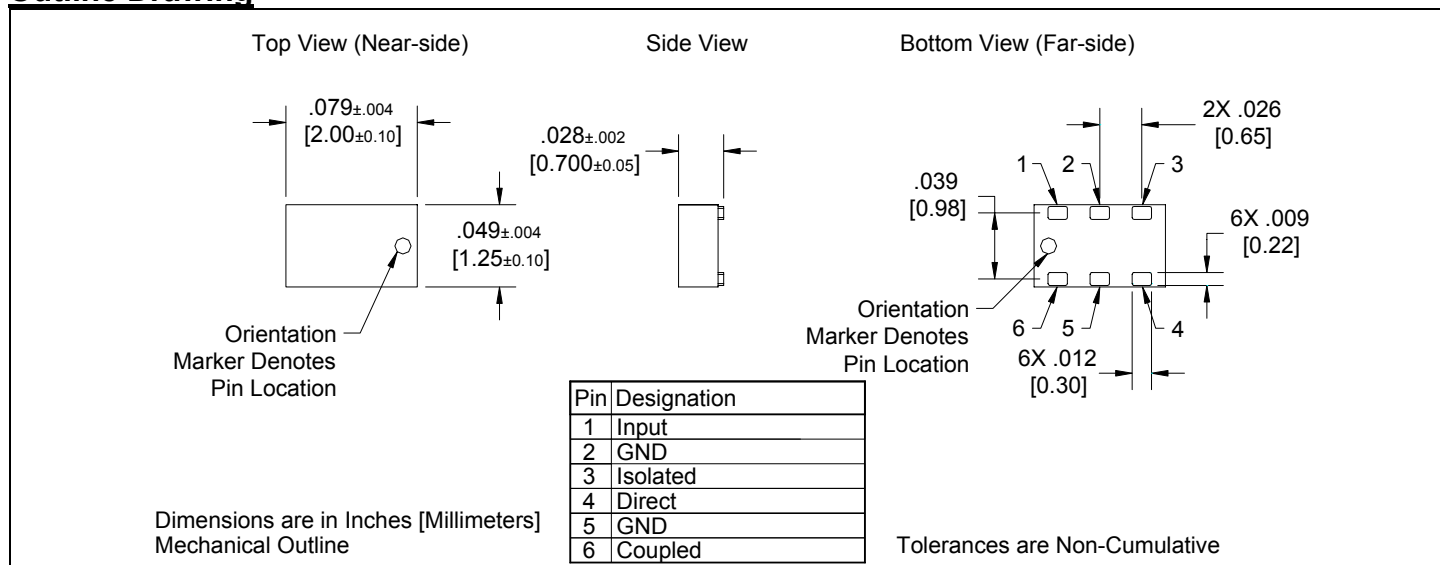
All of the Xinger components are constructed from ceramic filled PTFE composites which possess excellent electrical and mechanical stability having X and Y thermal coefficient of expansion (CTE) of 17 ppm/°C

Detailed Electrical Specifications: Specifications subject to change without notice.

| Features: | Parameter | ROOM (25°C) | | | Unit |
|--|---------------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| <ul style="list-style-type: none"> 2000 – 2300 MHz 0.7mm Height Profile WiMax, WiBro, UMTS & IMT2000 applications Low Insertion Loss High Isolation Surface Mountable Tape & Reel Non-conductive Surface RoHS Compliant | Frequency | 2000 | | 2300 | MHz |
| | Port Impedance | | 50 | | Ω |
| | Return Loss | 18 | 22 | | dB |
| | Isolation | 21 | 25 | | dB |
| | Insertion Loss* | | 0.3 | 0.4 | dB |
| | Amplitude Balance | | 0.1 | 0.8 | dB |
| | Phase Balance (relative to 90°) | | 2 | 6 | Degrees |
| | Power Handling | | | 4.0 | Watts |
| | Operating Temperature | -55 | | +85 | °C |

* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®

Ultra Low Profile 0805 3 dB, 90° Hybrid Coupler

Description

The C2327J5003A00 is a low cost, low profile sub-miniature high performance 3 dB coupler in an easy to use surface mount package. It is designed for WiMax, WiBro, WiFi, ISM, and EUMTS applications. The C2327J5003A00 is ideal for balanced power and low noise amplifiers, plus signal distribution and other applications where low insertion loss and tight amplitude and phase balance are required. The C2327J5003A00 is available on tape and reel for pick and place high volume manufacturing.

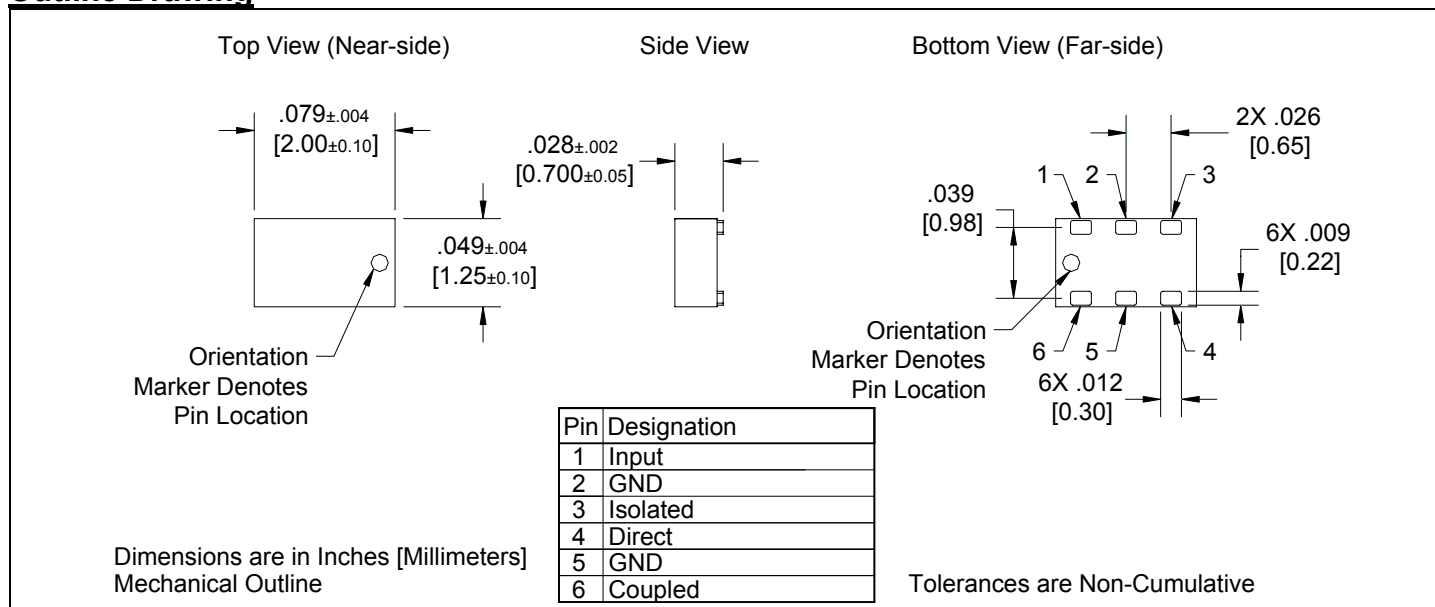
All of the Xinger components are constructed from ceramic filled PTFE composites which possess excellent electrical and mechanical stability having X and Y thermal coefficient of expansion (CTE) of 17 ppm/°C.

Detailed Electrical Specifications: Specifications subject to change without notice.

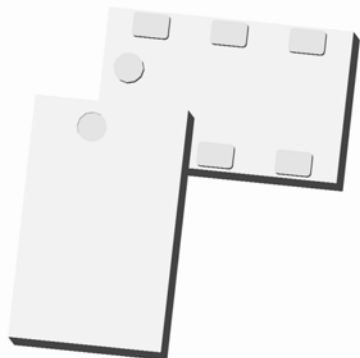
| Features: | Parameter | ROOM (25°C) | | | Unit |
|--|---------------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| <ul style="list-style-type: none"> 2300 – 2700 MHz 0.7mm Height Profile WiMax, WiBro, WiFi, ISM & EUMTS Low Insertion Loss High Isolation Surface Mountable Tape & Reel Non-conductive Surface RoHS Compliant | Frequency | 2300 | | 2700 | MHz |
| | Port Impedance | | 50 | | Ω |
| | Return Loss | 15 | 18 | | dB |
| | Isolation | 18 | 22 | | dB |
| | Insertion Loss* | | 0.3 | 0.4 | dB |
| | Amplitude Balance | | 0.1 | 0.9 | dB |
| | Phase Balance (relative to 90°) | | 4 | 8 | Degrees |
| | Power Handling | | | 4.0 | Watts |
| | Operating Temperature | -55 | | +85 | °C |

* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®



Ultra Low Profile 0805 3 dB, 90° Hybrid Coupler

Description

The C3337J5003A00 is a low cost, low profile sub-miniature high performance 3 dB coupler in an easy to use surface mount package. It is designed for WiMax and WiBro applications. The C3337J5003A00 is ideal for balanced power and low noise amplifiers, plus signal distribution and other applications where low insertion loss and tight amplitude and phase balance are required. The C3337J5003A00 is available on tape and reel for pick and place high volume manufacturing.

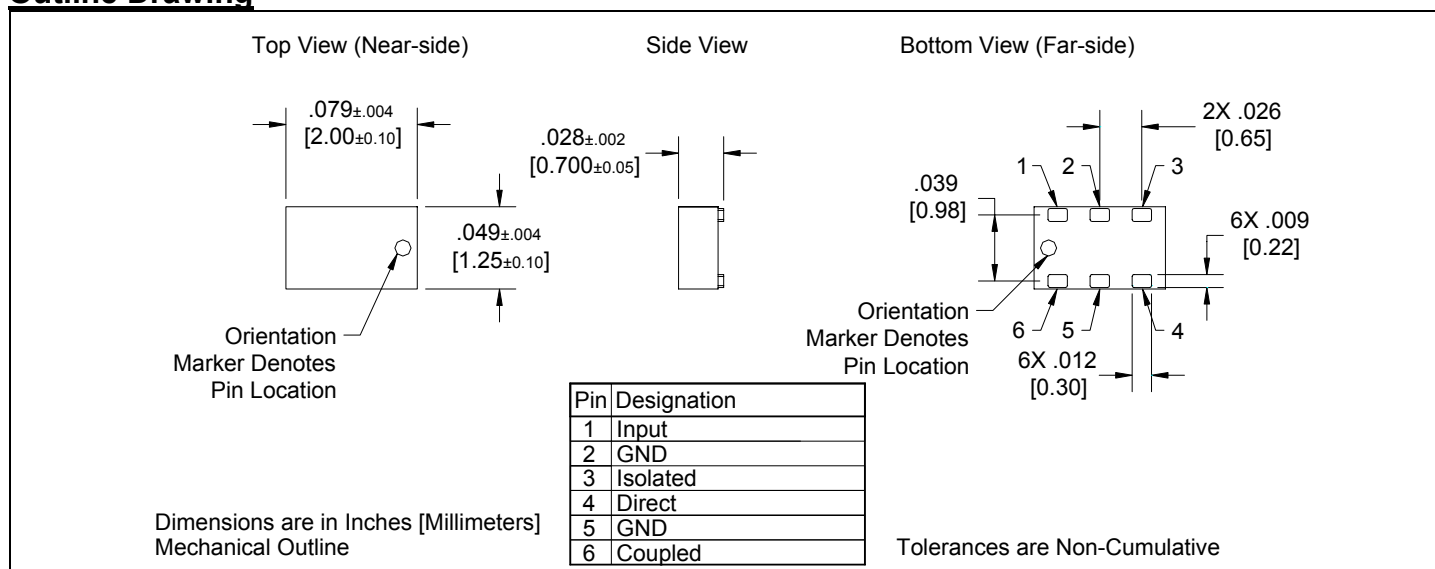
All of the Xinger components are constructed from ceramic filled PTFE composites which possess excellent electrical and mechanical stability having X and Y thermal coefficient of expansion (CTE) of 17 ppm/°C

Detailed Electrical Specifications: Specifications subject to change without notice.

| Features: | Parameter | ROOM (25°C) | | | Unit |
|---|---------------------------------|-------------|------|------|---------|
| | | Min. | Typ. | Max | |
| <ul style="list-style-type: none"> 3300 – 3700 MHz 0.7mm Height Profile WiMax and WiBro applications Low Insertion Loss High Isolation Surface Mountable Tape & Reel Non-conductive Surface RoHS Compliant | Frequency | 3300 | | 3700 | MHz |
| | Port Impedance | | 50 | | Ω |
| | Return Loss | 15 | 18 | | dB |
| | Isolation | 18 | 22 | | dB |
| | Insertion Loss* | | 0.2 | 0.3 | dB |
| | Amplitude Balance | | 0.3 | 1.0 | dB |
| | Phase Balance (relative to 90°) | | 3 | 7 | Degrees |
| | Power Handling | | | 4.0 | Watts |
| | Operating Temperature | -55 | | +85 | °C |

* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Xinger®

Ultra Low Profile 0603 RF Crossover

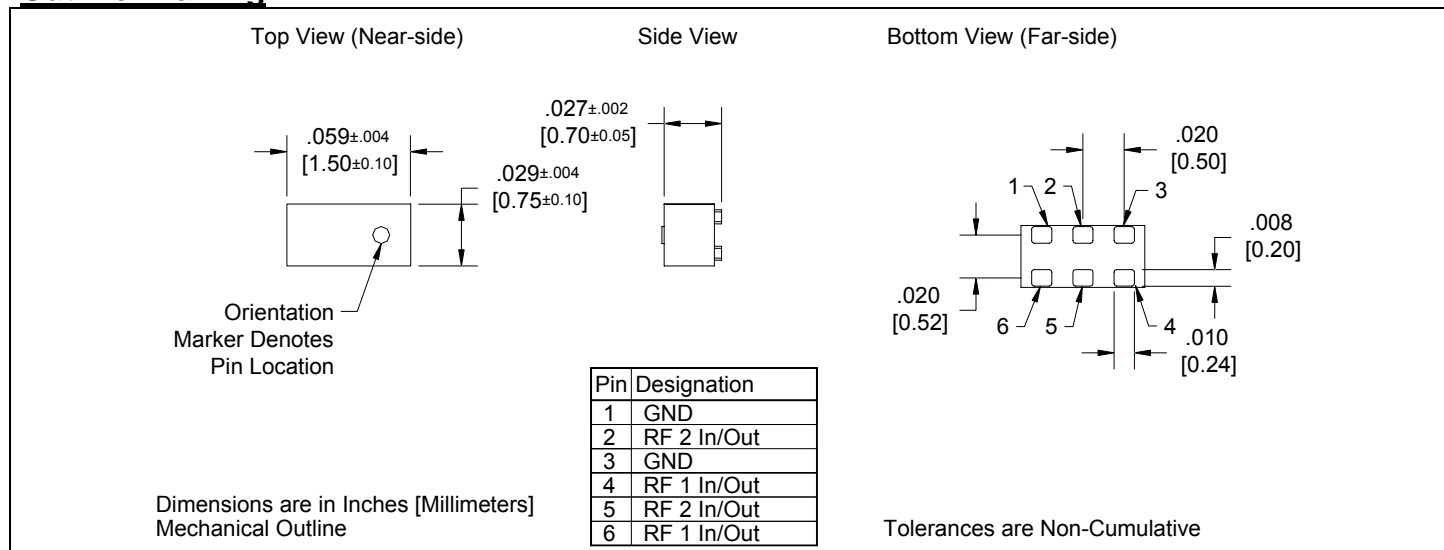
Description

The (patent pending) X0060L5050A00 is an ultra-small low profile crossover that enables the transition of two intersecting RF traces in an easy to use industry standard SMT package. The 0603 crossover is ideal for any critical applications where layout and available space are a premium and resorting to addition PWB layers and larger overall footprints are unacceptable. With low insertion loss and high isolation packaged with cost in mind, this novel component delivers.

Detailed Electrical Specifications*: Specifications subject to change without notice.

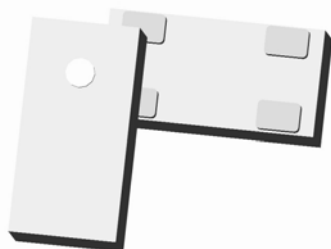
| Features: | Parameter | ROOM (25°C) | | | Unit |
|---|------------------------|-------------|------|------|-------|
| | | Min. | Typ. | Max | |
| <ul style="list-style-type: none"> 0 – 6000 MHz. 0.7mm Height Profile 50 Ohm RF-RF Crossover All Wireless Frequencies Low Insertion Loss High Isolation Surface Mountable Tape & Reel Non-conductive Surface RoHS Compliant | Frequency | 0 | | 6000 | MHz |
| | Port Impedance | | 50 | | Ω |
| | Return Loss | 16 | 19 | | dB |
| | Insertion Loss | | 0.1 | 0.15 | dB |
| | Isolation (cross-talk) | | | | |
| | 0 – 700 MHz | 45 | 53 | | dB |
| | 700 - 1700 MHz | 40 | 47 | | dB |
| | 1700 - 2200 MHz | 39 | 46 | | dB |
| | 2200 - 3000 MHz | 37 | 43 | | dB |
| | 3000 - 6000 MHz | 27 | 31 | | dB |
| | Power Handling | | | 2 | Watts |
| | Operating Temperature | -55 | | +85 | °C |

Outline Drawing



Xinger®

Ultra Low Profile 0603 RF Jumper



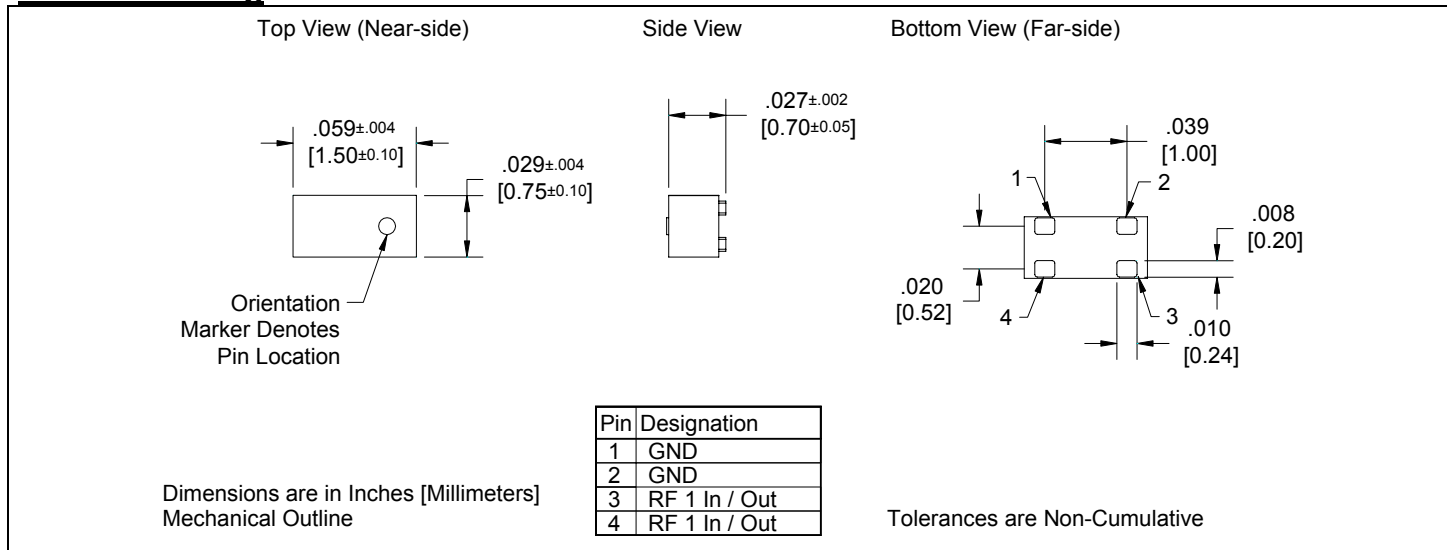
Description

The (patent pending) J0060L5050A00 is an ultra-small low profile jumper that enables the transition of two intersecting RF traces in an easy to use industry standard SMT package. The 0603 jumper permits one path to continue on the PWB while the other path is jumped within the component. The jumper is ideal for any critical applications where layout and available space are a premium and resorting to addition PWB layers and larger overall footprints are unacceptable. With low insertion loss and high isolation packaged with cost in mind, this novel component delivers.

Detailed Electrical Specifications*: Specifications subject to change without notice.

| Features: | Parameter | ROOM (25°C) | | | Unit |
|---|------------------------|-------------|------|------|-------|
| | | Min. | Typ. | Max | |
| <ul style="list-style-type: none"> 0 – 6000 MHz. 0.7mm Height Profile 50 Ohm RF Jumper All Wireless Frequencies Low Insertion Loss High Isolation Surface Mountable Tape & Reel Non-conductive Surface RoHS Compliant | Frequency | 0 | | 6000 | MHz |
| | Port Impedance | | 50 | | Ω |
| | Return Loss | 16 | 18 | | dB |
| | Insertion Loss | | 0.1 | 0.15 | dB |
| | Isolation (cross-talk) | | | | |
| | 0 – 700 MHz | 45 | 53 | | dB |
| | 700 - 1700 MHz | 40 | 48 | | dB |
| | 1700 - 2200 MHz | 39 | 46 | | dB |
| | 2200 - 3000 MHz | 37 | 44 | | dB |
| | 3000 - 6000 MHz | 29 | 33 | | dB |
| | Power Handling | | | 2 | Watts |
| | Operating Temperature | -55 | | +85 | °C |

Outline Drawing



Xinger®

Ultra Low Profile 0603 RF Crossover

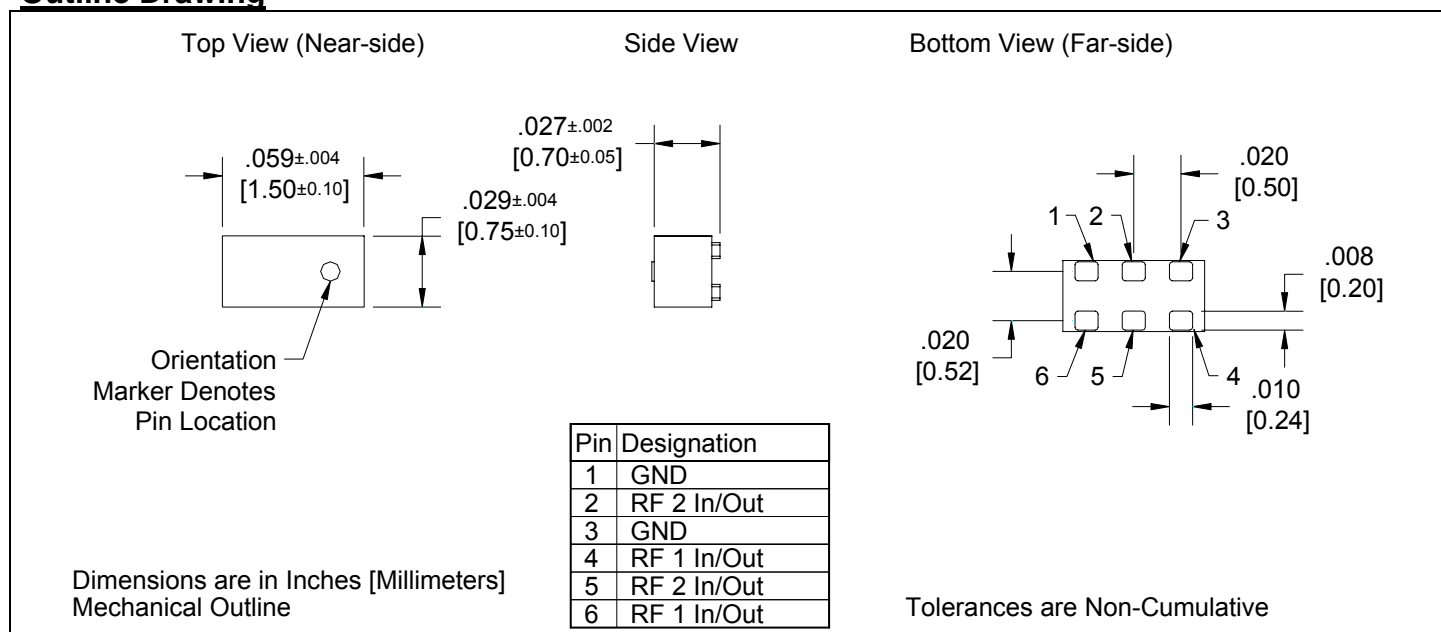
Description

The (patent pending) X0066L7575A00 is an ultra-small low profile crossover that enables the transition of two intersecting RF traces in an easy to use industry standard SMT package. The 0603 crossover is ideal for any critical applications where layout and available space are a premium and resorting to addition PWB layers and larger overall footprints are unacceptable. With low insertion loss and high isolation packaged with cost in mind, this novel component delivers.

Detailed Electrical Specifications*: Specifications subject to change without notice.

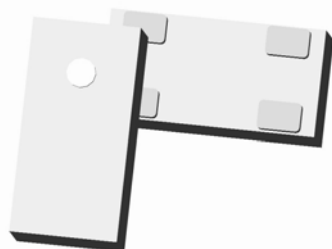
| Features: | Parameter | ROOM (25°C) | | | Unit |
|---|------------------------|-------------|------|------|-------|
| | | Min. | Typ. | Max | |
| <ul style="list-style-type: none"> 0 – 2500 MHz. 0.7mm Height Profile 75 Ohm RF-RF Crossover All Wireless Frequencies Low Insertion Loss High Isolation Surface Mountable Tape & Reel Non-conductive Surface RoHS Compliant | Frequency | 0 | | 2500 | MHz |
| | Port Impedance | | 75 | | Ω |
| | Return Loss | 19 | 21 | | dB |
| | Insertion Loss | | 0.1 | 0.15 | dB |
| | Isolation (cross-talk) | | | | |
| | 0 – 700 MHz | 44 | 52 | | dB |
| | 700 - 1700 MHz | 40 | 47 | | dB |
| | 1700 - 2500 MHz | 38 | 43 | | dB |
| | Power Handling | | | 2 | Watts |
| | Operating Temperature | -55 | | +85 | °C |

Outline Drawing



Xinger®

Ultra Low Profile 0603 RF Jumper



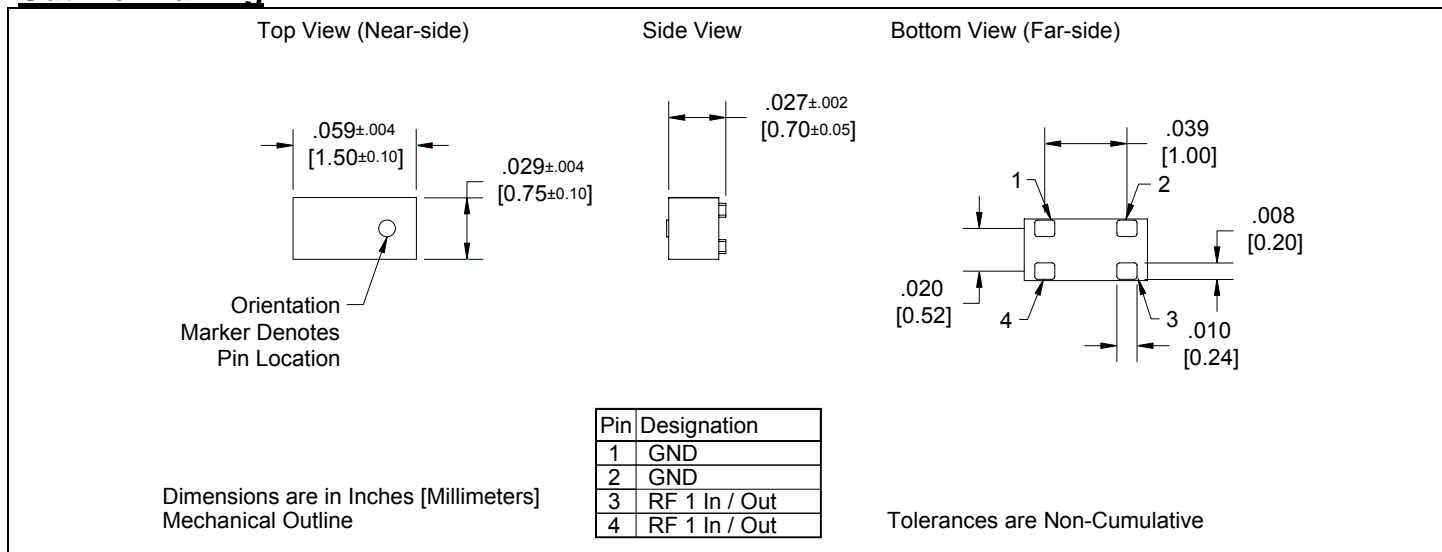
Description

The (patent pending) J0060L7575A00 is an ultra-small low profile jumper that enables the transition of two intersecting RF traces in an easy to use industry standard SMT package. The 0603 jumper permits one path to continue on the PWB while the other path is jumped within the component. The jumper is ideal for any critical applications where layout and available space are a premium and resorting to addition PWB layers and larger overall footprints are unacceptable. With low insertion loss and high isolation packaged with cost in mind, this novel component delivers.

Detailed Electrical Specifications*: Specifications subject to change without notice.

| Features: | Parameter | ROOM (25°C) | | | Unit |
|--|------------------------|-------------|------|------|-------|
| | | Min. | Typ. | Max | |
| <ul style="list-style-type: none"> 0 – 2500 MHz. 0.7mm Height Profile 75 Ohm RFJumper All Wireless Frequencies Low Insertion Loss High Isolation Surface Mountable Tape & Reel Non-conductive Surface RoHS Compliant | Frequency | 0 | | 2500 | MHz |
| | Port Impedance | | 75 | | Ω |
| | Return Loss | 19 | 22 | | dB |
| | Insertion Loss | | 0.13 | 0.2 | dB |
| | Isolation (cross-talk) | | | | |
| | 0 – 700 MHz | 45 | 51 | | dB |
| | 700 - 1700 MHz | 40 | 45 | | dB |
| | 1700 - 2200 MHz | 38 | 43 | | dB |
| | Power Handling | | | 2 | Watts |
| | Operating Temperature | -55 | | +85 | °C |

Outline Drawing



Resistive Components Selection Matrix

Terminations

| Model Number | Package | Package Size LxWxT [inch] | Freq. Band [MHz] | Impedance Ω $\pm 2\%$ | Return Loss [dB] | Power Handling [W] | Derating Curve |
|--------------|--------------------|---------------------------|------------------|------------------------------|------------------|--------------------|----------------|
| A100N50X4 | Chip | 0.25 x 0.225 x 0.04 | DC - 2700 | 50 | 26 | 100 | 1 |
| A125N50X4 | Chip | 0.25 x 0.25 x 0.04 | DC - 2700 | 50 | 26 | 125 | 1 |
| | | | DC - 4000 | 50 | 20 | 125 | 1 |
| A150N50X4B | Chip | 0.375 x .250 x 0.040 | DC - 2000 | 50 | 26 | 150 | 4 |
| | | | DC - 2700 | 50 | 20 | 150 | 4 |
| C10N50Z4A | Surface Mount | 0.10 x 0.20 x .040 | DC - 2000 | 50 | 19 | 10 | 2 |
| | | | DC - 3000 | 50 | 15 | 10 | 2 |
| C25N50Z4A | Surface Mount | 0.375 x .250 x 0.040 | DC - 3000 | 50 | 19 | 25 | 2 |
| C50A50Z4 | Surface Mount | 0.25 x 0.25 x 0.05 | DC - 2200 | 50 | 26 | 50 | 2 |
| | | | DC - 2700 | 50 | 24 | 50 | 2 |
| C100N50Z4 | Surface Mount | 0.250 x 0.250 x 0.06 | DC - 2700 | 50 | 24 | 100 | 2 |
| | | | DC - 4000 | 50 | 20 | 100 | 2 |
| E150N50X4 | Flangeless | 0.205 x 0.375 x .073 | DC - 2000 | 50 | 25 | 150 | 1 |
| | lidded & leaded | | DC - 2700 | 50 | 20 | 150 | 1 |
| C16N50Z4A | Surface Mount | 0.250 x 0.250 x .060 | DC - 3000 | 50 | 19 | 16 | 2 |
| J100N50X4 | Half Flange Center | 0.250 x 0.515 x 0.148 | DC - 3000 | 50 | 19 | 100 | 1 |
| C16A50Z4 | Surface Mount | 0.10 x 0.20 x .020 | DC - 3000 | 50 | 19 | 16 | 2 |
| K100N50X4 | Half Flanged Right | 0.25 x 0.515x 0.138 | DC - 3000 | 50 | 19 | 100 | 1 |
| I100N50X4 | Half Flanged Left | 0.25 x 0.515x 0.138 | DC - 3000 | 50 | 19 | 100 | 1 |
| C10A50Z4 | Surface Mount | 0.10 x 0.20 x 0.025 | DC - 3000 | 50 | 19 | 10 | 2 |
| C40A50Z4 | Surface Mount | 0.375 x 0.375 x 0.060 | DC - 2300 | 50 | 21 | 40 | 3 |
| A20A50X1A | Surface Mount | 0.10 x 0.20 x 0.025 | DC - 6000 | 50 | 19 | 20 | 3 |
| G150N50W4B | Flanged | 0.87 x 0.375 x 0.134 | DC - 2000 | 50 | 25 | 150 | 5 |
| | | | DC - 2700 | 50 | 20 | 150 | 5 |

Attenuators

| Model Number | Package | Package Size LxWxT [inch] | Freq. Band [MHz] | Attenuation [dB] | Return Loss [dB] | Power Handling [W] | Derating Curve |
|--------------|---------------|---------------------------|------------------|------------------|------------------|--------------------|----------------|
| B100NA20X4 | Chip | 0.25 x 0.25 x 0.04 | DC - 2700 | 20 \pm 1 dB | 20 | 100 | 1 |
| | | | DC - 4000 | 20 \pm 1 dB | 19 | 100 | 1 |
| H100NA20X4 | Flanged | 0.79 x 0.25x 0.142 | DC - 2700 | 20 \pm 1 dB | 24 | 100 | 1 |
| | | | DC - 4000 | 20 \pm 1 dB | 20 | 100 | 1 |
| H100NA30X4 | Flanged | 0.79 x 0.25x 0.142 | DC - 2200 | 30 + 5/-2 | 24 | 100 | 1 |
| | | | DC - 4000 | 30 + 7/-2 | 20 | 100 | 1 |
| D30A20Y4 | Surface Mount | 0.375 x 0.365 x 0.06 | DC - 2000 | 20 \pm 0.75 dB | 21 | 30 | 1 |
| D30A30Y4 | Surface Mount | 0.375 x 0.365 x 0.06 | DC - 2000 | 30 \pm 0.75 dB | 21 | 30 | 1 |
| D10AA1Z4 | Surface Mount | 0.100 x 0.200 x 0.025 | DC - 3000 | 1 \pm .30 dB | 19 | 7 | 2 |
| D10AA2Z4 | Surface Mount | 0.100 x 0.200 x 0.025 | DC - 3000 | 2 \pm .30 dB | 19 | 7 | 2 |
| D10AA3Z4 | Surface Mount | 0.100 x 0.200 x 0.025 | DC - 3000 | 3 \pm .30 dB | 19 | 7 | 2 |
| D10AA4Z4 | Surface Mount | 0.100 x 0.200 x 0.025 | DC - 3000 | 4 \pm .30 dB | 19 | 7 | 2 |
| D10AA5Z4 | Surface Mount | 0.100 x 0.200 x 0.025 | DC - 3000 | 5 \pm .30 dB | 19 | 7 | 2 |
| D10AA6Z4 | Surface Mount | 0.100 x 0.200 x 0.025 | DC - 3000 | 6 \pm .30 dB | 19 | 7 | 2 |
| D10AA9Z4 | Surface Mount | 0.100 x 0.200 x 0.025 | DC - 3000 | 9 \pm .25 dB | 19 | 7 | 2 |
| D10AA10Z4 | Surface Mount | 0.100 x 0.200 x 0.025 | DC - 3000 | 10 \pm .25 dB | 19 | 7 | 2 |
| D10AA20Z4 | Surface Mount | 0.100 x 0.200 x 0.025 | DC - 3000 | 20 \pm .50 dB | 19 | 7 | 2 |
| D10AA30Z4 | Surface Mount | 0.100 x 0.200 x 0.025 | DC - 3000 | 30 \pm 1.50 dB | 19 | 7 | 2 |

Resistors

| Model Number | Package | Size | Freq. Band [MHz] | Resistance Ω | Capacitance [pF] | Power Handling [W] | Derating Curve |
|--------------|---------------|-----------------------|------------------|---------------------|------------------|--------------------|----------------|
| D5B50Y1A | Surface Mount | 0.200 x 0.100 x 0.040 | DC - 3000 | 50 | 0.30 | 5 | 2 |
| D5B100Y1A | Surface Mount | 0.200 x 0.100 x 0.040 | DC - 3000 | 100 | 0.30 | 5 | 2 |
| D10B50Y1A | Surface Mount | 0.250 x 0.375 x 0.040 | DC - 2000 | 50 | 1.40 | 10 | 2 |
| D10B100Y1A | Surface Mount | 0.250 x 0.375 x 0.040 | DC - 2000 | 100 | 1.40 | 10 | 2 |

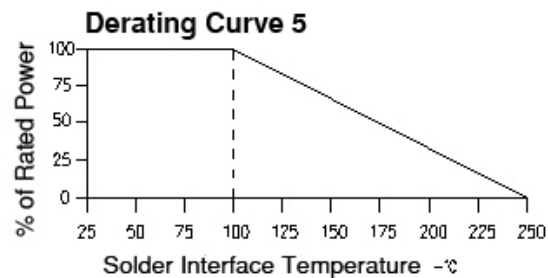
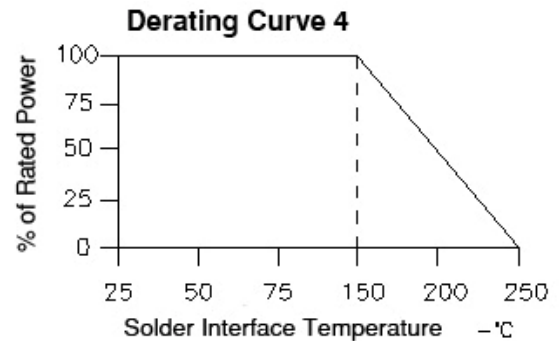
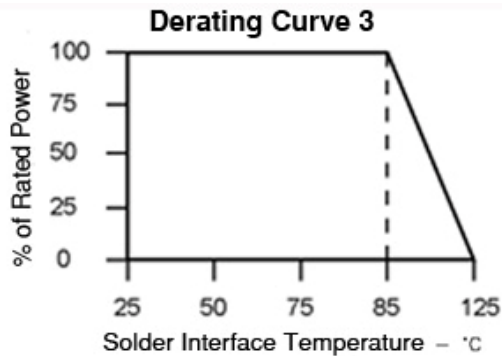
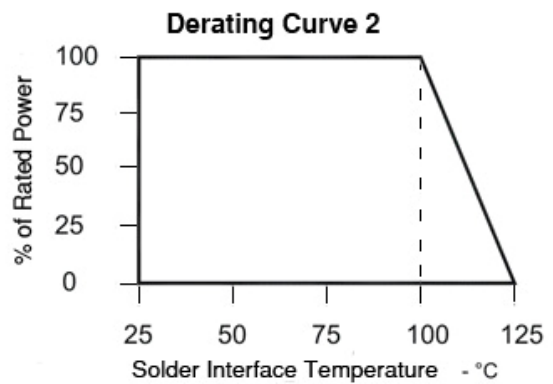
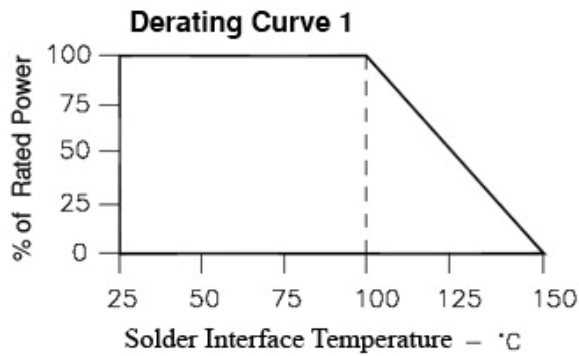
Resistive Components Selection Matrix

Nomenclature Chart

X XX X XX X X

| Package Style | Power Handling (W) | Material | Impedance/Attenuation | Edge Wrap | Plating Finish |
|-------------------------------|---------------------|---------------|-----------------------|---------------------|-------------------|
| A = Chip | Average Power in W. | A = Al_2O_3 | 50 = 50 Ohm | V = Dual | 1 = Thick Film Ag |
| B = Chip Attenuator | | B = BeO | A30 = 30 dB | W = No Wrap | 2 = SN10/Ni |
| C = SMD | | N = AlN | | X = Single/Term. | 3 = SN96/Ni |
| D = SMD Attenuator | | | | Y = Dual Attenuator | 4 = Matte Tin |
| E = Flangeless | | | | Z = Dual Term. | 5 = Immersion Au |
| G = Full Flange | | | | | 6 = Immersion Ag |
| H = Full Flange Attenuator | | | | | |
| I = Half Flange (Left Lead) | | | | | |
| J = Half Flange (Center Lead) | | | | | |
| K = Half Flange (Right Lead) | | | | | |

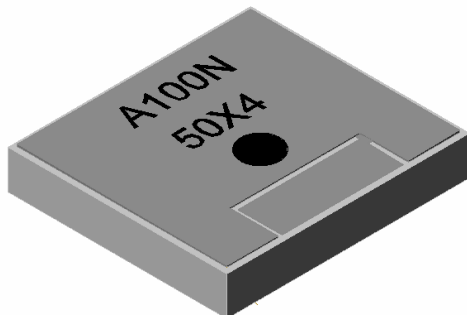
Note: These tables are for reference only. Please review complete data sheet for actual specification data.



**RoHS
Compliant**

Chip Termination
100 Watts, 50Ω

Description



The A100N50X4 is high performance Aluminum Nitride (AlN) chip termination intended as an alternative to Beryllium Oxide (BeO). The termination is well suited to all cellular frequency bands such as; AMPS, GSM, DCS, PCS, PHS and UMTS. The high power handling makes the part ideal for terminating circulators and for use in power combiners. The termination is also RoHS compliant!

General Specifications

| | |
|------------------------------|-------------------------------------|
| Resistive Element | Thick film |
| Substrate | AlN Ceramic |
| Terminal Finish | Matte Tin over Nickel Barrier |
| Operating Temperature | -55 to +150°C (See de rating chart) |

Tolerance is ± 0.010 ", unless otherwise specified. Designed to meet or exceed applicable portions of MIL-E-5400. All dimensions in inches.

Electrical Specifications

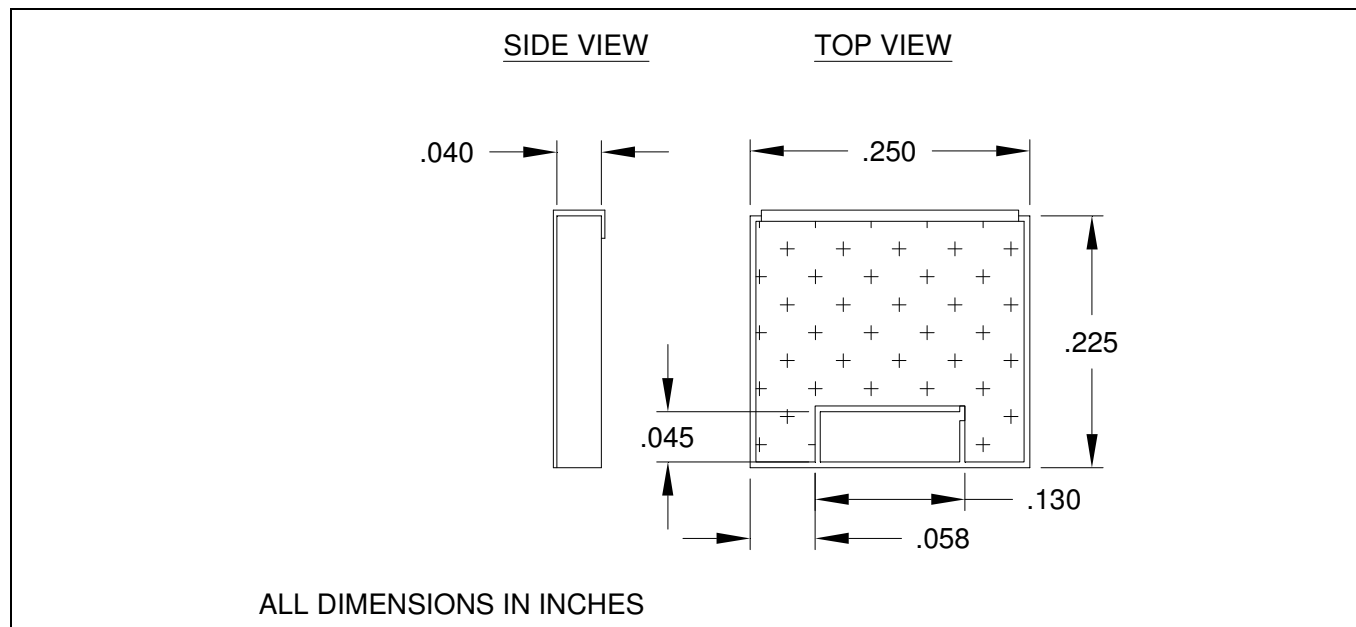
| | |
|--------------------------|--------------------|
| Resistance Value: | 50 Ohms, $\pm 2\%$ |
| Power: | 100 Watts |
| Frequency Range: | DC – 2.7 GHz |
| V.S.W.R. | 1.1:1 to 2.7 GHz |

Specification based on unit properly installed using suggested mounting instructions and a 50 ohm nominal impedance. **Specifications subject to change.**

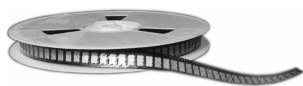
Features:

- RoHS Compliant
- 100 Watts
- DC - 2.7 GHz
- AlN Ceramic
- Non-Nichrome Resistive Element
- Low VSWR
- 100% Tested
- Small Size

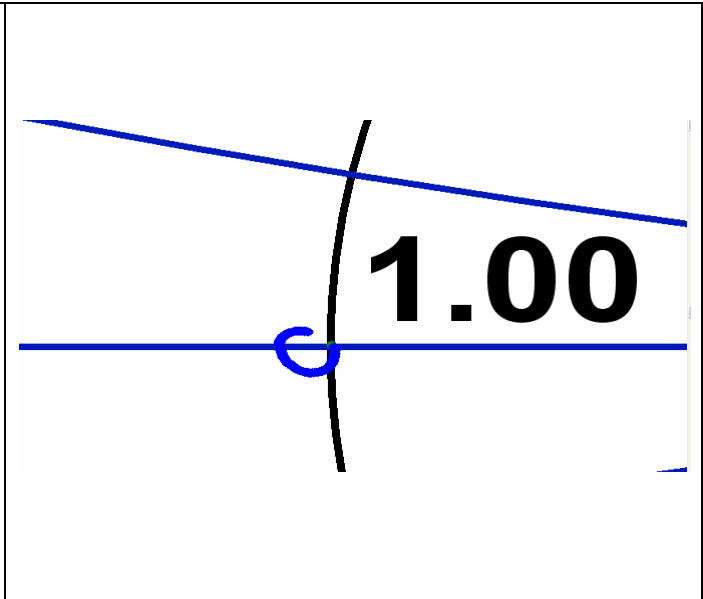
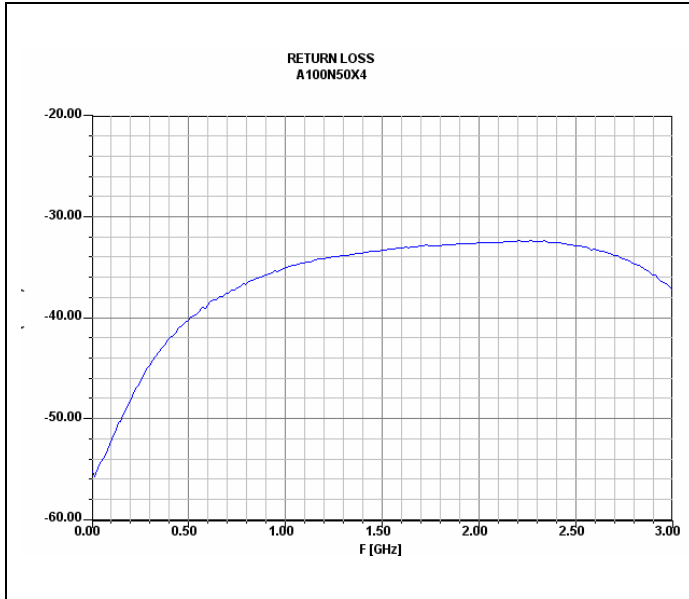
Outline Drawing



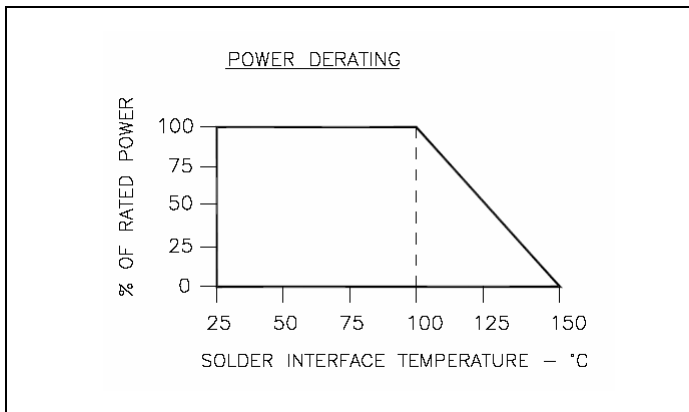
A100N50X4 (097) Rev B



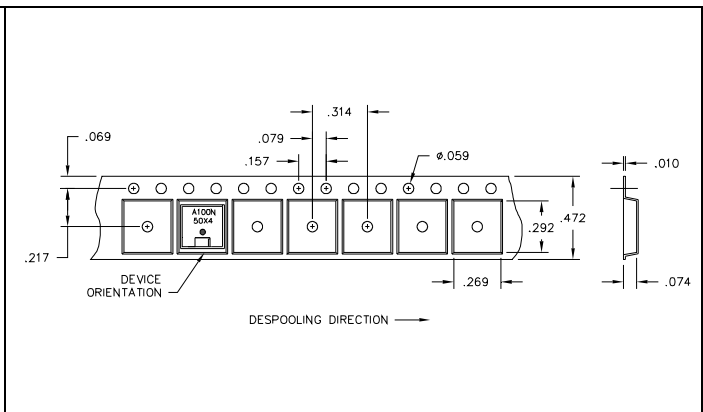
Typical Performance:



Power De-rating:



Tape & Reel:



Mounting Footprint and Procedure:

SUGGESTED STRESS RELIEF METHODS
SCALE: NONE

NOT RECOMMENDED APPLICATION
SCALE: NONE

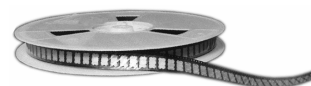
SUGGESTED MOUNTING PROCEDURES:

1. MAKE SURE THAT THE DEVICES ARE MOUNTED ON FLAT SURFACES (.001" UNDER THE DEVICE) TO OPTIMIZE THE HEAT TRANSFER.
2. POSITION DEVICE ON MOUNTING SURFACE AND SOLDER IN PLACE USING APPROPRIATE SOLDER WITH A CONTROLLED TEMPERATURE IRON.

A100N50X4 (097) Rev B

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Description



The A125N50X4 is high performance Aluminum Nitride (AlN) chip termination intended as an alternative to Beryllium Oxide (BeO). The termination is well suited to all cellular frequency bands such as; AMPS, GSM, DCS, PCS, PHS and UMTS. The high power handling makes the part ideal for terminating circulators and for use in power combiners. The termination is also RoHS compliant!

General Specifications

| | |
|------------------------------|-------------------------------------|
| Resistive Element | Thick film |
| Substrate | AlN Ceramic |
| Terminal Finish | Matte Tin over Nickel Barrier |
| Operating Temperature | -55 to +150°C (see de rating chart) |

Tolerance is ± 0.010 ", unless otherwise specified. Designed to meet or exceed applicable portions of MIL-E-5400. **All dimensions in inches.**

Features:

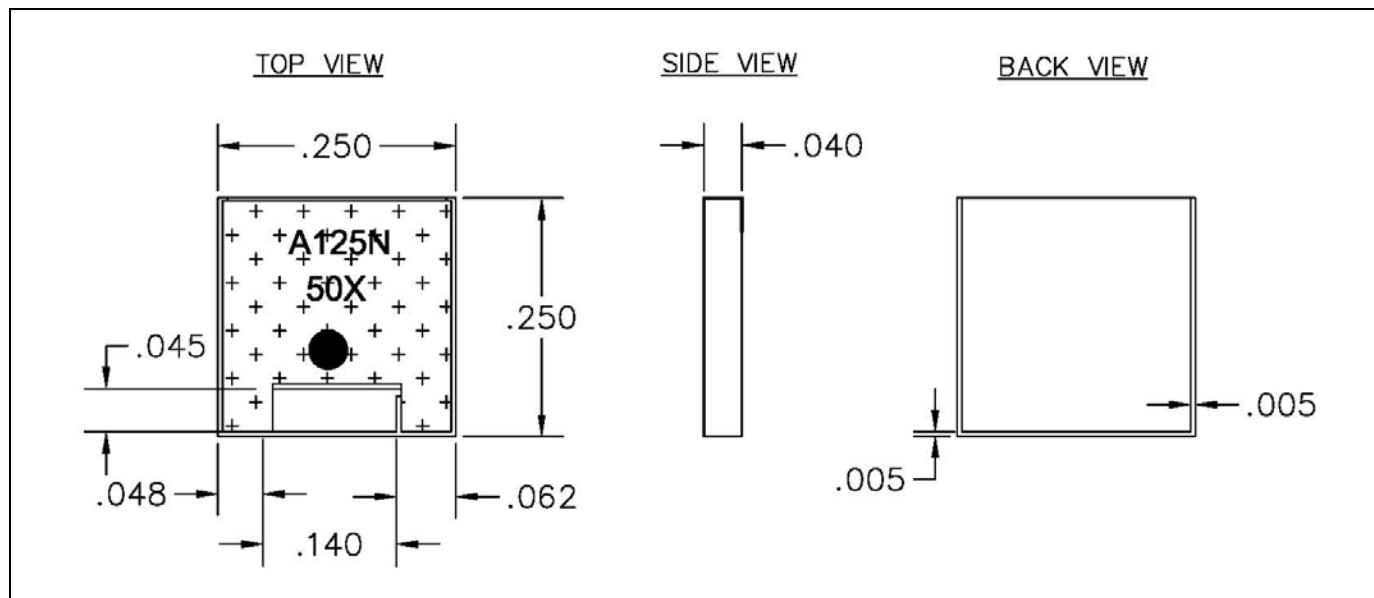
- RoHS Compliant
- 125 Watts
- DC – 4.0 GHz
- AlN Ceramic
- Non-Nichrome Resistive Element
- Low VSWR
- 100% Tested
- Small Size

Electrical Specifications

| | |
|--------------------------|--|
| Resistance Value: | 50 Ohms, $\pm 2\%$ |
| Power: | 125 Watts |
| Frequency Range: | DC – 4.0 GHz |
| Return Loss | > 26 dB to 2.7 GHz > 20 dB to 4.0 GHz |

Specification based on unit properly installed using suggested mounting instructions and a 50 ohm nominal impedance. **Specifications subject to change.**

Outline Drawing

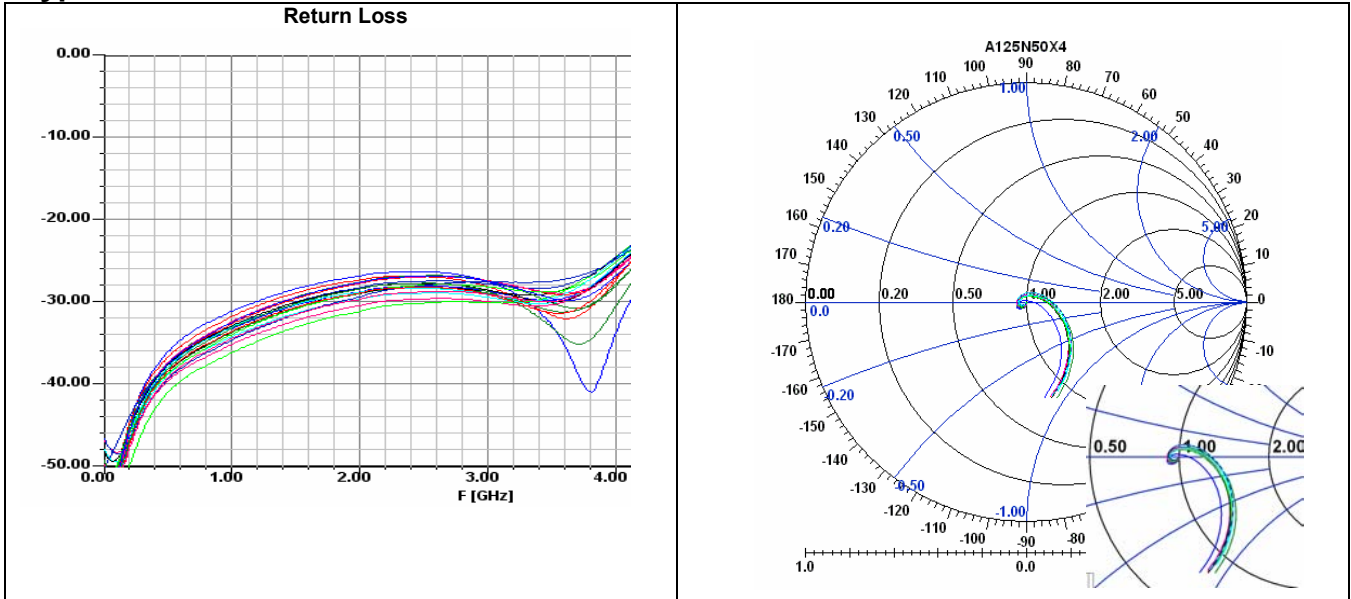


A125N50X4 (097) rev.D pg.1 of 2

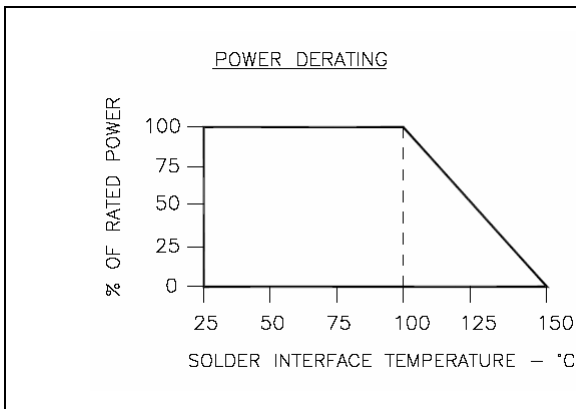




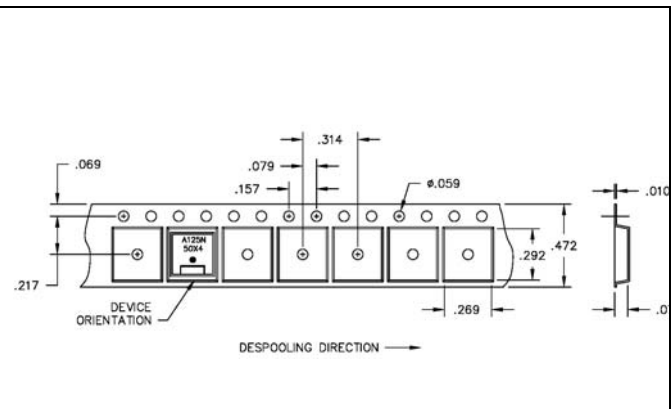
Typical Performance:



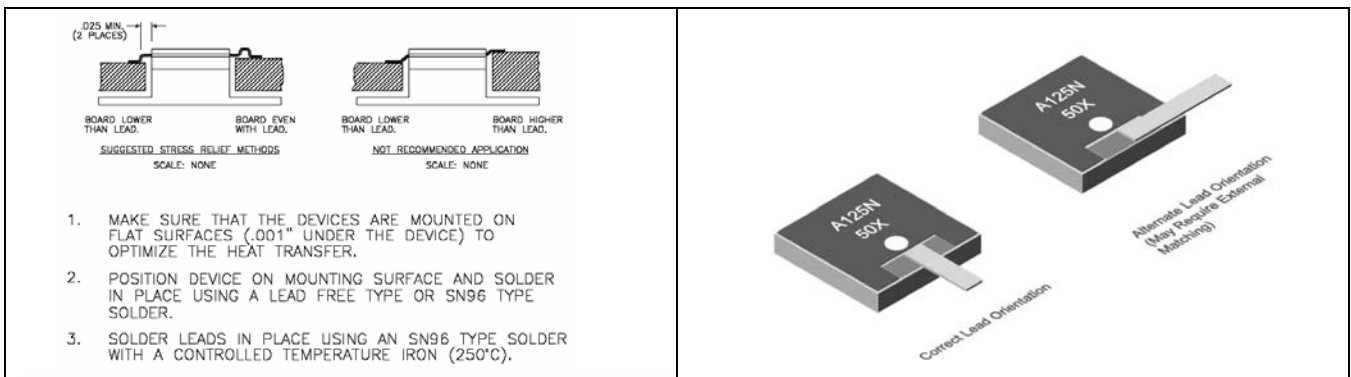
Power De-rating:



Tape & Reel:



Mounting Footprint and Procedure:





Description

The A150N50X4B is high performance Aluminum Nitride (AlN) chip termination intended as a cost competitive alternative to Beryllium Oxide (BeO). The termination is well suited to all cellular frequency bands such as; AMPS, GSM, DCS, PCS, PHS and UMTS. The high power handling makes the part ideal for terminating circulators, and for use in power combiners. The termination is also RoHS compliant!

General Specifications

| | |
|------------------------------|--------------------------------------|
| Resistive Element | Thick film |
| Substrate | AlN Ceramic |
| Terminal Finish | Matte Tin over Nickel Barrier |
| Operating Temperature | -55 to +200°C (see de rating chart) |

Tolerance is ± 0.010 ", unless otherwise specified. Designed to meet or exceed applicable portions of MIL-E-5400. All dimensions in inches.

Electrical Specifications

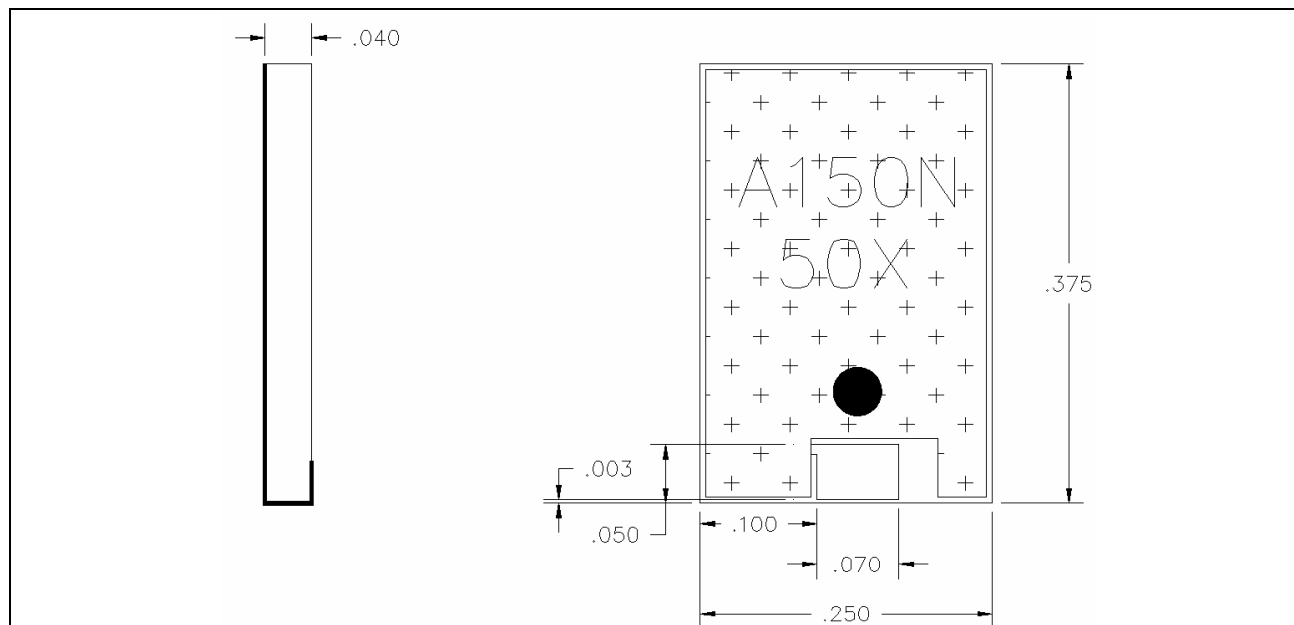
| | |
|--------------------------|--------------------------------------|
| Resistance Value: | 50 Ohms, $\pm 2\%$ |
| Power: | 150 Watts |
| Frequency Range: | DC – 2.7 GHz |
| Return Loss | >26dB to 2.0 GHz >20dB to 2.7 GHz |

Specification based on unit properly installed using suggested mounting instructions and a 50 ohm nominal impedance. **Specifications subject to change.**

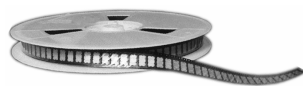
Features:

- RoHS Compliant
- 150 Watts
- DC - 2.7 GHz
- AlN Ceramic
- Non-Nichrome Resistive Element
- Low VSWR
- 100% Tested

Outline Drawing



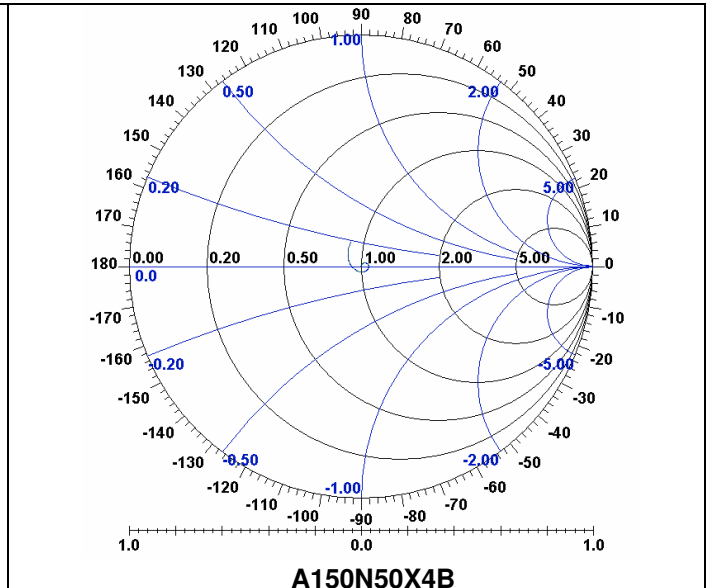
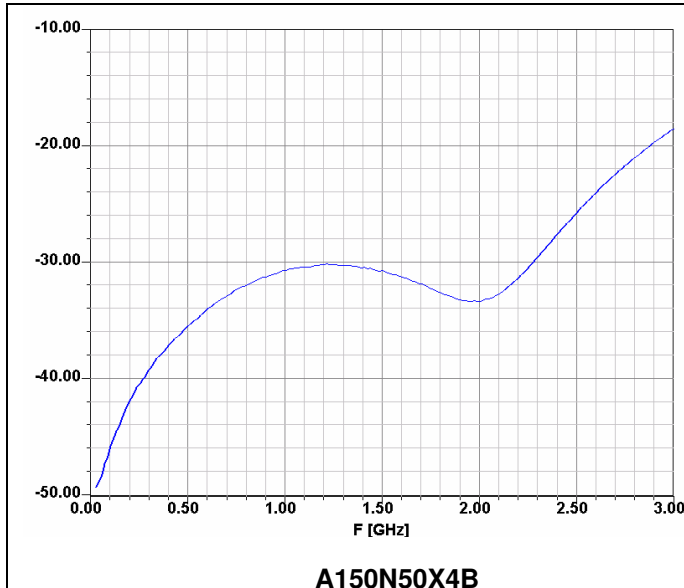
A150N50X4 (097) Rev E



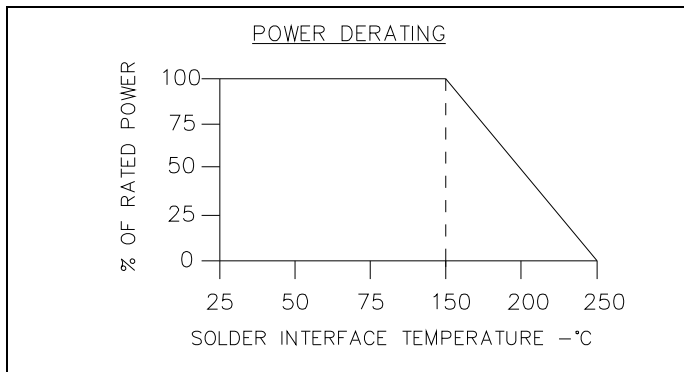
Model A150N50X4B

Anaren

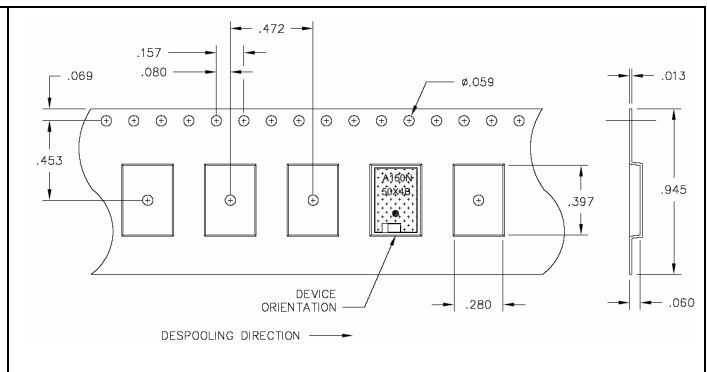
Typical Performance:



Power De-rating:



Tape & Reel:



Mounting Footprint and Procedure:

SUGGESTED STRESS RELIEF METHODS
SCALE: NONE

NOT RECOMMENDED APPLICATION
SCALE: NONE

SUGGESTED MOUNTING PROCEDURES:

- MAKE SURE THAT THE DEVICES ARE MOUNTED ON FLAT SURFACES (.001" UNDER THE DEVICE) TO OPTIMIZE THE HEAT TRANSFER.
- POSITION DEVICE ON MOUNTING SURFACE AND SOLDER IN PLACE USING SN96 SOLDER.
- SOLDER LEADS IN PLACE USING AN SN96 TYPE SOLDER WITH A CONTROLLED TEMPERATURE IRON (260°C).

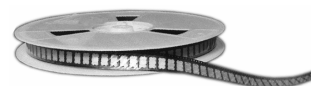
Correct Lead Orientation

**Alternate Lead Orientation
(May Require External Matching)**

A150N50X4 (097) Rev E

USA/Canada: (315) 432-8909
Toll Free: (800) 544-2414
Europe: +44 2392-232392

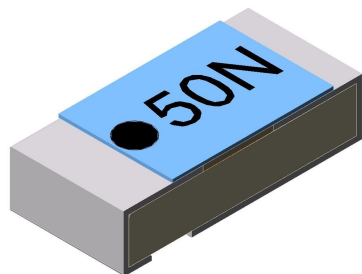
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**RoHS
Compliant**

**Surface Mount Termination
10 Watts, 50Ω**



General Specifications

| | |
|---------------------------|--------------------------|
| Resistive Element: | Thick film |
| Terminations: | Thick film silver |
| Substrate: | Aluminum Nitride Ceramic |

Electrical Specifications

| | |
|--------------------------|----------------------------------|
| Resistance value: | 50 ohms |
| Frequency Range: | DC – 3.0 GHz |
| Power: | 10 Watts |
| VSWR: | 1.25:1 to 2 GHz, 1.43:1 to 3 GHz |

Tolerance is $\pm 0.010"$, unless otherwise specified. Designed to meet or exceed applicable portions of MIL-E-5400. Operating temperature is -55°C to 125°C (see chart for derating temperatures).

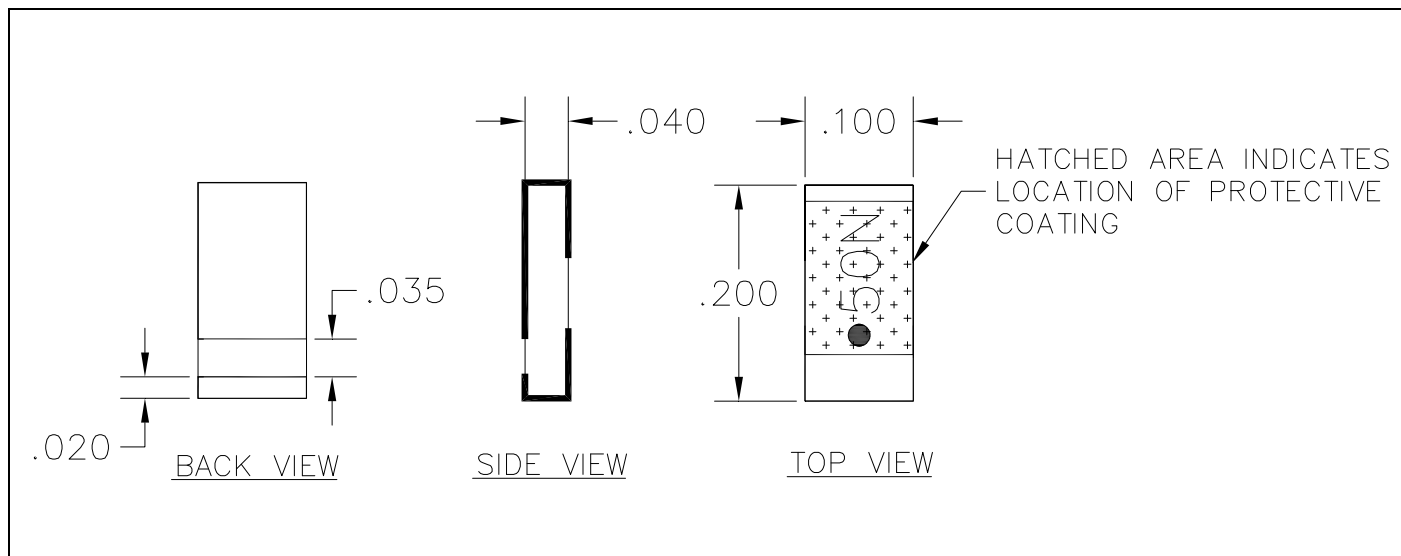
All dimensions in inches.

Specifications subject to change without notice.

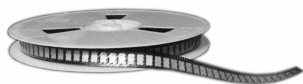
Features:

- DC – 3.0 GHz
- 10 Watts
- ALN Ceramic
- Non-Nichrome Resistive Element
- 100% Tested
- RoHS Compliant

Outline Drawing

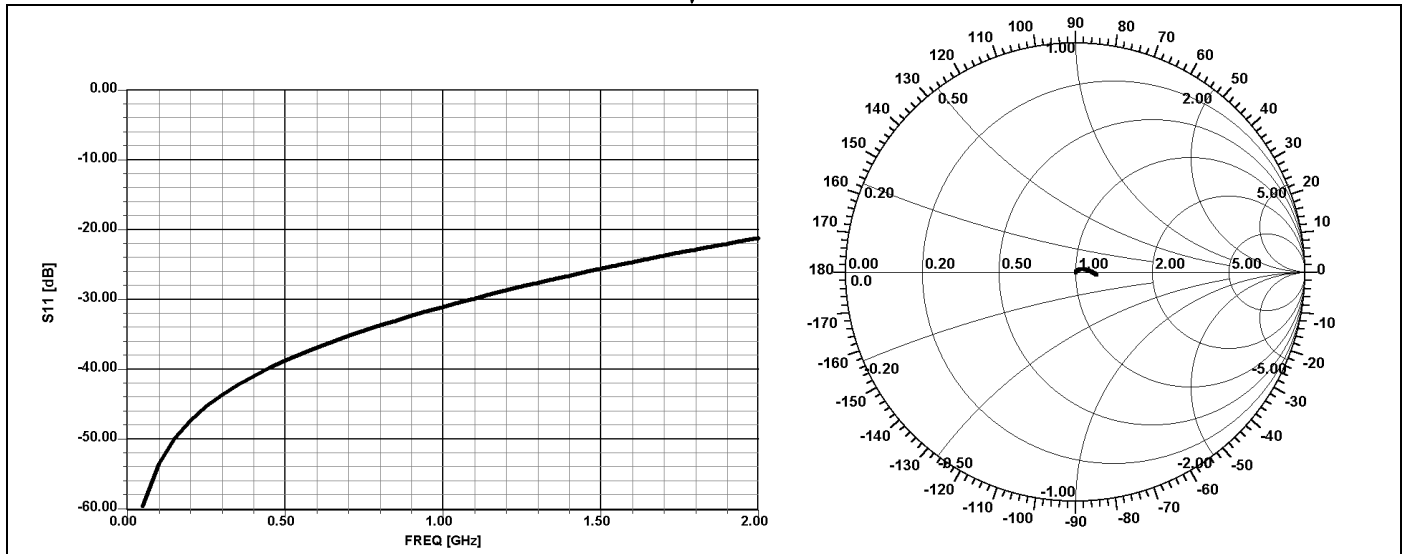


C10N50Z4A (097) Rev B

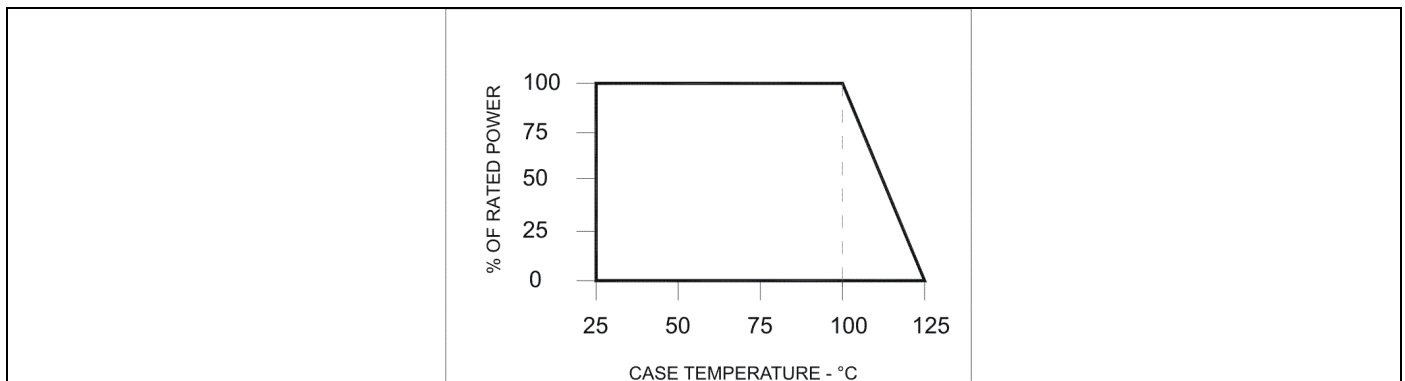


Typical Performance:

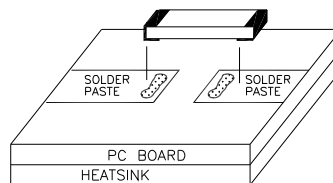
**RoHS
Compliant**



Power De-rating:



Mounting Procedure:



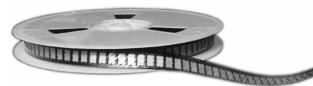
MOUNTING PROCEDURE

1. Make sure that the devices are mounted on flat surfaces (0.001" under the device) to optimize the heat transfer.
2. Position device on mounting surface and solder in place using an appropriate type solder.

C10N50Z4A (097) Rev B

USA/Canada: (315) 432-8909
Toll Free: (800) 544-2414
Europe: +44 2392-232392

Available on Tape and
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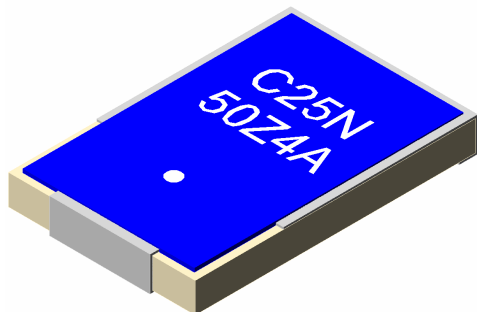
Anaren

RF Power

Model C25N50Z4A

**RoHS
Compliant**

**ALN SMT Termination
25 Watts, 50Ω**



General Specifications

| | |
|-------------------|------------------|
| Resistive Element | Thick film |
| Terminations | Matte Tin Finish |
| Substrate | Aluminum Nitride |

Electrical Specifications

| | |
|-------------------|--------------|
| Resistance value: | 50 ohms |
| Frequency Range; | DC – 3.0 GHz |
| Power: | 25 Watts |
| VSWR: | 1.25:1 |

Tolerance is ± 0.010 ", unless otherwise specified. Designed to meet or exceed applicable portions of MIL-E-5400. Operating temperature is -55°C to 125°C (see chart for derating temperatures).

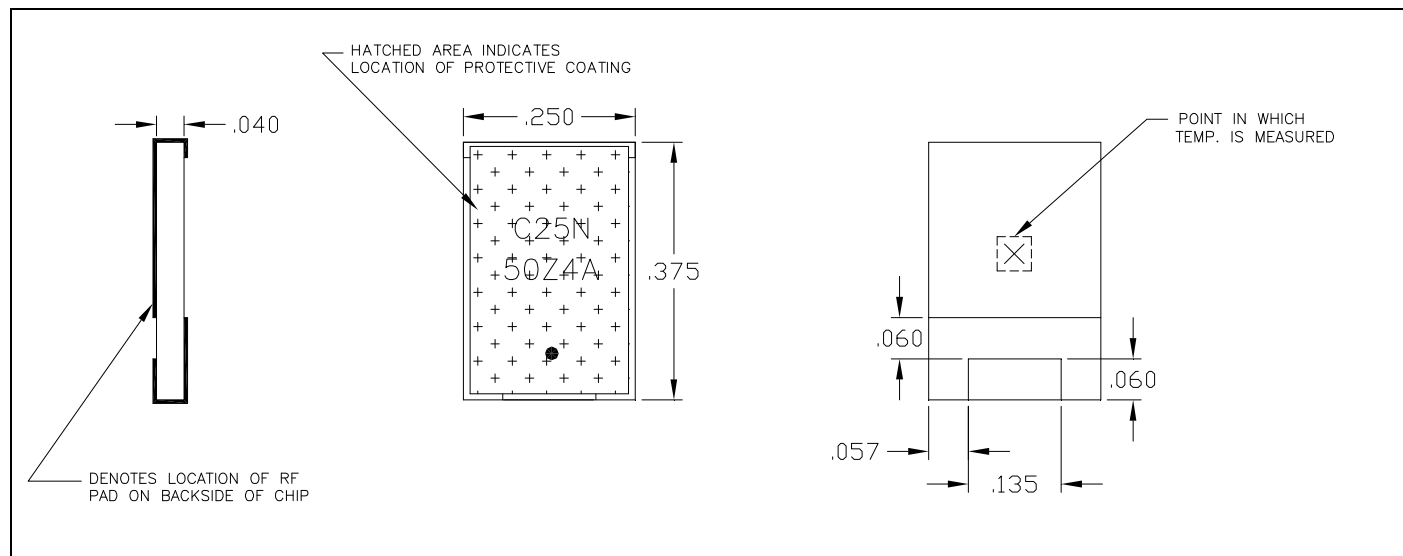
All dimensions in inches.

Specifications subject to change with out notice.

Features:

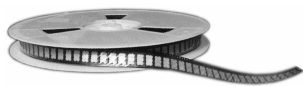
- DC – 3.0 GHz
- 25 Watts
- Aluminum Nitride Ceramic
- Non-Nichrome Resistive Element
- 100% Tested
- RoHS Compliant

Outline Drawing



C25N50Z4A (097) Rev C

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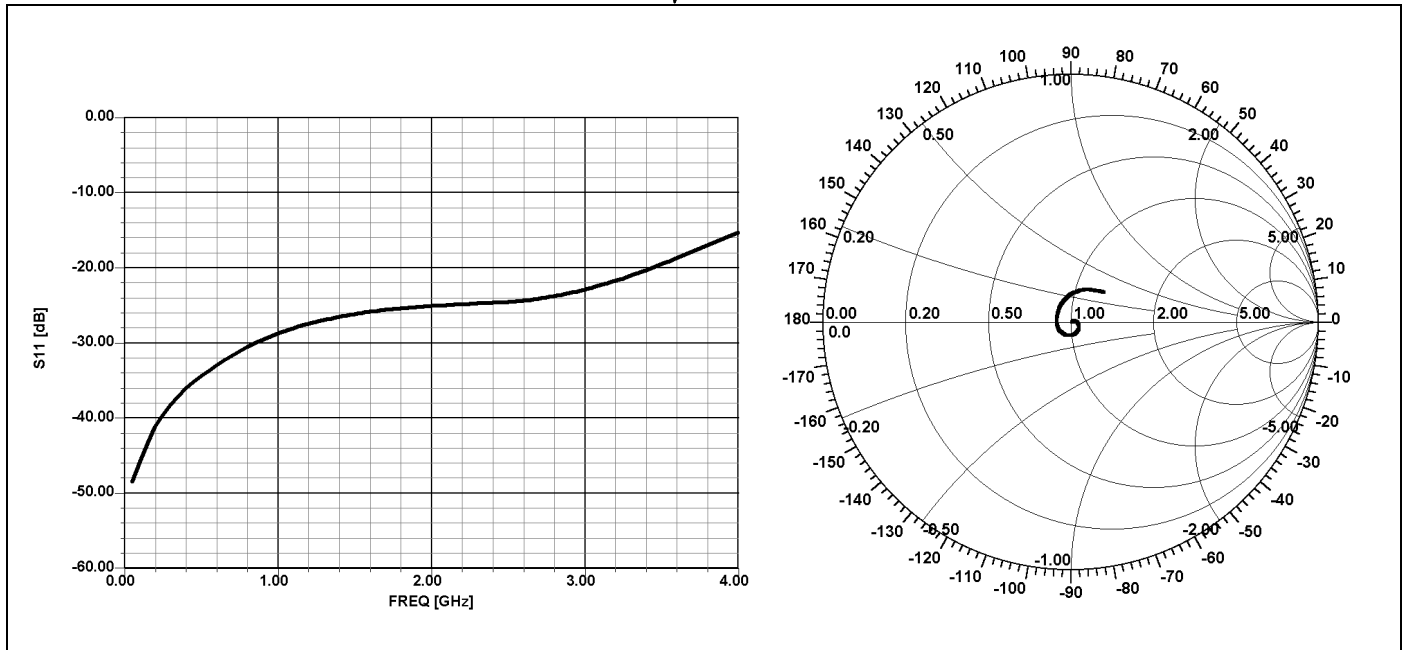
Model C25N50Z4A

Anaren

Typical performance

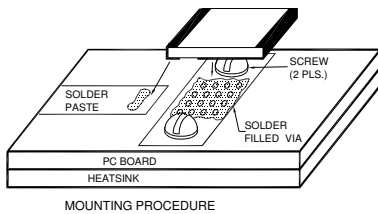
RoHS
Compliant

RF Power

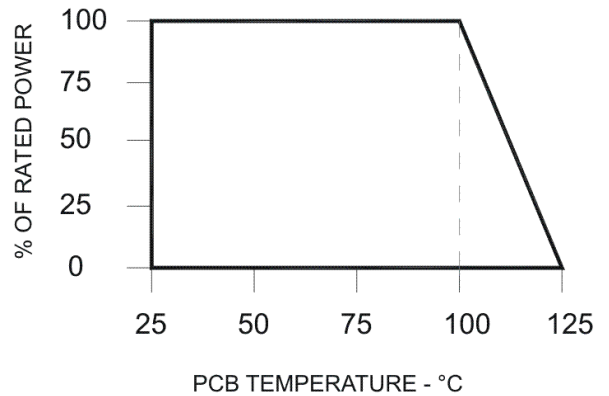


Mounting Procedure:

Power De-rating:



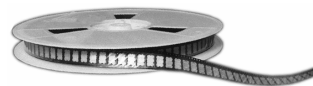
1. Solder part in place using SN96 type solder with a controlled temperature iron.
2. Drill thermal vias through PCB and fill with solder.
3. To ensure good thermal connectivity to heat sink, which is critical for proper operation drill and tap heatsink and mount PCB to heat sink using screws.



C25N50Z4A (097) Rev C

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Description



The C50A50Z4 is high performance Alumina (Al₂O₃) surface mount termination intended as a low cost alternative to Aluminum Oxide (AlN). The termination is well suited to all cellular frequency bands such as; AMPS, GSM, DCS, PCS, PHS and UMTS. The high power handling makes the part ideal for terminating high power 90 degree couplers, and for use in microstrip circuits. The termination is also RoHS compliant!

General Specifications

| | |
|------------------------------|--|
| Resistive Element | Thick film |
| Substrate | Al ₂ O ₃ Ceramic |
| Terminal Finish | Matte Tin over Nickel Barrier |
| Operating Temperature | -55 to +125°C (see de rating chart) |

Tolerance is ± 0.010 ", unless otherwise specified. Designed to meet or exceed applicable portions of MIL-E-5400. **All dimensions in inches.**

Features:

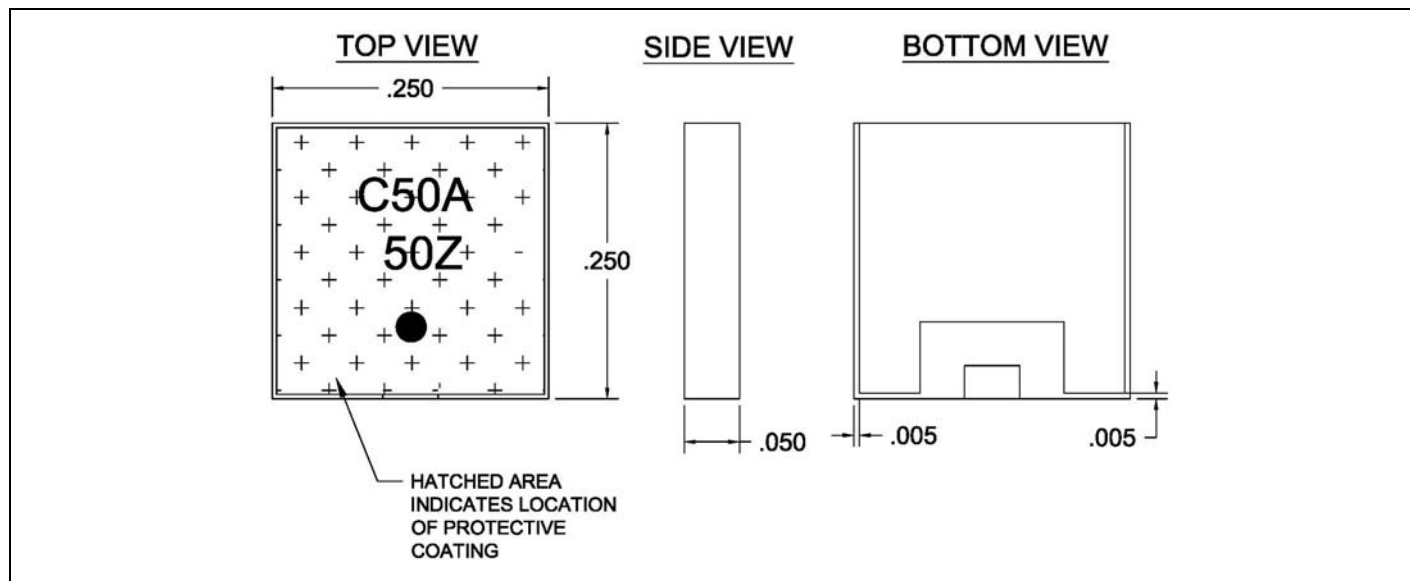
- RoHS Compliant
- 50 Watts
- DC - 2.7 GHz
- Al₂O₃ Ceramic
- Non-Nichrome Resistive Element
- Low VSWR
- 100% Tested
- Small Size

Electrical Specifications

| | |
|--------------------------|--|
| Resistance Value: | 50 Ohms, $\pm 2\%$ |
| Power: | 50 Watts |
| Frequency Range: | DC – 2.7 GHz |
| Return Loss | >26 dB to 2.2 GHz >24 dB to 2.7 GHz |

Specification based on unit properly installed using suggested mounting instructions and a 50 ohm nominal impedance. **Specifications subject to change.**

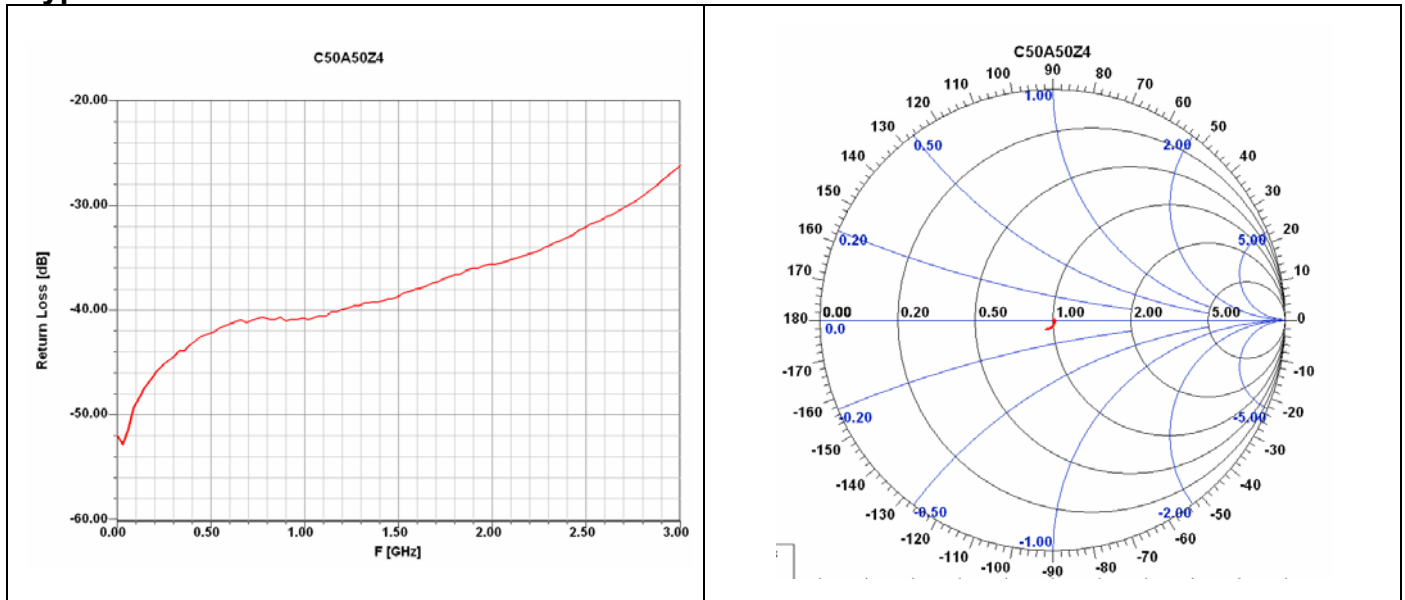
Outline Drawing



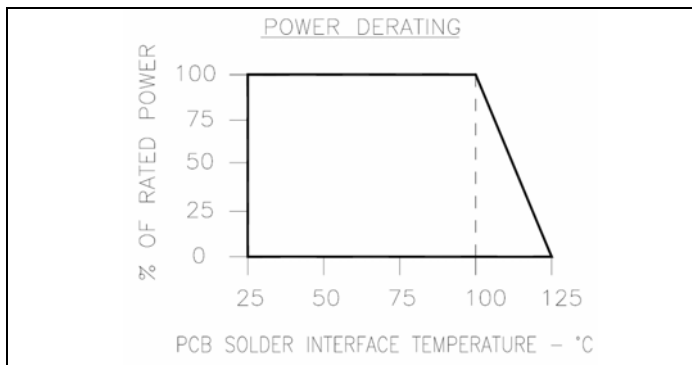
C50A50Z4 (097) rev.C pg. 1 of 2



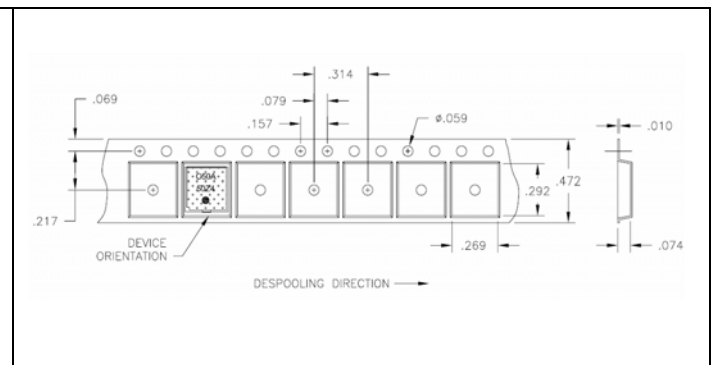
Typical Performance:



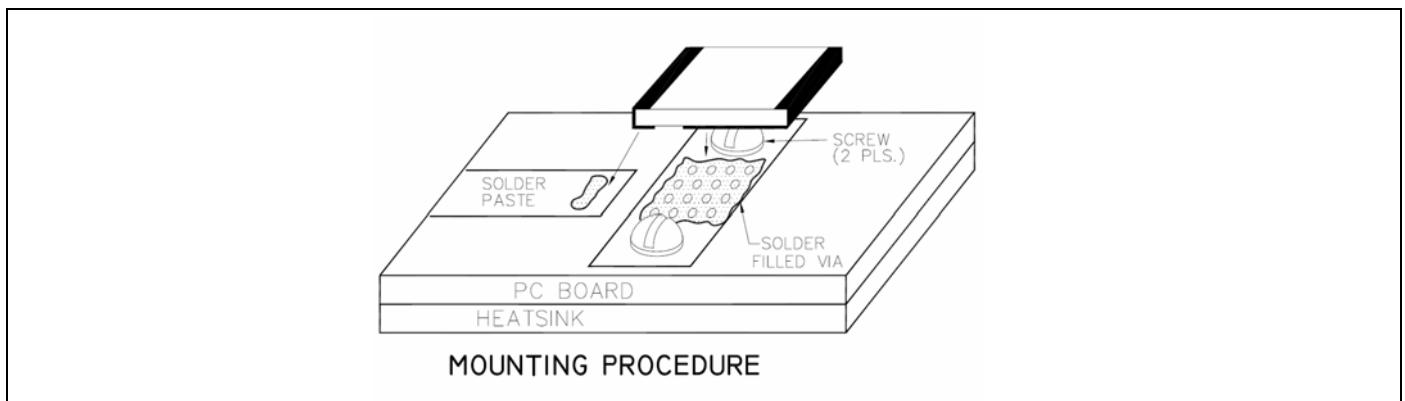
Power De-rating:



Tape & Reel:



Mounting Footprint and Procedure:



C50A50Z4 (097) rev.C pg. 2 of 2





Surface Mount Termination 100 Watts, 50Ω



Description

The C100N50Z4 is high performance Aluminum Nitride (AlN) surface mount termination intended as a cost competitive alternative to Beryllium Oxide (BeO). The termination is well suited to all cellular frequency bands such as; AMPS, GSM, DCS, PCS, PHS and UMTS. The high power handling makes the part ideal for terminating high power 90 degree couplers, and for use in microstrip circuits. The termination is also RoHS compliant!

General Specifications

| | |
|------------------------------|-------------------------------------|
| Resistive Element | Thick film |
| Substrate | AlN Ceramic |
| Terminal Finish | Matte Tin over Nickel Barrier |
| Operating Temperature | -55 to +125°C (see de rating chart) |

Tolerance is ± 0.010 ", unless otherwise specified. Designed to meet or exceed applicable portions of MIL-E-5400. **All dimensions in inches.**

Features:

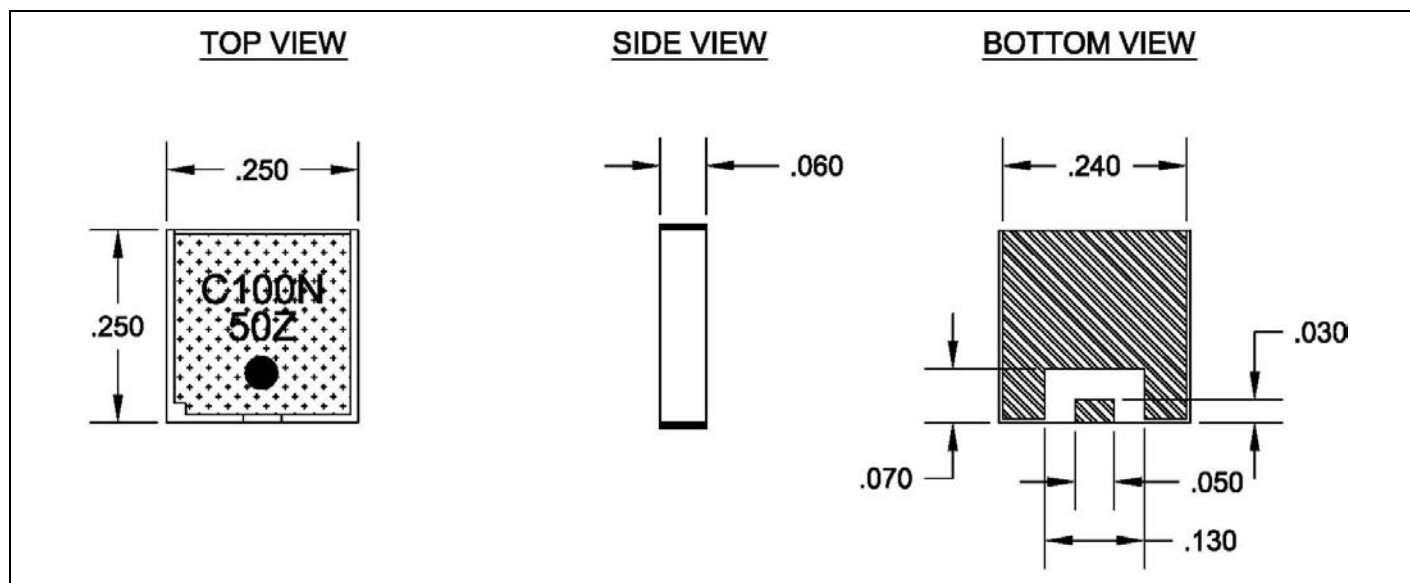
- RoHS Compliant
- 100 Watts
- DC – 4.0 GHz
- AlN Ceramic
- Non-Nichrome Resistive Element
- Low VSWR
- 100% Tested
- Small Size

Electrical Specifications

| | |
|--------------------------|--|
| Resistance Value: | 50 Ohms, $\pm 2\%$ |
| Power: | 100 Watts |
| Frequency Range: | DC – 4.0 GHz |
| Return Loss | >24 dB DC - 2.7 GHz >20 dB DC - 4.0 GHz |

Specification based on unit properly installed using suggested mounting instructions and a 50 ohm nominal impedance. **Specifications subject to change.**

Outline Drawing



C100N50Z4 (097) rev.C pg. 1 of 2



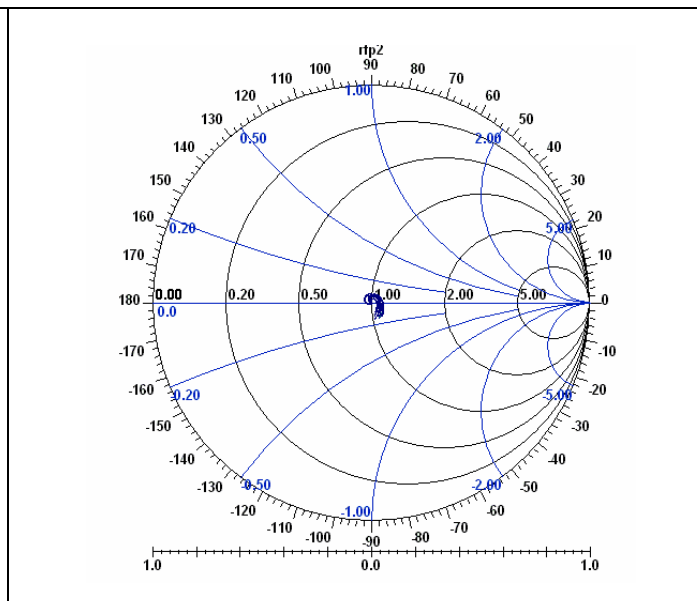
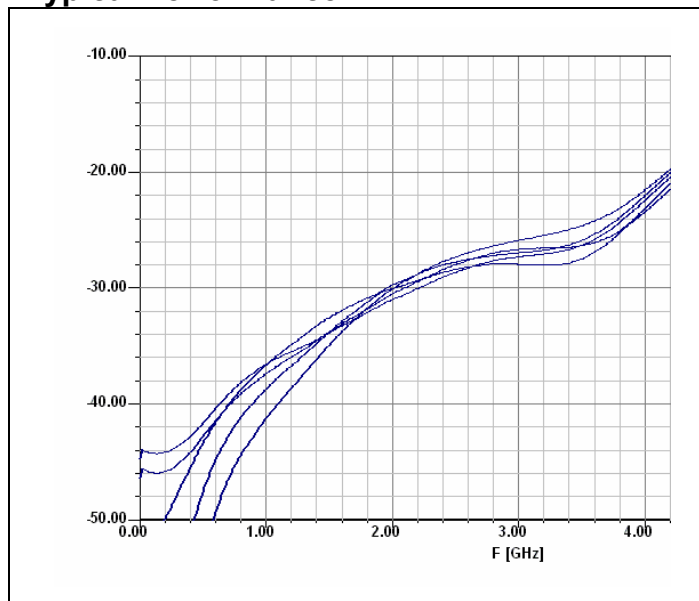
Model C100N50Z4

ROHS
Compliant

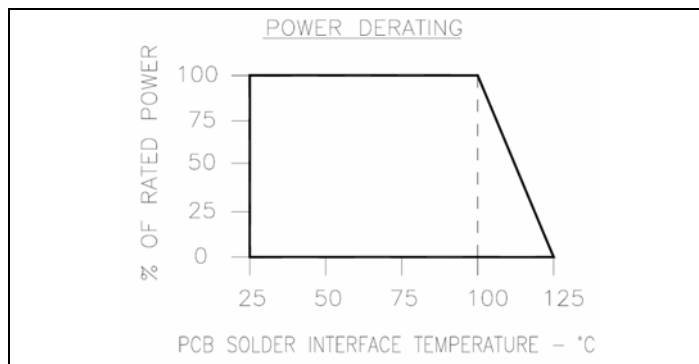
Anaren

RF Power

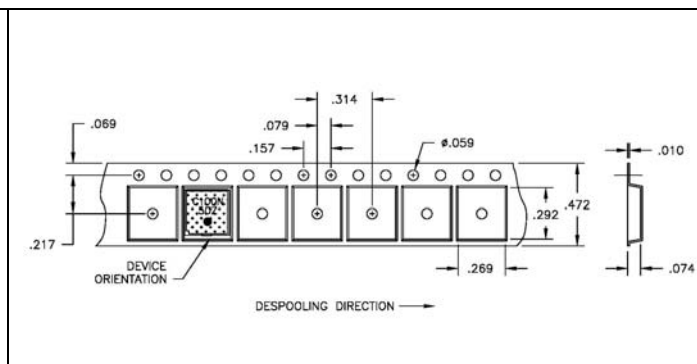
Typical Performance:



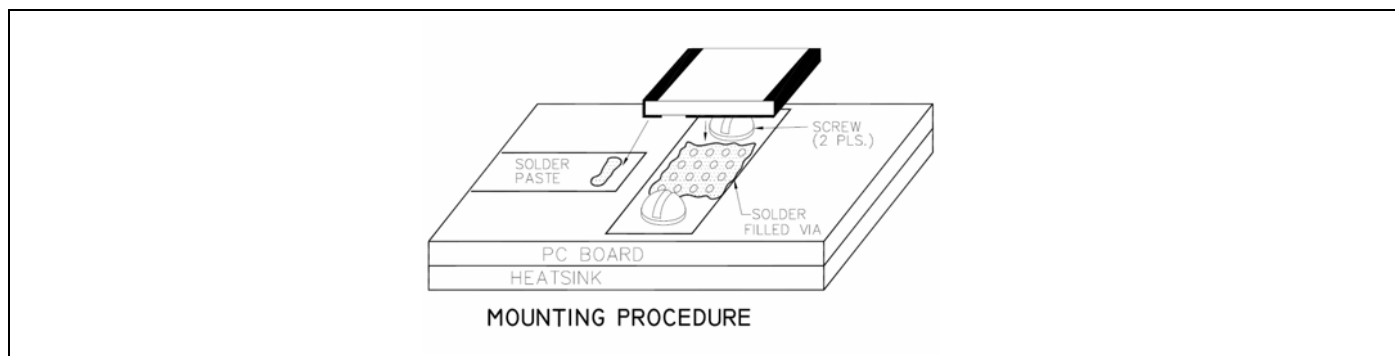
Power De-rating:



Tape & Reel:



Mounting Footprint and Procedure:



C100N50Z4 (097) rev.C pg. 2 of 2

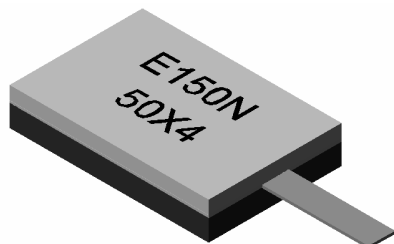
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Flangeless Mount Termination 150 Watts, 50Ω



Description

The E150N50X4 is high performance Aluminum Nitride (AlN) termination intended as a cost competitive alternative to Beryllium Oxide (BeO). The termination is well suited to all cellular frequency bands such as; AMPS, GSM, DCS, PCS, PHS and UMTS. The high power handling makes the part ideal for terminating circulators, and for use in power combiners. The termination is also RoHS compliant!

General Specifications

| | |
|--------------------------|-----------------------|
| Resistive Element | Thick Film |
| Substrate | AlN Ceramic |
| Finish | Matte Tin over Nickel |
| Cover | Alumina Ceramic |

Tolerance is ± 0.010 ", unless otherwise specified. Designed to meet or exceed applicable portions of MIL-E-5400. **All dimensions in inches.**

Electrical Specifications

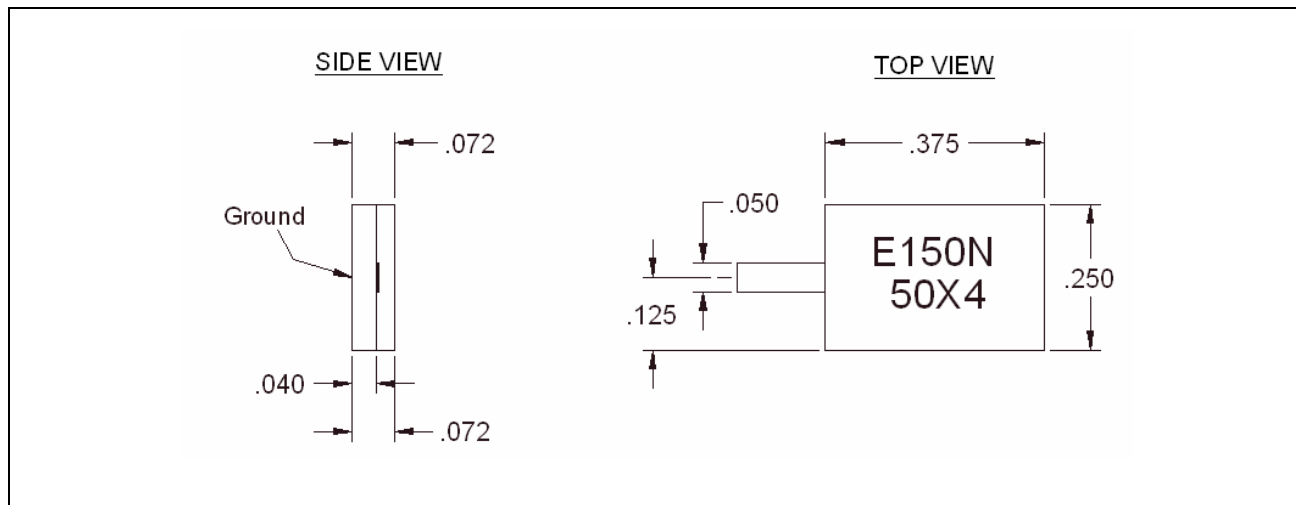
| | |
|--------------------------|--|
| Resistance Value: | 50 Ohms, $\pm 2\%$ |
| Power: | 150 Watts |
| Frequency Range: | DC – 2.7 GHz |
| Return Loss | > 25 dB DC – 2.0 GHz > 20 dB DC – 2.7 GHz |

Specification based on unit properly installed using suggested mounting instructions and a 50 ohm nominal impedance. **Specifications subject to change.**

Features:

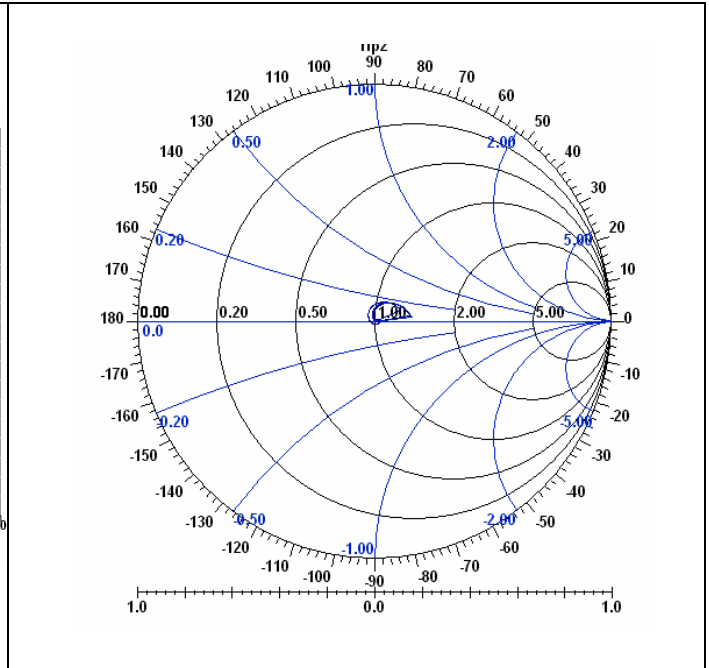
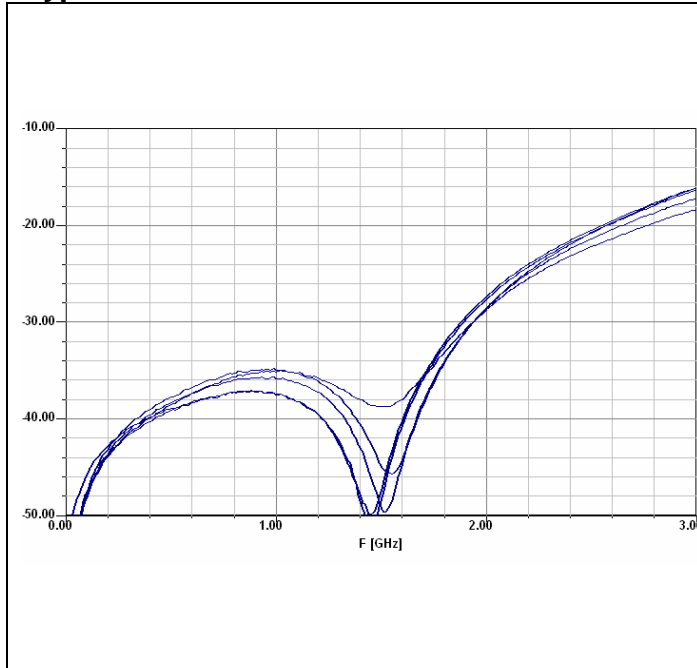
- RoHS Compliant
- 150 Watts
- DC – 2.7GHz
- AlN Ceramic
- Non-Nichrome Resistive Element
- Low VSWR
- 100% Tested

Outline Drawing



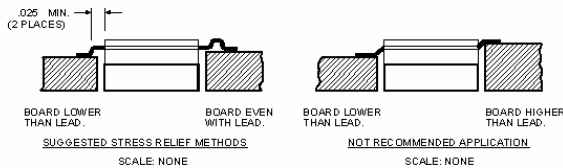
E150N50X4 (097) rev.E pg. 1 of 2

Typical Performance:



Power De-rating:

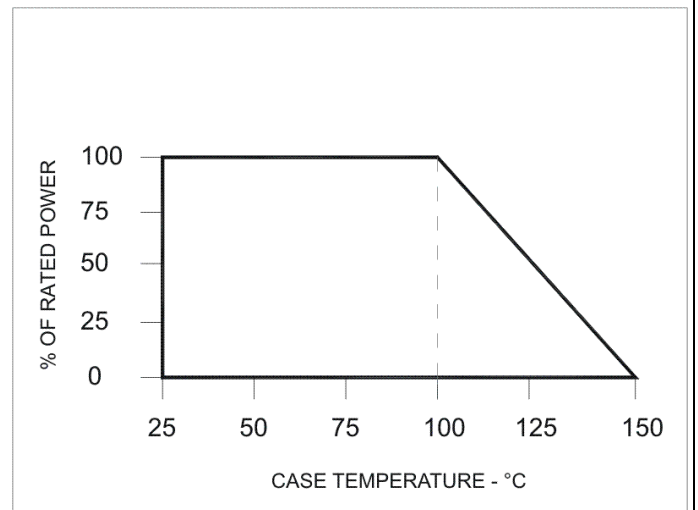
Mounting Footprint and Procedure:



SUGGESTED MOUNTING PROCEDURES:

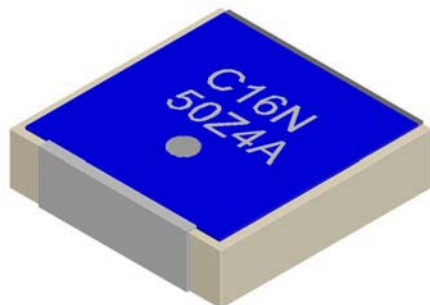
1. MAKE SURE THAT THE DEVICES ARE MOUNTED ON FLAT SURFACES (.001" UNDER THE DEVICE) TO OPTIMIZE THE HEAT TRANSFER.
2. DRILL & TAP THE HEATSINK FOR THE APPROPRIATE THREAD SIZE TO BE USED.
3. COAT HEATSINK WITH A MINIMUM AMOUNT OF HIGH QUALITY SILICONE GREASE (.001" MAX. THICKNESS).
4. POSITION DEVICE ON MOUNTING SURFACE & SECURE USING SOCKET HEAD SCREWS, FLAT & SPLIT WASHER. TORQUE SCREWS TO THE APPROPRIATE VALUE. MAKE SURE THAT THE DEVICE IS FLAT AGAINST THE HEATSINK (CARE SHOULD BE TAKEN TO AVOID UPWARD PRESSURE OF THE LEADS TOWARDS THE LID).
5. SOLDER LEADS IN PLACE USING LEAD FREE TYPE SOLDER WITH A CONTROLLED TEMPERATURE IRON

** FOR MORE DETAILS CONTACT FACTORY **



**RoHS
Compliant**

**Surface Mount Termination
16 Watts, 50Ω**



General Specifications

| | |
|--------------------------|---------------------------------|
| Resistive Element | Thick film |
| Finish | Matte Tin over Sulfamate Nickel |
| Substrate | ALN |

Electrical Specifications

| | |
|--------------------------|--------------|
| Resistance value: | 50 ohms |
| Frequency Range; | DC – 3.0 GHz |
| Power: | 16 Watts |
| VSWR: | <1.25:1 |

Tolerance is ± 0.010 ", unless otherwise specified. Designed to meet or exceed applicable portions of MIL-E-5400. Operating temperature is -55°C to 125°C (see chart for derating temperatures).

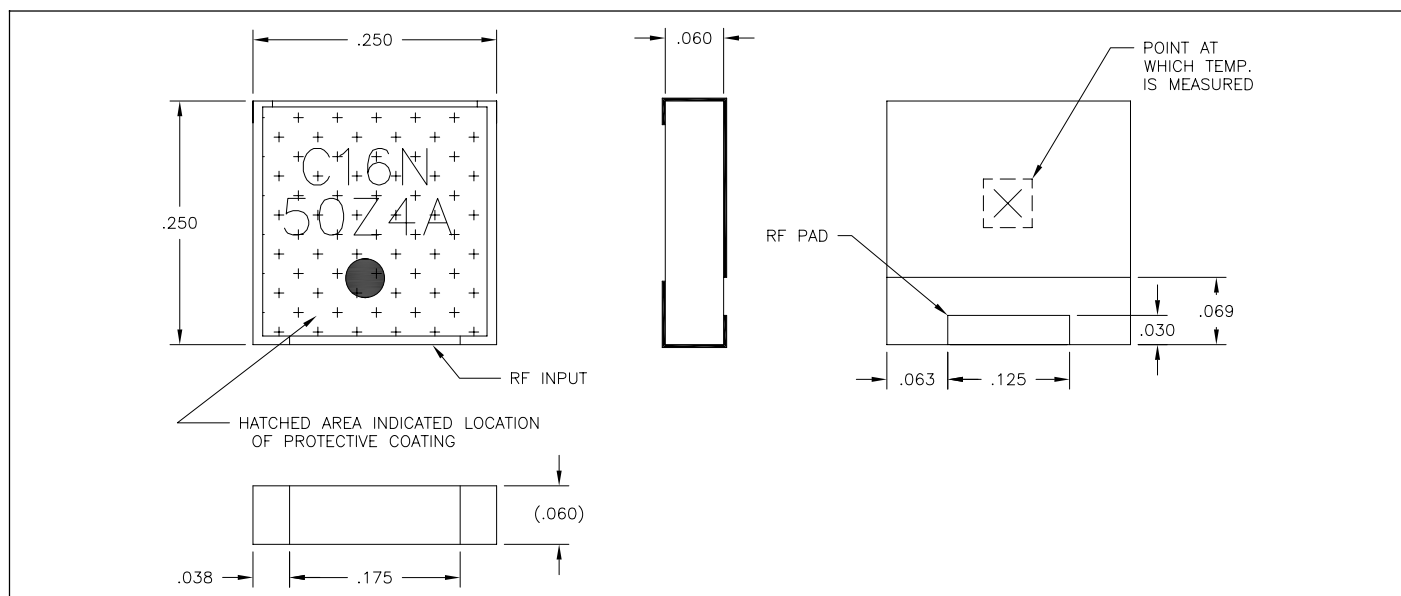
All dimensions in inches.

Specifications subject to change without notice.

Features:

- DC – 3.0 GHz
- 16 Watts
- ALN Ceramic
- Non-Nichrome Resistive Element
- 100% Tested
- RoHS Compliant

Outline Drawing

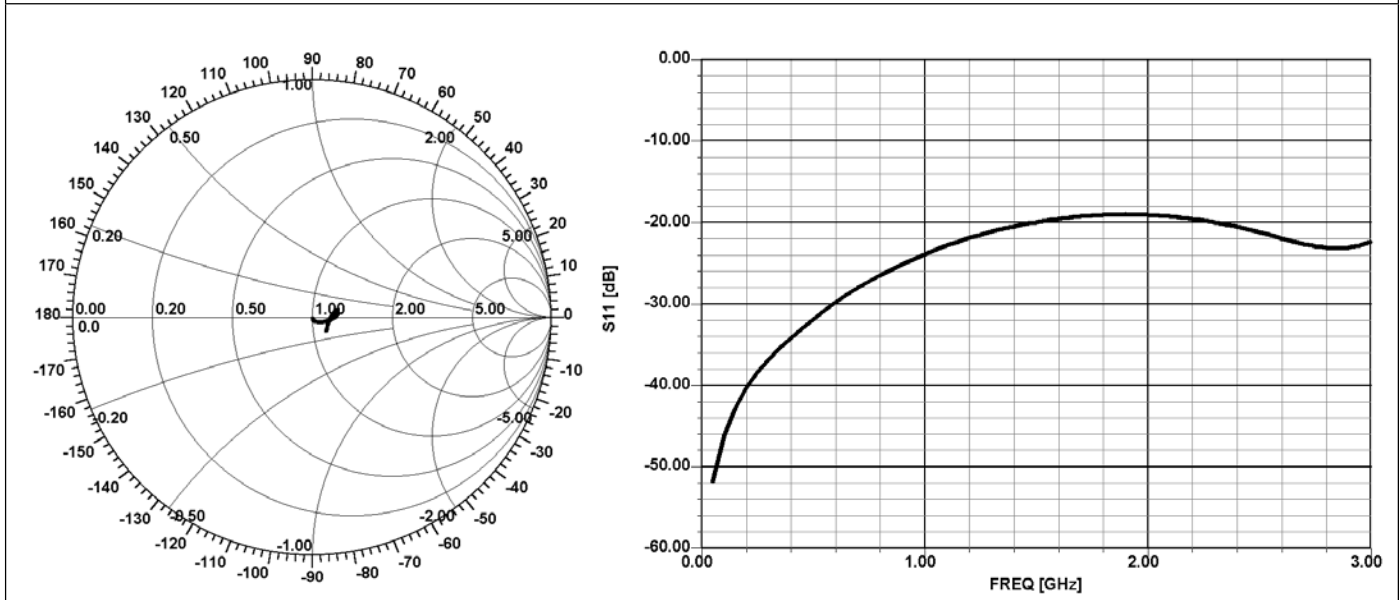


C16N50Z4A (097) Rev B



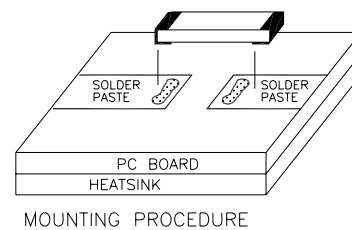
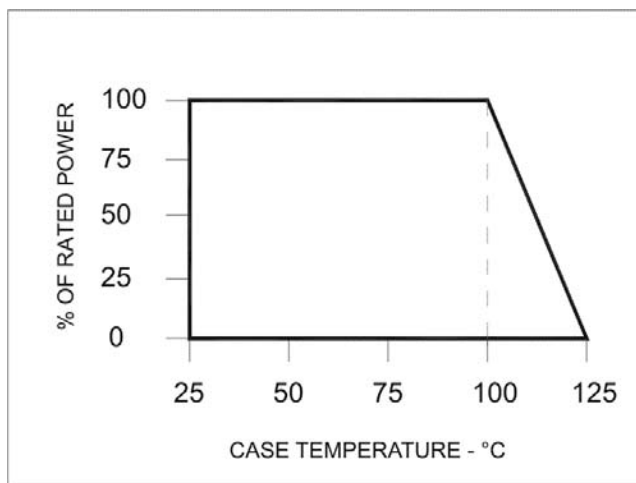
**RoHS
Compliant**

Typical Performance:



Power De-rating:

Mounting Procedure:



1. Make sure that the devices are mounted on flat surfaces (0.001" under the device) to optimize the heat transfer.
2. Position device on mounting surface and solder in place using an appropriate type solder.

C16N50Z4A (097) Rev B

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Toll Free: (800) 544-2414
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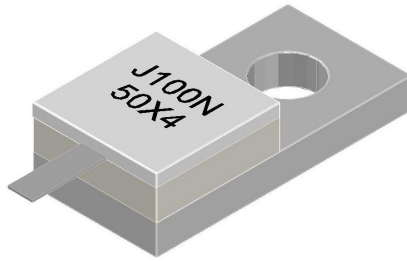
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**ROHS
Compliant**

Half Flange Termination 100 Watts, 50Ω



Description

The J100N50X4 is high performance Aluminum Nitride (AlN) half flange termination intended as a cost competitive alternative to Beryllium Oxide (BeO). The termination is well suited to all cellular frequency bands such as; AMPS, GSM, DCS, PCS, PHS and UMTS. The high power handling makes the part ideal for terminating circulators, and for use in power combiners. The termination is also RoHS compliant!

General Specifications

| | |
|--------------------------|------------------------------------|
| Resistive Element | Thick Film |
| Substrate | AlN Ceramic |
| Cover | Alumina Ceramic |
| Mounting Flange | Copper, nickel plated per QC-N-290 |
| Leads | 99% pure silver (.006" thick) |
| Cover | Alumina Ceramic |

Tolerance is $\pm 0.010"$, unless otherwise specified. Designed to meet or exceed applicable portions of MIL-E-5400. All dimensions in inches.

Electrical Specifications

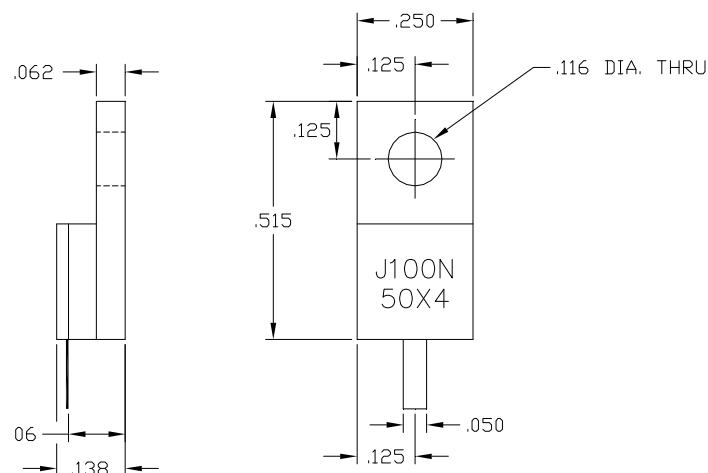
| | |
|--------------------------|--------------------|
| Resistance Value: | 50 Ohms, $\pm 2\%$ |
| Power: | 100 Watts |
| Frequency Range: | DC – 3.0GHz |
| V.S.W.R. | 1.25 : 1 |

Specification based on unit properly installed using suggested mounting instructions and a 50 ohm nominal impedance. Storage temperature is -20°C to 85°C. Operating temperature is -55°C to 125°C (see chart for derating temperatures). **Specifications subject to change with out notice.**

Features:

- RoHS Compliant
- 100 Watts
- DC – 3.0 GHz
- AlN Ceramic
- Non-Nichrome Resistive Element
- Low VSWR
- 100% Tested

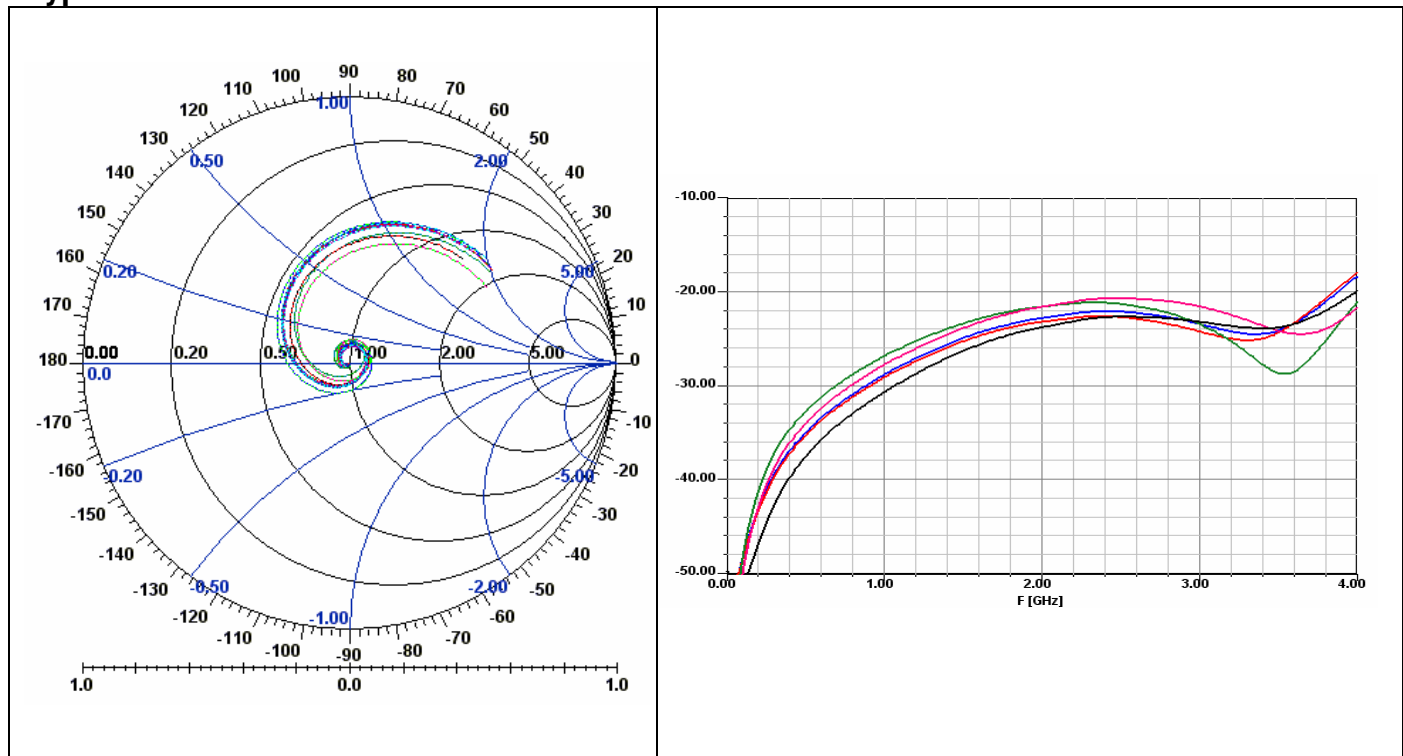
Outline Drawing



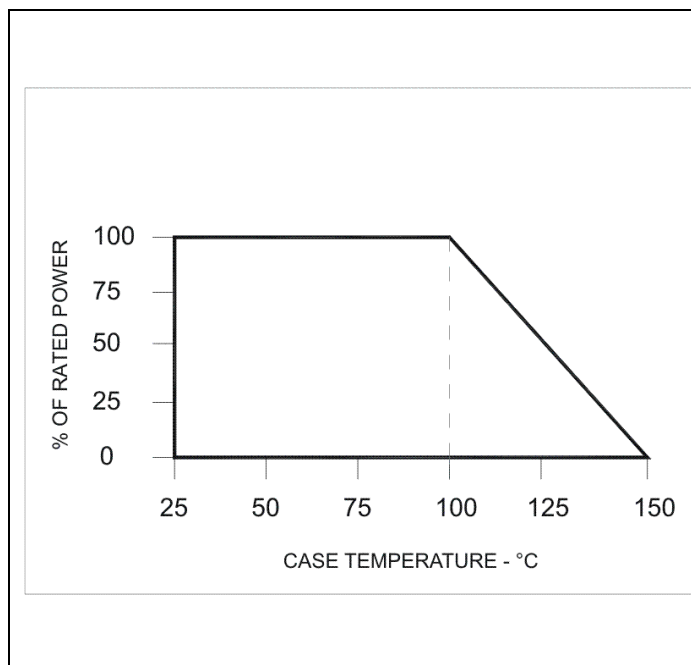
Note: All dimensions in inches – 1inch = 2.54cm. Lead Length: 0.150in min.

J100N50X4 (097) Rev D.

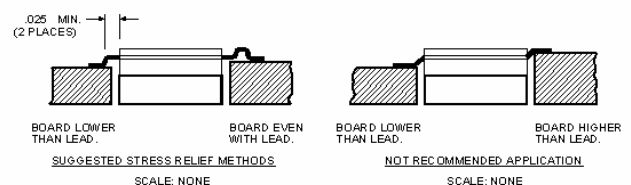
Typical Performance:



Power De-rating:



Mounting Footprint and Procedure:



SUGGESTED MOUNTING PROCEDURES:

1. MAKE SURE THAT THE DEVICES ARE MOUNTED ON FLAT SURFACES (.001" UNDER THE DEVICE) TO OPTIMIZE THE HEAT TRANSFER.
2. DRILL & TAP THE HEATSINK FOR THE APPROPRIATE THREAD SIZE TO BE USED.
3. COAT HEATSINK WITH A MINIMUM AMOUNT OF HIGH QUALITY SILICONE GREASE (.001" MAX. THICKNESS).
4. POSITION DEVICE ON MOUNTING SURFACE & SECURE USING SOCKET HEAD SCREWS, FLAT & SPLIT WASHER. TORQUE SCREWS TO THE APPROPRIATE VALUE. MAKE SURE THAT THE DEVICE IS FLAT AGAINST THE HEATSINK. (CARE SHOULD BE TAKEN TO AVOID UPWARD PRESSURE OF THE LEADS TOWARDS THE LID).
5. SOLDER LEADS IN PLACE USING LEAD FREE TYPE SOLDER WITH A CONTROLLED TEMPERATURE IRON

** FOR MORE DETAILS CONTACT FACTORY **

J100N50X4 (097) Rev D

Description



The C16A50Z4 is high performance Alumina (Al_2O_3) surface mount termination intended as a low cost alternative to Aluminum Oxide (AlN). The termination is well suited to all cellular frequency bands such as; AMPS, GSM, DCS, PCS, PHS and UMTS. The high power handling makes the part ideal for terminating high power 90 degree couplers, and for use in microstrip circuits. The termination is also RoHS compliant!

General Specifications

| | |
|------------------------------|-------------------------------------|
| Resistive Element | Thick film |
| Substrate | Al_2O_3 Ceramic |
| Terminal Finish | Matte Tin over Nickel Barrier |
| Operating Temperature | -55 to +125°C (see de rating chart) |

Tolerance is ± 0.010 ", unless otherwise specified. Designed to meet or exceed applicable portions of MIL-E-5400. **All dimensions in inches.**

Electrical Specifications

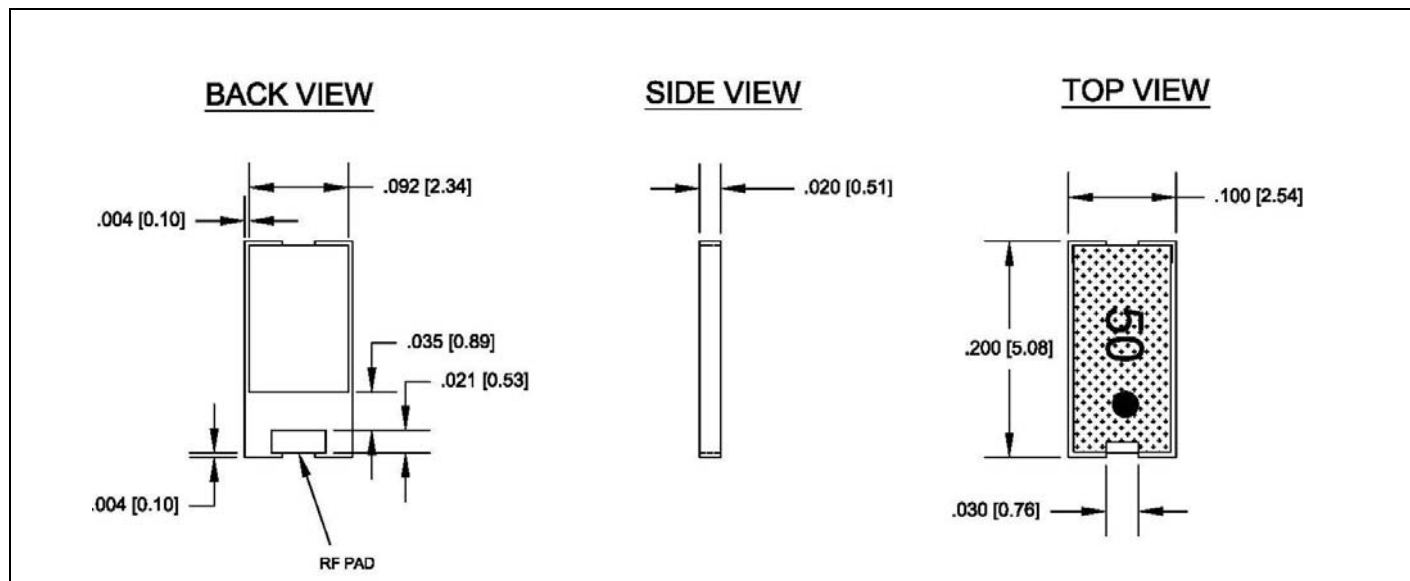
| | |
|--------------------------|--|
| Resistance Value: | 50 Ohms, $\pm 2\%$ |
| Power: | 16 Watts |
| Frequency Range: | DC – 4.0 GHz |
| Return Loss | > 26 dB DC to 2.7 GHz > 24 dB 2.7 GHz to 4.0GHz |

Specification based on unit properly installed using suggested mounting instructions and a 50 ohm nominal impedance. **Specifications subject to change.**

Features:

- RoHS Compliant
- 16 Watts
- DC – 4.0 GHz
- Al_2O_3 Ceramic
- Non-Nichrome Resistive Element
- Low Return Loss
- 100% Tested
- Small Size

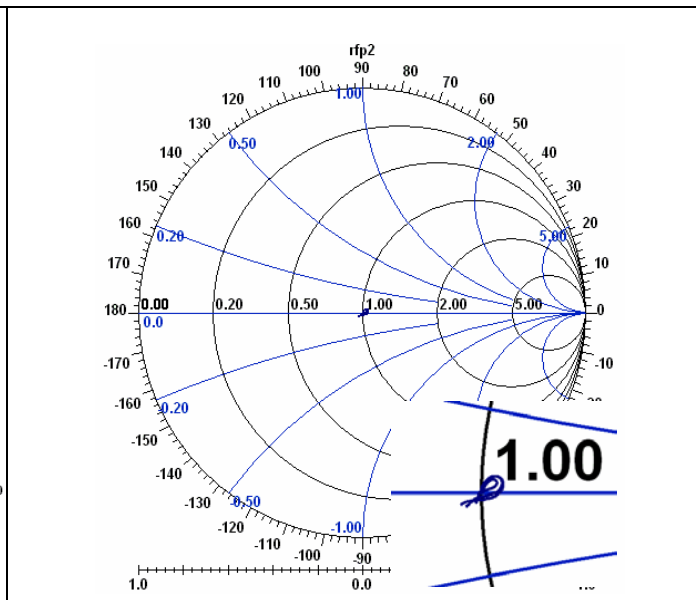
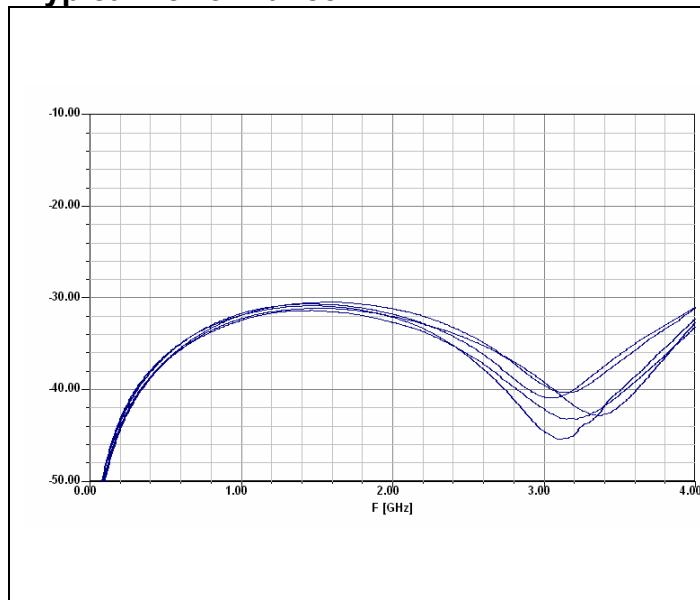
Outline Drawing



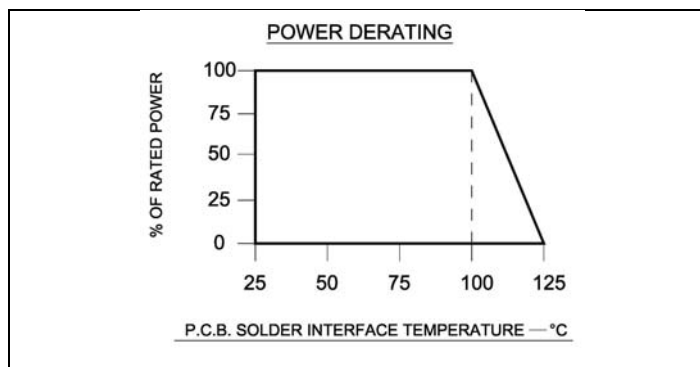
C16A50Z4 (097) rev.E pg. 1 of 2



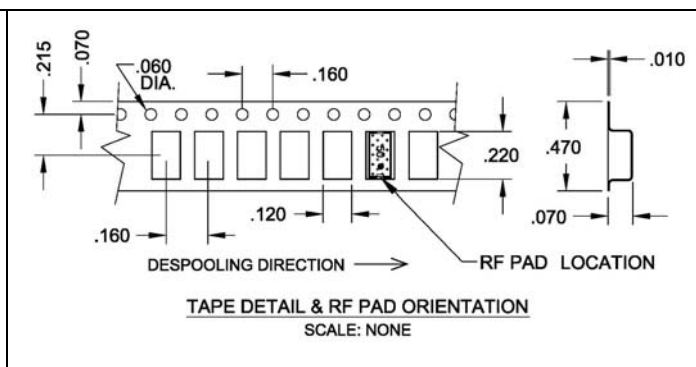
Typical Performance:



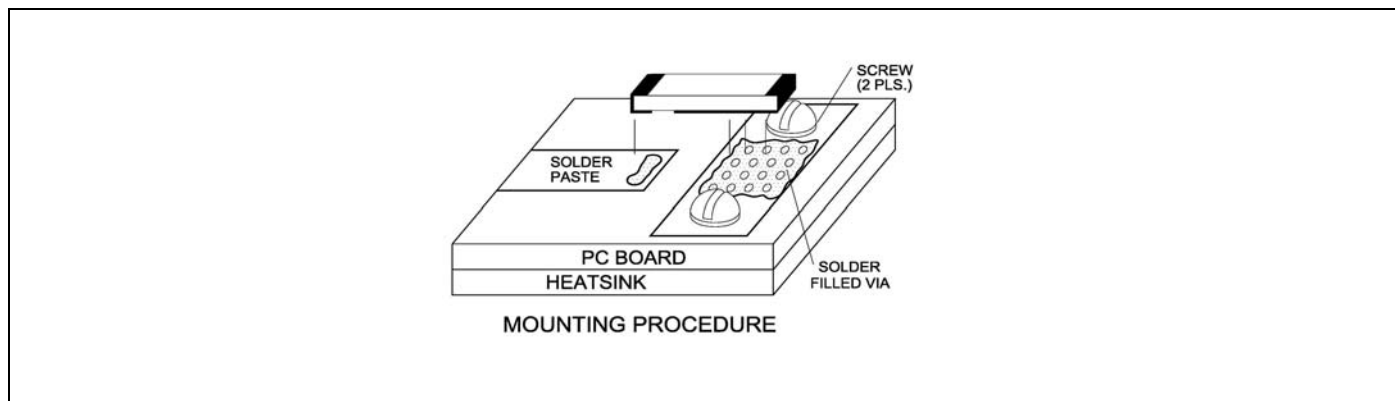
Power De-rating:



Tape & Reel:



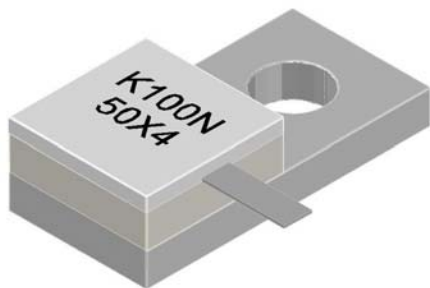
Mounting Footprint and Procedure:



C16A50Z4 (097) rev.E pg. 2 of 2



Half Flange Termination 100 Watts, 50Ω



Description

The K100N50X4 is high performance Aluminum Nitride (AlN) half flange termination intended as a cost competitive alternative to Beryllium Oxide (BeO). The termination is well suited to all cellular frequency bands such as; AMPS, GSM, DCS, PCS, PHS and UMTS. The high power handling makes the part ideal for terminating circulators, and for use in power combiners. The termination is also RoHS compliant!

General Specifications

| | |
|--------------------------|------------------------------------|
| Resistive Element | Thick Film |
| Substrate | AlN Ceramic |
| Cover | Alumina Ceramic |
| Mounting Flange | Copper, nickel plated per QC-N-290 |
| Leads | 99% pure silver (.006" thick) |

Tolerance is $\pm 0.010"$, unless otherwise specified. Designed to meet or exceed applicable portions of MIL-E-5400. All dimensions in inches.

Electrical Specifications

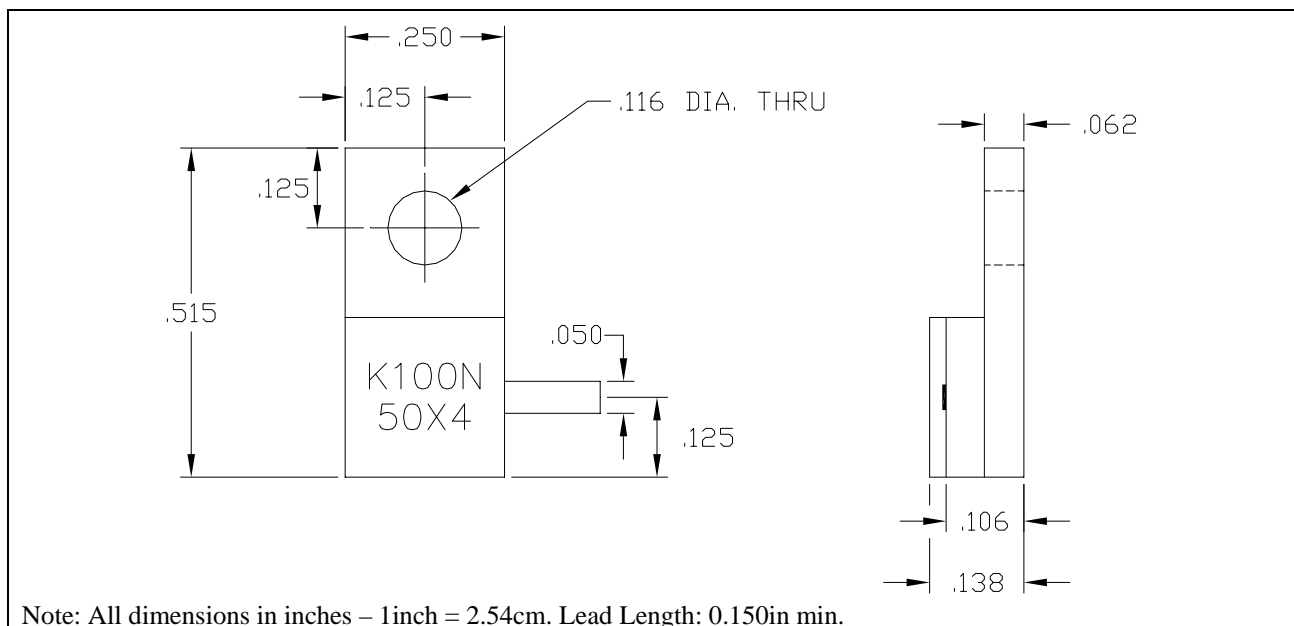
| | |
|--------------------------|--------------------|
| Resistance Value: | 50 Ohms, $\pm 2\%$ |
| Power: | 100 Watts |
| Frequency Range: | DC – 3.0GHz |
| V.S.W.R. | 1.25 : 1 |

Specification based on unit properly installed using suggested mounting instructions and a 50 ohm nominal impedance. Storage temperature is -20°C to 85°C . Operating temperature is -55°C to 125°C (see chart for derating temperatures). **Specifications subject to change with out notice.**

Features:

- RoHS Compliant
- 100 Watts
- DC – 3.0 GHz
- AlN Ceramic
- Non-Nichrome Resistive Element
- Low VSWR
- 100% Tested

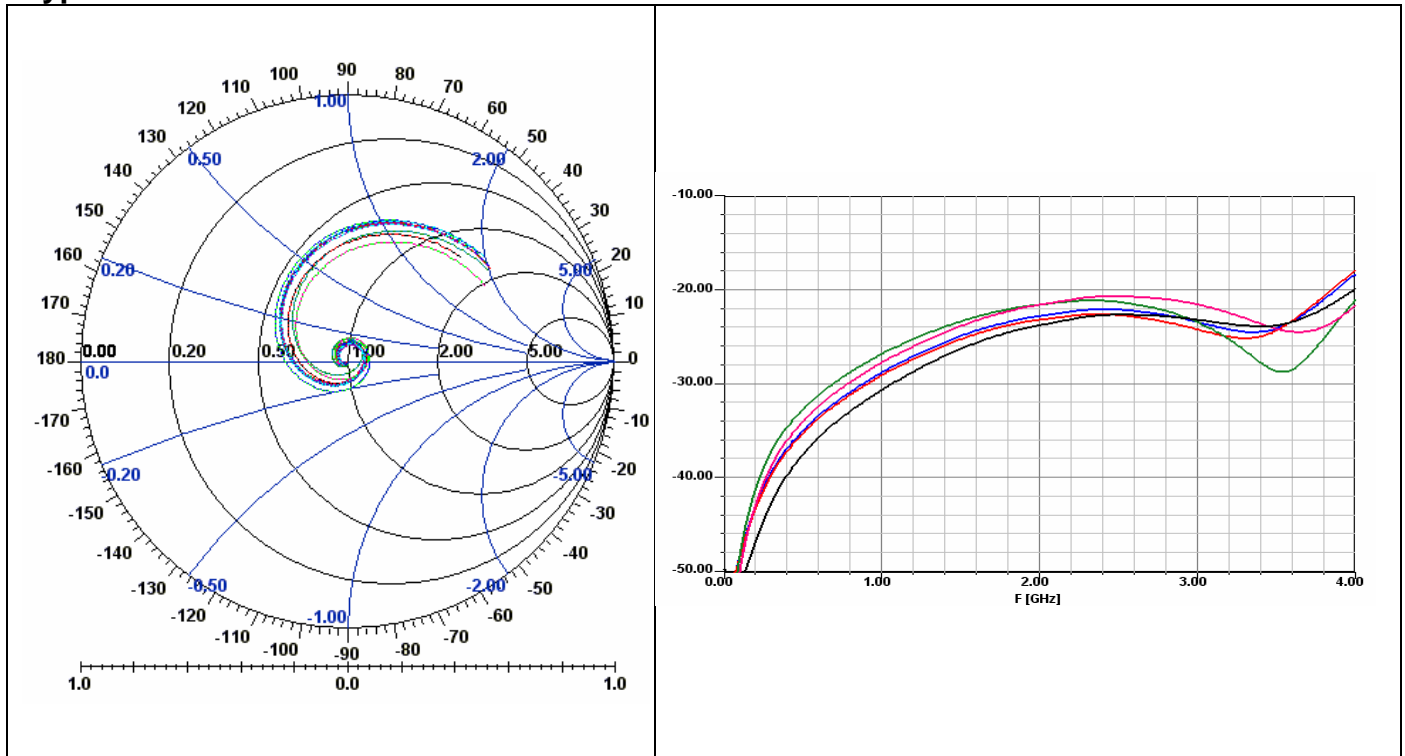
Outline Drawing



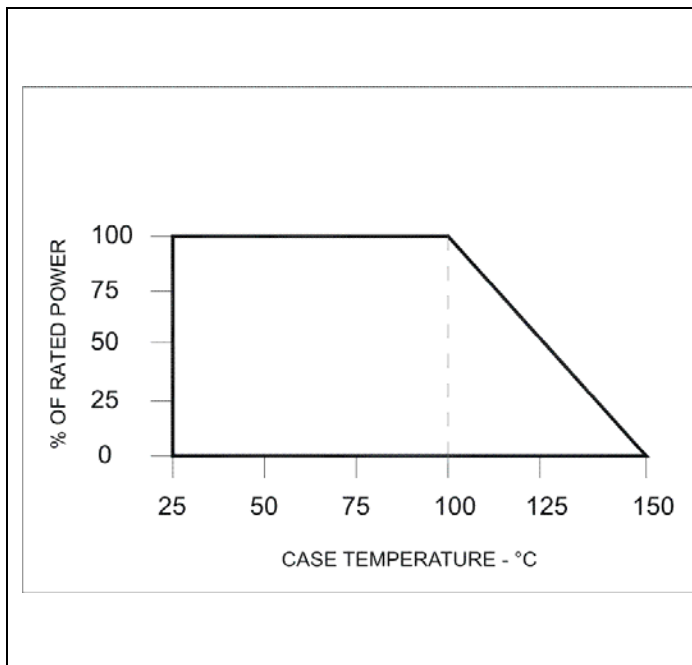
Note: All dimensions in inches – 1inch = 2.54cm. Lead Length: 0.150in min.

K100N50X4 (097) Rev D.

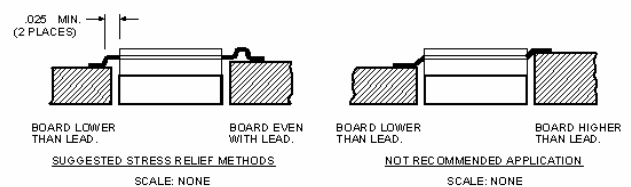
Typical Performance:



Power De-rating:



Mounting Footprint and Procedure:



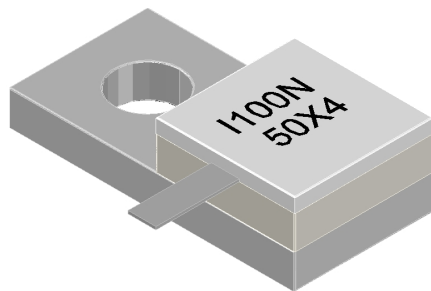
SUGGESTED MOUNTING PROCEDURES:

1. MAKE SURE THAT THE DEVICES ARE MOUNTED ON FLAT SURFACES (.001" UNDER THE DEVICE) TO OPTIMIZE THE HEAT TRANSFER.
2. DRILL & TAP THE HEATSINK FOR THE APPROPRIATE THREAD SIZE TO BE USED.
3. COAT HEATSINK WITH A MINIMUM AMOUNT OF HIGH QUALITY SILICONE GREASE (.001" MAX. THICKNESS).
4. POSITION DEVICE ON MOUNTING SURFACE & SECURE USING SOCKET HEAD SCREWS, FLAT & SPLIT WASHER. TORQUE SCREWS TO THE APPROPRIATE VALUE. MAKE SURE THAT THE DEVICE IS FLAT AGAINST THE HEATSINK. (CARE SHOULD BE TAKEN TO AVOID UPWARD PRESSURE OF THE LEADS TOWARDS THE LID).
5. SOLDER LEADS IN PLACE USING LEAD FREE TYPE SOLDER WITH A CONTROLLED TEMPERATURE IRON

** FOR MORE DETAILS CONTACT FACTORY **

K100N50X4 (097) Rev D

Flange Mount Termination 100 Watts, 50Ω



Description

The I100N50X4 is high performance Aluminum Nitride (AlN) flange mount termination intended as a cost competitive alternative to Beryllium Oxide (BeO). The termination is well suited to all cellular frequency bands such as; AMPS, GSM, DCS, PCS, PHS and UMTS. The high power handling makes the part ideal for terminating circulators, and for use in power combiners. The termination is also RoHS compliant!

General Specifications

| | |
|--------------------------|-----------------|
| Resistive Element | Thick Film |
| Substrate | AlN Ceramic |
| Cover | Alumina Ceramic |

Tolerance is ± 0.010 ", unless otherwise specified. Designed to meet or exceed applicable portions of MIL-E-5400. All dimensions in inches.

Features:

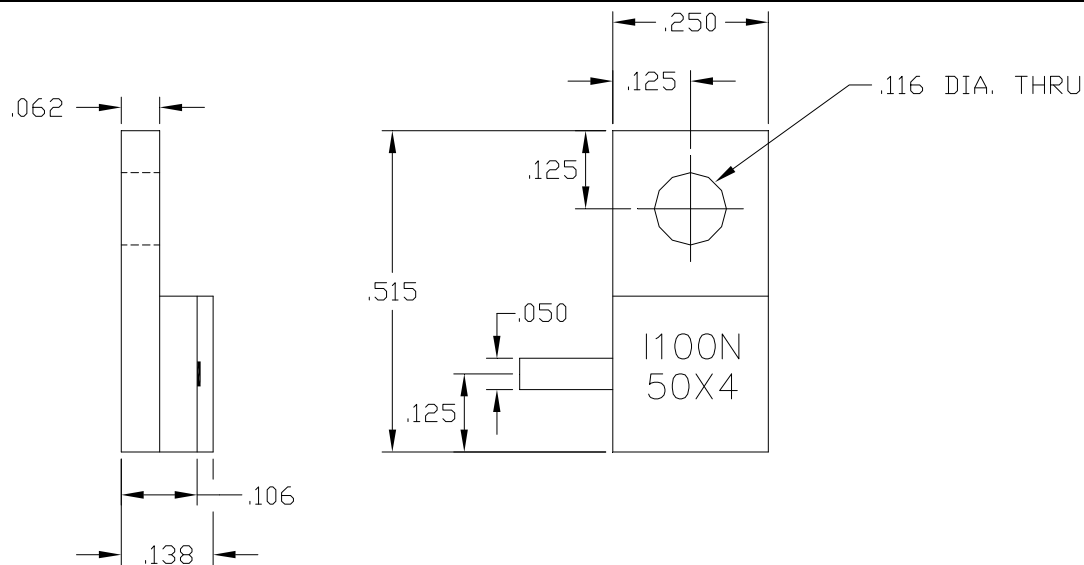
- RoHS Compliant
- 100 Watts
- DC – 3.0 GHz
- AlN Ceramic
- Non-Nichrome Resistive Element
- Low VSWR
- 100% Tested

Electrical Specifications

| | |
|--------------------------|--------------------|
| Resistance Value: | 50 Ohms, $\pm 2\%$ |
| Power: | 100 Watts |
| Frequency Range: | DC – 3.0GHz |
| V.S.W.R. | 1.25 : 1 |

Specification based on unit properly installed using suggested mounting instructions and a 50 ohm nominal impedance. Storage temperature is -20°C to 85 °C . Operating temperature is -55°C to 125°C (see chart for derating temperatures). **Specifications subject to change with out notice.**

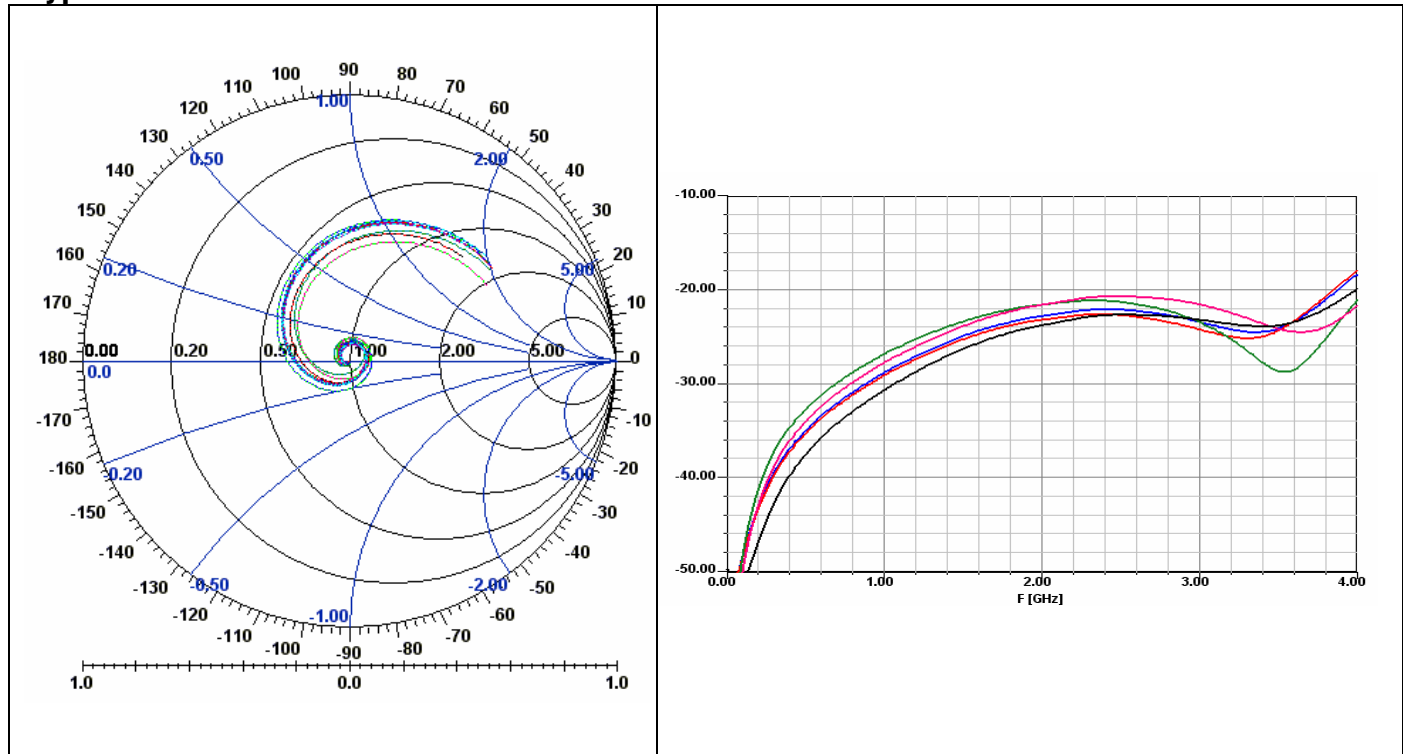
Outline Drawing



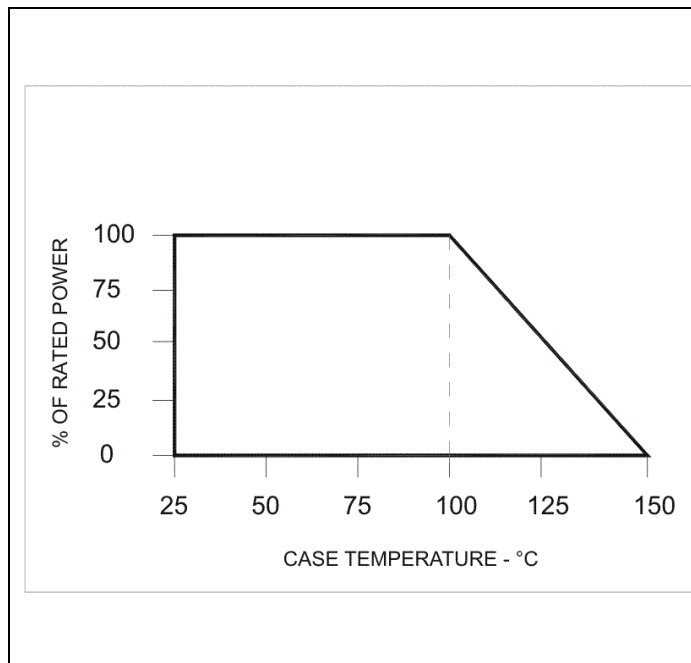
Note: All dimensions in inches – 1inch = 2.54cm. Lead Length: 0.150in min.

I100N50X4 (097) Rev D.

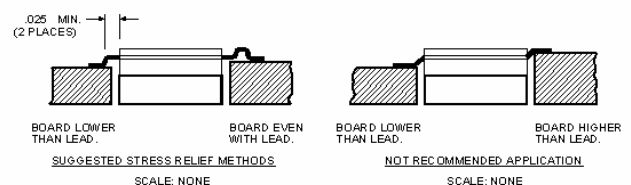
Typical Performance:



Power De-rating:



Mounting Footprint and Procedure:



SUGGESTED MOUNTING PROCEDURES:

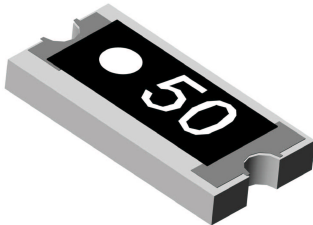
1. MAKE SURE THAT THE DEVICES ARE MOUNTED ON FLAT SURFACES (.001" UNDER THE DEVICE) TO OPTIMIZE THE HEAT TRANSFER.
2. DRILL & TAP THE HEATSINK FOR THE APPROPRIATE THREAD SIZE TO BE USED.
3. COAT HEATSINK WITH A MINIMUM AMOUNT OF HIGH QUALITY SILICONE GREASE (.001" MAX. THICKNESS).
4. POSITION DEVICE ON MOUNTING SURFACE & SECURE USING SOCKET HEAD SCREWS, FLAT & SPLIT WASHER. TORQUE SCREWS TO THE APPROPRIATE VALUE. MAKE SURE THAT THE DEVICE IS FLAT AGAINST THE HEATSINK. (CARE SHOULD BE TAKEN TO AVOID UPWARD PRESSURE OF THE LEADS TOWARDS THE LID).
5. SOLDER LEADS IN PLACE USING LEAD FREE TYPE SOLDER WITH A CONTROLLED TEMPERATURE IRON

** FOR MORE DETAILS CONTACT FACTORY **

I100N50X4 (097) Rev D.



Surface Mount Termination 10 Watts, 50Ω



Description

The C10A50Z4 is high performance RoHS compliant Alumina (Al_2O_3) surface mount termination intended as a lower cost alternative to Aluminum Nitride (AlN) and Beryllium Oxide (BeO). The termination is well suited to all cellular frequency bands such as; AMPS, GSM, DCS, PCS, PHS and UMTS. The high power handling makes the part ideal for terminating 90 degree hybrid directional couplers, and for use in isolators.

General Specifications

| | |
|------------------------------|---------------------------|
| Resistive Element | Thick film |
| Substrate | Alumina Ceramic |
| Terminal Finish | Matte Tin over Nickel |
| Operating Temperature | -55 to +125°C (see chart) |

Tolerance is $\pm 0.010"$, unless otherwise specified. Designed to meet or exceed applicable portions of MIL-E-5400. **All dimensions in inches.**

Electrical Specifications

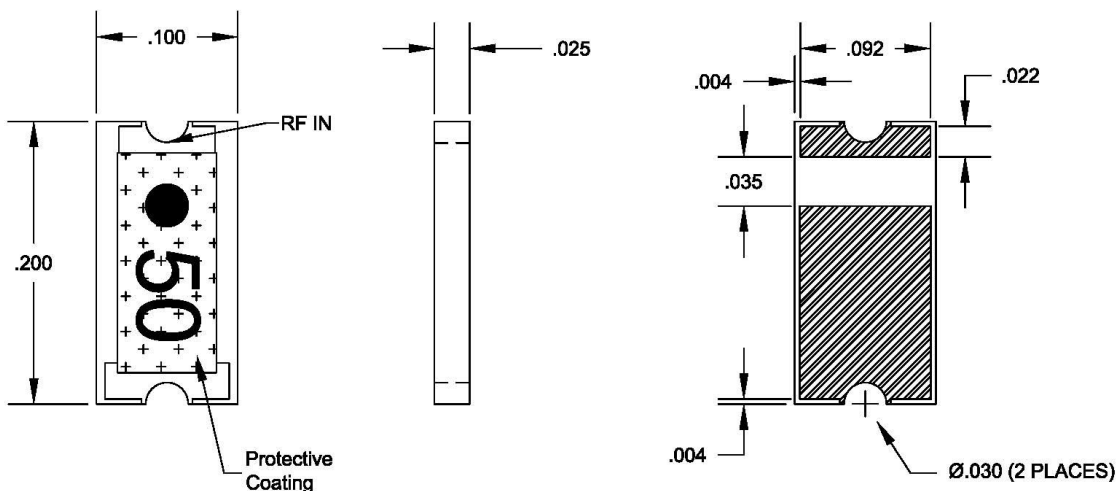
| | |
|--------------------------|--------------------|
| Resistance Value: | 50 ohms, $\pm 2\%$ |
| Power: | 10 Watts |
| Frequency Range: | DC – 3.0 GHz |
| V.S.W.R.: | <1.25:1 |

Specification based on unit properly installed using suggested mounting instructions and a 50 ohm nominal impedance. **Specifications subject to change without notice**

Features:

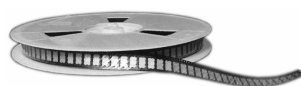
- 10 Watts
- Lowest Cost
- RoHS Compliant
- Alumina Ceramic
- Non-Nichrome Resistive Element
- Low VSWR
- 100% Tested

Outline Drawing

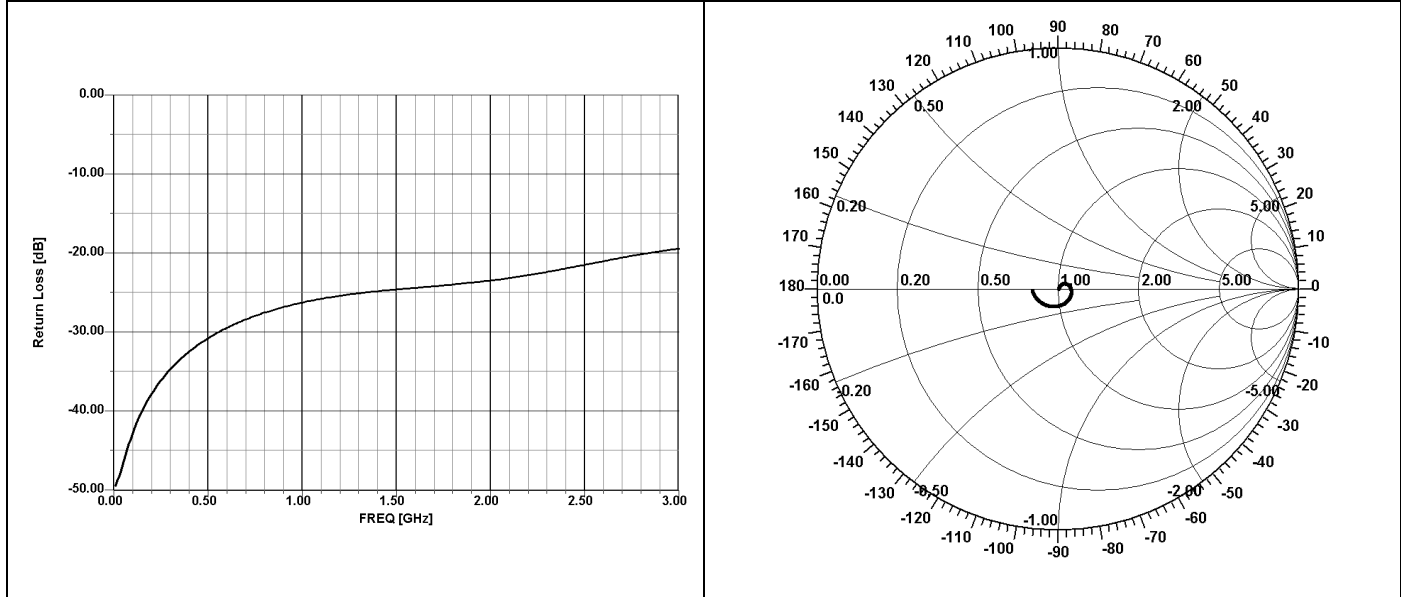


All dimensions in inches.

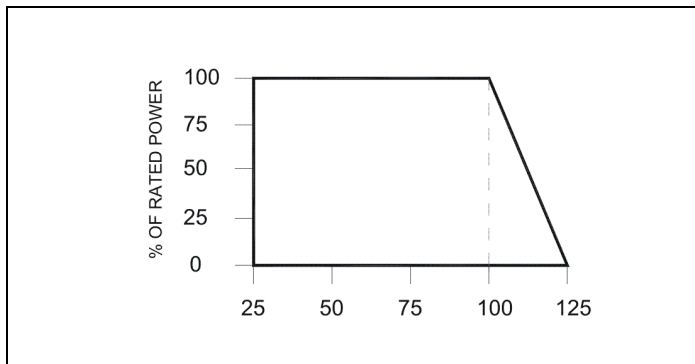
07/26/2006 Rev. B



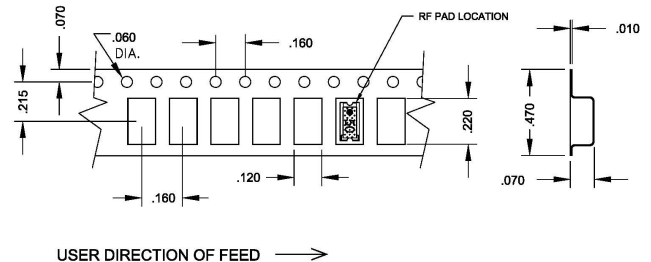
Typical Performance:



Power De-rating:



Tape & Reel:



Mounting Footprint and Procedure:

50 ohm line

0.092 [2.34]

0.025 [0.63]

0.035 [0.89]

0.00101 [02.57]

2x 4-40 Screw Hole

0.0031 [00.79]

0.060 [1.52]

0.250 [6.35]

Dimension given in inches [millimeters]

For best thermal performance the PCB should be soldered to the heat sink.

PC BOARD

HEATSINK

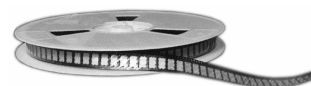
SOLDER PASTE

SOLDER FILLED VIA

SCREW (2 PLS.)

MOUNTING PROCEDURE

1. Drill thermal vias through PCB and fill with solder.
2. To ensure good thermal connectivity to heat sink, which is critical for proper operation drill and tap heatsink and mount PCB to heat sink using screws.





Surface Mount Termination 40 Watts, 50Ω



Description

The C40A50Z4 is a high performance RoHS compliant Alumina (Al₂O₃) surface mount termination intended as a lower cost alternative to Aluminum Nitride (AlN) and Beryllium Oxide (BeO). The SMD termination is well suited to all cellular frequency bands such as: AMPS, GSM, DCS, PCS, PHS and UMTS. The high power handling makes the part ideal for terminating 90° hybrids, directional couplers, and for use in isolators.

General Specifications

| | |
|------------------------------|---------------------------|
| Resistive Element | Thick film |
| Substrate | Alumina Ceramic |
| Terminal Finish | Tin over Nickel |
| Operating Temperature | -55 to +125°C (see chart) |

Tolerance is $\pm 0.010"$, unless otherwise specified. Designed to meet or exceed applicable portions of MIL-E-5400. All dimensions in inches.

Electrical Specifications

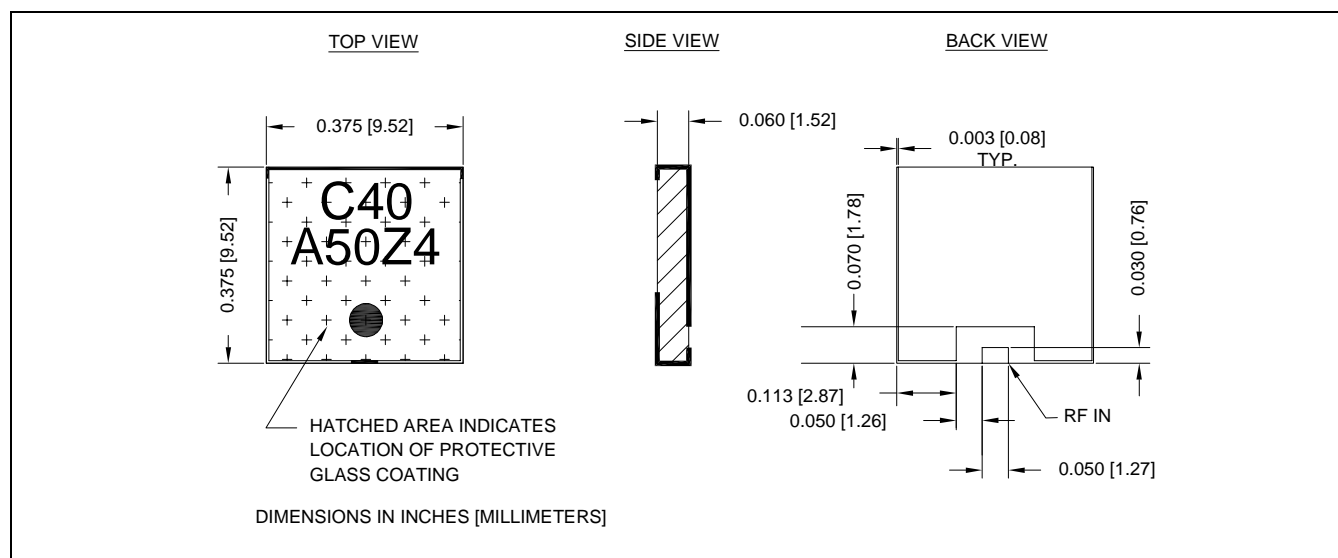
| | |
|--------------------------|--------------------|
| Resistance Value: | 50 ohms, $\pm 2\%$ |
| Power: | 40 Watts |
| Frequency Range: | 1KHz – 2.3GHz |
| V.S.W.R.: | <1.20:1 |

Specification based on unit properly installed using suggested mounting instructions and a 50 ohm nominal impedance. **Specifications subject to change without notice**

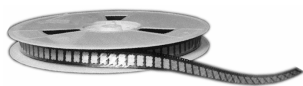
Features:

- 40 Watts
- Lowest Cost
- RoHS Compliant
- Alumina Ceramic
- Non-Nichrome Resistive Element
- Low VSWR
- 100% Tested

Outline Drawing



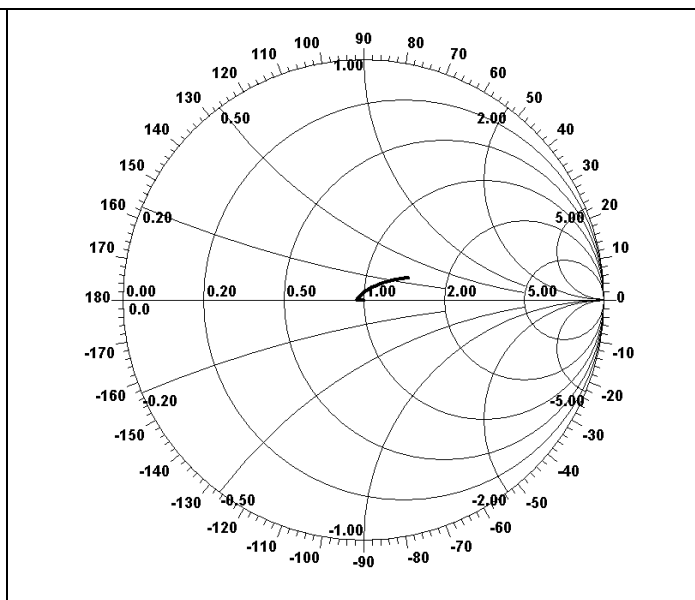
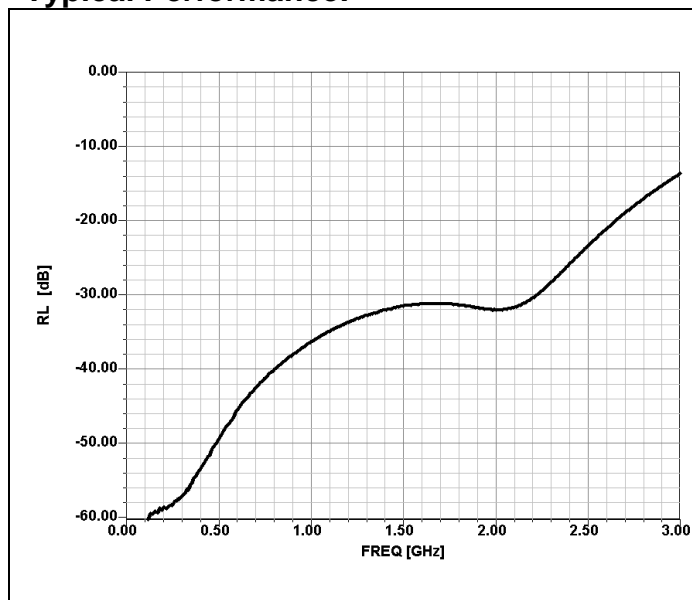
Rev. 5/13/05



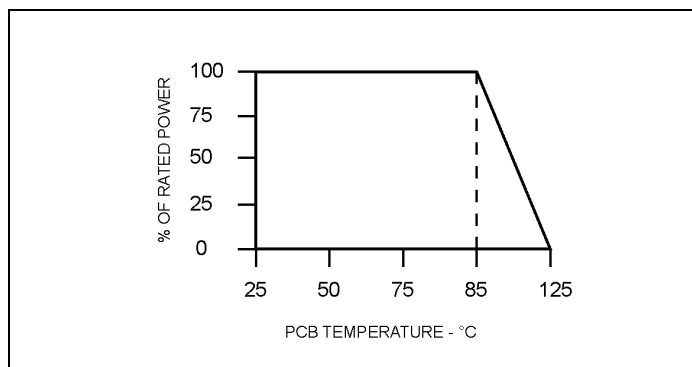
Anaren

RF Power

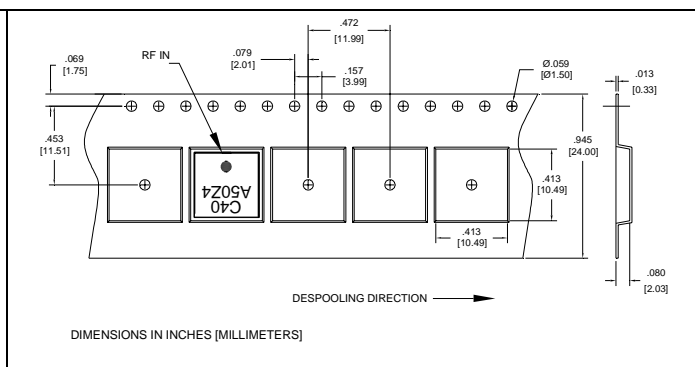
Typical Performance:



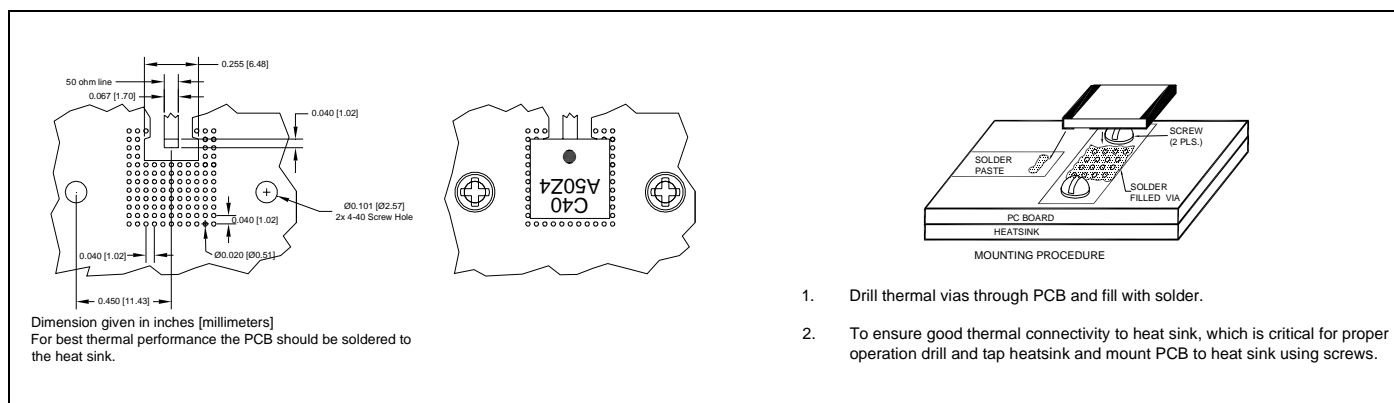
Power De-rating:



Tape & Reel:

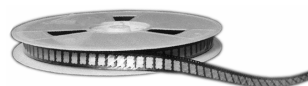


Mounting Footprint and Procedure:



USA/Canada: (315) 432-8909
Toll Free: (800) 544-2414
Europe: +44 2392-232392

Available on Tape and
Reel For Pick and Place
Manufacturing.



Anaren
What'll we think of next?"

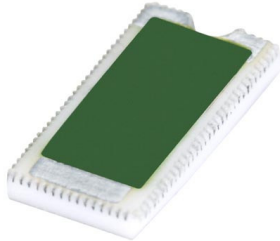
Anaren

RF Power

Model A20A50X1A

**RoHS
Compliant**

**Surface mount
Termination
20 Watts, 50Ω**



General Specifications

| | |
|------------------------------|---------------------------|
| Resistive Element | Thick film |
| Substrate | Alumina Ceramic |
| Terminal Finish | Thick film Silver |
| Operating Temperature | -55 to +125°C (see chart) |

Tolerance is ± 0.010 ", unless otherwise specified. Designed to meet or exceed applicable portions of MIL-E-5400. All dimensions in inches.

Electrical Specifications

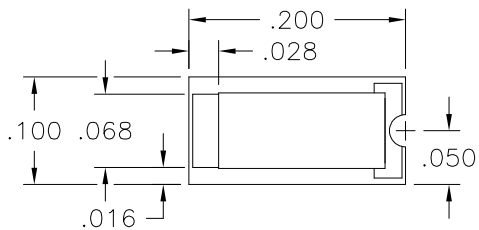
| | |
|--------------------------|--------------------|
| Resistance Value: | 50 ohms, $\pm 2\%$ |
| Power: | 20 Watts |
| Frequency Range: | DC – 6.0 GHz |
| V.S.W.R.: | 1.25:1 |

Specification based on unit properly installed using suggested mounting instructions and a 50 ohm nominal impedance. **Specifications subject to change without notice**

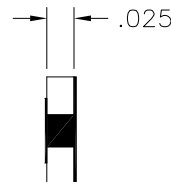
Features:

- 20 Watts
- Surface Mountable
- Alumina Ceramic
- Non-Nichrome Resistive Element
- Low VSWR
- 100% Tested
- RoHS Compliant

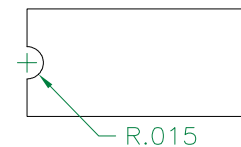
Outline Drawing



TOP VIEW



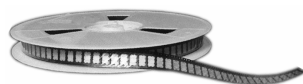
SIDE VIEW



BOTTOM VIEW

A20A50X1A (097) Rev B

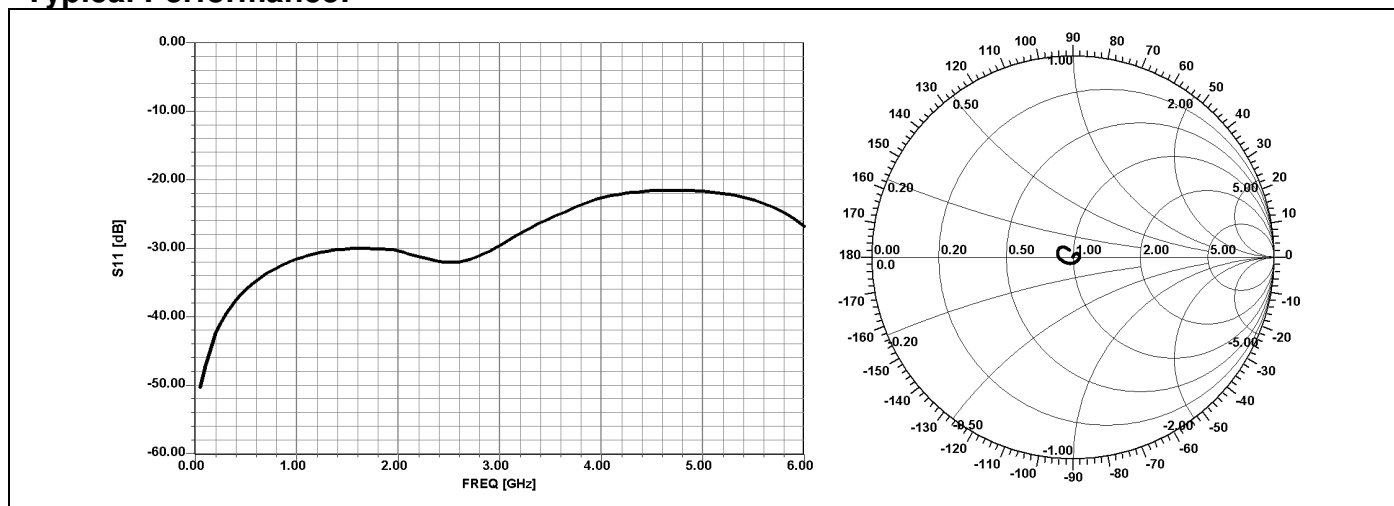
Anaren
What'll we think of next?™



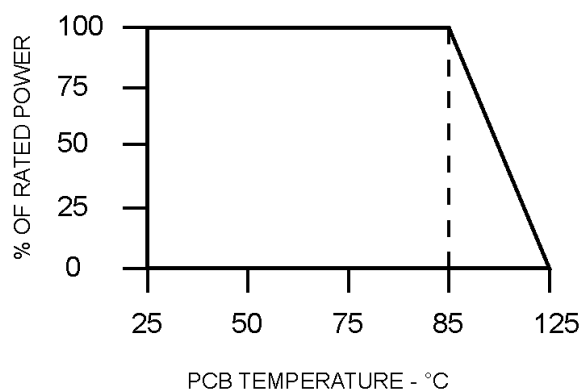
Available on Tape
and Reel For Pick and
Place Manufacturing.

USA/Canada: (315) 432-8909
Toll Free: (800) 544-2414
Europe: +44 2392-232392

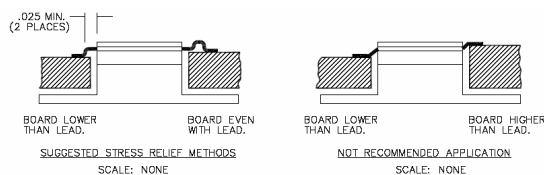
Typical Performance:



Derating:



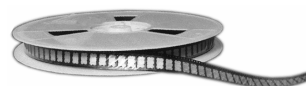
Mounting Footprint and Procedure:

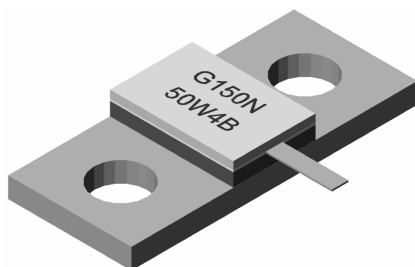


SUGGESTED MOUNTING PROCEDURES:

1. MAKE SURE THAT THE DEVICES ARE MOUNTED ON FLAT SURFACES (.001" UNDER THE DEVICE) TO OPTIMIZE THE HEAT TRANSFER.
2. POSITION DEVICE ON MOUNTING SURFACE AND SOLDER IN PLACE USING SN96 SOLDER.
3. SOLDER LEADS IN PLACE USING AN SN96 TYPE SOLDER WITH A CONTROLLED TEMPERATURE IRON (260°C).

A20A50X1A (097) Rev B





Description

The G150N50W4B is high performance Aluminum Nitride (AlN) flange mount termination intended as a cost competitive alternative to Beryllium Oxide (BeO). The termination is well suited to all cellular frequency bands such as; AMPS, GSM, DCS, PCS, PHS and UMTS. The high power handling makes the part ideal for terminating circulators, and for use in power combiners. The termination is also RoHS compliant!

General Specifications

| | |
|--------------------------|----------------------|
| Resistive Element | Thick Film |
| Substrate | AlN Ceramic |
| Cover | Alumina Ceramic |
| Mounting Flange | Nickel Plated Copper |

Tolerance is ± 0.010 ", unless otherwise specified. Designed to meet or exceed applicable portions of MIL-E-5400. **All dimensions in inches.**

Features:

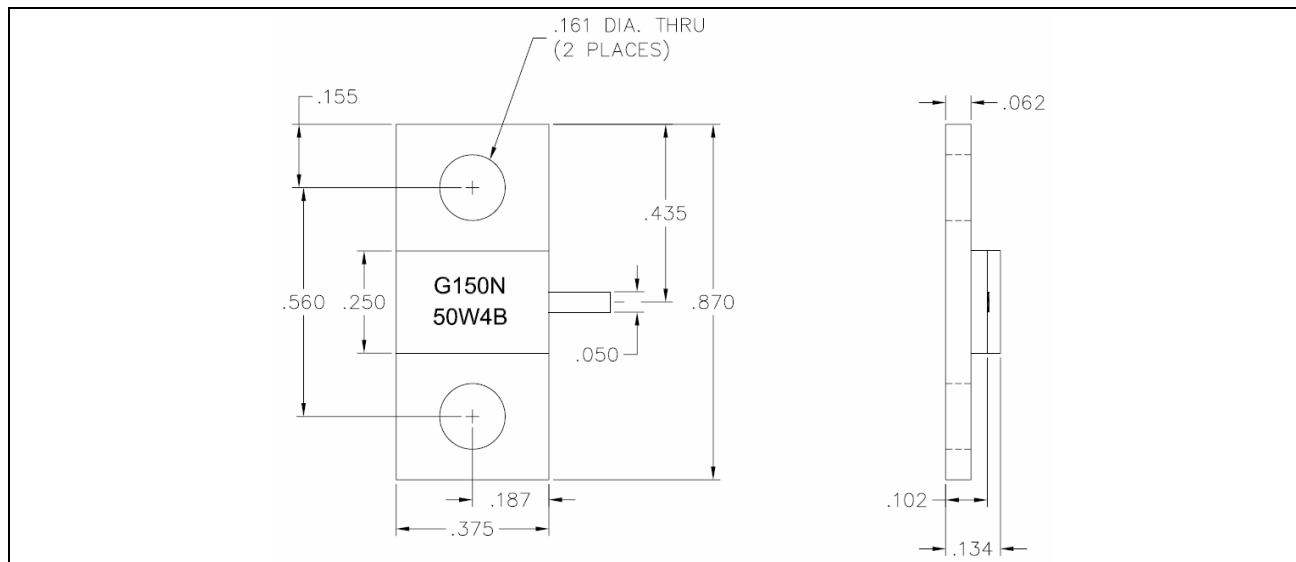
- RoHS Compliant
- 150 Watts
- DC - 2.7 GHz
- AlN Ceramic
- Non-Nichrome Resistive Element
- Low VSWR
- 100% Tested

Electrical Specifications

| | |
|--------------------------|--|
| Resistance Value: | 50 Ohms, $\pm 2\%$ |
| Power: | 150 Watts |
| Frequency Range: | DC – 2.7 GHz |
| Return Loss | > 25 dB to 2.0 GHz > 20 dB to 2.7 GHz |

Specification based on unit properly installed using suggested mounting instructions and a 50 ohm nominal impedance. **Specifications subject to change.**

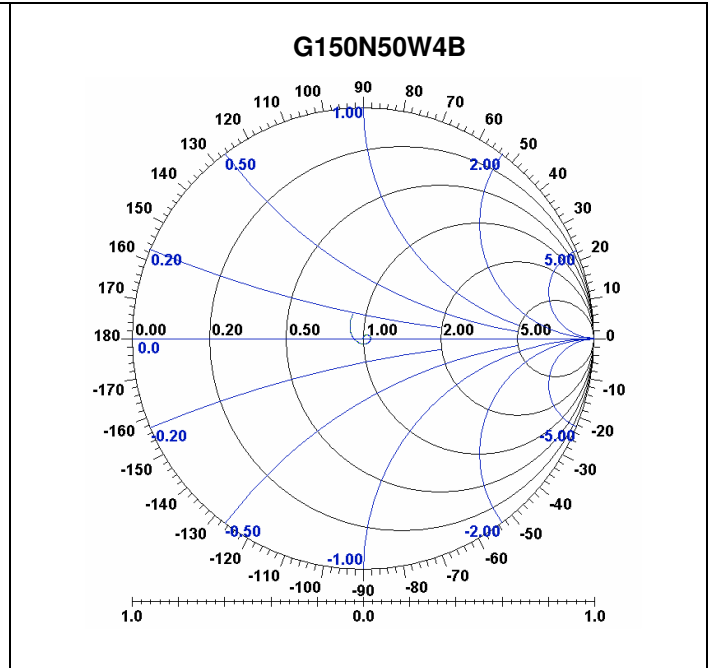
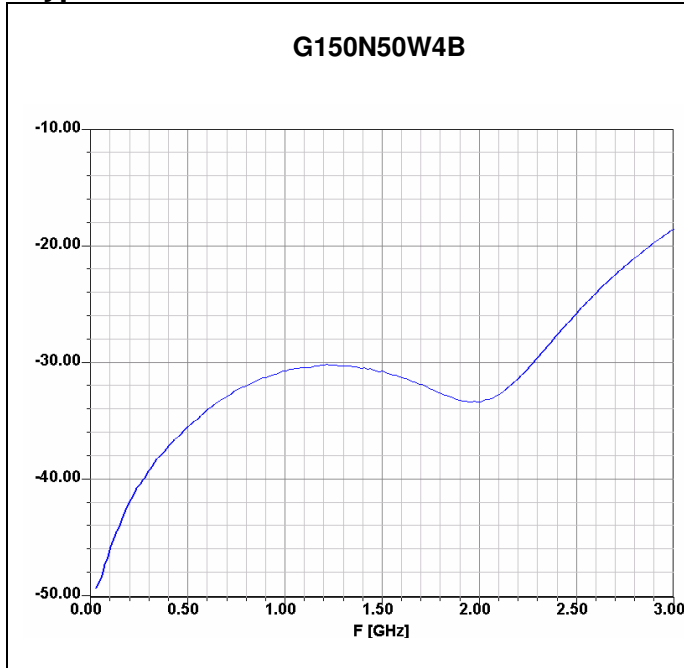
Outline Drawing



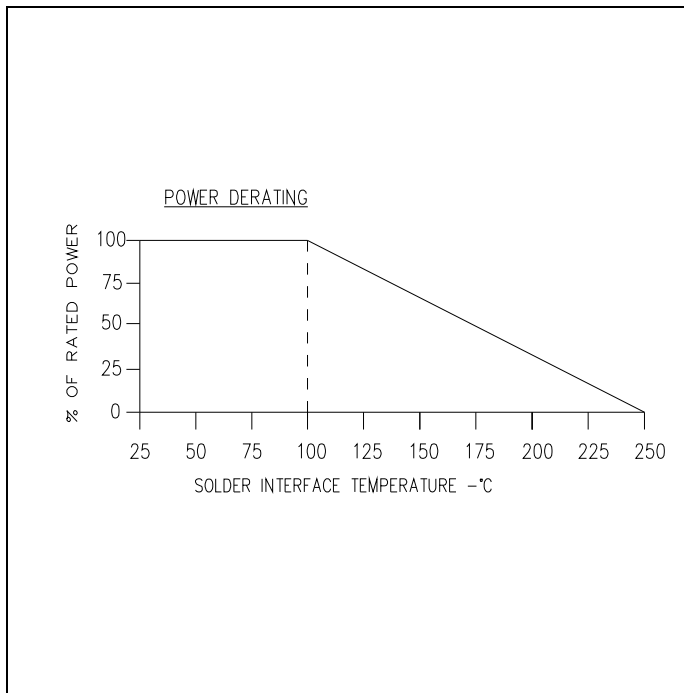
Lead Length: 0.150 Min

G150N50W4B (097) rev. D pg. 1 of 2

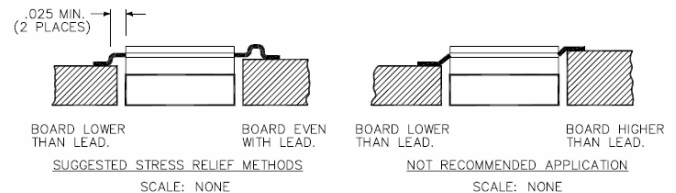
Typical Performance:



Power De-rating:



Mounting Footprint and Procedure:

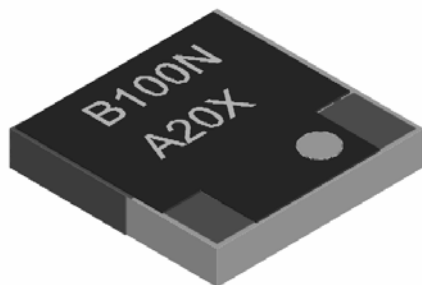


SUGGESTED MOUNTING PROCEDURES:

1. MAKE SURE THAT THE DEVICES ARE MOUNTED ON FLAT SURFACES (.001" UNDER THE DEVICE) TO OPTIMIZE THE HEAT TRANSFER.
2. DRILL & TAP THE HEATSINK FOR THE APPROPRIATE THREAD SIZE TO BE USED.
3. COAT HEATSINK WITH A MINIMUM AMOUNT OF HIGH QUALITY SILICONE GREASE (.001" MAX. THICKNESS).
4. POSITION DEVICE ON MOUNTING SURFACE & SECURE USING SOCKET HEAD SCREWS, FLAT & SPLIT WASHER. TORQUE SCREWS TO THE APPROPRIATE VALUE. MAKE SURE THAT THE DEVICE IS FLAT AGAINST THE HEATSINK. (CARE SHOULD BE TAKEN TO AVOID UPWARD PRESSURE OF THE LEADS TOWARDS THE LID).
5. SOLDER LEADS IN PLACE USING LEAD FREE TYPE SOLDER WITH A CONTROLLED TEMPERATURE IRON

**ROHS
Compliant**

**Chip Attenuator
100 Watts, 20 dB**



Description

The B100NA20X4 is high performance Aluminum Nitride (AlN) chip attenuator intended as a cost competitive alternative to Beryllium Oxide (BeO). The termination is well suited to all cellular frequency bands such as; AMPS, GSM, DCS, PCS, PHS and UMTS. The high power handling makes the part ideal for terminating circulators, and for use in power monitoring. The termination is also RoHS compliant!

General Specifications

Features:

- RoHS Compliant
- 100 Watts
- DC – 4.0 GHz
- AlN Ceramic
- Non-Nichrome Resistive Element
- Low VSWR
- 100% Tested
- Small Size

| | |
|------------------------------|-------------------------------------|
| Resistive Element | Thick film |
| Substrate | AlN Ceramic |
| Terminal Finish | Matte Tin over Nickel Barrier |
| Operating Temperature | -55 to +150°C (see de rating chart) |

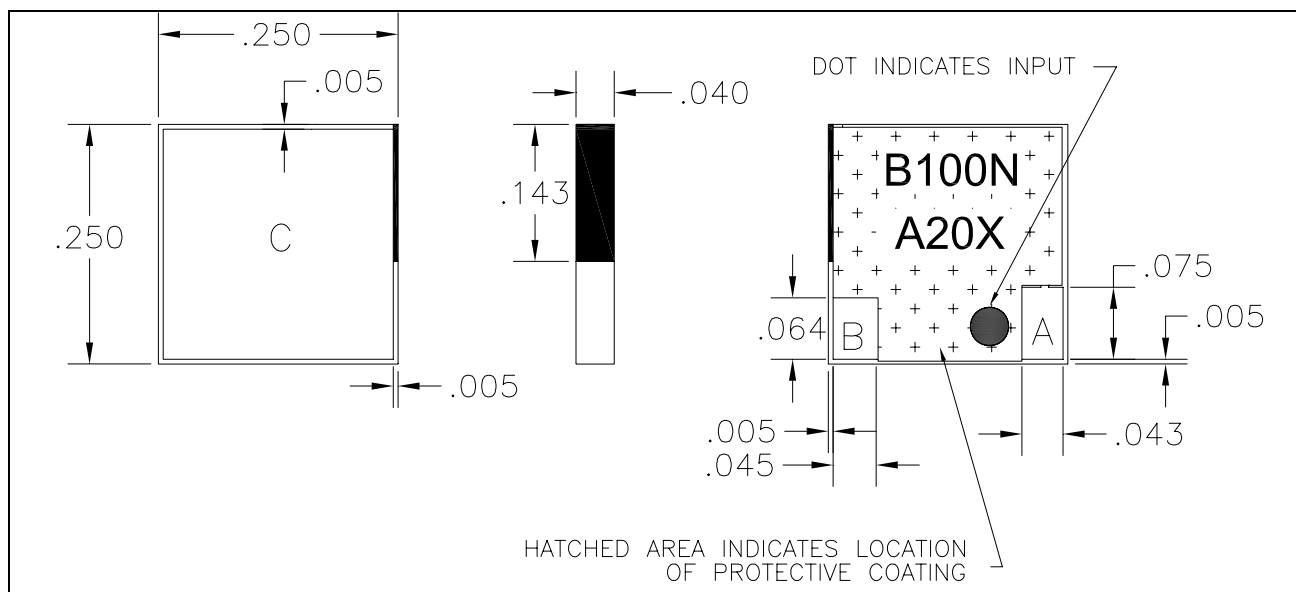
Tolerance is ± 0.010 ", unless otherwise specified. Designed to meet or exceed applicable portions of MIL-E-5400. All dimensions in inches.

Electrical Specifications

| | | | |
|---------------------------|--|--------------------|------------------|
| Attenuation Value: | 20 dB, ± 1.0 dB, DC – 4.0 GHz | | |
| Power: | 100 Watts | | |
| Frequency Range: | DC – 4.0 GHz | | |
| Return Loss | >20 dB to 2.7 GHz >19 dB to 4.0 GHz | | |
| Value (A-B) | Value (A-C) | Value (B-C) | Tolerance |
| 81.8 Ω | 50.9 Ω | 50.9 Ω | $\pm 4\%$ |

Specification based on unit properly installed using suggested mounting instructions and a 50 ohm nominal impedance. **Specifications subject to change.**

Outline Drawing

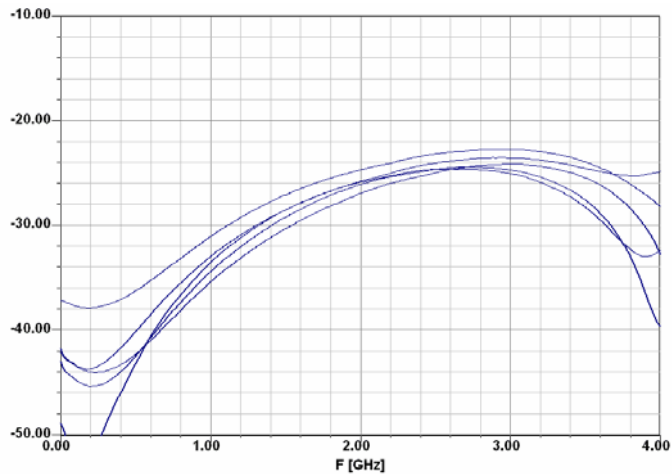


B100NA20X4 (097) Rev. E pg.1 of 2

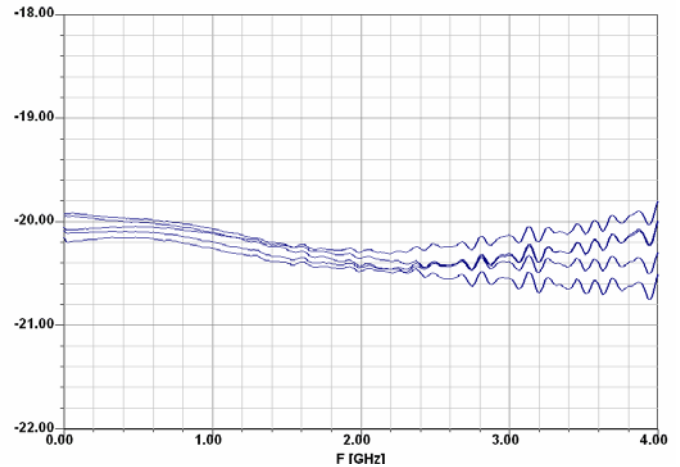


Typical Performance:

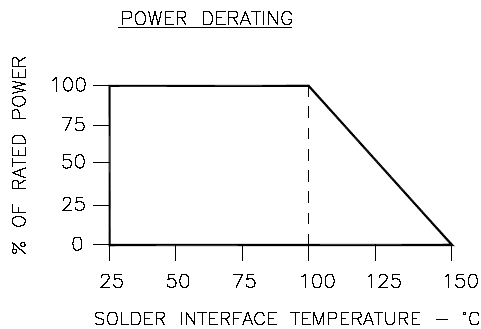
Return Loss:



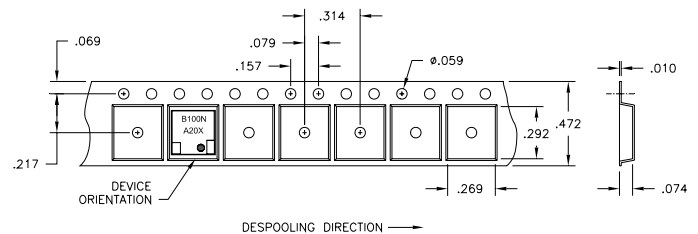
Attenuation:



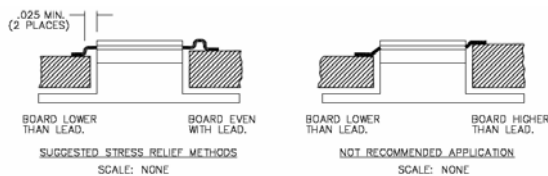
Power De-rating:



Tape & Reel:



Mounting Footprint and Procedure:

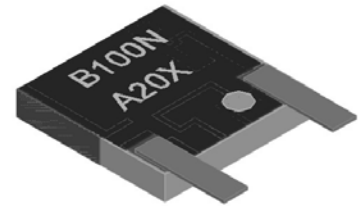


SUGGESTED MOUNTING PROCEDURES:

1. MAKE SURE THAT THE DEVICES ARE MOUNTED ON FLAT SURFACES (.001" UNDER THE DEVICE) TO OPTIMIZE THE HEAT TRANSFER.
2. POSITION DEVICE ON MOUNTING SURFACE AND SOLDER IN PLACE USING SN96 SOLDER.
3. SOLDER LEADS IN PLACE USING AN SN96 TYPE SOLDER WITH A CONTROLLED TEMPERATURE IRON (260°C).



Correct lead orientation

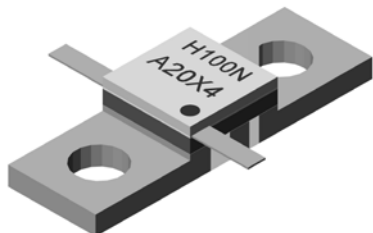


Alternate lead Orientation.
(May require external matching)



Flange Attenuator 100 Watts, 20 dB

Description



The H100NA20X4 is high performance Aluminum Nitride (AlN) high power flange mount attenuator intended as a cost competitive alternative to Beryllium Oxide (BeO). The termination is well suited to all cellular frequency bands such as; AMPS, GSM, DCS, PCS, PHS and UMTS. The high power handling makes the part ideal for terminating circulators, and for use in power monitoring. The termination is also RoHS compliant!

General Specifications

| | |
|------------------------------|-------------------------------------|
| Resistive Element | Thick film |
| Substrate | AlN Ceramic |
| Cover | Alumina Ceramic |
| Mounting Flange | Nickel Plated Copper |
| Operating Temperature | -55 to +150°C (see de rating chart) |

Tolerance is ± 0.010 ", unless otherwise specified. Designed to meet or exceed applicable portions of MIL-E-5400. **All dimensions in inches.**

Electrical Specifications

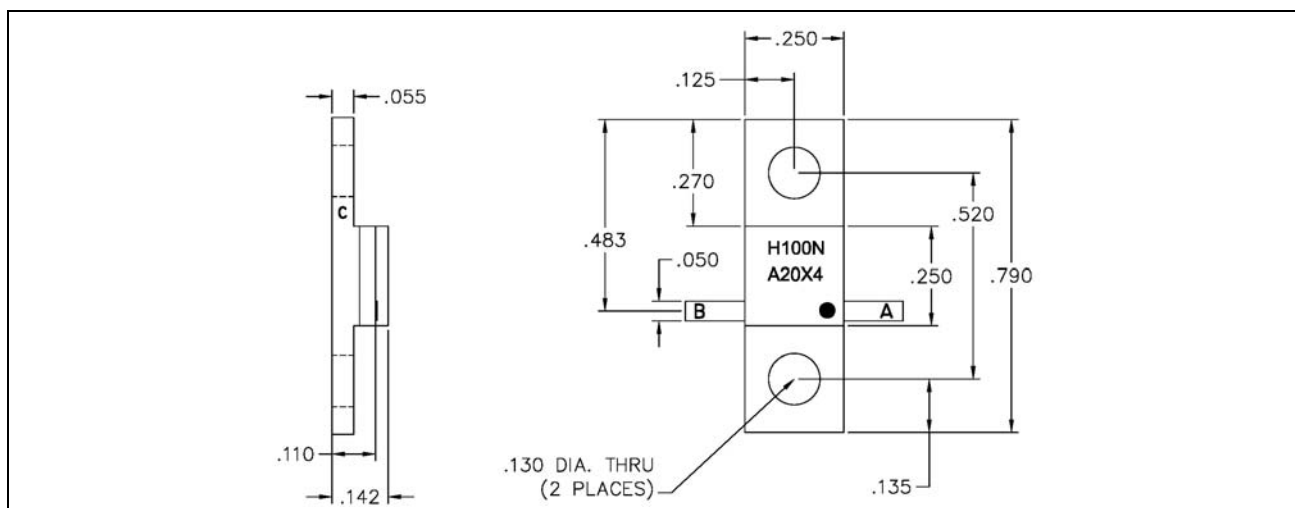
| | |
|---------------------------|--|
| Attenuation Value: | 20 dB, ± 1.0 dB, DC – 4.0GHz |
| Power: | 100 Watts |
| Frequency Range: | DC – 4.0 GHz |
| Return Loss | > 24 dB to 2.7 GHz > 20 dB to 4.0 GHz |

Specification based on unit properly installed using suggested mounting instructions and a 50 ohm nominal impedance. **Specifications subject to change.**

Features:

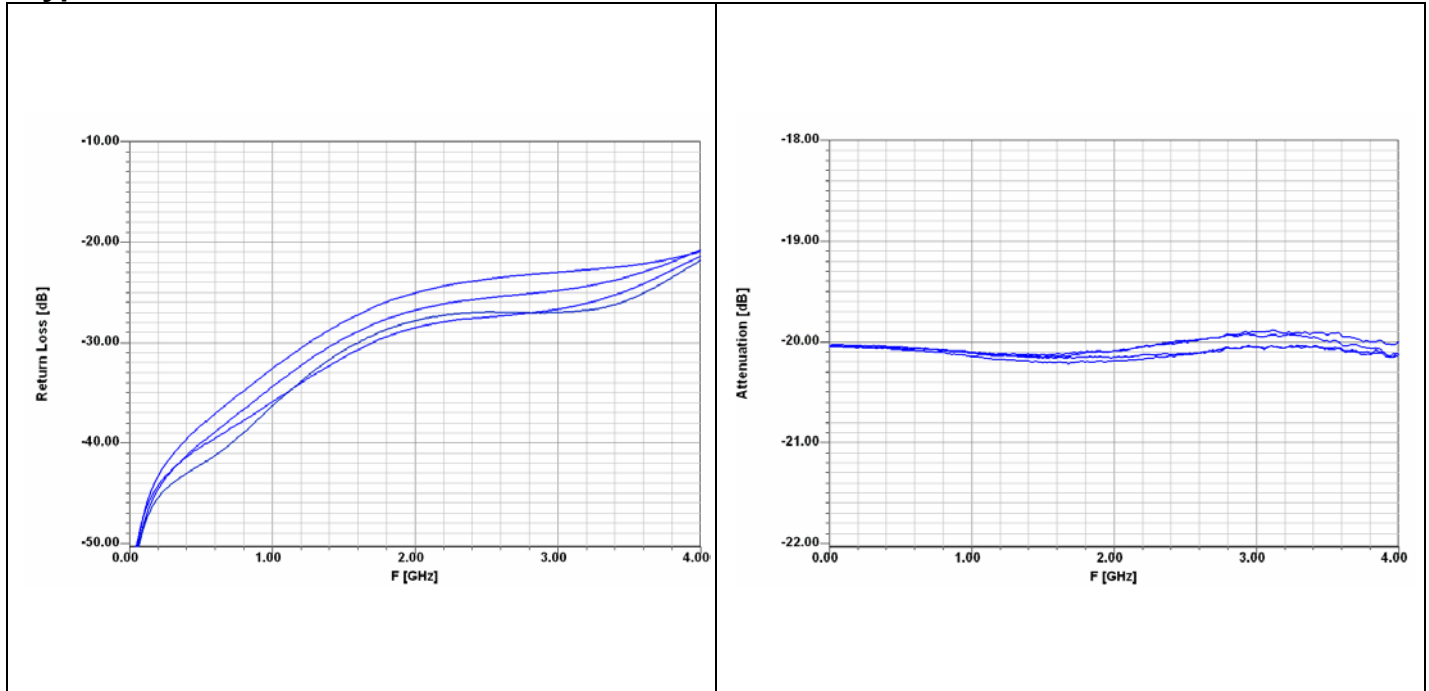
- RoHS Compliant
- 100 Watts
- DC - 2.7 GHz
- AlN Ceramic
- Non-Nichrome Resistive Element
- Low VSWR
- 100% Tested
- Small Size

Outline Drawing

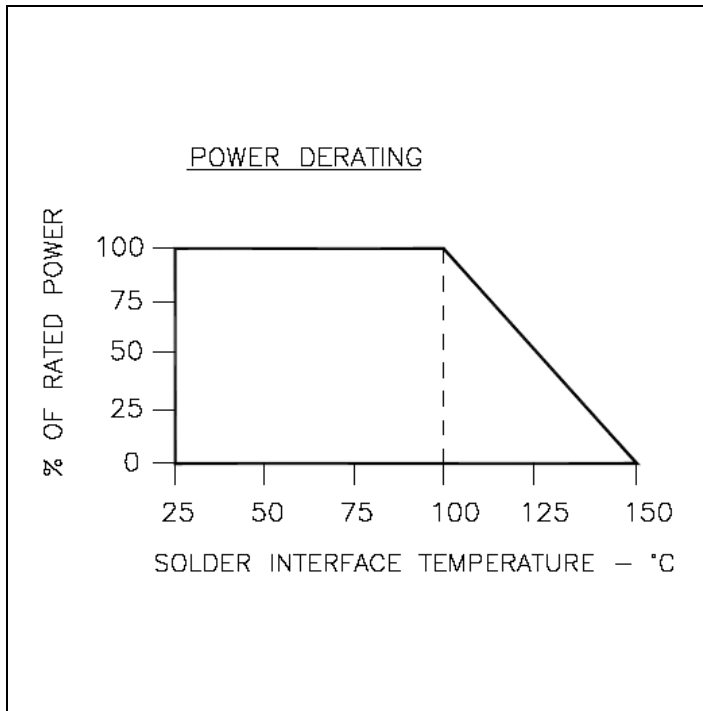


H100NA20X4 (097) rev.B pg. 1 of 2

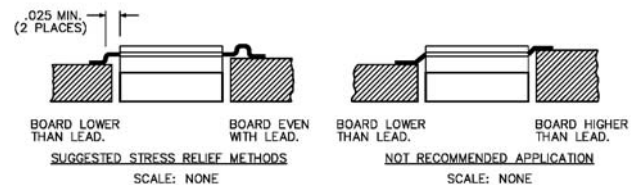
Typical Performance:



Power De-rating:



Mounting Footprint and Procedure:



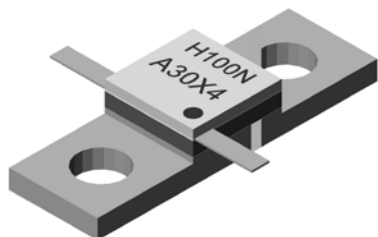
SUGGESTED MOUNTING PROCEDURES:

1. MAKE SURE THAT THE DEVICES ARE MOUNTED ON FLAT SURFACES (.001" UNDER THE DEVICE) TO OPTIMIZE THE HEAT TRANSFER.
2. DRILL & TAP THE HEATSINK FOR THE APPROPRIATE THREAD SIZE TO BE USED.
3. COAT HEATSINK WITH A MINIMUM AMOUNT OF HIGH QUALITY SILICONE GREASE (.001" MAX. THICKNESS).
4. POSITION DEVICE ON MOUNTING SURFACE & SECURE USING SOCKET HEAD SCREWS, FLAT & SPLIT WASHER. TORQUE SCREWS TO THE APPROPRIATE VALUE. MAKE SURE THAT THE DEVICE IS FLAT AGAINST THE HEATSINK. (CARE SHOULD BE TAKEN TO AVOID UPWARD PRESSURE OF THE LEADS TOWARDS THE LID).
5. SOLDER LEADS IN PLACE USING LEAD FREE TYPE SOLDER WITH A CONTROLLED TEMPERATURE IRON

Flange Attenuator 100 Watts, 30 dB

Description

The H100NA30X4 is high performance Aluminum Nitride (AlN) high power flange mount attenuator intended as a cost competitive alternative to Beryllium Oxide (BeO). The termination is well suited to all cellular frequency bands such as; AMPS, GSM, DCS, PCS, PHS and UMTS. The high power handling makes the part ideal for terminating circulators, and for use in power monitoring. The termination is also RoHS compliant!



Features:

- RoHS Compliant
- 100 Watts
- DC – 4.0 GHz
- AlN Ceramic
- Non-Nichrome Resistive Element
- Low VSWR
- 100% Tested
- Small Size

General Specifications

| | |
|------------------------------|-------------------------------------|
| Resistive Element | Thick film |
| Substrate | AlN Ceramic |
| Cover | Alumina Ceramic |
| Mounting Flange | Nickel Plated Copper |
| Operating Temperature | -55 to +150°C (see de rating chart) |

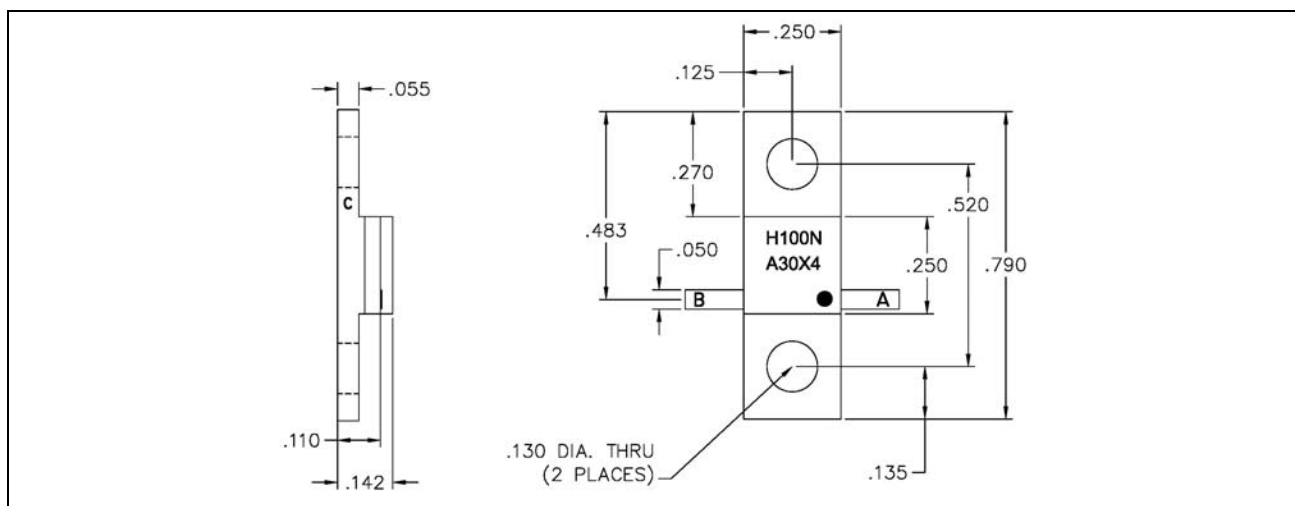
Tolerance is ± 0.010 ", unless otherwise specified. Designed to meet or exceed applicable portions of MIL-E-5400. **All dimensions in inches.**

Electrical Specifications

| | |
|---------------------------|---|
| Attenuation Value: | 30 dB, $\pm 5/-2$ dB, DC - 2.2 GHz 30 dB, $\pm 7/-2$ dB, 2.2 GHz – 2.7 GHz |
| Power: | 100 Watts |
| Frequency Range: | DC – 2.7 GHz |
| Return Loss | >24 dB to 2.2 GHz >20 dB to 4.0 GHz |

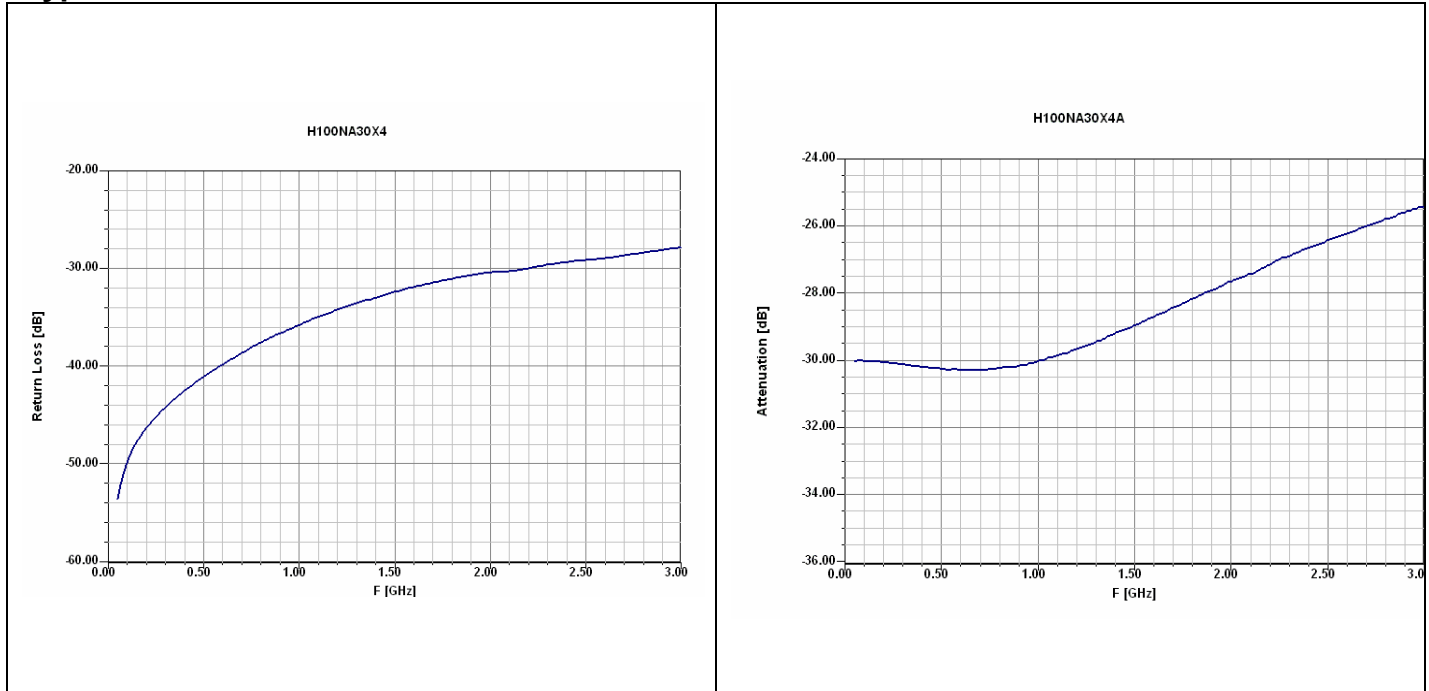
Specification based on unit properly installed using suggested mounting instructions and a 50 ohm nominal impedance. **Specifications subject to change.**

Outline Drawing

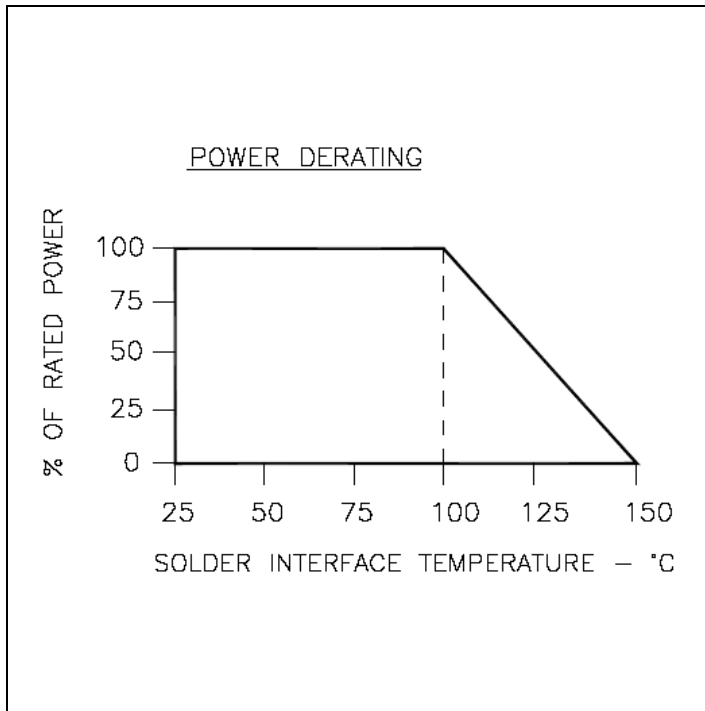


H100NA30X4 (097) rev.B pg. 1 of 2

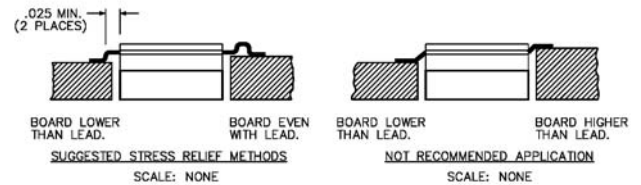
Typical Performance:



Power De-rating:



Mounting Footprint and Procedure:

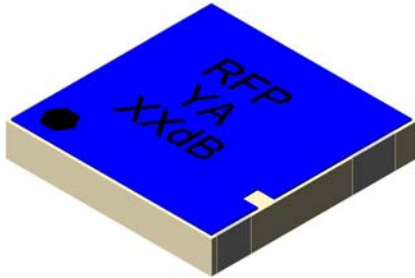


SUGGESTED MOUNTING PROCEDURES:

1. MAKE SURE THAT THE DEVICES ARE MOUNTED ON FLAT SURFACES (.001" UNDER THE DEVICE) TO OPTIMIZE THE HEAT TRANSFER.
2. DRILL & TAP THE HEATSINK FOR THE APPROPRIATE THREAD SIZE TO BE USED.
3. COAT HEATSINK WITH A MINIMUM AMOUNT OF HIGH QUALITY SILICONE GREASE (.001" MAX. THICKNESS).
4. POSITION DEVICE ON MOUNTING SURFACE & SECURE USING SOCKET HEAD SCREWS, FLAT & SPLIT WASHER. TORQUE SCREWS TO THE APPROPRIATE VALUE. MAKE SURE THAT THE DEVICE IS FLAT AGAINST THE HEATSINK. (CARE SHOULD BE TAKEN TO AVOID UPWARD PRESSURE OF THE LEADS TOWARDS THE LID).
5. SOLDER LEADS IN PLACE USING LEAD FREE TYPE SOLDER WITH A CONTROLLED TEMPERATURE IRON

**RoHS
Compliant**

Surface Mount Attenuator 30 Watts



Description

The D30AXXY4 is high performance Alumina (Al₂O₃) surface mount attenuator intended as a lower cost alternative to Aluminum Nitride (AlN) and Beryllium Oxide (BeO). The attenuator is well suited to all cellular frequency bands such as; AMPS, GSM, DCS, PCS, PHS and UMTS. The high power handling makes the part ideal for inter-stage matching, directional couplers, and for use in isolators.

General Specifications

| | |
|------------------------------|---------------------------------|
| Resistive Element | Thick film |
| Substrate | Alumina Ceramic |
| Terminal Finish | Matte Tin over Sulfamate Nickel |
| Operating Temperature | -55 to +150°C (see chart) |

Tolerance is ± 0.010 ", unless otherwise specified. Designed to meet or exceed applicable portions of MIL-E-5400. All dimensions in inches.

Electrical Specifications

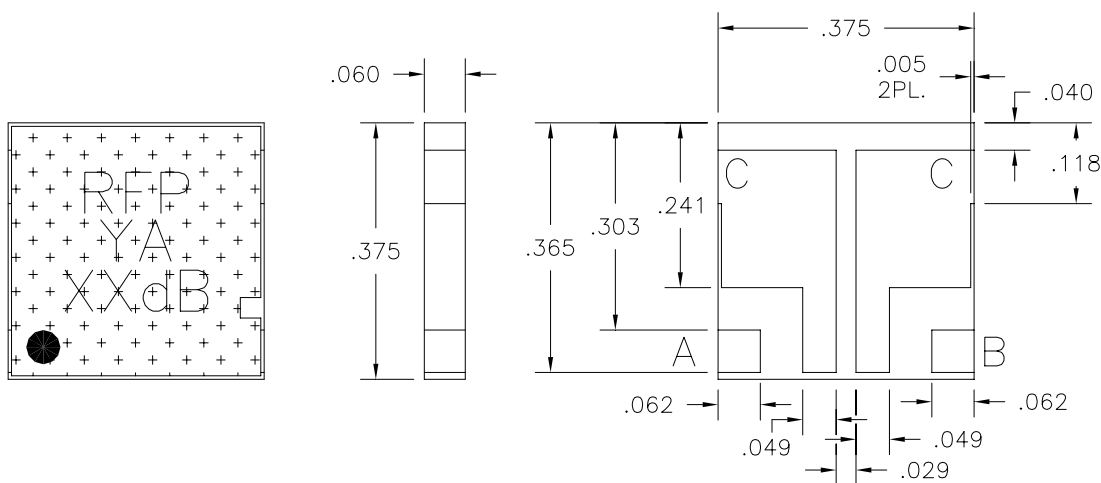
| | |
|---------------------------|--------------|
| Attenuation Value: | 20 & 30dB |
| Power: | 30 Watts |
| Frequency Range: | DC – 2.0 GHz |
| V.S.W.R.: | 1.20:1 |

Specification based on unit properly installed using suggested mounting instructions and a 50 ohm nominal impedance. **Specifications subject to change.**

Features:

- 30 Watts
- Lowest Cost
- True Surface Mount
- Alumina Ceramic
- Non-Nichrome Resistive Element
- Low VSWR
- 100% Tested

Outline Drawing



Dimensions given in inches.

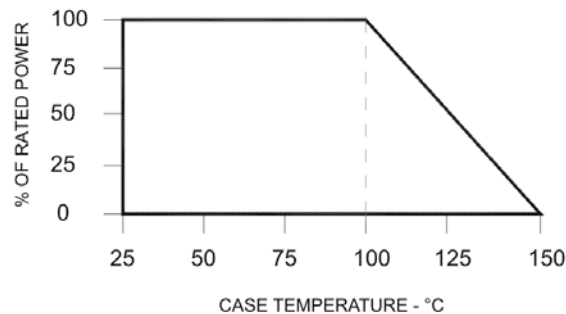
D30AXXY1 (097) Rev B



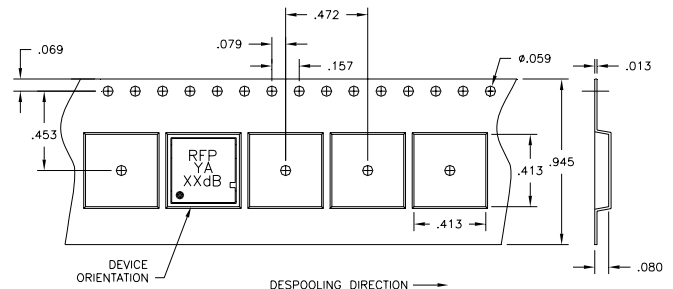
Specifications:

| RESISTOR VALUE CHART | | | | | |
|----------------------|-------------|-------------|-------------|-----------|---------------------|
| ATTENUATION | VALUE (A-B) | VALUE (A-C) | VALUE (B-C) | TOLERANCE | R.F.P. STOCKING P/N |
| 20dB±.75dB | 258Ω | 61Ω | 61Ω | ±4% | D30A20Y4 |
| 30dB±.75dB | 197Ω | 53Ω | 53Ω | ±4% | D30A30Y4 |

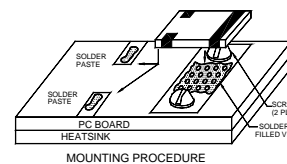
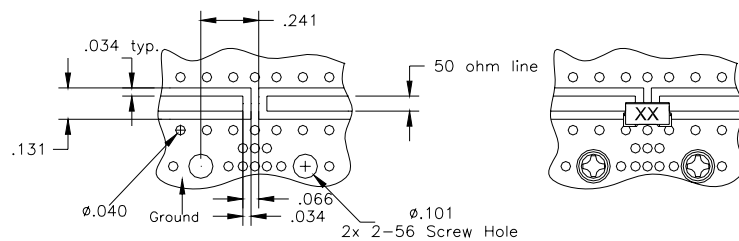
Power De-rating:



Tape & Reel:



Mounting Footprint and Procedure:



1. Drill thermal vias through PCB and fill with solder, such as SN63 type.
2. Solder part in place using SN63 type solder with controlled temperature iron (700°F).
3. To ensure good thermal connectivity to heat sink, drill and tap heatsink and mount PCB board to heat sink using screws.

D30AXXY4 (097) Rev B

USA/Canada: (315) 432-8909
Toll Free: (800) 544-2414
Europe: +44 2392-232392

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Reel For Pick and Place
Manufacturing.



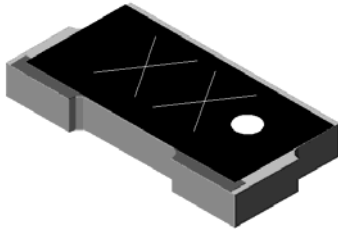
Anaren

What'll we think of next?™



Surface Mount Attenuator 7 Watts

Description



The D10AAXXZ4 is high performance Alumina (Al_2O_3) surface mount attenuator intended as a lower cost alternative to Aluminum Nitride (AlN) and Beryllium Oxide (BeO). The attenuator is well suited to all cellular frequency bands such as; AMPS, GSM, DCS, PCS, PHS and UMTS. The high power handling makes the part ideal for inter-stage matching, directional couplers, and for use in isolators.

General Specifications

| | |
|------------------------------|---------------------------------|
| Resistive Element | Thick film |
| Substrate | Alumina Ceramic |
| Terminal Finish | Matte Tin over Sulfamate Nickel |
| Operating Temperature | -55 to +125°C (see chart) |

Tolerance is $\pm 0.010"$, unless otherwise specified. Designed to meet or exceed applicable portions of MIL-E-5400. All dimensions in inches.

Electrical Specifications

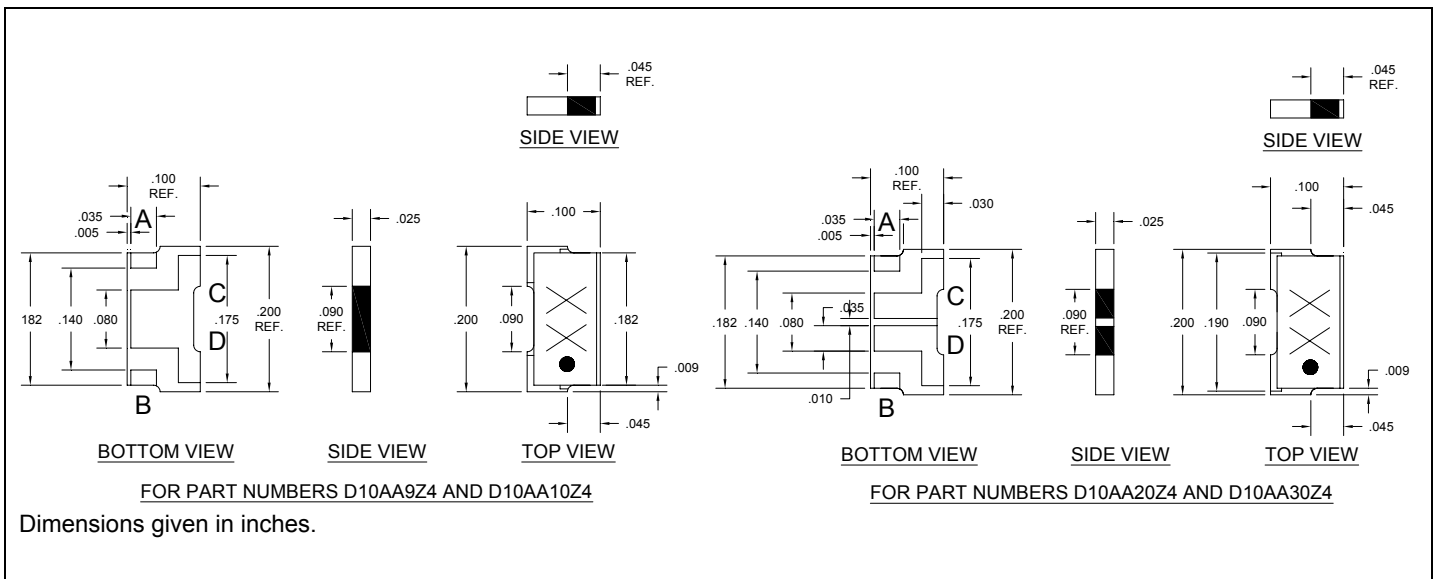
| | |
|---------------------------|-------------------------|
| Attenuation Value: | 1 – 6, 9, 10, 20 & 30dB |
| Power: | 7 Watts |
| Frequency Range: | DC – 3.0 GHz |
| V.S.W.R.: | <1.25:1 |

Specification based on unit properly installed using suggested mounting instructions and a 50 ohm nominal impedance. **Specifications subject to change.**

Features:

- RoHS compliant
- Lowest Cost
- True Surface Mount
- Alumina Ceramic
- Non-Nichrome Resistive Element
- Low VSWR
- 100% Tested

Outline Drawing



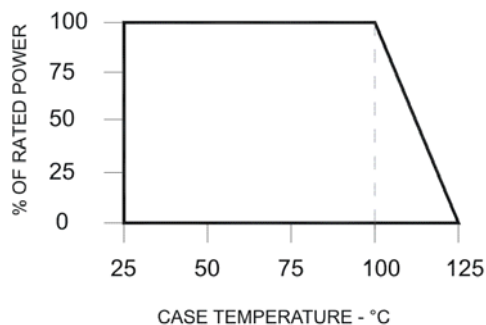
Rev. 6/24/05



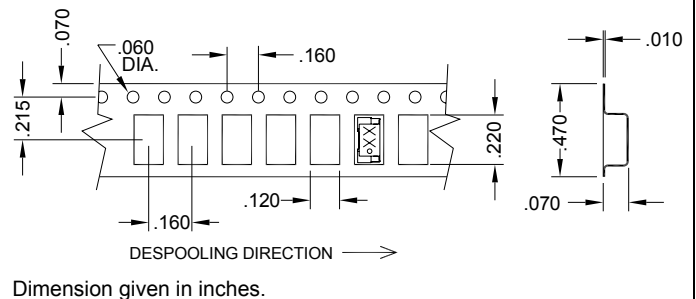
Specifications:

| PART NUMBER | ATTENUATION(dB) | TOL. (±dB) | POWER (WATTS) | VSWR | FREQ (GHZ) |
|-------------|-----------------|------------|---------------|--------|------------|
| D10AA1Z4 | 1 | 0.30 | 7 | 1.25:1 | 3.0 |
| D10AA2Z4 | 2 | 0.30 | 7 | 1.25:1 | 3.0 |
| D10AA3Z4 | 3 | 0.30 | 7 | 1.25:1 | 3.0 |
| D10AA4Z4 | 4 | 0.30 | 7 | 1.25:1 | 3.0 |
| D10AA5Z4 | 5 | 0.30 | 7 | 1.25:1 | 3.0 |
| D10AA6Z4 | 6 | 0.30 | 7 | 1.25:1 | 3.0 |
| D10AA9Z4 | 9 | 0.25 | 7 | 1.25:1 | 3.0 |
| D10AA10Z4 | 10 | 0.25 | 7 | 1.25:1 | 3.0 |
| D10AA20Z4 | 20 | 0.50 | 7 | 1.25:1 | 3.0 |
| D10AA30Z4 | 30 | 1.50 | 7 | 1.25:1 | 3.0 |

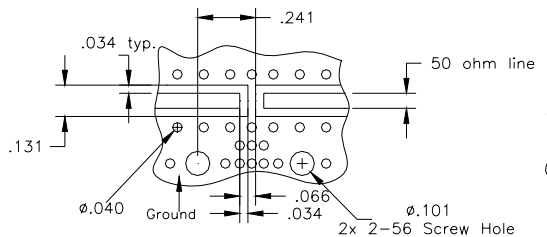
Power De-rating:



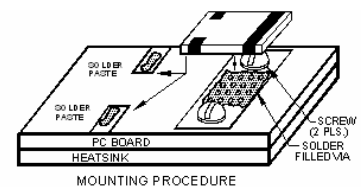
Tape & Reel:



Mounting Footprint and Procedure:



Dimension given in inches.
For best thermal performance the PCB should be placed with thermal joint compound to the heat sink.



1. DRILL THERMAL VIAS THROUGH PCB AND FILL WITH SOLDER, SUCH AS Sn96.
2. SOLDER PART IN PLACE USING Sn96 TYPE SOLDER WITH A CONTROLLED TEMPERATURE IRON (260°C)
3. TO ENSURE GOOD THERMAL CONNECTIVITY TO HEAT SINK, DRILL AND TAP HEATSINK AND MOUNT PCB BOARD TO HEATSINK USING SCREWS.

USA/Canada: (315) 432-8909
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Available on Tape and Reel For Pick and Place Manufacturing.



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Material Declaration

D10AAXXZ4

Matte Tin Finish

| Material | Weight | | (PPM) | CAS Number |
|---|-----------|-----------|-----------|------------|
| | (lbs) | (g) | | |
| Alumina | 5.889E-05 | 2.671E-02 | 7.496E+05 | 1344-28-1 |
| Diethylene Glycol Ethyl Ether Acetate | 2.212E-07 | 1.004E-04 | 2.818E+03 | 1121-52 |
| Dipropylene Glycol Monomethyl Ether | 2.976E-7 | 1.350E-04 | 3.789E+03 | 3459-09-48 |
| Epoxy resin and polymers | 1.323E-06 | 6.000E-04 | 1.684E+4 | 1002 |
| Matte Tin | 1.381E-06 | 6.262E-04 | 1.758E+04 | 7440-31-5 |
| Nickel | 8.416E-07 | 3.817E-04 | 1.071E+04 | 7440-02-0 |
| Polymer | 6.507E-07 | 2.952E-04 | 8.285E+03 | |
| Propylene Glycol Monomethyl Ether Acetate | 1.775E-07 | 8.050E-05 | 2.259E+03 | 1086-56 |
| Ruthenium | 1.618E-06 | 7.341E-04 | 2.060E+04 | 12036-10-1 |
| Silicon Oxide | 7.490E-07 | 3.397E-04 | 9.534E+03 | 10097-28-6 |
| Silver Alloy | 1.062E-05 | 4.816E-03 | 1.352E+05 | 7440-22-4 |

| | | |
|--------------------------------|-----------|-----------|
| Total Weight Calculated | 7.855E-05 | 3.563E-02 |
|--------------------------------|-----------|-----------|

| | | |
|------------------------------|-----------|-----------|
| Total Weight Measured | 7.932E-05 | 3.598E-02 |
|------------------------------|-----------|-----------|

The values presented above are estimates at the current revision, and it is derived from vendor supplied data. While Anaren strives for accurate reporting, due to product and process variations at both Anaren and our suppliers, the quoted values are our best estimates only, and not measured absolute values. Product specifications are subject to change without notice.



**RoHS
Compliant**

**Surface Mount
Resistors
5 Watts**



General Specifications

| | |
|------------------------------|---------------------------|
| Resistive Element | Thick film |
| Substrate | Alumina Ceramic |
| Terminals | Thick film Silver |
| Operating Temperature | -55 to +125°C (see chart) |

Tolerance is $\pm 0.010"$, unless otherwise specified. Designed to meet or exceed applicable portions of MIL-E-5400. All dimensions in inches.

Electrical Specifications

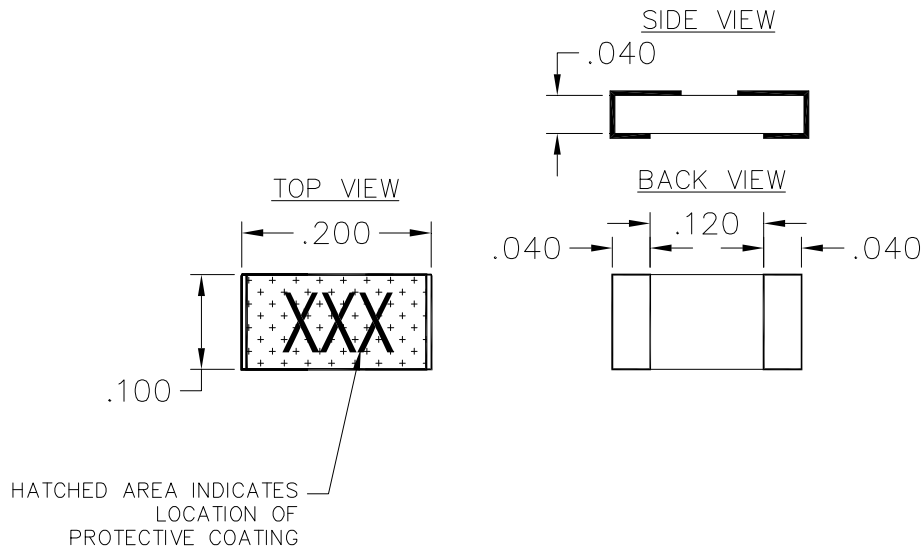
| | |
|--------------------------|----------------------|
| Resistance Value: | See Chart, $\pm 2\%$ |
| Power: | 5 Watts |
| Frequency Range: | DC – 3.0 GHz |
| Capacitance | 0.3 pF |

Specification based on unit properly installed using suggested mounting instructions and a 50 ohm nominal impedance. **Specifications subject to change without notice**

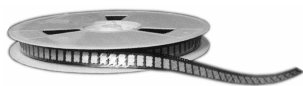
Features:

- 5 Watts
- Surface Mount
- Beryllium Oxide Ceramic
- Non-Nichrome Resistive Element
- Low VSWR
- 100% Tested
- RoHS Compliant

Outline Drawing



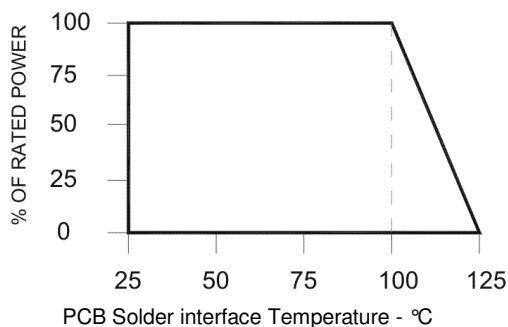
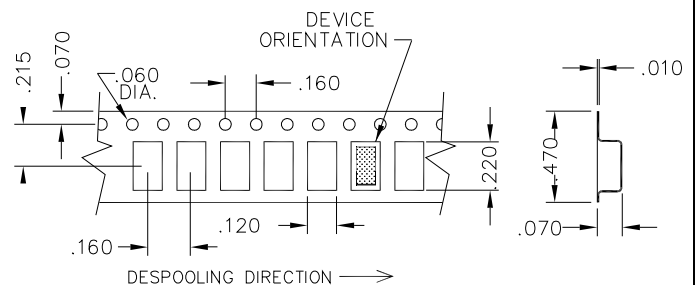
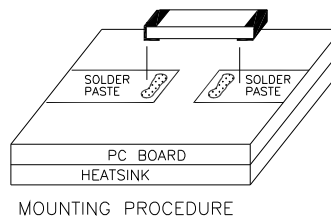
D5BXXXXY1A (097) Rev D



**RoHS
Compliant**

TABLE I

| REFERENCE | VALUE | TOL. | MATERIAL |
|------------|---------------|-----------|----------|
| D5BR5Y1A | 0.5 Ω | $\pm 2\%$ | BeO .040 |
| D5B1Y1A | 1 Ω | $\pm 2\%$ | BeO .040 |
| D5B1R2Y1A | 1.2 Ω | $\pm 2\%$ | BeO .040 |
| D5B4Y1A | 4 Ω | $\pm 2\%$ | BeO .040 |
| D5B5Y1A | 5 Ω | $\pm 2\%$ | BeO .040 |
| D5B10Y1A | 10 Ω | $\pm 2\%$ | BeO .040 |
| D5B25Y1A | 25 Ω | $\pm 2\%$ | BeO .040 |
| D5B36R5Y1A | 36.5 Ω | $\pm 1\%$ | BeO .040 |
| D5B39R2Y1A | 39.2 Ω | $\pm 1\%$ | BeO .040 |
| D5B50Y1A | 50 Ω | $\pm 2\%$ | BeO .040 |
| D5B51Y1A | 51 Ω | $\pm 1\%$ | BeO .040 |
| D5B54Y1A | 54 Ω | $\pm 2\%$ | BeO .040 |
| D5B100Y1A | 100 Ω | $\pm 2\%$ | BeO .040 |
| D5B120Y1A | 120 Ω | $\pm 2\%$ | BeO .040 |
| D5B150Y1A | 150 Ω | $\pm 2\%$ | BeO .040 |
| D5B220Y1A | 220 Ω | $\pm 2\%$ | BeO .040 |
| D5B255Y1A | 255 Ω | $\pm 2\%$ | BeO .040 |
| D5B750Y1A | 750 Ω | $\pm 2\%$ | BeO .040 |
| D5B1KY1A | 1K Ω | $\pm 2\%$ | BeO .040 |

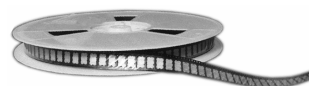
Power De-rating:**Tape & Reel:****Mounting Footprint and Procedure:**

1. Make sure that the devices are mounted on flat surfaces (0.001" under the device) to optimize the heat transfer.
2. Position device on mounting surface and solder in place using an appropriate type solder.

D5BXXXXY1A (097) Rev D

USA/Canada: (315) 432-8909
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Europe: +44 2392-232392

Available on Tape and
Reel For Pick and Place
Manufacturing.



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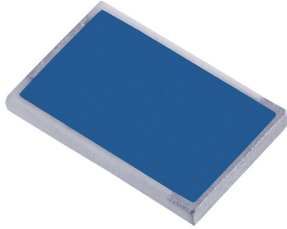
Anaren

RF Power

Model D10BXXXY1A

**RoHS
Compliant**

**Surface Mount Resistor
10 Watts**



General Specifications

| | |
|-------------------|-------------------------|
| Resistive Element | Thick film |
| Substrate | Beryllium oxide ceramic |

Electrical Specifications

| | |
|-------------------|--------------|
| Resistance Range: | See Chart |
| Frequency Range; | DC – 2.0 GHz |
| Power: | 10 Watts |
| Capacitance: | 1.4 pF |

Tolerance is ± 0.010 ", unless otherwise specified. Designed to meet or exceed applicable portions of MIL-E-5400. Operating temperature is -55°C to 125°C (see chart for derating temperatures).

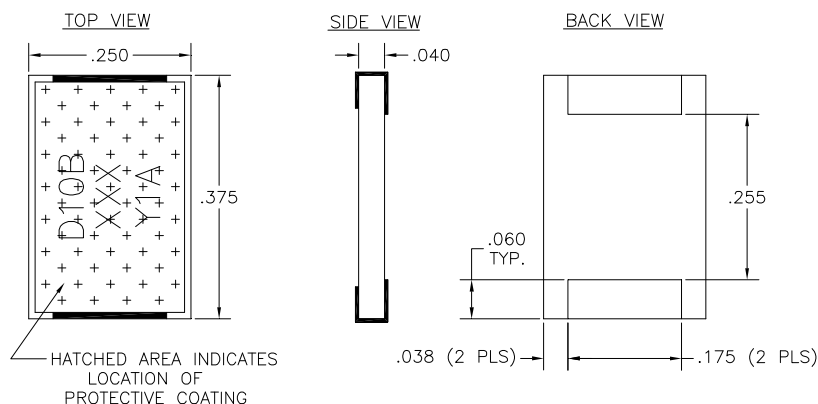
All dimensions in inches.

Specifications subject to change without notice.

Features:

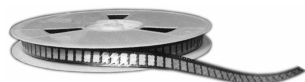
- DC – 2.0 GHz
- 10 Watts
- BeO Ceramic
- Non-Nichrome Resistive Element
- 100% Tested
- RoHS Compliant

Outline Drawing



D10BXXXY1A (097) Rev B

Anaren
What'll we think of next?™

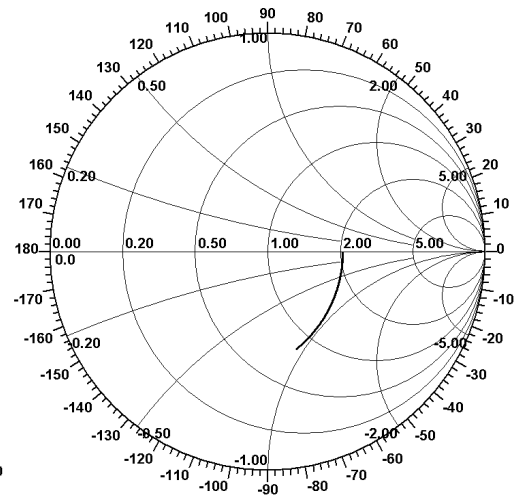
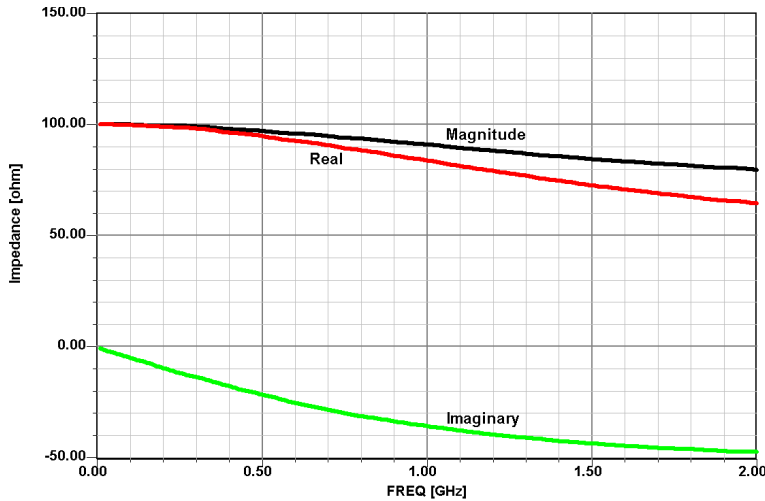


Available on Tape
and Reel For Pick and
Place Manufacturing.

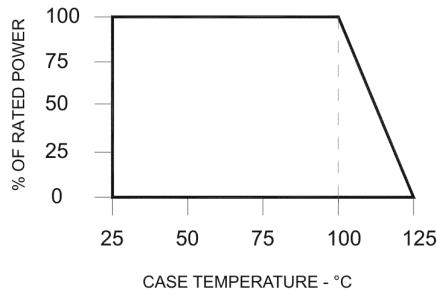
USA/Canada: (315) 432-8909
Toll Free: (800) 544-2414
Europe: +44 2392-232392

Typical Performance for D10B100Y1A

RF Power

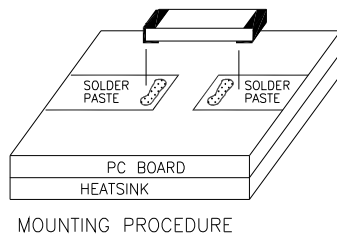


Power De-rating:



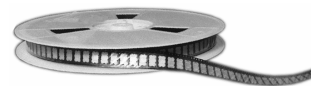
Mounting Procedure:

Performance Chart:



1. Make sure that the devices are mounted on flat surfaces (0.001" under the device) to optimize the heat transfer.
2. Position device on mounting surface and solder in place using an appropriate type solder.

| Value | Part Number | Tolerance |
|----------|-------------|-----------|
| 50 ohms | D10B50Y1A | ± 2% |
| 68 ohms | D10B68Y1A | ± 2% |
| 100 ohms | D10B100Y1A | ± 2% |
| 300 ohms | D10B300Y1A | ± 1% |
| 1K ohms | D10B1KY1A | ± 2% |





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